

CC253x System-on-Chip Solution for 2.4-GHz IEEE 802.15.4 and ZigBee® Applications

CC2540 System-on-Chip Solution for 2.4-GHz *Bluetooth*® low energy Applications

User's Guide



Literature Number: SWRU191B
April 2009–Revised September 2010

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Read This First

About This Manual

The CC2540 is a cost-effective, low-power, and true system-on-chip (SoC) solution for Bluetooth low-energy applications. It enables robust BLE master or slave nodes to be built with very low total bill-of-material costs. The CC2540 combines the excellent performance of a leading RF transceiver with an industry-standard enhanced 8051 MCU, in-system programmable flash memory, 8-KB RAM, and many other powerful supporting features and peripherals. The CC2540 is suited for systems where very low power consumption is required. Very low-power sleep modes are available. Short transition times between operating modes further enable low power consumption.

The CC2540 comes in two different versions: CC2540F128 and CC2540F256, with 128 KB and 256 KB of flash memory, respectively.

Combined with the Bluetooth low-energy protocol stack from Texas Instruments, the CC2540F128/F256 constitutes the market's most comprehensive single-mode Bluetooth low energy solution.

The CC253x System-on-Chip solution for 2.4 GHz is suitable for a wide range of applications. These can easily be built on top of the IEEE 802.15.4 based standard protocols (RemoTI™ network protocol, TIMAC software, and Z-Stack™ software for ZigBee® compliant solutions) or on top of the proprietary SimpliciTI™ network protocol. The usage is, however, not limited to these protocols alone. The CC253x family is, e.g. also suitable for 6LoWPAN and Wireless HART implementations.

Each chapter of this manual describes details of a module or peripheral; however, not all features are present on all devices. To see the differences regarding features, see [Table 0-1](#) in the [Devices](#) section.

For detailed technical numbers, such as power consumption and RF performance, see the device-specific data sheet ([Appendix C](#)).

Related Documentation and Software From Texas Instruments

Related documentation (e.g., the CC2530 data sheet <http://www-s.ti.com/sc/techlit/swrs081> and CC2540 data sheet <http://www-s.ti.com/sc/techlit/swrs084>) can be found in [Appendix C](#).

For more information regarding software that can be used with the CC253x/CC2540 System-on-Chip solution (e.g., SmartRF™ software for radio performance and functionality evaluation), see [Chapter 26](#), which also contains more information regarding the RemoTI network protocol, the SimpliciTI network protocol, the TIMAC software, the Z-Stack software, and the BLE stack software.

FCC Warning

This equipment is intended for use in a laboratory test environment only. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to subpart J of part 15 of FCC rules, which are designed to provide reasonable protection against radio frequency interference. Operation of this equipment in other environments may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

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Bluetooth is a registered trademark of Bluetooth SIG, Inc.
Microsoft, Windows are trademarks of Microsoft Corporation.
ZigBee is a registered trademark of ZigBee Alliance.

If You Need Assistance

All technical support is channeled through the TI Product Information Centers (PIC) - www.ti.com/support. To send an E-mail request, please enter your contact information, along with your request at the following link – [PIC request form](#).

Also visit the Low Power RF, ZigBee, and Bluetooth low-energy sections of the TI E2E Community (www.ti.com/lprf-forum), where you can easily get in touch with other CC253x and CC2540 users and find FAQs, Design Notes, Application Notes, Videos, etc.

You can also see the [TI Knowledgebase for Analog & Mixed-Signal](#).

Glossary

Abbreviations used in this user guide can be found in [Appendix A](#).

Devices

The CC253x System-on-Chip solution family consists of several devices. The following table provides a device overview and points out the differences regarding memory sizes and peripherals. For a complete feature list of any of the devices, see the corresponding data sheet ([Appendix C](#)).

Table 0-1. CC253x Family Overview

Feature	CC2530F32/F64/F128/F256	CC2531F128/F256	CC2533F32/F64/F96	CC2540F128/F256
FLASH_SIZE	32 KB/64 KB/128 KB/256 KB	128 KB/256 KB	32 KB/64 KB/96 KB	128 KB/256 KB
SRAM_SIZE	8 KB/8 KB/8 KB/8 KB	8 KB/8 KB	4 KB/4 KB/6 KB	8 KB
USB	Not included	Included	Not included	Included
ADC	Included	Included	Not included	Included
Battery monitor	Not included	Not included	Included	Not included
I ² C	Not included	Not included	Included	Not included
Operational amplifier	Included	Included	Not included	Included
Analog comparator	Included	Included	Not included	Included

Legend:

FLASH_SIZE – The size of the flash

SRAM_SIZE – The size of the SRAM

Register Conventions

Each SFR and XREG register is described in a separate table, where each table title contains the following information in the format indicated:

For SFR registers: REGISTER NAME (SFR address) – register description

For XREG registers: REGISTER NAME (XDATA address) – register description

Each table has five columns to describe the different register fields as described in the following:

Column 1 – Bit: Denotes which bits of the register are described/addressed in the specific row

Column 2 – Name: Specific name of the register field

Column 3 – Reset: Reset/initial value of the register field

Column 4 – R/W: Key indicating the accessibility of the bits in the field (see [Table 0-2](#) for more details)

Column 5 – Description: More details about the register field, and often a description of the functions of the different values

In the register descriptions, each register field is shown with a symbol (R/W) indicating the access mode of the register field. The register values are always given in binary notation unless prefixed by 0x, which indicates hexadecimal notation.

Table 0-2. Register Bit Conventions

SYMBOL	ACCESS MODE
R/W	Read/write
R	Read-only
R0	Read as 0
R1	Read as 1
W	Write-only
W0	Write as 0
W1	Write as 1
H0	Hardware clear
H1	Hardware set

Introduction

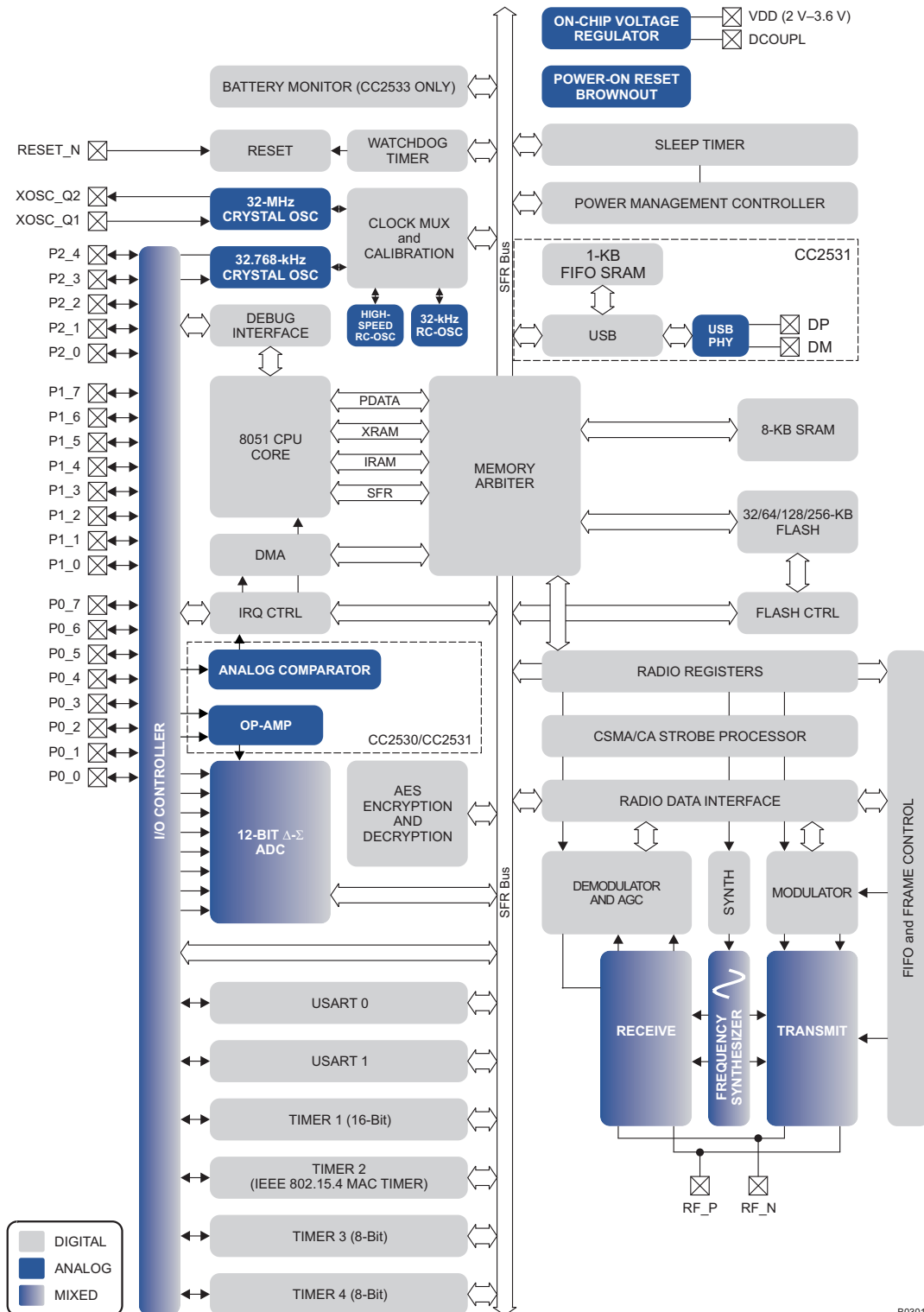
As mentioned in the preface, the CC253x/CC2540 device family provides solutions for a wide range of applications. In order to help the user to develop these applications, this user's guide focuses on the usage of the different building blocks of the CC253x/CC2540 device family. For detailed device descriptions, complete feature lists, and performance numbers, see the device-specific data sheet ([Appendix C](#)).

In order to provide easy access to relevant information, the following subsections guide the reader to the different chapters in this guide.

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1.1 Overview

The block diagrams in [Figure 1-1](#) and [Figure 1-2](#) show the different building blocks of the CC253x and CC2540 device family. Not all features and functions of all modules or peripherals are present on all devices of the CC253x/CC2540; hence, see the device-specific data sheet for a device-specific block diagram.



B0301-03

Figure 1-1. CC253x Block Diagram

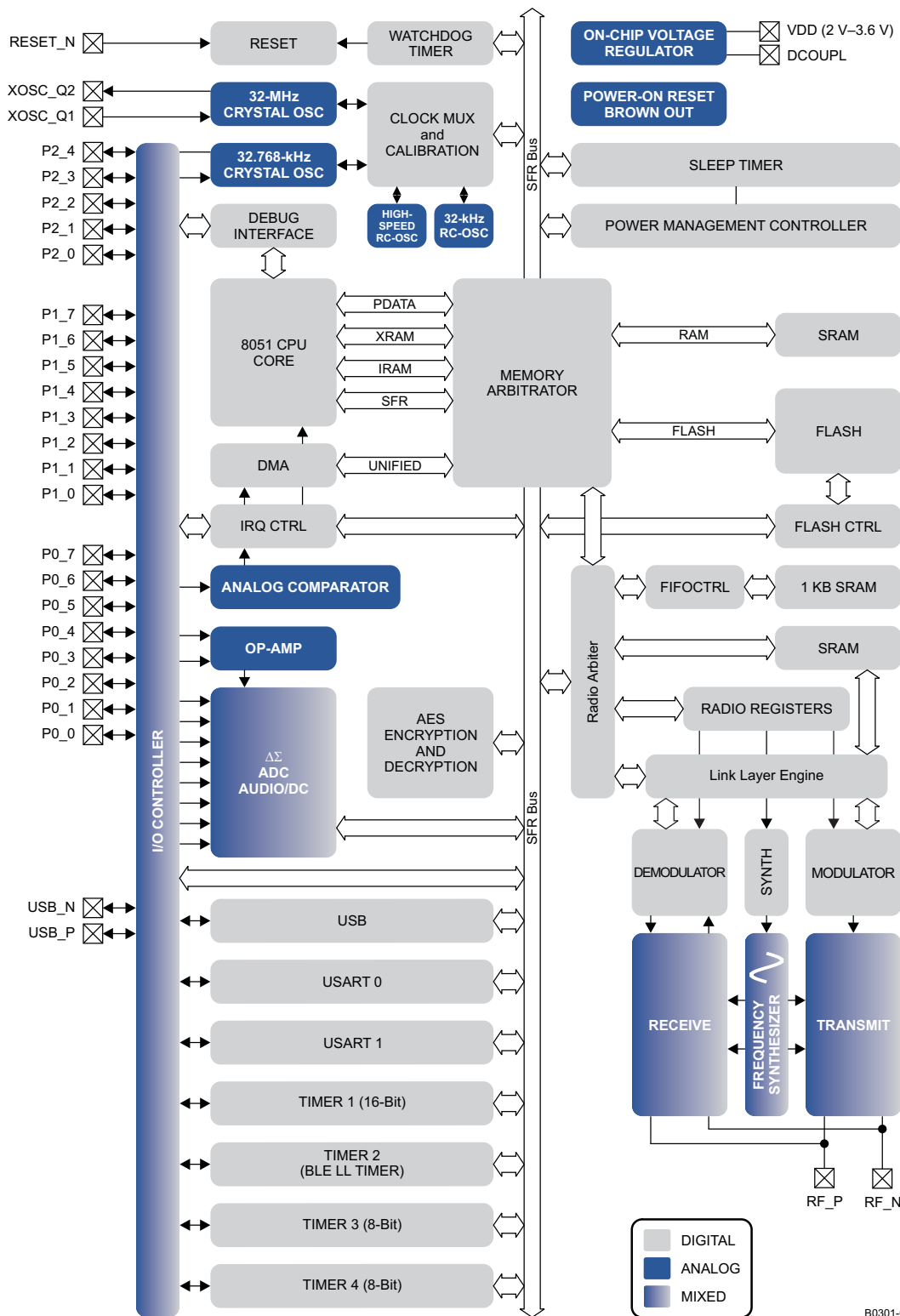


Figure 1-2. 95CC2540 Block Diagram

The modules can be roughly divided into one of three categories: CPU and memory related modules; modules related to peripherals, clocks, and power management; and radio-related modules.

1.1.1 CPU and Memory

The **8051 CPU core** is a single-cycle 8051-compatible core. It has three different memory access buses (SFR, DATA, and CODE/XDATA) with single-cycle access to SFR, DATA, and the main SRAM. It also includes a debug interface and an 18-input extended interrupt unit. The detailed functionality of the CPU and the memory is addressed in [Chapter 2](#).

The **interrupt controller** services a total of 18 interrupt sources, divided into six interrupt groups, each of which is associated with one of four interrupt priorities. Any interrupt service request is serviced also when the device is in idle mode by going back to active mode. Some interrupts can also wake up the device from sleep mode (when in sleep mode, the device is in one of the three low-power modes PM1, PM2, or PM3); see [Chapter 4](#) for more details.

The **memory arbiter** is at the heart of the system, as it connects the CPU and DMA controller with the physical memories and all peripherals through the SFR bus. The memory arbiter has four memory access points, access of which can map to one of three physical memories: SRAM, flash memory, and XREG/SFR registers. It is responsible for performing arbitration and sequencing between simultaneous memory accesses to the same physical memory.

The **4/6/8-KB SRAM** maps to the DATA memory space and to parts of the XDATA memory spaces. The SRAM is an ultralow-power SRAM that retains its contents in all power modes. This is an important feature for low-power applications.

The **32/64/96/128/256 KB flash block** provides in-circuit programmable non-volatile program memory for the device, and maps into the CODE and XDATA memory spaces. In addition to holding program code and constants, the non-volatile memory allows the application to save data that must be preserved such that it is available after restarting the device. Using this feature one can, e.g., use saved network-specific data to avoid the need for a full start-up and network find-and-join process.

1.1.2 Clocks and Power Management

The digital core and peripherals are powered by a 1.8-V low-dropout **voltage regulator** ([Chapter 25](#)). Additionally, the CC253x/CC2540 contains a power management functionality that allows the use of different low-power modes (PM1, PM2, and PM3) for low-power applications with a long battery life (see [Chapter 4](#) for more details). Five different **reset** sources exist to reset the device; see [Chapter 5](#) for more details.

1.1.3 Peripherals

The CC253x/CC2540 includes many different peripherals that allow the application designer to develop advanced applications. Not all peripherals are present on all devices. See [Table 0-1](#) for a listing of which peripherals are present on each device.

The **debug interface** ([Chapter 3](#)) implements a proprietary two-wire serial interface that is used for in-circuit debugging. Through this debug interface, it is possible to perform an erasure of the entire flash memory, control which oscillators are enabled, stop and start execution of the user program, execute supplied instructions on the 8051 core, set code breakpoints, and single-step through instructions in the code. Using these techniques, it is possible to perform in-circuit debugging and external flash programming elegantly.

The device contains flash memory for storage of program code. The flash memory is programmable from the user software and through the debug interface (as mentioned previously). The **flash controller** ([Chapter 6](#)) handles writing and erasing the embedded flash memory. The flash controller allows page-wise erasure and 4-bytewise programming.

The **I/O controller** ([Chapter 7](#)) is responsible for all general-purpose I/O pins. The CPU can configure whether peripheral modules control certain pins or whether they are under software control, and if so, whether each pin is configured as an input or output and if a pullup or pulldown resistor in the pad is connected. CPU interrupts can be enabled on each pin individually. Each peripheral that connects to the I/O pins can choose between two different I/O pin locations to ensure flexibility in various applications.

A versatile five-channel **DMA controller** ([Chapter 8](#)) is available in the system, accesses memory using the XDATA memory space, and thus has access to all physical memories. Each channel (trigger, priority, transfer mode, addressing mode, source and destination pointers, and transfer count) is configured with DMA descriptors anywhere in memory. Many of the hardware peripherals (AES core, flash controller, USARTs, timers, ADC interface) achieve highly efficient operation by using the DMA controller for data transfers between SFR or XREG addresses and flash/SRAM.

Timer 1 ([Chapter 9](#)) is a 16-bit timer with timer/counter/PWM functionality. It has a programmable prescaler, a 16-bit period value, and five individually programmable counter/capture channels, each with a 16-bit compare value. Each of the counter/capture channels can be used as a PWM output or to capture the timing of edges on input signals. It can also be configured in IR generation mode, where it counts Timer 3 periods and the output is ANDed with the output of Timer 3 to generate modulated consumer IR signals with minimal CPU interaction (see [Section 9.9](#)).

Timer 2 (the MAC Timer) ([Chapter 22](#)) is specially designed for supporting an IEEE 802.15.4 MAC or other time-slotted protocol in software. The timer has a configurable timer period and a 24-bit overflow counter that can be used to keep track of the number of periods that have transpired. A 40-bit capture register is also used to record the exact time at which a start-of-frame delimiter is received/transmitted or the exact time at which transmission ends, as well as two 16-bit output compare registers and two 24-bit overflow compare registers that can send various command strobes (start RX, start TX, etc.) at specific times to the radio modules.

Timer 3 and Timer 4 ([Chapter 10](#)) are 8-bit timers with timer/counter/PWM functionality. They have a programmable prescaler, an 8-bit period value, and one programmable counter channel with an 8-bit compare value. Each of the counter channels can be used as a PWM output.

The **Sleep Timer** ([Chapter 11](#)) is an ultralow-power timer that counts 32-kHz crystal oscillator or 32-kHz RC oscillator periods. The Sleep Timer runs continuously in all operating modes except power mode 3 (PM3). Typical applications of this timer are as a real-time counter or as a wake-up timer for coming out of power mode 1 (PM1) or power mode 2 (PM2).

The **ADC** ([Chapter 12](#)) supports 7 bits (30 kHz bandwidth) to 12 bits (4 kHz bandwidth) of resolution. DC and audio conversions with up to eight input channels (Port 0) are possible. The inputs can be selected as single-ended or differential. The reference voltage can be internal, AVDD, or a single-ended or differential external signal. The ADC also has a temperature-sensor input channel. The ADC can automate the process of periodic sampling or conversion over a sequence of channels.

The **battery monitor** ([Chapter 13](#)) (CC2533 only) enables simple voltage monitoring in devices that do not include an ADC. It is designed such that it is accurate in the voltage areas around 2 V, with lower resolution at higher voltages.

The **random-number generator** ([Chapter 14](#)) uses a 16-bit LFSR to generate pseudorandom numbers, which can be read by the CPU or used directly by the command strobe processor. It can be seeded with random data from noise in the radio ADC.

The **AES coprocessor** ([Chapter 15](#)) allows the user to encrypt and decrypt data using the AES algorithm with 128-bit keys. The core is able to support the security operations required by IEEE 802.15.4 MAC security, the ZigBee network layer, and the application layer.

A built-in **Watchdog Timer** ([Chapter 16](#)) allows the device to reset itself in case the firmware hangs. When enabled by software, the Watchdog Timer must be cleared periodically; otherwise, it resets the device when it times out. It can alternatively be configured for use as a general 32-kHz timer.

USART 0 and **USART 1** ([Chapter 18](#)) are each configurable as either a SPI master/slave or a UART. They provide double buffering on both RX and TX and hardware flow control, and are thus well suited to high-throughput full-duplex applications. Each has its own high-precision baud-rate generator, thus leaving the ordinary timers free for other uses.

The **I²C** module ([Chapter 20](#)) (CC2533 only) provides a digital peripheral connection with two pins and supports both master and slave operation.

The **USB 2.0 controller** ([Chapter 21](#)) (CC2531 and CC2540) operates at Full-Speed, 12 Mbps transfer rate. The controller has five bidirectional endpoints in addition to control endpoint 0. The endpoints support Bulk, Interrupt, and Isochronous operation for implementation of a wide range of applications. The 1024 bytes of dedicated, flexible FIFO memory combined with DMA access ensures that a minimum of CPU involvement is needed for USB communication.

The **operational amplifier** ([Chapter 18](#)) (CC2530, CC2531, and CC2540) is intended to provide front-end buffering and gain for the ADC. Both the inputs as well as the output are available on pins, so the feedback network is fully customizable. A chopper-stabilized mode is available for applications that need good accuracy with high gain.

The ultralow-power **analog comparator** ([Chapter 19](#)) (CC2530, CC2531 and CC2540) enables applications to wake up from PM2 or PM3 based on an analog signal. Both inputs are brought out to pins; the reference voltage must be provided externally. The comparator output is mapped into the digital I/O port and can be treated by the MCU as a regular digital input.

1.1.4 Radio

The CC2540 provides a Bluetooth low-energy-compliant radio transceiver. The RF core which controls the analog and digital radio modules is only indirectly accessible through API commands to the BLE stack. More details about the CC2540 radio can be found in [Chapter 24](#).

The CC253x device family provides an **IEEE 802.15.4-compliant radio transceiver**. The RF Core controls the analog radio modules. In addition, it provides an interface between the MCU and the radio which makes it possible to issue commands, read status, and automate and sequence radio events. The radio also includes a packet-filtering and address-recognition module. More details about the CC253x radio can be found in [Chapter 23](#).

1.2 Applications

As shown in the overview ([Section 1.1](#)), this user's guide focuses on the functionality of the different modules that are available to build different types of applications based on the CC253x/CC2540 device family. When looking at the complete application development process, additional information is useful. However, as this information and help is not device-specific (i.e., not unique for the CC253x/CC2540 device family), see the additional information sources in the following paragraphs.

The first step is to set up the development environment (HW, tools, etc.) by purchasing a **development kit** (see the device-specific product Web site to find links to the relevant development kits). The development kits come with an out-of-the-box demo and information on how to set up the development environment; install required drivers (done easily by installing the **SmartRF software**, [Section 26.1](#)), set up the compiler tool chain, etc. As soon as one has installed the development environment, one is ready to start the application development.

The easiest way to write the application software is to base the application on one of the available standard protocols (**RemoTI** network protocol, [Section 26.2](#); **TIMAC** software, [Section 26.4](#); **Z-Stack** software for ZigBee-compliant solutions, [Section 26.5](#)); BLE stack software for Bluetooth low-energy-compliant solutions [Section 26.6](#); or the proprietary **SimpliciTI** network protocol ([Section 26.3](#)). They all come with several sample applications.

For the hardware layout design of the user-specific HW, the designer can find reference designs on the different product pages ([Section B.1](#)). By copying these designs, the designer achieves optimal performance. The developed HW can then be tested easily using the SmartRF Studio software ([Section 26.1](#)).

In case the final system should not have the expected performance, it is recommended to try out the developed software on the development kit hardware and see how it works there. To check the user-specific HW, it is a good first step to use SmartRF Studio software to compare the development kit performance versus the user-specific HW using the same settings.

The user can also find additional information and help by joining the **Low-Power RF Online Community** ([Section B.2](#)) and by subscribing to the **Low-Power RF eNewsletter** ([Section B.4](#)).

To contact a third-party to help with development or to use modules, check out the Texas Instruments **Low-Power RF Developer Network** ([Section B.3](#)).

8051 CPU

The System-on-Chip solution is based on an enhanced 8051 core. More details regarding the core, memory map, instruction set, and interrupts are described in the following subsections.

Topic	Page
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2.2 Memory	24
2.3 CPU Registers	33
2.4 Instruction Set Summary	35
2.5 Interrupts	39

2.1 8051 CPU Introduction

The enhanced 8051 core uses the standard 8051 instruction set. Instructions execute faster than the standard 8051 due to the following:

- One clock per instruction cycle is used as opposed to 12 clocks per instruction cycle in the standard 8051.
- Wasted bus states are eliminated.

Because an instruction cycle is aligned with memory fetch when possible, most of the single-byte instructions are performed in a single clock cycle. In addition to the speed improvement, the enhanced 8051 core also includes architectural enhancements:

- A second data pointer
- An extended 18-source interrupt unit

The 8051 core is object-code-compatible with the industry-standard 8051 microcontroller. That is, object code compiled with an industry-standard 8051 compiler or assembler executes on the 8051 core and is functionally equivalent. However, because the 8051 core uses a different instruction timing than many other 8051 variants, existing code with timing loops may require modification. Also, because the peripheral units such as timers and serial ports differ from those on other 8051 cores, code which includes instructions using the peripheral-unit SFRs does not work correctly.

Flash prefetching is not enabled by default, but improves CPU performance by up to 33%. This is at the expense of slightly increased power consumption, but in most cases improves energy consumption as it is faster. Flash prefetching can be enabled in the `FCTL` register.

2.2 Memory

The 8051 CPU architecture has four different memory spaces. The 8051 has separate memory spaces for program memory and data memory. The 8051 memory spaces are the following (see [Section 2.2.1](#) and [Section 2.2.2](#) for details):

CODE. A read-only memory space for program memory. This memory space addresses 64 KB.

DATA. A read/write data memory space that can be directly or indirectly accessed by a single-cycle CPU instruction. This memory space addresses 256 bytes. The lower 128 bytes of the DATA memory space can be addressed either directly or indirectly, the upper 128 bytes only indirectly.

XDATA. A read/write data memory space, access to which usually requires 4–5 CPU instruction cycles. This memory space addresses 64 KB. Access to XDATA memory is also slower than DATA access, as the CODE and XDATA memory spaces share a common bus on the CPU core, and instruction prefetch from CODE can thus not be performed in parallel with XDATA accesses.

SFR. A read/write register memory space which can be directly accessed by a single CPU instruction. This memory space consists of 128 bytes. For SFR registers whose address is divisible by eight, each bit is also individually addressable.

The four different memory spaces are distinct in the 8051 architecture, but are partly overlapping in the device to ease DMA transfers and hardware debugger operation.

How the different memory spaces are mapped onto the three physical memories (flash program memory, SRAM, and memory-mapped registers) is described in [Section 2.2.1](#) and [Section 2.2.2](#).

2.2.1 Memory Map

The memory map differs from the standard 8051 memory map in two important aspects, as described in the following paragraphs.

First, in order to allow the DMA controller access to all physical memory and thus allow DMA transfers between the different 8051 memory spaces, parts of SFR and the DATA memory space are mapped into the XDATA memory space.

Second, two alternative schemes for CODE memory space mapping can be used. The first scheme is the standard 8051 mapping where only the program memory (i.e., flash memory) is mapped to CODE memory space. This mapping is the default after a device reset.

The second scheme is used for executing code from SRAM. In this mode, the SRAM is mapped into the region of 0x8000 through (0x8000 + SRAM_SIZE - 1). The map is shown in Figure 2. Executing code from SRAM improves performance and reduces power consumption.

The upper 32 KB of XDATA is a read-only area called XBANK. Any of the available 32 KB flash banks can be mapped in here. This gives software access to the whole flash memory. This area is typically used to store additional constant data.

Details about mapping of all 8051 memory spaces are given in Section 2.2.2.

The memory map showing how the different physical memories are mapped into the CPU memory spaces is given in Figure 2-1 through Figure 3. The number of available flash banks depends on the flash size option.

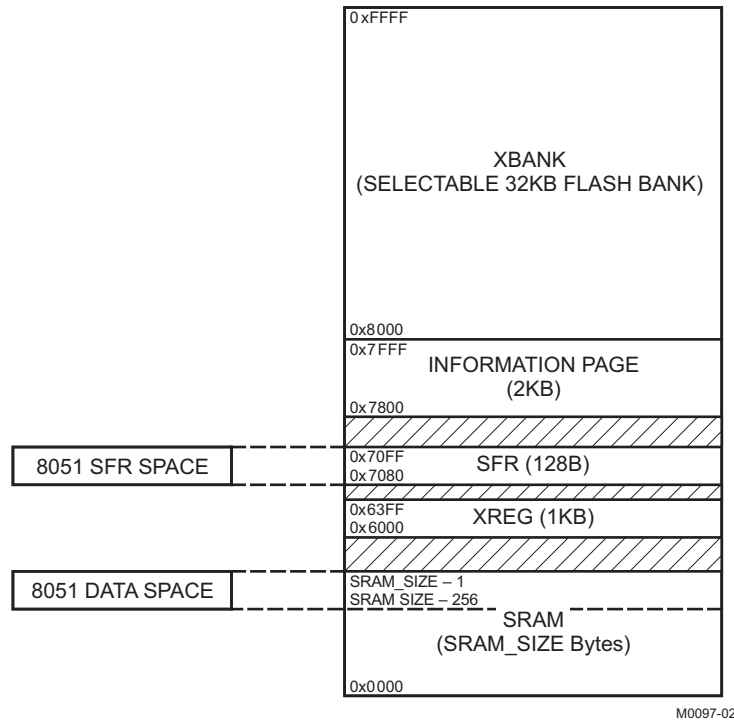


Figure 2-1. XDATA Memory Space (Showing SFR and DATA Mapping)

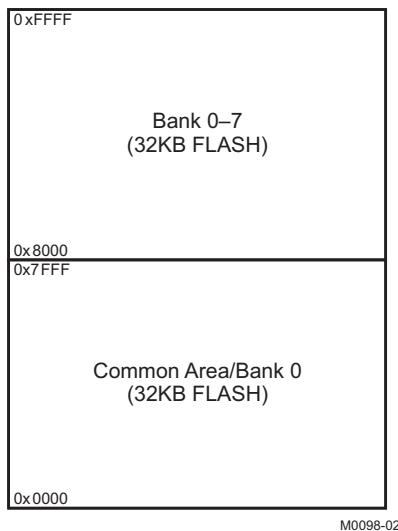


Figure 2. CODE Memory Space

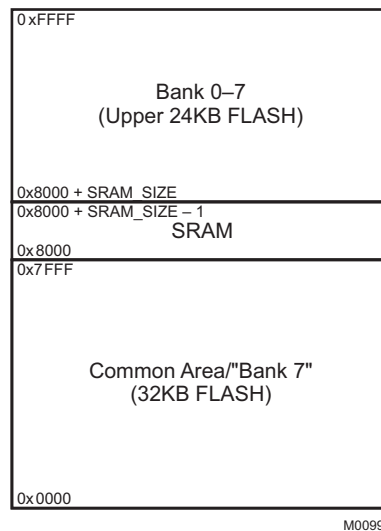


Figure 3. CODE Memory Space for Running Code From SRAM

2.2.2 CPU Memory Space

XDATA memory space. The XDATA memory map is given in [Figure 2-1](#).

The SRAM is mapped into address range of 0x0000 through (SRAM_SIZE – 1).

The XREG area is mapped into the 1-KB address range (0x6000–0x63FF). These registers are additional registers, effectively extending the SFR register space. Some peripheral registers and most of the radio control and data registers are mapped in here.

The SFR registers are mapped into address range (0x7080–0x70FF).

The flash information page (2 KB) is mapped into the address range (0x7800–0x7FFF). This is a read-only area and contains various information about the device.

The upper 32 KB of the XDATA memory space (0x8000–0xFFFF) is a read-only flash code bank (XBANK) and can be mapped to any of the available flash banks using the MEMCTR.XBANK[2:0] bits.

The mapping of flash memory, SRAM, and registers to XDATA allows the DMA controller and the CPU access to all the physical memories in a single unified address space.

Writing to unimplemented areas in the memory map (shaded in the figure) has no effect. Reading from unimplemented areas returns 0x00. Writes to read-only regions, i.e., flash areas, are ignored.

CODE memory space. The CODE memory space is 64 KB and is divided into a common area (0x0000–0x7FFF) and a bank area (0x8000–0xFFFF) as shown in [Figure 2](#). The common area is always mapped to the lower 32 KB of the physical flash memory (bank 0). The bank area can be mapped to any of the available 32-KB flash banks (from 0 to 7). The number of available flash banks depends on the flash size option. Use the flash-bank-select register, FMAP, to select the flash bank. On 32-KB devices, no flash memory can be mapped into the bank area. Reads from this region return 0x00 on these devices.

To allow program execution from SRAM, it is possible to map the available SRAM into the lower range of the bank area from 0x8000 through (0x8000 + SRAM_SIZE – 1). The rest of the currently selected bank is still mapped into the address range from (0x8000 + SRAM_SIZE) through 0xFFFF). Set the MEMCTR.XMAP bit to enable this feature.

DATA memory space. The 8-bit address range of DATA memory is mapped into the upper 256 bytes of the SRAM, i.e., the address range from (SRAM_SIZE – 256) through (SRAM_SIZE – 1).

SFR memory space. The 128-entry hardware register area is accessed through this memory space. The SFR registers are also accessible through the XDATA address space at the address range (0x7080–0x70FF). Some CPU-specific SFR registers reside inside the CPU core and can only be accessed using the SFR memory space and not through the duplicate mapping into XDATA memory space. These specific SFR registers are listed in [SFR Registers](#).

2.2.3 Physical Memory

RAM. All devices contain static RAM. At power on, the content of RAM is undefined. RAM content is retained in all power modes.

Flash Memory. The on-chip flash memory is primarily intended to hold program code and constant data. The flash memory has the following features:

- Page size: 1 KB or 2 KB (details are given in the data sheet of the device.)
- Flash-page erase time: 20 ms
- Flash-chip (mass) erase time: 20 ms
- Flash write time (4 bytes): 20 μs
- Data retention (at room temperature): 100 years
- Program/erase endurance: 20,000 cycles

The flash memory is organized as a set of 1- or 2-KB pages. The 16 bytes of the upper available page contain page-lock bits and the debug-lock bit. There is one lock bit for each page, except the lock-bit page which is implicitly locked when not in debug mode. When the lock bit for a page is 0, it is impossible to erase/write that page. When the debug lock bit is 0, most of the commands on the debug interface are ignored. The primary purpose of the debug lock bit is to protect the contents of the flash against read-out. The Flash Controller is used to write and erase the contents of the flash memory.

When the CPU reads instructions and constants from flash memory, it fetches the instructions through a cache. Four bytes of instructions and four bytes of constant data are cached, at 4-byte boundaries. That is, when the CPU reads from address 0x00F1 for example, bytes 0x00F0–0x00F3 are cached. A separate prefetch unit is capable of prefetching 4 additional bytes of instructions. The cache is provided mainly to reduce power consumption by reducing the amount of time the flash memory is accessed. The cache may be disabled with the `FCTL.CM[1:0]` register bits. Doing so increases power consumption and is not recommended. The execution time from flash is not cycle-accurate when using the default cache mode and the cache mode with prefetch, i.e., one cannot determine exactly the number of clock cycles a set of instructions takes. To obtain cycle-accurate execution, enable the real-time cache mode and ensure all DMA transfers have low priority. The prefetch mode improves performance by up to 33%, at the expense of increased power consumption due to wasted flash reads. Typically, performance improves by 15%–20%. Total energy, however, may decrease (depending on the application) due to fewer wasted clock cycles waiting for the flash to return instructions/data. This is very application-dependent and requires the use of power modes to be effective.

The **Information Page** is a 2-KB read-only region that stores various device information. Among other things, it contains for IEEE 802.15.4 or *Bluetooth* low energy compliant devices a unique IEEE address from the TI range of addresses. For CC253x, this is a 64-bit IEEE address stored with least-significant byte first at XDATA address 0x780C. For CC2540, this is a 48-bit IEEE address stored with least-significant byte first at XDATA address 0x780E.

SFR Registers. The special function registers (SFRs) control several of the features of the 8051 CPU core and/or peripherals. Many of the 8051 core SFRs are identical to the standard 8051 SFRs. However, there are additional SFRs that control features that are not available in the standard 8051. The additional SFRs are used to interface with the peripheral units and RF transceiver.

[Table 2-1](#) shows the addresses of all SFRs in the device. The 8051 internal SFRs are shown with gray background, whereas the other SFRs are the SFRs specific to the device.

NOTE: All internal SFRs (shown with gray background in [Table 2-1](#)), can only be accessed through SFR space, as these registers are not mapped into XDATA space. One exception is the port registers (P0, P1, and P2) which are readable from XDATA.

Table 2-1. SFR Overview

Register Name	SFR Address	Module	Description
ADCCON1	0xB4	ADC	ADC control 1
ADCCON2	0xB5	ADC	ADC control 2
ADCCON3	0xB6	ADC	ADC control 3
ADCL	0xBA	ADC	ADC data low
ADCH	0xBB	ADC	ADC data high
RNDL	0xBC	ADC	Random number generator data low
RNDH	0xBD	ADC	Random number generator data high
ENCDI	0xB1	AES	Encryption/decryption input data
ENCDO	0xB2	AES	Encryption/decryption output data
ENCCS	0xB3	AES	Encryption/decryption control and status
P0	0x80	CPU	Port 0. Readable from XDATA (0x7080)
SP	0x81	CPU	Stack pointer
DPL0	0x82	CPU	Data pointer 0 low byte
DPH0	0x83	CPU	Data pointer 0 high byte
DPL1	0x84	CPU	Data pointer 1 low byte
DPH1	0x85	CPU	Data pointer 1 high byte
PCON	0x87	CPU	Power mode control
TCON	0x88	CPU	Interrupt flags
P1	0x90	CPU	Port 1. Readable from XDATA (0x7090)

Table 2-1. SFR Overview (continued)

Register Name	SFR Address	Module	Description
DPS	0x92	CPU	Data pointer select
S0CON	0x98	CPU	Interrupt flags 2
IEN2	0x9A	CPU	Interrupt enable 2
S1CON	0x9B	CPU	Interrupt flags 3
P2	0xA0	CPU	Port 2. Readable from XDATA (0x70A0)
IEN0	0xA8	CPU	Interrupt enable 0
IP0	0xA9	CPU	Interrupt priority 0
IEN1	0xB8	CPU	Interrupt enable 1
IP1	0xB9	CPU	Interrupt priority 1
IRCON	0xC0	CPU	Interrupt flags 4
PSW	0xD0	CPU	Program status Word
ACC	0xE0	CPU	Accumulator
IRCON2	0xE8	CPU	Interrupt flags 5
B	0xF0	CPU	B register
DMAIRQ	0xD1	DMA	DMA interrupt flag
DMA1CFGH	0xD2	DMA	DMA channel 1–4 configuration address high
DMA1CFGH	0xD3	DMA	DMA channel 1–4 configuration address high
DMA0CFGH	0xD4	DMA	DMA channel 0 configuration address high
DMA0CFGH	0xD5	DMA	DMA channel 0 configuration address high
DMAARM	0xD6	DMA	DMA channel armed
DMAREQ	0xD7	DMA	DMA channel start request and status
—	0xAA	—	Reserved
—	0x8E	—	Reserved
—	0x99	—	Reserved
—	0xB0	—	Reserved
—	0xB7	—	Reserved
—	0xC8	—	Reserved
P0IFG	0x89	IOC	Port 0 interrupt status flag
P1IFG	0x8A	IOC	Port 1 interrupt status flag
P2IFG	0x8B	IOC	Port 2 interrupt status flag
PICTL	0x8C	IOC	Port pins interrupt mask and edge
P0IEN	0xAB	IOC	Port 0 interrupt mask
P1IEN	0x8D	IOC	Port 1 interrupt mask
P2IEN	0xAC	IOC	Port 2 interrupt mask
P0INP	0x8F	IOC	Port 0 input mode
PERCFG	0xF1	IOC	Peripheral I/O control
APCFG	0xF2	IOC	Analog peripheral I/O configuration
P0SEL	0xF3	IOC	Port 0 function select
P1SEL	0xF4	IOC	Port 1 function select
P2SEL	0xF5	IOC	Port 2 function select
P1INP	0xF6	IOC	Port 1 input mode
P2INP	0xF7	IOC	Port 2 input mode
P0DIR	0xFD	IOC	Port 0 direction
P1DIR	0xFE	IOC	Port 1 direction
P2DIR	0xFF	IOC	Port 2 direction
PMUX	0xAE	IOC	Power-down signal mux
MPAGE	0x93	MEMORY	Memory page select

Table 2-1. SFR Overview (continued)

Register Name	SFR Address	Module	Description
MEMCTR	0xC7	MEMORY	Memory system control
FMAP	0x9F	MEMORY	Flash-memory bank mapping
RFIRQF1	0x91	RF	RF interrupt flags MSB
RFD	0xD9	RF	RF data
RFST	0xE1	RF	RF command strobe
RFIRQF0	0xE9	RF	RF interrupt flags LSB
RFERRF	0xBF	RF	RF error interrupt flags
ST0	0x95	ST	Sleep Timer 0
ST1	0x96	ST	Sleep Timer 1
ST2	0x97	ST	Sleep Timer 2
STLOAD	0xAD	ST	Sleep-timer load status
SLEEP_CMD	0xBE	PMC	Sleep-mode control command
SLEEP_STA	0x9D	PMC	Sleep-mode control status
CLKCONCMD	0xC6	PMC	Clock control command
CLKCONSTA	0x9E	PMC	Clock control status
T1CC0L	0xDA	Timer 1	Timer 1 channel 0 capture/compare value low
T1CC0H	0xDB	Timer 1	Timer 1 channel 0 capture/compare value high
T1CC1L	0xDC	Timer 1	Timer 1 channel 1 capture/compare value low
T1CC1H	0xDD	Timer 1	Timer 1 channel 1 capture/compare value high
T1CC2L	0xDE	Timer 1	Timer 1 channel 2 capture/compare value low
T1CC2H	0xDF	Timer 1	Timer 1 channel 2 capture/compare value high
T1CNTL	0xE2	Timer 1	Timer 1 counter low
T1CNTH	0xE3	Timer 1	Timer 1 counter high
T1CTL	0xE4	Timer 1	Timer 1 control and status
T1CCTL0	0xE5	Timer 1	Timer 1 channel 0 capture/compare control
T1CCTL1	0xE6	Timer 1	Timer 1 channel 1 capture/compare control
T1CCTL2	0xE7	Timer 1	Timer 1 channel 2 capture/compare control
T1STAT	0xAF	Timer 1	Timer 1 status
T2CTRL	0x94	Timer 2	Timer 2 control
T2EVT_CFG	0x9C	Timer 2	Timer 2 event configuration
T2IRQF	0xA1	Timer 2	Timer 2 interrupt flags
T2M0	0xA2	Timer 2	Timer 2 multiplexed register 0
T2M1	0xA3	Timer 2	Timer 2 multiplexed register 1
T2MOV_F0	0xA4	Timer 2	Timer 2 multiplexed overflow register 0
T2MOV_F1	0xA5	Timer 2	Timer 2 multiplexed overflow register 1
T2MOV_F2	0xA6	Timer 2	Timer 2 multiplexed overflow register 2
T2IRQM	0xA7	Timer 2	Timer 2 interrupt mask
T2MSEL	0xC3	Timer 2	Timer 2 multiplex select
T3CNT	0xCA	Timer 3	Timer 3 counter
T3CTL	0xCB	Timer 3	Timer 3 control
T3CCTL0	0xCC	Timer 3	Timer 3 channel 0 compare control
T3CC0	0xCD	Timer 3	Timer 3 channel 0 compare value
T3CCTL1	0xCE	Timer 3	Timer 3 channel 1 compare control
T3CC1	0xCF	Timer 3	Timer 3 channel 1 compare value
T4CNT	0xEA	Timer 4	Timer 4 counter
T4CTL	0xEB	Timer 4	Timer 4 control
T4CCTL0	0xEC	Timer 4	Timer 4 channel 0 compare control

Table 2-1. SFR Overview (continued)

Register Name	SFR Address	Module	Description
T4CC0	0xED	Timer 4	Timer 4 channel 0 compare value
T4CCTL1	0xEE	Timer 4	Timer 4 channel 1 compare control
T4CC1	0xEF	Timer 4	Timer 4 channel 1 compare value
TIMIF	0xD8	TMINT	Timers 1/3/4 joint interrupt mask/flags
U0CSR	0x86	USART 0	USART 0 control and status
U0DBUF	0xC1	USART 0	USART 0 receive/transmit data buffer
U0BAUD	0xC2	USART 0	USART 0 baud-rate control
U0UCR	0xC4	USART 0	USART 0 UART control
U0GCR	0xC5	USART 0	USART 0 generic control
U1CSR	0xF8	USART 1	USART 1 control and status
U1DBUF	0xF9	USART 1	USART 1 receive/transmit data buffer
U1BAUD	0xFA	USART 1	USART 1 baud-rate control
U1UCR	0xFB	USART 1	USART 1 UART control
U1GCR	0xFC	USART 1	USART 1 generic control
WDCTL	0xC9	WDT	Watchdog Timer control

XREG Registers. The XREG registers are additional registers in the XDATA memory space. These registers are mainly used for radio configuration and control. For more details regarding each register, see the corresponding module/peripheral chapter. [Table 2-2](#) gives a descriptive overview of the register address space.

Table 2-2. Overview of XREG Registers

XDATA Address	Register Name	Description
0x6000–0x61FF	—	Radio registers (see CC253x Radio Section 23.15 or CC2540 Radio Section 24.1 for complete list)
0x61A6	MONMUX	Battery monitor MUX (CC2533)
	OPAMPMC	Operational amplifier mode control (CC2530/CC2531)
0x61AD	OPAMPMC	Operational amplifier mode control (CC2540)
0x6200–0x622B	—	USB registers (see Section 21.12 for complete list)
0x6230	I2CCFG	I ² C control
0x6231	I2CSTAT	I ² C status
0x6232	I2CDATA	I ² C data
0x6233	I2CADDR	I ² C own slave address
0x6234	I2CWC	Wrapper control
0x6235	I2CIO	GPIO
0x6243	OBSSEL0	Observation output control register 0
0x6244	OBSSEL1	Observation output control register 1
0x6245	OBSSEL2	Observation output control register 2
0x6246	OBSSEL3	Observation output control register 3
0x6247	OBSSEL4	Observation output control register 4
0x6248	OBSSEL5	Observation output control register 5
0x6249	CHVER	Chip version
0x624A	CHIPID	Chip identification
0x624B	TR0	Test register 0
0x6260	DBGDATA	Debug interface write data
0x6262	SRCRC	Sleep reset CRC
0x6264	BATTMON	Battery monitor
0x6265	IVCTRL	Analog control register
0x6270	FCTL	Flash control
0x6271	FADDRL	Flash address low
0x6272	FADDRH	Flash address high
0x6273	FWDATA	Flash write data
0x6276	CHIPINFO0	Chip information byte 0
0x6277	CHIPINFO1	Chip information byte 1
0x6281	IRCTL	Timer 1 IR generation control
0x6290	CLD	Clock-loss detection
0x62A0	T1CCTL0	Timer 1 channel 0 capture/compare control (additional XREG mapping of SFR register)
0x62A1	T1CCTL1	Timer 1 channel 1 capture/compare control (additional XREG mapping of SFR register)
0x62A2	T1CCTL2	Timer 1 channel 2 capture/compare control (additional XREG mapping of SFR register)
0x62A3	T1CCTL3	Timer 1 channel 3 capture/compare control
0x62A4	T1CCTL4	Timer 1 channel 4 capture/compare control
0x62A6	T1CC0L	Timer 1 channel 0 capture/compare value low (additional XREG mapping of SFR register)
0x62A7	T1CC0H	Timer 1 channel 0 capture/compare value high (additional XREG mapping of SFR register)

Table 2-2. Overview of XREG Registers (continued)

XDATA Address	Register Name	Description
0x62A8	T1CC1L	Timer 1 channel 1 capture/compare value low (additional XREG mapping of SFR register)
0x62A9	T1CC1H	Timer 1 channel 1 capture/compare value high (additional XREG mapping of SFR register)
0x62AA	T1CC2L	Timer 1 channel 2 capture/compare value low (additional XREG mapping of SFR register)
0x62AB	T1CC2H	Timer 1 channel 2 capture/compare value high (additional XREG mapping of SFR register)
0x62AC	T1CC3L	Timer 1 channel 3 capture/compare value low
0x62AD	T1CC3H	Timer 1 channel 3 capture/compare value high
0x62AE	T1CC4L	Timer 1 channel 4 capture/compare value low
0x62AF	T1CC4H	Timer 1 channel 4 capture/compare value high
0x62B0	STCC	Sleep Timer capture control
0x62B1	STCS	Sleep Timer capture status
0x62B2	STCV0	Sleep Timer capture value byte 0
0x62B3	STCV1	Sleep Timer capture value byte 1
0x62B4	STCV2	Sleep Timer capture value byte 2
0x62C0	OPAMPC	Operational amplifier control
0x62C1	OPAMPS	Operational amplifier status
0x62D0	CMPCTL	Analog comparator control and status

2.2.4 XDATA Memory Access

The **MPAGE** register is used during instructions `MOVX A, @Ri` and `MOVX @Ri, A`. **MPAGE** gives the 8 most-significant address bits, whereas the register **Ri** gives the 8 least-significant bits.

In some 8051 implementations, this type of XDATA access is performed using **P2** to give the most-significant address bits. Existing software may therefore have to be adapted to make use of **MPAGE** instead of **P2**.

MPAGE (0x93) – Memory Page Select

Bit	Name	Reset	R/W	Description
7:0	MPAGE[7:0]	0x00	R/W	Memory page, high-order bits of address in MOVX instruction

2.2.5 Memory Arbiter

The memory arbiter handles CPU and DMA access to all physical memory except the CPU internal registers. When an access conflict between the CPU and DMA occurs, the memory arbiter stalls one of the bus masters so that the conflict is resolved.

The control registers **MEMCTR** and **FMAP** are used to control various aspects of the memory subsystem. The **MEMCTR** and **FMAP** registers are described as follows.

MEMCTR.XMAP must be set to enable program execution from RAM.

The flash-bank map register, **FMAP**, controls mapping of physical 32-KB code banks to the program address region 0x8000–0xFFFF in CODE memory space.

MEMCTR (0xC7) – Memory Arbiter Control

Bit	Name	Reset	R/W	Description
7:4	—	0000	R0	Reserved
3	XMAP	0	R/W	XDATA map to code. When this bit is set, the SRAM XDATA region, from 0x0000 through (SRAM_SIZE – 1) is mapped into the CODE region from 0x8000 through (0x8000 + SRAM_SIZE – 1). This enables execution of program code from RAM. 0: SRAM map into CODE feature disabled 1: SRAM map into CODE feature enabled
2:0	XBANK[2:0]	000	R/W	XDATA bank select. Controls which code bank of the physical flash memory is mapped into the XDATA region (0x8000–0xFFFF). When set to 0, the root bank is mapped in. Valid settings depend on the flash size for the device. Writing an invalid setting is ignored, i.e., no update to XBANK[2:0] is performed. 32-KB version: 0 only (i.e, the root bank is always mapped in.) 64-KB version: 0–1 96-KB version: 0–2 128-KB version: 0–3 256-KB version: 0–7

FMAP (0x9F) – Flash Bank Map

Bit	Name	Reset	R/W	Description
7:3	—	0000 0	R0	Reserved
2:0	MAP[2:0]	001	R/W	Flash bank map. Controls which bank is mapped into the bank area of the CODE memory space (0x8000–0xFFFF). When set to 0, the root bank is mapped in. Valid settings depend on the flash size for the device. Writing an invalid setting is ignored, i.e., no update to MAP[2:0] is performed. 32-KB version: No value can be written. Bank area is only used for running program code from SRAM. See MEMCTR.XMAP. 64-KB version: 0–1 96-KB version: 0–2 128-KB version: 0–3 256-KB version: 0–7

2.3 CPU Registers

This section describes the internal registers found in the CPU.

2.3.1 Data Pointers

Two data pointers, DPTR0 and DPTR1, exist to accelerate the movement of data blocks to/from memory. The data pointers are generally used to access CODE or XDATA space. For example:

```
MOVC A, @A+DPTR
MOV A, @DPTR.
```

The data pointer select bit, bit 0 in the data pointer select register DPS, chooses which data pointer is the active one during execution of an instruction that uses the data pointer, e.g., in one of the preceding instructions.

The data pointers are two bytes wide, consisting of the following SFRs:

- DPTR0–DPH0:DPL0
- DPTR1–DPH1:DPL1

DPH0 (0x83) – Data Pointer-0 High Byte

Bit	Name	Reset	R/W	Description
7:0	DPH0[7:0]	0x00	R/W	Data pointer-0, high byte

DPL0 (0x82) – Data Pointer-0 Low Byte

Bit	Name	Reset	R/W	Description
7:0	DPL0[7:0]	0x00	R/W	Data pointer-0, low byte

DPH1 (0x85) – Data Pointer-1 High Byte

Bit	Name	Reset	R/W	Description
7:0	DPH1[7:0]	0x00	R/W	Data pointer-1, high byte

DPL1 (0x84) – Data Pointer-1 Low Byte

Bit	Name	Reset	R/W	Description
7:0	DPL1[7:0]	0x00	R/W	Data pointer-1, low byte

DPS (0x92) – Data-Pointer Select

Bit	Name	Reset	R/W	Description
7:1	–	0000 000	R0	Reserved
0	DPS	0	R/W	Data pointer select. Selects active data pointer. 0: DPTR0 1: DPTR1

2.3.2 Registers R0–R7

There are four register banks (not to be confused with CODE memory space banks that only apply to flash memory organization) of eight registers each. These register banks are mapped in the DATA memory space at addresses 0x00–0x07, 0x08–0x0F, 0x10–0x17, and 0x18–0x1F. Each register bank contains the eight 8-bit registers R0–R7. The register bank to be used is selected through the program status word PSW.RS[1:0]. Register bank 0 uses flip-flops internally for storing the values (SRAM is bypassed/unused), whereas banks 1–3 use SRAM for storage. This is done to save power. Typically, the current consumption goes down by approximately 200 μ A by using register bank 0 instead of register banks 1–3.

2.3.3 Program Status Word

The program status word (PSW) contains several bits that show the current state of the CPU. The PSW is accessible as an SFR, and it is bit-addressable. The PSW is shown as follows and contains the carry flag, auxiliary carry flag for BCD operations, register-select bits, overflow flag, and parity flag. Two bits in the PSW are uncommitted and can be used as user-defined status flags.

PSW (0xD0) – Program Status Word

Bit	Name	Reset	R/W	Description
7	CY	0	R/W	Carry flag. Set to 1 when the last arithmetic operation resulted in a carry (during addition) or borrow (during subtraction); otherwise, cleared to 0 by all arithmetic operations.
6	AC	0	R/W	Auxiliary carry flag for BCD operations. Set to 1 when the last arithmetic operation resulted in a carry into (during addition) or borrow from (during subtraction) the high-order nibble, otherwise cleared to 0 by all arithmetic operations.
5	F0	0	R/W	User-defined, bit-addressable
4:3	RS[1:0]	00	R/W	Register bank select bits. Selects which set of R7–R0 registers to use from four possible banks in DATA space. 00: Register bank 0, 0x00–0x07 01: Register bank 1, 0x08–0x0F 10: Register bank 2, 0x10–0x17 11: Register bank 3, 0x18–0x1F
2	OV	0	R/W	Overflow flag, set by arithmetic operations. Set to 1 when the last arithmetic operation is a carry (addition), borrow (subtraction), or overflow (multiply or divide). Otherwise, the bit is cleared to 0 by all arithmetic operations.
1	F1	0	R/W	User-defined, bit-addressable
0	P	0	R/W	Parity flag, parity of accumulator set by hardware to 1 if it contains an odd number of 1s; otherwise it is cleared to 0.

2.3.4 Accumulator

ACC is the accumulator. This is the source and destination of most arithmetic instructions, data transfers, and other instructions. The mnemonic for the accumulator (in instructions involving the accumulator) is A instead of ACC.

ACC (0xE0) – Accumulator

Bit	Name	Reset	R/W	Description
7:0	ACC[7:0]	0x00	R/W	Accumulator

2.3.5 B Register

The B register is used as the second 8-bit argument during execution of multiply and divide instructions. When not used for these purposes, it may be used as a scratchpad register to hold temporary data.

B (0xF0) – B Register

Bit	Name	Reset	R/W	Description
7:0	B[7:0]	0x00	R/W	B register. Used in MUL/DIV instructions

2.3.6 Stack Pointer

The stack resides in DATA memory space and grows upwards. The PUSH instruction first increments the stack pointer (SP) and then copies the byte into the stack. The SP is initialized to 0x07 after a reset, and it is incremented once to start from location 0x08, which is the first register (R0) of the second register bank. Thus, in order to use more than one register bank, the SP should be initialized to a different location not used for data storage.

SP (0x81) – Stack Pointer

Bit	Name	Reset	R/W	Description
7:0	SP[7:0]	0x07	R/W	Stack pointer

2.4 Instruction Set Summary

The 8051 instruction set is summarized in [Table 2-3](#). All mnemonics copyrighted © Intel Corporation, 1980.

The following conventions are used in the instruction set summary:

- Rn – Register R7–R0 of the currently selected register bank
- Direct – 8-bit internal data-location address. This can be DATA area (0x00–0x7F) or SFR area (0x80–0xFF).
- @Ri – 8-bit internal data location, DATA area (0x00–0xFF) addressed indirectly through register R1 or R0
- #data – 8-bit constant included in instruction
- #data16 – 16-bit constant included in instruction
- addr16 – 16-bit destination address. Used by LCALL and LJMP. A branch can be anywhere within the 64-KB CODE memory space.
- addr11 – 11-bit destination address. Used by ACALL and AJMP. The branch is within the same 2-KB page of program memory as the first byte of the following instruction.
- rel – Signed (2s-complement) 8-bit offset byte. Used by SJMP and all conditional jumps. Range is –128 to 127 bytes relative to first byte of the following instruction.
- bit – Direct addressed bit in DATA area or SFR

The instructions that affect CPU flag settings located in PSW are listed in [Table 2-4](#). Note that operations on the PSW register or bits in PSW also affect the flag settings. Also note that the cycle count for many instructions assumes single-cycle access to the memory element being accessed, i.e., the best-case situation. This is not always the case. Reads from flash may take 1–3 cycles, for example.

Table 2-3. Instruction Set Summary

Mnemonic	Description	Hex Opcode	Bytes	Cycles
ARITHMETIC OPERATIONS				
ADD A,Rn	Add register to accumulator	28–2F	1	1
ADD A,direct	Add direct byte to accumulator	25	2	2
ADD A,@Ri	Add indirect RAM to accumulator	26–27	1	2
ADD A,#data	Add immediate data to accumulator	24	2	2
ADDC A,Rn	Add register to accumulator with carry flag	38–3F	1	1
ADDC A,direct	Add direct byte to A with carry flag	35	2	2
ADDC A,@Ri	Add indirect RAM to A with carry flag	36–37	1	2
ADDC A,#data	Add immediate data to A with carry flag	34	2	2
SUBB A,Rn	Subtract register from A with borrow	98–9F	1	1
SUBB A,direct	Subtract direct byte from A with borrow	95	2	2
SUBB A,@Ri	Subtract indirect RAM from A with borrow	96–97	1	2
SUBB A,#data	Subtract immediate data from A with borrow	94	2	2
INC A	Increment accumulator	04	1	1
INC Rn	Increment register	08–0F	1	2
INC direct	Increment direct byte	05	2	3
INC @Ri	Increment indirect RAM	06–07	1	3
INC DPTR	Increment data pointer	A3	1	1
DEC A	Decrement accumulator	14	1	1
DEC Rn	Decrement register	18–1F	1	2
DEC direct	Decrement direct byte	15	2	3
DEC @Ri	Decrement indirect RAM	16–17	1	3
MUL AB	Multiply A and B	A4	1	5
DIV A	Divide A by B	84	1	5
DA A	Decimal adjust accumulator	D4	1	1
LOGICAL OPERATIONS				
ANL A,Rn	AND register to accumulator	58–5F	1	1
ANL A,direct	AND direct byte to accumulator	55	2	2
ANL A,@Ri	AND indirect RAM to accumulator	56–57	1	2
ANL A,#data	AND immediate data to accumulator	54	2	2
ANL direct,A	AND accumulator to direct byte	52	2	3
ANL direct,#data	AND immediate data to direct byte	53	3	4
ORL A,Rn	OR register to accumulator	48–4F	1	1
ORL A,direct	OR direct byte to accumulator	45	2	2
ORL A,@Ri	OR indirect RAM to accumulator	46–47	1	2
ORL A,#data	OR immediate data to accumulator	44	2	2
ORL direct,A	OR accumulator to direct byte	42	2	3
ORL direct,#data	OR immediate data to direct byte	43	3	4
XRL A,Rn	Exclusive OR register to accumulator	68–6F	1	1
XRL A,direct	Exclusive OR direct byte to accumulator	65	2	2
XRL A,@Ri	Exclusive OR indirect RAM to accumulator	66–67	1	2
XRL A,#data	Exclusive OR immediate data to accumulator	64	2	2
XRL direct,A	Exclusive OR accumulator to direct byte	62	2	3
XRL direct,#data	Exclusive OR immediate data to direct byte	63	3	4
CLR A	Clear accumulator	E4	1	1
CPL A	Complement accumulator	F4	1	1
RL A	Rotate accumulator left	23	1	1
RLC A	Rotate accumulator left through carry	33	1	1

Table 2-3. Instruction Set Summary (continued)

Mnemonic	Description	Hex Opcode	Bytes	Cycles
RR A	Rotate accumulator right	03	1	1
RRC A	Rotate accumulator right through carry	13	1	1
SWAP A	Swap nibbles within the accumulator	C4	1	1
DATA TRANSFERS				
MOV A,Rn	Move register to accumulator	E8–EF	1	1
MOV A,direct	Move direct byte to accumulator	E5	2	2
MOV A,@Ri	Move indirect RAM to accumulator	E6–E7	1	2
MOV A,#data	Move immediate data to accumulator	74	2	2
MOV Rn,A	Move accumulator to register	F8–FF	1	2
MOV Rn,direct	Move direct byte to register	A8–AF	2	4
MOV Rn,#data	Move immediate data to register	78–7F	2	2
MOV direct,A	Move accumulator to direct byte	F5	2	3
MOV direct,Rn	Move register to direct byte	88–8F	2	3
MOV direct1,direct2	Move direct byte to direct byte	85	3	4
MOV direct,@Ri	Move indirect RAM to direct byte	86–87	2	4
MOV direct,#data	Move immediate data to direct byte	75	3	3
MOV @Ri,A	Move accumulator to indirect RAM	F6–F7	1	3
MOV @Ri,direct	Move direct byte to indirect RAM	A6–A7	2	5
MOV @Ri,#data	Move immediate data to indirect RAM	76–77	2	3
MOV DPTR,#data16	Load data pointer with a 16-bit constant	90	3	3
MOVC A,@A+DPTR	Move code byte relative to DPTR to accumulator	93	1	3
MOVC A,@A+PC	Move code byte relative to PC to accumulator	83	1	3
MOVX A,@Ri	Move external RAM (8-bit address) to A	E2–E3	1	3
MOVX A,@DPTR	Move external RAM (16-bit address) to A	E0	1	3
MOVX @Ri,A	Move A to external RAM (8-bit address)	F2–F3	1	4
MOVX @DPTR,A	Move A to external RAM (16-bit address)	F0	1	4
PUSH direct	Push direct byte onto stack	C0	2	4
POP direct	Pop direct byte from stack	D0	2	3
XCH A,Rn	Exchange register with accumulator	C8–CF	1	2
XCH A,direct	Exchange direct byte with accumulator	C5	2	3
XCH A,@Ri	Exchange indirect RAM with accumulator	C6–C7	1	3
XCHD A,@Ri	Exchange low-order nibble indirect. RAM with A	D6–D7	1	3
PROGRAM BRANCHING				
ACALL addr11	Absolute subroutine call	xxx11	2	6
LCALL addr16	Long subroutine call	12	3	6
RET	Return from subroutine	22	1	4
RETI	Return from interrupt	32	1	4
AJMP addr11	Absolute jump	xxx01	2	3
LJMP addr16	Long jump	02	3	4
SJMP rel	Short jump (relative address)	80	2	3
JMP @A+DPTR	Jump indirect relative to the DPTR	73	1	2
JZ rel	Jump if accumulator is zero	60	2	3
JNZ rel	Jump if accumulator is not zero	70	2	3
JC rel	Jump if carry flag is set	40	2	3
JNC	Jump if carry flag is not set	50	2	3
JB bit,rel	Jump if direct bit is set	20	3	4
JNB bit,rel	Jump if direct bit is not set	30	3	4

Table 2-3. Instruction Set Summary (continued)

Mnemonic	Description	Hex Opcode	Bytes	Cycles
JBC bit,direct rel	Jump if direct bit is set and clear bit	10	3	4
CJNE A,direct rel	Compare direct byte to A and jump if not equal	B5	3	4
CJNE A,#data rel	Compare immediate to A and jump if not equal	B4	3	4
CJNE Rn,#data rel	Compare immediate to reg. and jump if not equal	B8–BF	3	4
CJNE @Ri,#data rel	Compare immediate to indirect and jump if not equal	B6–B7	3	4
DJNZ Rn,rel	Decrement register and jump if not zero	D8–DF	1	3
DJNZ direct,rel	Decrement direct byte and jump if not zero	D5	3	4
NOP	No operation	00	1	1
Boolean VARIABLE OPERATIONS				
CLR C	Clear carry flag	C3	1	1
CLR bit	Clear direct bit	C2	2	3
SETB C	Set carry flag	D3	1	1
SETB bit	Set direct bit	D2	2	3
CPL C	Complement carry flag	B3	1	1
CPL bit	Complement direct bit	B2	2	3
ANL C,bit	AND direct bit to carry flag	82	2	2
ANL C,/bit	AND complement of direct bit to carry	B0	2	2
ORL C,bit	OR direct bit to carry flag	72	2	2
ORL C,/bit	OR complement of direct bit to carry	A0	2	2
MOV C,bit	Move direct bit to carry flag	A2	2	2
MOV bit,C	Move carry flag to direct bit	92	2	3

Table 2-4. Instructions That Affect Flag Settings⁽¹⁾

Instruction	CY	OV	AC
ADD	x	x	x
ADDC	x	x	x
SUBB	x	x	x
MUL	0	x	–
DIV	0	x	–
DA	x	–	–
RRC	x	–	–
RLC	x	–	–
SETB C	1	–	–
CLR C	x	–	–
CPLC	x	–	–
ANL C,bit	x	–	–
ANL C,/bit	x	–	–
ORL C,bit	x	–	–
ORL C,/bit	x	–	–
MOV C,bit	x	–	–
CJNE	x	–	–

⁽¹⁾ 0 = set to 0, 1 = set to 1, x = set to 0/1, – = not affected

2.5 Interrupts

The CPU has 18 interrupt sources. Each source has its own request flag located in a set of interrupt flag SFR registers. Each interrupt requested by the corresponding flag can be individually enabled or disabled. The definitions of the interrupt sources and the interrupt vectors are given in [Table 2-5](#).

The interrupts are grouped into a set of priority-level groups with selectable priority levels.

The interrupt-enable registers are described in [Section 2.5.1](#) and the interrupt priority settings are described in [Section 2.5.3](#).


2.5.1 Interrupt Masking

Each interrupt can be individually enabled or disabled by the interrupt-enable bits in the interrupt-enable SFRs IEN0, IEN1, and IEN2. The CPU interrupt-enable SFRs are described as follows and summarized in [Table 2-5](#).

Note that some peripherals have several events that can generate the interrupt request associated with that peripheral. This applies to Port 0, Port 1, Port 2, Timer 1, Timer 2, Timer 3, Timer 4, DMA controller, and Radio. These peripherals have interrupt mask bits for each internal interrupt source in the corresponding SFR or XREG registers.

In order to enable any of the interrupts, the following steps must be taken:

1. Clear interrupt flags.
2. Set individual interrupt-enable bit in the peripherals SFR register, if any.
3. Set the corresponding individual interrupt-enable bit in the IEN0, IEN1, or IEN2 register to 1.
4. Enable global interrupt by setting the EA bit in IEN0 to 1.
5. Begin the interrupt service routine at the corresponding vector address of that interrupt. See [Table 2-5](#) for addresses.

[Figure 2-4](#) gives a complete overview of all interrupt sources and associated control and state registers. Shaded boxes are interrupt flags that are automatically cleared by hardware when the interrupt service routine is called.  indicates a one-shot, either due to the level source or due to edge shaping. Interrupts

missing this are to be treated as level-triggered (apply to ports P0, P1, and P2). The switch boxes are shown in the default state, and or indicates rising- or falling-edge detection, i.e., at what time instance the interrupt is generated. As a general rule for pulsed or edge-shaped interrupt sources, one should clear CPU interrupt flag registers prior to clearing the source flag bit, if available, for flags that are not automatically cleared. For level sources, one must clear the source prior to clearing the CPU flag.

Note that when clearing source interrupt flags in a register that contains several flags, interrupts may be lost if a read-modify-write operation is done (even in a single assembly instruction), as it will also clear interrupt flags that became active between the read and write operation. The source interrupt flags (with the exception of the USB controller interrupt flags) have the access mode R/W0. This means that writing 1 to a bit has no effect, so 1 should be written to an interrupt flag that is not to be cleared. For instance, to clear the `TIMER2_OVF_PERF` bit (bit 3) of `T2IRQF` in C code, one should do:

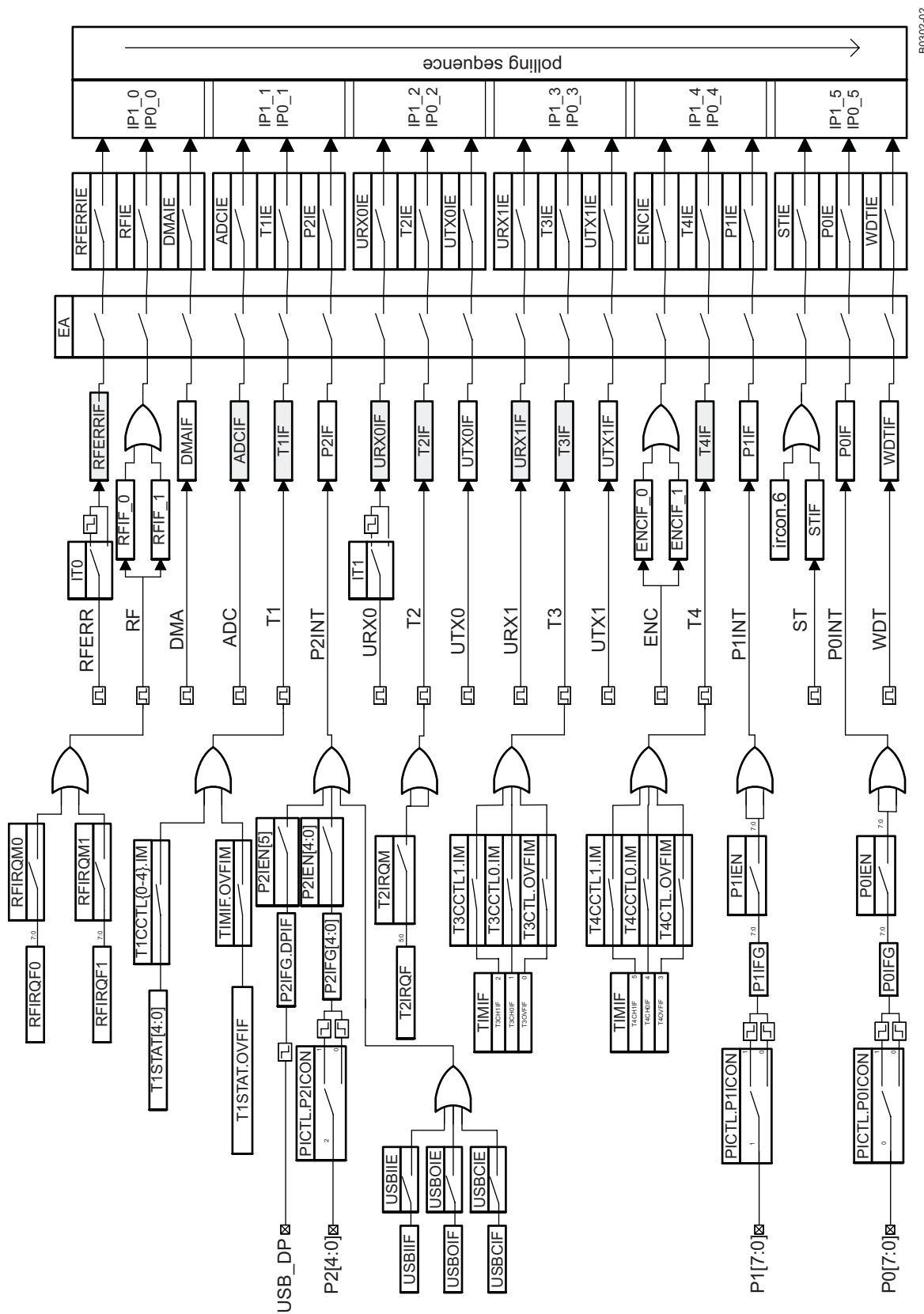
```
T2IRQF = ~(1 << 3);
and not:
T2IRQF &= ~(1 << 3); // wrong!
```

Table 2-5. Interrupts Overview

Interrupt Number	Description	Interrupt Name	Interrupt Vector	Interrupt Mask, CPU	Interrupt Flag, CPU
0	RF TXFIFO underflow and RXFIFO overflow	RFERR	0x03	IEN0.RFERRIE	TCON.RFERRIF ⁽¹⁾
1	ADC end of conversion	ADC	0x0B	IEN0.ADCIE	TCON.ADCIF ⁽¹⁾
2	USART 0 RX complete	URX0	0x13	IEN0.URX0IE	TCON.URX0IF ⁽¹⁾
3	USART 1 RX complete	URX1	0x1B	IEN0.URX1IE	TCON.URX1IF ⁽¹⁾
4	AES encryption/decryption complete	ENC	0x23	IEN0.ENCIE	SOCON.ENCIF
5	Sleep Timer compare	ST	0x2B	IEN0.STIE	IRCON.STIF
6	Port-2 inputs/USB/I ² C	P2INT	0x33	IEN2.P2IE	IRCON2.P2IF ⁽²⁾
7	USART 0 TX complete	UTX0	0x3B	IEN2.UTX0IE	IRCON2.UTX0IF
8	DMA transfer complete	DMA	0x43	IEN1.DMAIE	IRCON.DMAIF
9	Timer 1 (16-bit) capture/compare/overflow	T1	0x4B	IEN1.T1IE	IRCON.T1IF ^{(1) (2)}
10	Timer 2	T2	0x53	IEN1.T2IE	IRCON.T2IF ^{(1) (2)}
11	Timer 3 (8-bit) compare/overflow	T3	0x5B	IEN1.T3IE	IRCON.T3IF ^{(1) (2)}
12	Timer 4 (8-bit) compare/overflow	T4	0x63	IEN1.T4IE	IRCON.T4IF ^{(1) (2)}
13	Port 0 inputs	P0INT	0x6B	IEN1.P0IE	IRCON.P0IF ⁽²⁾
14	USART 1 TX complete	UTX1	0x73	IEN2.UTX1IE	IRCON2.UTX1IF
15	Port 1 inputs	P1INT	0x7B	IEN2.P1IE	IRCON2.P1IF ⁽²⁾
16	RF general interrupts	RF	0x83	IEN2.RFIE	S1CON.RFIF ⁽²⁾
17	Watchdog overflow in timer mode	WDT	0x8B	IEN2.WDTIE	IRCON2.WDTIF

⁽¹⁾ Hardware-cleared when interrupt service routine is called

⁽²⁾ Additional IRQ mask and IRQ flag bits exist.



80002.02

Figure 2-4. Interrupt Overview

IEN0 (0xA8) – Interrupt Enable 0

Bit	Name	Reset	R/W	Description
7	EA	0	R/W	Disables all interrupts. 0: No interrupt is acknowledged. 1: Each interrupt source is individually enabled or disabled by setting its corresponding enable bit.
6	–	0	R0	Reserved. Read as 0
5	STIE	0	R/W	Sleep Timer interrupt enable 0: Interrupt disabled 1: Interrupt enabled
4	ENCIE	0	R/W	AES encryption/decryption interrupt enable 0: Interrupt disabled 1: Interrupt enabled
3	URX1IE	0	R/W	USART 1 RX interrupt enable 0: Interrupt disabled 1: Interrupt enabled
2	URX0IE	0	R/W	USART0 RX interrupt enable 0: Interrupt disabled 1: Interrupt enabled
1	ADCIE	0	R/W	ADC interrupt enable 0: Interrupt disabled 1: Interrupt enabled
0	RFERRIE	0	R/W	RF TXFIFO/RXFIFO interrupt enable 0: Interrupt disabled 1: Interrupt enabled

IEN1 (0xB8) – Interrupt Enable 1

Bit	Name	Reset	R/W	Description
7:6	–	00	R0	Reserved. Read as 0
5	P0IE	0	R/W	Port 0 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
4	T4IE	0	R/W	Timer 4 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
3	T3IE	0	R/W	Timer 3 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
2	T2IE	0	R/W	Timer 2 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
1	T1IE	0	R/W	Timer 1 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
0	DMAIE	0	R/W	DMA transfer interrupt enable 0: Interrupt disabled 1: Interrupt enabled

IEN2 (0x9A) – Interrupt Enable 2

Bit	Name	Reset	R/W	Description
7:6	–	00	R0	Reserved. Read as 0
5	WDTIE	0	R/W	Watchdog Timer interrupt enable 0: Interrupt disabled 1: Interrupt enabled
4	P1IE	0	R/W	Port 1 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
3	UTX1IE	0	R/W	USART 1 TX interrupt enable 0: Interrupt disabled 1: Interrupt enabled
2	UTX0IE	0	R/W	USART 0 TX interrupt enable 0: Interrupt disabled 1: Interrupt enabled
1	P2IE	0	R/W	Port 2 and USB interrupt enable 0: Interrupt disabled 1: Interrupt enabled
0	RFIE	0	R/W	RF general interrupt enable 0: Interrupt disabled 1: Interrupt enabled

2.5.2 Interrupt Processing

When an interrupt occurs, the CPU vectors to the interrupt-vector address as shown in [Table 2-5](#). Once an interrupt service has begun, it can be interrupted only by a higher-priority interrupt. The interrupt service is terminated by an `RETI` (return-from-interrupt instruction). When an `RETI` is performed, the CPU returns to the instruction that would have been next when the interrupt occurred.

When the interrupt condition occurs, the CPU also indicates this by setting an interrupt flag bit in the interrupt flag registers. This bit is set regardless of whether the interrupt is enabled or disabled. If the interrupt is enabled when an interrupt flag is set, then on the next instruction cycle, the interrupt is acknowledged by hardware, forcing an `LCALL` to the appropriate vector address.

Interrupt response requires a varying amount of time, depending on the state of the CPU when the interrupt occurs. If the CPU is performing an interrupt service with equal or greater priority, the new interrupt is pending until it becomes the interrupt with highest priority. In other cases, the response time depends on current instruction. The fastest possible response to an interrupt is seven machine cycles. This includes one machine cycle for detecting the interrupt and six cycles to perform the `LCALL`.

NOTE: If an interrupt is disabled and the interrupt flag is polled, the 8051 assembly instruction `JBC` must not be used to poll the interrupt flag and clear it when set. If the `JBC` instruction is used, the interrupt flag may be re-asserted immediately.

NOTE: If the assembly instruction `XCH A, IEN0` is used to clear the global interrupt enable flag `EA`, the CPU may enter the interrupt routine on the cycle following this instruction. If that happens, the interrupt routine is executed with `EA` set to 0, which may delay the service of higher-priority interrupts.

TCON (0x88) – Interrupt Flags

Bit	Name	Reset	R/W	Description
7	URX1IF	0	R/W H0	USART 1 RX interrupt flag. Set to 1 when USART 1 RX interrupt occurs and cleared when CPU vectors to the interrupt service routine. 0: Interrupt not pending 1: Interrupt pending
6	–	0	R/W	Reserved
5	ADCIF	0	R/W H0	ADC interrupt flag. Set to 1 when ADC interrupt occurs and cleared when CPU vectors to the interrupt service routine. 0: Interrupt not pending 1: Interrupt pending
4	–	0	R/W	Reserved
3	URX0IF	0	R/W H0	USART 0 RX interrupt flag. Set to 1 when USART 0 interrupt occurs and cleared when CPU vectors to the interrupt service routine. 0: Interrupt not pending 1: Interrupt pending
2	IT1	1	R/W	Reserved. Must always be set to 1. Setting a zero enables low-level interrupt detection, which is almost always the case (one-shot when interrupt request is initiated).
1	RFERRIF	0	R/W H0	RF TXFIFO/RXFIFO interrupt flag. Set to 1 when RFERR interrupt occurs and cleared when CPU vectors to the interrupt service routine. 0: Interrupt not pending 1: Interrupt pending
0	IT0	1	R/W	Reserved. Must always be set to 1. Setting a zero enables low-level interrupt detection, which is almost always the case (one-shot when interrupt request is initiated).

S0CON (0x98) – Interrupt Flags 2

Bit	Name	Reset	R/W	Description
7:2	–	0000 00	R/W	Reserved
1	ENCIF_1	0	R/W	AES interrupt. ENC has two interrupt flags, ENCIF_1 and ENCIF_0. Setting one of these flags requests interrupt service. Both flags are set when the AES coprocessor requests the interrupt. 0: Interrupt not pending 1: Interrupt pending
0	ENCIF_0	0	R/W	AES interrupt. ENC has two interrupt flags, ENCIF_1 and ENCIF_0. Setting one of these flags requests interrupt service. Both flags are set when the AES coprocessor requests the interrupt. 0: Interrupt not pending 1: Interrupt pending

S1CON (0x9B) – Interrupt Flags 3

Bit	Name	Reset	R/W	Description
7:2	–	0000 00	R/W	Reserved
1	RFIF_1	0	R/W	RF general interrupt. RF has two interrupt flags, RFIF_1 and RFIF_0. Setting one of these flags requests interrupt service. Both flags are set when the radio requests the interrupt. 0: Interrupt not pending 1: Interrupt pending
0	RFIF_0	0	R/W	RF general interrupt. RF has two interrupt flags, RFIF_1 and RFIF_0. Setting one of these flags requests interrupt service. Both flags are set when the radio requests the interrupt. 0: Interrupt not pending 1: Interrupt pending

IRCON (0xC0) – Interrupt Flags 4

Bit	Name	Reset	R/W	Description
7	STIF	0	R/W	Sleep Timer interrupt flag 0: Interrupt not pending 1: Interrupt pending
6	–	0	R/W	Must be written 0. Writing a 1 always enables the interrupt source.
5	P0IF	0	R/W	Port 0 interrupt flag 0: Interrupt not pending 1: Interrupt pending
4	T4IF	0	R/W H0	Timer 4 interrupt flag. Set to 1 when Timer 4 interrupt occurs and cleared when CPU vectors to the interrupt service routine. 0: Interrupt not pending 1: Interrupt pending
3	T3IF	0	R/W H0	Timer 3 interrupt flag. Set to 1 when Timer 3 interrupt occurs and cleared when CPU vectors to the interrupt service routine. 0: Interrupt not pending 1: Interrupt pending
2	T2IF	0	R/W H0	Timer 2 interrupt flag. Set to 1 when Timer 2 interrupt occurs and cleared when CPU vectors to the interrupt service routine. 0: Interrupt not pending 1: Interrupt pending
1	T1IF	0	R/W H0	Timer 1 interrupt flag. Set to 1 when Timer 1 interrupt occurs and cleared when CPU vectors to the interrupt service routine. 0: Interrupt not pending 1: Interrupt pending
0	DMAIF	0	R/W	DMA-complete interrupt flag 0: Interrupt not pending 1: Interrupt pending

IRCON2 (0xE8) – Interrupt Flags 5

Bit	Name	Reset	R/W	Description
7:5	–	000	R/W	Reserved
4	WDTIF	0	R/W	Watchdog Timer interrupt flag 0: Interrupt not pending 1: Interrupt pending
3	P1IF	0	R/W	Port 1 interrupt flag 0: Interrupt not pending 1: Interrupt pending
2	UTX1IF	0	R/W	USART 1 TX interrupt flag 0: Interrupt not pending 1: Interrupt pending
1	UTX0IF	0	R/W	USART 0 TX interrupt flag 0: Interrupt not pending 1: Interrupt pending
0	P2IF	0	R/W	Port 2 interrupt flag 0: Interrupt not pending 1: Interrupt pending

2.5.3 Interrupt Priority

The interrupts are grouped into six interrupt priority groups, and the priority for each group is set by registers IP0 and IP1. In order to assign a higher priority to an interrupt, i.e., to its interrupt group, the corresponding bits in IP0 and IP1 must be set as shown in [Table 2-6](#).

The interrupt priority groups with assigned interrupt sources are shown in [Table 2-7](#). Each group is assigned one of four priority levels. While an interrupt service request is in progress, it cannot be interrupted by a lower- or same-level interrupt.

In the case when interrupt requests of the same priority level are received simultaneously, the polling sequence shown in [Table 2-8](#) is used to resolve the priority of each request. Note that the polling sequence in [Figure 2-4](#) is the algorithm found in [Table 2-8](#), not that polling is among the IP bits as listed in the figure.

IP1 (0xB9) – Interrupt Priority 1

Bit	Name	Reset	R/W	Description
7:6	–	00	R/W	Reserved
5	IP1_IPG5	0	R/W	Interrupt group 5, priority control bit 1, see Table 2-7: Interrupt Priority Groups
4	IP1_IPG4	0	R/W	Interrupt group 4, priority control bit 1, see Table 2-7: Interrupt Priority Groups
3	IP1_IPG3	0	R/W	Interrupt group 3, priority control bit 1, see Table 2-7: Interrupt Priority Groups
2	IP1_IPG2	0	R/W	Interrupt group 2, priority control bit 1, see Table 2-7: Interrupt Priority Groups
1	IP1_IPG1	0	R/W	Interrupt group 1, priority control bit 1, see Table 2-7: Interrupt Priority Groups
0	IP1_IPG0	0	R/W	Interrupt group 0, priority control bit 1, see Table 2-7: Interrupt Priority Groups

IP0 (0xA9) – Interrupt Priority 0

Bit	Name	Reset	R/W	Description
7:6	–	00	R/W	Reserved
5	IP0_IPG5	0	R/W	Interrupt group 5, priority control bit 0, see Table 2-7: Interrupt Priority Groups
4	IP0_IPG4	0	R/W	Interrupt group 4, priority control bit 0, see Table 2-7: Interrupt Priority Groups
3	IP0_IPG3	0	R/W	Interrupt group 3, priority control bit 0, see Table 2-7: Interrupt Priority Groups
2	IP0_IPG2	0	R/W	Interrupt group 2, priority control bit 0, see Table 2-7: Interrupt Priority Groups
1	IP0_IPG1	0	R/W	Interrupt group 1, priority control bit 0, see Table 2-7: Interrupt Priority Groups
0	IP0_IPG0	0	R/W	Interrupt group 0, priority control bit 0, see Table 2-7: Interrupt Priority Groups

Table 2-6. Priority Level Setting

IP1_x	IP0_x	Priority Level
0	0	0 – lowest
0	1	1
1	0	2
1	1	3 – highest

Table 2-7. Interrupt Priority Groups

Group	Interrupts		
IPG0	RFERR	RF	DMA
IPG1	ADC	T1	P2INT
IPG2	URX0	T2	UTX0
IPG3	URX1	T3	UTX1
IPG4	ENC	T4	P1INT
IPG5	ST	P0INT	WDT

Table 2-8. Interrupt Polling Sequence

Interrupt Number	Interrupt Name	
0	RFERR	Polling sequence ↓
16	RF	
8	DMA	
1	ADC	
9	T1	
2	URX0	
10	T2	
3	URX1	
11	T3	
4	ENC	
12	T4	
5	ST	
13	P0INT	
6	P2INT	
7	UTX0	
14	UTX1	
15	P1INT	
17	WDT	

Debug Interface

The two-wire debug interface allows programming of the on-chip flash, and it provides access to memory and register contents and debug features such as breakpoints, single-stepping, and register modification.

The debug interface uses I/O pins P2.1 and P2.2 as debug data and debug clock, respectively, during debug mode. These I/O pins can be used as general-purpose I/O only while the device is not in debug mode. Thus, the debug interface does not interfere with any peripheral I/O pins.

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3.1 Debug Mode

Debug mode is entered by forcing two falling-edge transitions on pin P2.2 (debug clock) while the RESET_N input is held low. When RESET_N is set high, the device is in debug mode.

On entering debug mode, the CPU is in the halted state with the program counter reset to address 0x0000.

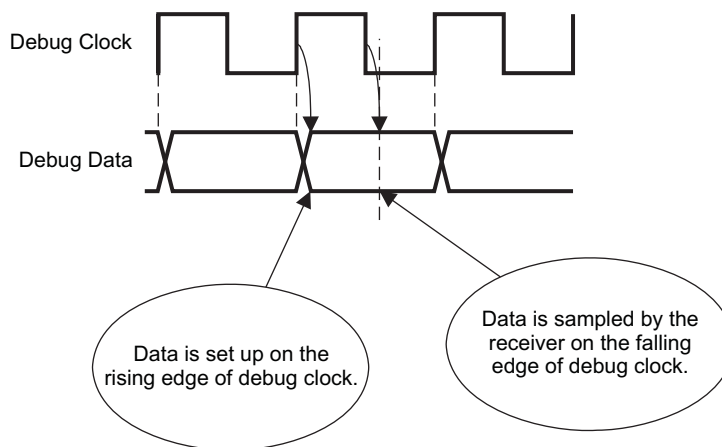
While in debug mode, pin P2.1 is the debug-data bidirectional pin, and P2.2 is the debug-clock input pin.

NOTE: Note that the debugger cannot be used with a divided system clock. When running the debugger, the value of `CLKCONCMD.CLKSPD` should be set to 000 when `CLKCONCMD.OSC = 0` or to 001 when `CLKCONCMD.OSC = 1`.

3.2 Debug Communication

The debug interface uses a SPI-like two-wire interface consisting of the P2.1 (debug data) and P2.2 (debug clock) pins. Data is driven on the bidirectional debug-data pin at the positive edge of the debug clock, and data is sampled on the negative edge of this clock.

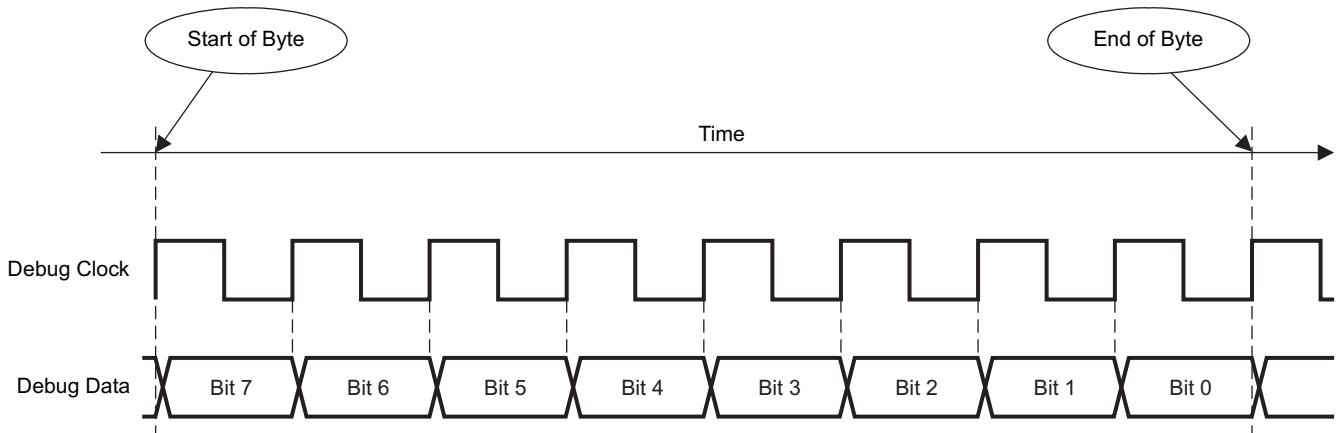
The direction of the debug-data pin depends on the command being issued. Data is driven on the positive edge of the debug clock and sampled on the negative edge. [Figure 3-1](#) shows how data is sampled.



T0302-01

Figure 3-1. External Debug Interface Timing

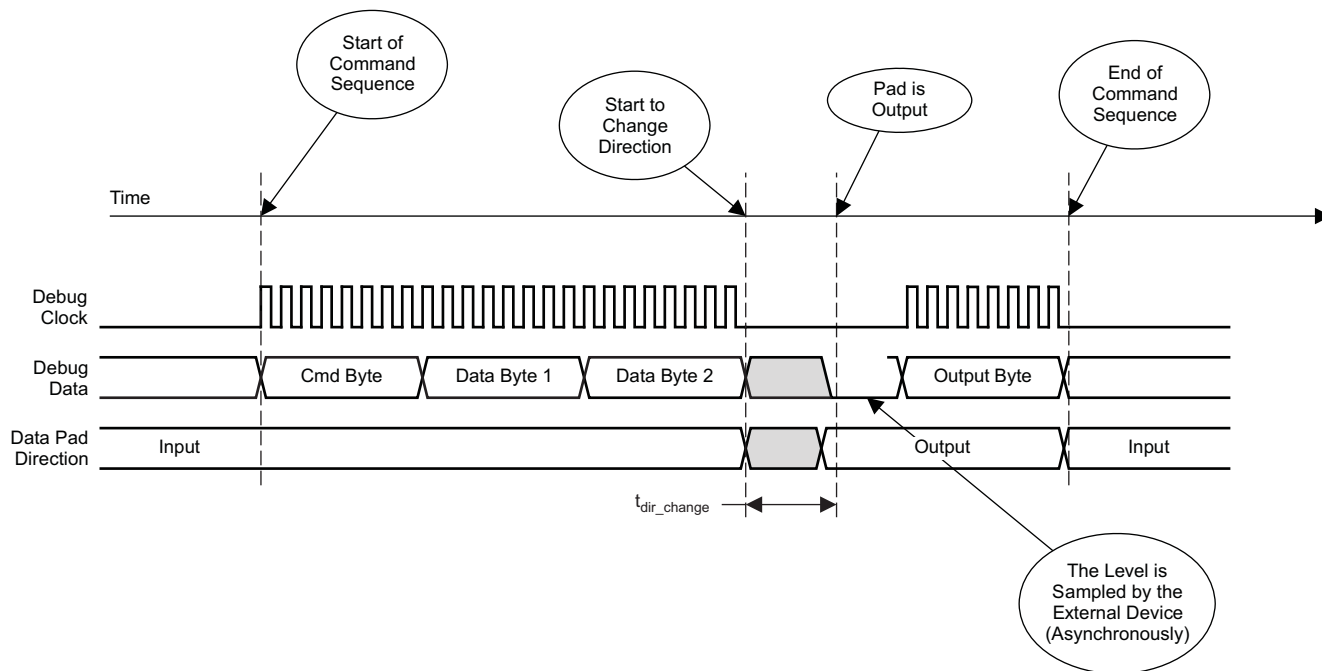
The data is byte-oriented and is transmitted MSB-first. A sequence of one byte is shown in [Figure 3-2](#).



T0303-01

Figure 3-2. Transmission of One Byte

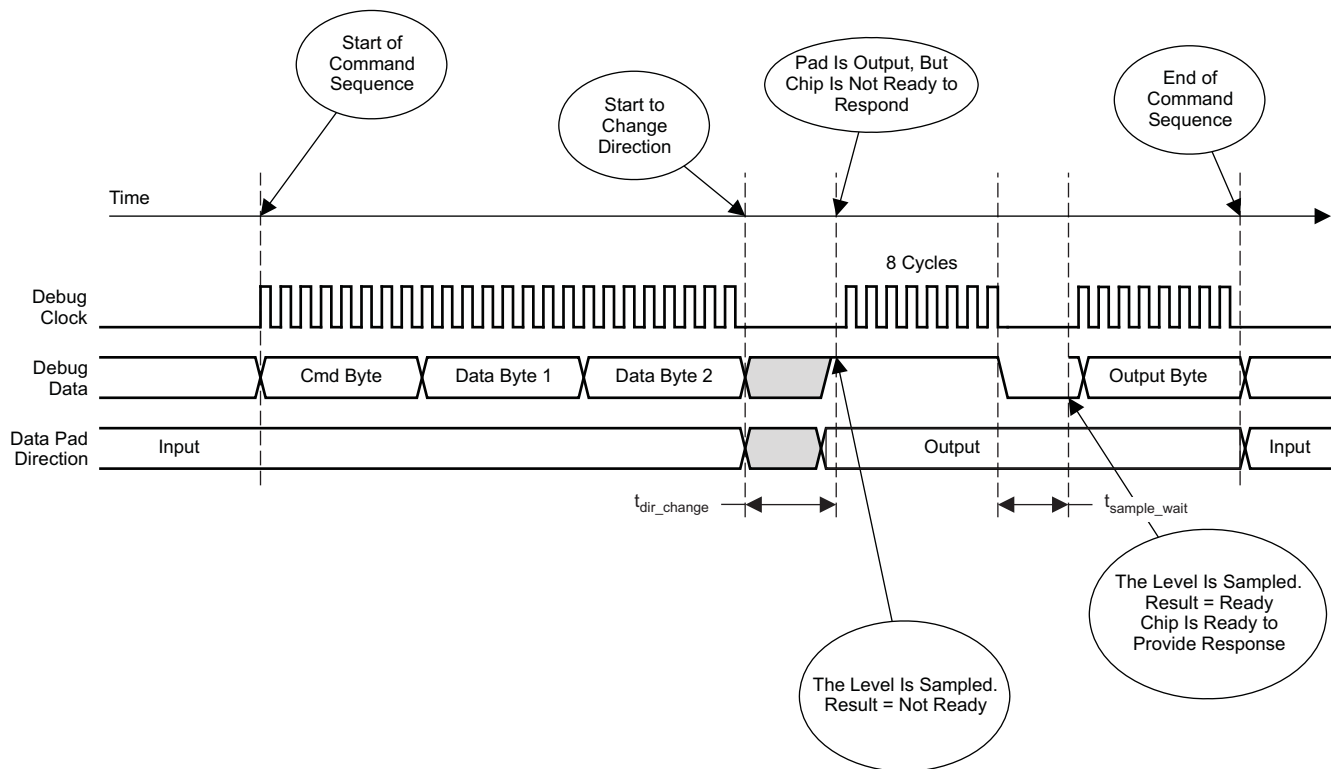
A debug command sequence always starts with the host transmitting a command through the serial interface. This command encodes the number of bytes containing further parameters to follow, and whether a response is required. Based on this command, the debug module controls the direction of the debug data pad. A typical command sequence is shown in Figure 3-3. Note that the debug-data signal is simplified for the clarity of the figure, not showing each individual bit change. The direction is not explicitly indicated to the outside world, but must be derived by the host from the command protocol.



T0304-01

Figure 3-3. Typical Command Sequence—No Extra Wait for Response

For commands that require a response, there must be a small idle period between the command and the response to allow the pad to change direction. After the minimum waiting time (t_{dir_change}), the chip indicates whether it is ready to deliver the response data by pulling the data pad low. The external debugger, which is sampling the data pad, detects this and begins to clock out the response data. If the data pad is high after the waiting time, it is an indication to the debugger that the chip is not ready yet. Figure 3-4 shows how the wait works.



T0305-01

Figure 3-4. Typical Command Sequence. Wait for Response

If the debug interface indicates by pulling the data line high that it is not ready to return data, the external device must issue exactly eight clock pulses before it samples the ready level again. This must be repeated until the level is low. The wait cycle is equivalent to reading a byte from the debug interface, but ignoring the result. Note that the pad starts to change direction on the falling edge of the debug clock. Thus, the pad driver drives against the driver in the programmer until the programmer changes pad direction. This duration should be minimized in a programmer implementation.

3.3 Debug Commands

The debug commands are shown in [Table 3-1](#). Some of the debug commands are described in further detail in the following subsections.

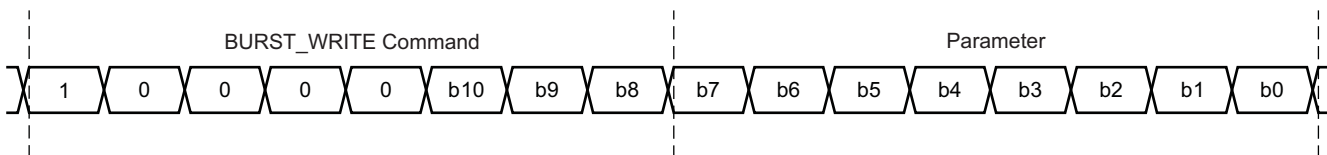
The 3 least-significant bits (the Xs) are don't care values.

Table 3-1. Debug Commands

Command	Instruction Byte	Additional Input Bytes	Output Bytes	Description
CHIP_ERASE	00010XXX	0	1	Perform flash chip erase (mass erase) and clear lock bits. If any other command except READ_STATUS is issued, then the use of CHIP_ERASE is disabled. Input byte: none Output byte: Debug status byte. See Table 3-3 .
WR_CONFIG	00011XXX	1	1	Write debug configuration data. Input byte: See Table 3-2 for details. Output byte: Debug status byte. See Table 3-3 .
RD_CONFIG	00100XXX	0	1	Read debug configuration data. Input byte: none. Output byte: Returns value set by WR_CONFIG command. See Table 3-2 .

Table 3-1. Debug Commands (continued)

Command	Instruction Byte	Additional Input Bytes	Output Bytes	Description
GET_PC	00101XXX	0	2	Return value of 16-bit program counter. Input byte: none Output bytes: Returns 2 bytes.
READ_STATUS	00110XXX	0	1	Read status byte. Input byte: none Output byte: Debug status byte. See Table 3-3 .
SET_HW_BRKPNT	00111XXX	3	1	Set hardware breakpoint. Input bytes: See Section 3.3.3 for details. Output byte: Debug status byte. See Table 3-3 .
HALT	01000XXX	0	1	Halt CPU operation Input byte: none Output byte: Debug status byte. See Table 3-3 . If the CPU was already halted, the output is undefined.
RESUME	01001XXX	0	1	Resume CPU operation. The CPU must be in the halted state for this command to be run. Input byte: none Output byte: Debug status byte. See Table 3-3 .
DEBUG_INSTR	01010Xyy	1–3	1	Run debug instruction. The supplied instruction is executed by the CPU without incrementing the program counter. The CPU must be in halted state for this command to be run. Note that yy is number of bytes following the command byte, i.e., how many bytes the CPU instruction has (see Table 2-3). Input byte(s): CPU instruction Output byte: The resulting accumulator register value after the instruction has been executed
STEP_INSTR	01011XXX	0	1	Step CPU instruction. The CPU executes the next instruction from program memory and increments the program counter after execution. The CPU must be in the halted state for this command to be run. Input byte: none Output byte: The resulting accumulator register value after the instruction has been executed
GET_BM	01100XXX	0	1	This command does the same thing as GET_PC, except that it returns the memory bank. It returns one byte, where the 3 least-significant bits are the currently used memory bank. Input byte: none Output byte: Memory bank (current value of <code>FMAP.MAP</code>)
GET_CHIP_ID	01101XXX	0	2	Return value of 16-bit chip ID and version number. Input byte: none. Output bytes: The <code>CHIPID</code> and <code>CHVER</code> register values
BURST_WRITE	10000kkk	2–2049	1	This command writes a sequence of 1–2048 bytes to the <code>DBGDATA</code> register. Each time the register is updated, a <code>DBG_BW</code> DMA trigger is generated. The number of parameters to the <code>BURST_WRITE</code> command is variable. The number of data bytes in the burst is indicated using the 3 last bits of the command byte (kkk), and the whole next byte. The command sequence is shown in Figure 3-5 . The burst length is indicated by an 11-bit value (b10–b0). After these two bytes, the given number of data bytes must be appended. The value 0 means 2048 data bytes; thus, the smallest number of bytes to transfer is 1. Input bytes: Command sequence Output byte: Debug status byte. See Table 3-3 .



T0306-01

Figure 3-5. Burst Write Command (First 2 Bytes)

3.3.1 Debug Configuration

The commands WR_CONFIG and RD_CONFIG are used to access the debug-configuration data byte. The format and description of this configuration data are shown in [Table 3-2](#).

Table 3-2. Debug Configuration

Bit	Name	Reset	Description
7:6	–	00	Reserved
5	SOFT_POWER_MODE	1	When set, the digital regulator is not turned off during PM2 and PM3. If this bit is cleared, the debug interface is reset during PM2 and PM3.
4	–	0	Reserved
3	TIMERS_OFF	0	Disable timers. Disable timer operation. This overrides the TIMER_SUSPEND bit and its function. 0: Do not disable timers 1: Disable timers
2	DMA_PAUSE	1	DMA pause. The DMA registers must not be accessed while this bit is set. 0: Enable DMA transfers 1: Pause all DMA transfers
1	TIMER_SUSPEND	1	Suspend timers. Suspend timers when the chip is halted. The timers are also suspended during debug instructions. When executing a STEP, the timers receive exactly (or as close as possible) as many ticks as they would if the program were free-running. 0: Do not suspend timers 1: Suspend timers
0	–	0	Reserved. Always write 0.

3.3.2 Debug Status

A debug-status byte is read using the READ_STATUS command. The format and description of this debug status is shown in [Table 3-3](#).

The READ_STATUS command is, for example, used for:

- Polling the status of the chip erase (CHIP_ERASE_BUSY) after a CHIP_ERASE command.
- Checking whether the oscillator is stable (OSCILLATOR_STABLE); required for debug commands HALT, RESUME, DEBUG_INSTR, STEP_REPLACE, and STEP_INSTR.

Table 3-3. Debug Status

Bit	Name	Reset	Description
7	CHIP_ERASE_BUSY	0	Flash chip erase busy The signal is only high when a chip erase is in progress. It goes high immediately after a CHIP_ERASE command is received and returns to low when the flash is fully erased. 0: – 1: Chip erase in progress
6	PCON_IDLE	0	PCON idle. See also Table 3-4 . 0: CPU is running. Chip in operational mode controlled by debugger. 1: CPU is not running. Chip is in power mode defined by SLEEPCMD.MODE register setting. See Section 4.1 - Section 4.3 for details.
5	CPU_HALTED	0	CPU was halted 0: CPU is running. 1: CPU was halted from a breakpoint or from a HALT debug command.
4	PM_ACTIVE	0	Chip is active. Note that PM0 and PM1 are not supported in debug mode. See also Table 3-4 . 0: Chip is out of normal operation (active mode) and either in transition up or down from power mode or stable in the power mode defined by SLEEPCMD.MODE register setting. See Section 4.1 - Section 4.3 for details. 1: Chip is in normal operation with CPU running (if not halted).

Table 3-3. Debug Status (continued)

Bit	Name	Reset	Description
3	HALT_STATUS	0	Halt status. Returns cause of last CPU halt 0: CPU was halted by HALT debug command 1: CPU was halted by hardware breakpoint
2	DEBUG_LOCKED	0	Debug interface is locked. Returns value of DBGLOCK bit. See Section 3.4.1 . 0: Debug interface is not locked. 1: Debug interface is locked.
1	OSCILLATOR_STABLE	0	System clock oscillator stable. 0: Oscillators not stable 1: Oscillators stable
0	STACK_OVERFLOW	0	Stack overflow. This bit indicates when the CPU writes to DATA memory space at address 0xFF, which is possibly a stack overflow. 0: No stack overflow 1: Stack overflow

Table 3-4. Relation Between PCON_IDLE and PM_ACTIVE

PCON_IDLE	PM_ACTIVE	Description
0	0	Chip in normal operation with CPU running (if not halted)
0	1	Chip in transition to start-up from power mode
1	0	Chip in transition to enter power mode
1	1	Chip stable in power mode

3.3.3 Hardware Breakpoints

The debug command SET_HW_BRKPNT is used to set one of the four available hardware breakpoints. When a hardware breakpoint is enabled, it compares the CPU address bus with the breakpoint. When a match occurs, the CPU is halted.

When issuing the SET_HW_BRKPNT, the external host must supply three data bytes that define the hardware breakpoint. The hardware breakpoint itself consists of 19 bits, whereas three bits are used for control purposes. The format of the three data bytes for the SET_HW_BRKPNT command is as follows.

The first data byte consists of the following:

- Bits 7–6: Unused
- Bits 5–4: Breakpoint number, 0–3
- Bit 3: 1 = enable, 0 = disable
- Bits 2–0: Memory bank bits. Bits 18–16 of hardware breakpoint.

The second data byte consists of bits 15–8 of the hardware breakpoint.

The third data byte consists of bits 7–0 of the hardware breakpoint. Thus, the second and third data bytes set the CPU CODE address at which to stop execution.

3.4 Flash Programming

Programming of the on-chip flash is performed via the debug interface. The external host must initially send instructions using the DEBUG_INSTR debug command to perform the flash programming with the flash controller.

3.4.1 Lock Bits

For software and/or access protection, a set of lock bits can be written to the upper available flash page—the lock-bit page. The lock-bit structure consists of FLASH_PAGES-1 lock bits followed by one debug lock bit (see [Table 3-5](#)). The structure starts at address (flash-page size in bytes - 16) in the lock-bit page and occupies up to 16 bytes. The rest of the lock-bit page (addresses 0–(flash-page size in bytes - 17)) can be used to store code/constants, but cannot be changed without entering debug mode.

The PAGEDLOCK[FLASH_PAGES-2:0] lock-protect bits are used to enable erase/write protection for individual flash memory pages (2 KB). There is one bit for each available page.

When the debug-lock bit, DBGLOCK, is set to 0 (see [Table 3-5](#)), all debug commands except CHIP_ERASE, READ_STATUS, and GET_CHIP_ID are disabled. The status of the debug-lock bit can be read using the READ_STATUS command (see [Section 3.3.2](#)).

Note that after the debug-lock bit has changed due to a write to the lock-bit page or a CHIP_ERASE command, the device must be reset to lock/unlock the debug interface.

Issuing a CHIP_ERASE command is the only way to clear the debug-lock bit, thereby unlocking the debug interface.

[Table 3-5](#) defines the 16-byte structure containing the flash lock-protection bits. Bit 0 of the first byte contains the lock bit for page 0, bit 1 of the first byte contains the lock bit for page 1, and so on. Bit 7 of the last byte in the flash is the DBGLOCK bit (bit 127 in the structure).

Table 3-5. Flash Lock-Protection Bit Structure Definition

Bit	Name	Description
127	DBGLOCK	Debug-lock bit 0: Disable debug commands 1: Enable debug commands
FLASH_PAGES-2:0	PAGEDLOCK[FLASH_PAGES - 2 : 0]	Page-lock bits. There is one bit for each of the up to 128 pages. Page-lock bits for unavailable pages are not used. 0: Page locked 1: Page not locked

3.5 Debug Interface and Power Modes

Power modes PM2 and PM3 may be handled in two different ways when the chip is in debug mode. The default behavior is never to turn off the digital voltage regulator. This emulates power modes while maintaining debug mode operation. The clock sources are turned off as in ordinary power modes. The other option is to turn off the 1.8-V internal digital power. This leads to a complete shutdown of the digital part, which disables debug mode. When the chip is in debug mode, the two options are controlled by configuration bit 5 (SOFT_POWER_MODE).

The debug interface still responds to a reduced set of commands while in one of the power modes. The chip can be woken up from sleep mode by issuing a HALT command to the debug interface. The HALT command brings the chip up from sleep mode in the halted state. The RESUME command must be issued to resume software execution.

The debug status may be read when in power modes. The status must be checked when leaving a power mode by issuing a HALT command. The time needed to power up depends on which power mode the chip is in, and must be checked in the debug status. The debug interface only accepts commands that are available in sleep mode before the chip is operational.

NOTE: Debugging in Idle mode and PM1 is not supported. It is recommended to use active mode or another power mode when debugging.

3.6 Registers

DBGDATA (0x6260) – Debug Data

Bit	Name	Reset	R/W	Description
7:0	BYTE[7:0]	0	R	Debug data from BURST_WRITE command This register is updated each time a new byte has been transferred to the debug interface using the BURST_WRITE command. A DBG_BW DMA trigger is generated when this byte is updated. This allows the DMA controller to fetch the data.

CHVER (0x6249) – Chip Version

Bit	Name	Reset	R/W	Description
7:0	VERSION[7:0]	Chip dependent	R	Chip revision number

CHIPID (0x624A) – Chip ID

Bit	Name	Reset	R/W	Description
7:0	CHIPID[7:0]	Chip dependent	R	Chip identification number. CC2530: 0xA5 CC2531: 0xB5 CC2533: 0x95 CC2540: 0x8D

CHIPINFO0 (0x6276) – Chip Information Byte 0

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Always 0.
6:4	FLASHSIZE[2:0]	Chip dependent	R	Flash Size. 001 – 32 KB, 010 – 64 KB, 011 – 128 KB (for CC2533: 011 – 96 KB), 100 – 256 KB
3	USB	Chip dependent	R	1 if chip has USB, 0 otherwise
2	–	1	R1	Reserved. Always 1
1:0	–	00	R0	Reserved. Always 00

CHIPINFO1 (0x6277) – Chip Information Byte 1

Bit	Name	Reset	R/W	Description
7:3	–	0000 0	R0	Reserved. Always 0000 0
2:0	SRAMSIZE[2:0]	Chip dependent	R	SRAM size in KB minus 1. For example, a 4-KB device has this field set to 011. Add 1 to the number to get the number of KB available.

Power Management and Clocks

Low-power operation is enabled through different operating modes (power modes). The various operating modes are referred to as active mode, idle mode, and power modes 1, 2, and 3 (PM1–PM3). Ultralow-power operation is obtained by turning off the power supply to modules to avoid static (leakage) power consumption and also by using clock gating and turning off oscillators to reduce dynamic power consumption.

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4.1 Power Management Introduction

Different operating modes, or power modes, are used to allow low-power operation. Ultralow-power operation is obtained by turning off the power supply to modules to avoid static (leakage) power consumption and also by using clock gating and turning off oscillators to reduce dynamic power consumption.

The five various operating modes (power modes) are called active mode, idle mode, PM1, PM2, and PM3 (PM1/PM2/PM3 are also referred to as sleep modes). Active mode is the normal operating mode, whereas PM3 has the lowest power consumption. The impact of the different power modes on system operation is shown in [Table 4-1](#), together with voltage regulator and oscillator options.

Table 4-1. Power Modes

Power Mode	High-Frequency Oscillator		Low-Frequency Oscillator		Voltage Regulator (Digital)
Configuration	A	32-MHz XOSC	C	32-kHz XOSC	
	B	16-MHz RCOSC	D	32-kHz RCOSC	
Active / idle mode	A or B		C or D		ON
PM1	None		C or D		ON
PM2	None		C or D		OFF
PM3	None		None		OFF

Active mode: The fully functional mode. The voltage regulator to the digital core is on, and either the 16-MHz RC oscillator or the 32-MHz crystal oscillator or both are running. Either the 32-kHz RCOSC or the 32-kHz XOSC is running.

Idle mode: Identical to active mode, except that the CPU core stops operating (is idle).

PM1: The voltage regulator to the digital part is on. Neither the 32-MHz XOSC nor the 16-MHz RCOSC is running. Either the 32-kHz RCOSC or the 32-kHz XOSC is running. The system goes to active mode on reset, an external interrupt, or when the Sleep Timer expires.

PM2: The voltage regulator to the digital core is turned off. Neither the 32-MHz XOSC nor the 16-MHz RCOSC is running. Either the 32-kHz RCOSC or the 32-kHz XOSC is running. The system goes to active mode on reset, an external interrupt, or when the Sleep Timer expires.

PM3: The voltage regulator to the digital core is turned off. None of the oscillators is running. The system goes to active mode on reset or an external interrupt.

The POR is active in PM2/PM3, but the BOD is powered down, which gives a limited voltage supervision. If the supply voltage is lowered to below 1.4 V during PM2/PM3, at temperatures of 70°C or higher, and then brought back up to good operating voltage before active mode is re-entered, registers and RAM contents that are saved in PM2/PM3 may become altered. Hence, care should be taken in the design of the system power supply to ensure that this does not occur. The voltage can be periodically supervised accurately by entering active mode, as a BOD reset is triggered if the supply voltage is below approximately 1.7 V.

The CC2533 has functionality to perform automatically a CRC check of the retained configuration register values in PM2/PM3 to check that the device state was not altered during sleep. The bits in SRCRC.CRC_RESULT indicate whether there were any changes, and by enabling SRCRC.CRC_RESET_EN, the device immediately resets itself with a watchdog reset if SRCRC.CRC_RESULT is not 00 (= CRC of retained registers passed) after wakeup from PM2/PM3. The SRCRC register also contains the SRCRC.FORCE_RESET bit that can be used by software to immediately trigger a watchdog reset to reboot the device.

For CC2533, a new analog reset architecture adds another brownout detector (the 3VBOD) that senses on the unregulated voltage. The purpose of this 3VBOD is to reduce the current consumption of the device when supplied with voltages well below the operating voltage.

4.1.1 Active and Idle Mode

Active mode is the fully functional mode of operation where the CPU, peripherals, and RF transceiver are active. The digital voltage regulator is turned on.

Active mode is used for normal operation. By enabling the `PCON.IDLE` bit while in active mode (`SLEEP_CMD.MODE = 0x00`), the CPU core stops operating and the idle mode is entered. All other peripherals function normally, and any enabled interrupt wakes up the CPU core (to transition back from idle mode to active mode).

4.1.2 PM1

In PM1, the high-frequency oscillators are powered down (32-MHz XOSC and 16-MHz RCOSC). The voltage regulator and the enabled 32-kHz oscillator are on. When PM1 is entered, a power-down sequence is run.

PM1 is used when the expected time until a wakeup event is relatively short (less than 3 ms), because PM1 uses a fast power-down/up sequence.

4.1.3 PM2

PM2 has the second-lowest power consumption. In PM2, the power-on reset, external interrupts, selected 32-kHz oscillator, and Sleep Timer peripherals are active. I/O pins retain the I/O mode and output value set before entering PM2. All other internal circuits are powered down. The voltage regulator is also turned off. When PM2 is entered, a power-down sequence is run.

PM2 is typically entered when using the Sleep Timer as the wakeup event, and also combined with external interrupts. PM2 should typically be chosen, compared to PM1, when expected sleep time exceeds 3 ms. Using less sleep time does not reduce system power consumption compared to using PM1.

4.1.4 PM3

PM3 is used to achieve the operating mode with the lowest power consumption. In PM3, all internal circuits that are powered from the voltage regulator are turned off (basically all digital modules; the only exceptions are interrupt detection and POR level sensing). The internal voltage regulator and all oscillators are also turned off.

Reset (POR or external) and external I/O port interrupts are the only functions that operate in this mode. I/O pins retain the I/O mode and output value set before entering PM3. A reset condition or an enabled external I/O interrupt event wakes the device up and places it into active mode (an external interrupt starts from where it entered PM3, whereas a reset returns to start-of-program execution). The content of RAM and registers is partially preserved in this mode (see [Section 4.6](#)). PM3 uses the same power-down/up sequence as PM2.

PM3 is used to achieve ultralow power consumption when waiting for an external event. It should be used when expected sleep time exceeds 3 ms.

4.2 Power-Management Control

The required power mode is selected by the MODE bits in the `SLEEP_CMD` control register and the `PCON.IDLE` bit. Setting the SFR register `PCON.IDLE` bit enters the mode selected by `SLEEP_CMD.MODE`.

An enabled interrupt from port pins or Sleep Timer or a power-on reset wakes the device from other power modes and brings it into active mode.

When PM1, PM2, or PM3 is entered, a power-down sequence is run. When the device is taken out of PM1, PM2, or PM3, it starts at 16 MHz and automatically changes to 32 MHz if `CLKCONCMD.OSC` was 0 when entering the power mode (setting `PCON.IDLE`). If `CLKCONCMD.OSC` was 1 when `PCON.IDLE` was set, when entering the power mode, it continues to run at 16 MHz.

The instruction that sets the `PCON.IDLE` bit must be aligned in a certain way for correct operation. The first byte of the assembly instruction immediately following this instruction must not be placed on a 4-byte boundary. Furthermore, cache must not be disabled (see `CM` in the `FCTL` register description in [Chapter 6](#)). Failure to comply with this requirement may cause higher current consumption. Provided this requirement is fulfilled, the first assembly instruction after the instruction that sets the `PCON.IDLE` bit is performed before the ISR of the interrupt that caused the system to wake up, but after the system woke up. If this instruction is a global interrupt disable, it is possible to have it followed by code for execution after wakeup, but before the ISR is serviced.

An example of how this can be done in the IAR compiler is shown as follows. The command for setting `PCON` to 1 is placed in a function written in assembly code. In a C file calling this function, a declaration such as `extern void EnterSleepModeDisableInterruptsOnWakeup(void);` is used. The `RSEG NEAR_CODE:CODE:NOROOT(2)` statement ensures that the `MOV PCON,#1` instruction is placed on a 2-byte boundary. It is a 3-byte instruction, so the following instruction is not placed on a 4-byte boundary, as required. In the following example, this instruction is `CLR EA`, which disables all interrupts. That means that the ISR of the interrupt that woke up the system is not executed until after the `IEN0.EA` bit has been set again later in the code. If this functionality is not wanted, the `CLR EA` instruction can be replaced by a `NOP`.

```
PUBLIC EnterSleepModeDisableInterruptsOnWakeup FUNCTION
EnterSleepModeDisableInterruptsOnWakeup,0201H RSEG NEAR_CODE:CODE:NOROOT(2)
EnterSleepModeDisableInterruptsOnWakeup: MOV PCON,#1 CLR EA RET
```

4.3 Power-Management Registers

This section describes the power-management registers. All register bits retain their previous values when entering PM2 or PM3.

SRCRC (0x6262) – Sleep Reset CRC (CC2533 only)

Bit	Name	Reset	R/W	Description
7	XOSC_AMP_DET_EN	0	R/W	0: Disable 1: Enable the amplitude detector for the 32-MHz XOSC
6	–	0	R0	Reserved. Always read 0.
5	FORCE_RESET	0	R/W	0: No action 1: Force watchdog reset.
4	–	0	R	Reserved
3:2	CRC_RESULT	00	R/W0	00: CRC of retained registers passed 01: Low CRC value failed 10: High CRC value failed 11: Both CRC values failed
1	–	0	R	Reserved
0	CRC_RESET_EN	0	R/W	0: Disable reset of chip due to CRC. 1: Enable reset of chip if <code>CRC_RESULT != 00</code> after wakeup from PM2/PM3.

PCON (0x87) – Power Mode Control

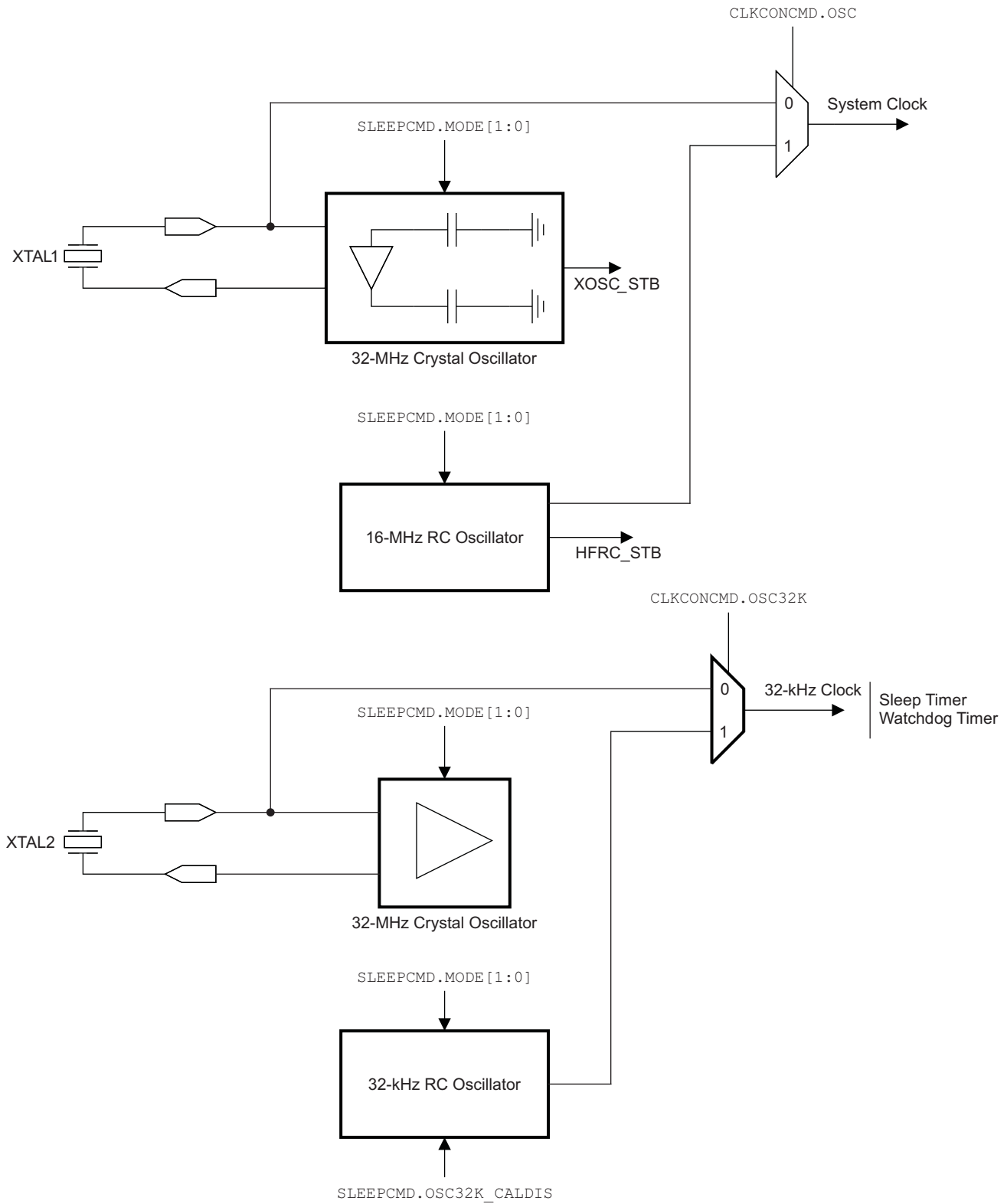
Bit	Name	Reset	R/W	Description
7:1	–	0000 000	R/W	Reserved, always write as 0000 000.
0	IDLE	0	R0/W H0	Power mode control. Writing 1 to this bit forces the device to enter the power mode set by <code>SLEEP_CMD.MODE</code> (note that <code>MODE = 0x00 AND IDLE = 1</code> stops the CPU core activity). This bit is always read as 0. All enabled interrupts clear this bit when active, and the device re-enters active mode.

SLEEP_CMD (0xBE) – Sleep-Mode Control Command

Bit	Name	Reset	R/W	Description
7	OSC32K_CALDIS	0	R/W	Disable 32-kHz RC oscillator calibration 0: 32-kHz RC oscillator calibration is enabled. 1: 32-kHz RC oscillator calibration is disabled. This setting can be written at any time, but does not take effect before the chip has been running on the 16-MHz high-frequency RC oscillator.
6:3	–	000 0	R0	Reserved
2	–	1	R/W	Reserved. Always write as 1
1:0	MODE[1:0]	00	R/W	Power-mode setting 00: Active / Idle mode 01: Power mode 1 (PM1) 10: Power mode 2 (PM2) 11: Power mode 3 (PM3)

SLEEP_STA (0x9D) – Sleep-Mode Control Status

Bit	Name	Reset	R/W	Description
7	OSC32K_CALDIS	0	R	32-kHz RC oscillator calibration status SLEEP_STA.OSC32K_CALDIS shows the current status of disabling of the 32-kHz RC calibration. The bit is not set to the same value as SLEEP_CMD.OSC32K_CALDIS before the chip has been run on the 32-kHz RC oscillator.
6:5	–	00	R	Reserved
4:3	RST[1:0]	XX	R	Status bit indicating the cause of the last reset. If there are multiple resets, the register only contains the last event. 00: Power-on reset and brownout detection 01: External reset 10: Watchdog Timer reset 11: Clock loss reset
2:1	–	00	R	Reserved
0	CLK32K	0	R	The 32-kHz clock signal (synchronized to the system clock)



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Figure 4-1. Clock System Overview

4.4 Oscillators and Clocks

The device has one internal system clock, or main clock. The source for the system clock can be either the 16-MHz RC oscillator or the 32-MHz crystal oscillator. Clock control is performed using the `CLKCONCMD` SFR register.

There is also one 32-kHz clock source that can either be an RC oscillator or a crystal oscillator, also controlled by the `CLKCONCMD` register.

The `CLKCONSTA` register is a read-only register used for getting the current clock status.

The choice of oscillator allows a trade-off between high accuracy in the case of the crystal oscillator and low power consumption when the RC oscillator is used. Note that operation of the RF transceiver requires that the 32-MHz crystal oscillator is used.

In the CC2533 and CC2540, an additional module for detection of 32-MHz XOSC stability is available. This amplitude detector can be useful in environments with significant noise on the power supply, to ensure that the clock source is not used until the clock signal is stable. In the CC2533, this module can be enabled by setting the `SRCRC.XOSC_AMP_DET_EN` bit, and this adds around 20 μ s to the 32-MHz XOSC startup time. In the CC2540, the module is always enabled.

4.4.1 Oscillators

Figure 4-1 gives an overview of the clock system with available clock sources.

Two high-frequency oscillators are present in the device:

- 32-MHz crystal oscillator
- 16-MHz RC oscillator

The 32-MHz crystal-oscillator start-up time may be too long for some applications; therefore, the device can run on the 16-MHz RC oscillator until the crystal oscillator is stable. The 16-MHz RC oscillator consumes less power than the crystal oscillator, but because it is not as accurate as the crystal oscillator it cannot be used for RF transceiver operation.

Two low-frequency oscillators are present in the device:

- 32-kHz crystal oscillator
- 32-kHz RC oscillator.

The 32-kHz XOSC is designed to operate at 32.768 kHz and provide a stable clock signal for systems requiring time accuracy. The 32-kHz RCOSC runs at 32.753 kHz when calibrated. The calibration can only take place when the 32-MHz XOSC is enabled, and this calibration can be disabled by enabling the `SLEEP_CMD.OSC32K_CALDIS` bit. The 32-kHz RCOSC should be used to reduce cost and power consumption compared to the 32-kHz XOSC solution. The two 32-kHz oscillators cannot be operated simultaneously.

4.4.2 System Clock

The system clock is derived from the selected system clock source, which is the 32-MHz XOSC or the 16-MHz RCOSC. The `CLKCONCMD.OSC` bit selects the source of the system clock. Note that to use the RF transceiver, the 32-MHz crystal oscillator must be selected and stable.

Note that changing the `CLKCONCMD.OSC` bit does not cause the system clock to change instantly. The clock source change first takes effect when `CLKCONSTA.OSC = CLKCONCMD.OSC`. This is due to the requirement to have stable clocks prior to actually changing the clock source. Also note that the `CLKCONCMD.CLKSPD` bit reflects the frequency of the system clock and thus is a mirror of the `CLKCONCMD.OSC` bit.

The 16 MHz RC oscillator is calibrated once after the 32-MHz XOSC has been selected and is stable, i.e., when the `CLKCONSTA.OSC` bit switches from 1 to 0.

NOTE: The change from the 16-MHz clock source to the 32-MHz clock source (and vice versa) aligns with the `CLKCONCMD.TICKSPD` setting. A slow `CLKCONCMD.TICKSPD` setting when `CLKCONCMD.OSC` is changed results in a longer time before the actual source change takes effect. The fastest switching is obtained when `CLKCONCMD.TICKSPD` equals 000.

NOTE: After coming up from PM1, PM2, or PM3, the CPU must wait for `CLKCONSTA.OSC` to be 0 before operations requiring the system to run on the 32-MHz XOSC (such as the radio) are started.

4.4.3 32 kHz Oscillators

Two 32 kHz oscillators are present in the device as clock sources for the 32-kHz clock:

- 32-kHz XOSC
- 32-kHz RCOSC

By default, after a reset, the 32-kHz RCOSC is enabled and selected as the 32-kHz clock source. The RCOSC consumes less power, but is less accurate compared to the 32-kHz XOSC. The chosen 32-kHz clock source drives the Sleep Timer, generates the tick for the Watchdog Timer, and is used as a strobe in Timer 2 to calculate the Sleep Timer sleep time. The `CLKCONCMD.OSC32K` register bit selects the oscillator to be used as the 32-kHz clock source.

The `CLKCONCMD.OSC32K` register bit can be written at any time, but does not take effect before the 16-MHz RCOSC is the active system clock source. When system clock is changed from the 16-MHz RCOSC to the 32-MHz XOSC (`CLKCONCMD.OSC` from 1 to 0), calibration of the 32-kHz RCOSC starts up and is performed once if the 32-kHz RCOSC is selected. During calibration, a divided version of the 32-MHz XOSC is used. The result of the calibration is that the 32-kHz RCOSC is running at 32.753 kHz. The 32-kHz RCOSC calibration may take up to 2 ms to complete. Calibration can be disabled by setting `SLEEP_CMD.OSC32K_CALDIS` to 1. At the end of the calibration, an extra pulse may occur on the 32-kHz clock source, which causes the sleep timer to be incremented by 1.

Note that after having switched to the 32-kHz XOSC and when coming up from PM3 with the 32-kHz XOSC enabled, the oscillator requires up to 500 ms to stabilize on the correct frequency. The Sleep Timer, Watchdog Timer and clock-loss detector should not be used before the 32-kHz XOSC is stable.

4.4.4 Oscillator and Clock Registers

This section describes the oscillator and clock registers. All register bits retain their previous values when entering PM2 or PM3.

CLKCONCMD (0xC6) – Clock Control Command

Bit	Name	Reset	R/W	Description
7	OSC32K	1	R/W	32 kHz clock-source select. Setting this bit initiates a clock-source change only. CLKCONSTA.OSC32K reflects the current setting. The 16 MHz RCOSC must be selected as system clock when this bit is to be changed. 0: 32 kHz XOSC 1: 32 kHz RCOSC
6	OSC	1	R/W	System clock-source select. Setting this bit initiates a clock-source change only. CLKCONSTA.OSC reflects the current setting. 0: 32 MHz XOSC 1: 16 MHz RCOSC
5:3	TICKSPD[2:0]	001	R/W	Timer ticks output setting. Cannot be higher than system clock setting given by OSC bit setting. 000: 32 MHz 001: 16 MHz 010: 8 MHz 011: 4 MHz 100: 2 MHz 101: 1 MHz 110: 500 kHz 111: 250 kHz Note that CLKCONCMD . TICKSPD can be set to any value, but the effect is limited by the CLKCONCMD . OSC setting; i.e., if CLKCONCMD . OSC = 1 and CLKCONCMD . TICKSPD = 000, CLKCONSTA . TICKSPD reads 001, and the real TICKSPD is 16 MHz.
2:0	CLKSPD	001	R/W	Clock speed. Cannot be higher than system clock setting given by the OSC bit setting. Indicates current system-clock frequency 000: 32 MHz 001: 16 MHz 010: 8 MHz 011: 4 MHz 100: 2 MHz 101: 1 MHz 110: 500 kHz 111: 250 kHz Note that CLKCONCMD . CLKSPD can be set to any value, but the effect is limited by the CLKCONCMD . OSC setting; i.e., if CLKCONCMD . OSC = 1 and CLKCONCMD . CLKSPD = 000, CLKCONSTA . CLKSPD reads 001, and the real CLKSPD is 16 MHz. Note also that the debugger cannot be used with a divided system clock. When running the debugger, the value of CLKCONCMD . CLKSPD should be set to 000 when CLKCONCMD . OSC = 0 or to 001 when CLKCONCMD . OSC = 1.

CLKCONSTA (0x9E) – Clock Control Status

Bit	Name	Reset	R/W	Description
7	OSC32K	1	R	Current 32-kHz clock source selected: 0: 32-kHz XOSC 1: 32-kHz RCOSC
6	OSC	1	R	Current system clock selected: 0: 32-MHz XOSC 1: 16-MHz RCOSC
5:3	TICKSPD[2:0]	001	R	Current timer ticks output setting 000: 32 MHz 001: 16 MHz 010: 8 MHz 011: 4 MHz 100: 2 MHz 101: 1 MHz 110: 500 kHz 111: 250 kHz
2:0	CLKSPD	001	R	Current clock speed 000: 32 MHz 001: 16 MHz 010: 8 MHz 011: 4 MHz 100: 2 MHz 101: 1 MHz 110: 500 kHz 111: 250 kHz

4.5 Timer Tick Generation

The value of the `CLKCONCMD.TICKSPD` register controls a global prescaler for Timer 1, Timer 3, and Timer 4. The prescaler value can be set to a value from 0.25 MHz to 32 MHz. It should be noted that if `CLKCONCMD.TICKSPD` indicates a higher frequency than the system clock, the actual prescaler value indicated in `CLKCONSTA.TICKSPD` is the same as the system clock.

4.6 Data Retention

In power modes PM2 and PM3, power is removed from most of the internal circuitry. However, SRAM retains its contents, and the content of internal registers is also retained in PM2 and PM3.

All CPU, RF, and peripheral registers retain their contents in PM2 and PM3, except the AES, I²C, and USB registers.

Switching to the PM2 or PM3 low-power modes appears transparent to software. Note that the value of the Sleep Timer is not preserved in PM3.

All registers retain their values in PM1.

Reset

The device has five reset sources. The following events generate a reset:

- Forcing the RESET_N input pin low
- A power-on reset condition
- A brownout reset condition
- Watchdog Timer reset condition
- Clock-loss reset condition

The initial conditions after a reset are as follows:

- I/O pins are configured as inputs with pullups (P1.0 and P1.1 are inputs, but do not have pullup/pulldown)
- CPU program counter is loaded with 0x0000 and program execution starts at this address
- All peripheral registers are initialized to their reset values (see register descriptions)
- Watchdog Timer is disabled
- Clock-loss detector is disabled

During reset, the I/O pins are configured as inputs with pullups (P1.0 and P1.1 are inputs, but do not have pullup/pulldown).

In the CC2533, a watchdog reset can be generated immediately in software by writing the SRCRC.FORCE_RESET bit to 1 (see [Section 4.3](#) for the register description). In the other devices in the family, a watchdog reset can be triggered from software by enabling the watchdog timer with the shortest time-out and waiting for it to trigger.

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5.1 Power-On Reset and Brownout Detector

The device includes a power-on reset (POR), providing correct initialization during device power on. It also includes a brownout detector (BOD) operating on the regulated 1.8-V digital power supply only. The BOD protects the memory contents during supply voltage variations which cause the regulated 1.8-V power to drop below the minimum level required by digital logic, flash memory, and SRAM.

When power is initially applied, the POR and BOD hold the device in the reset state until the supply voltage rises above the power-on-reset and brownout voltages.

The cause of the last reset can be read from the register bits `SLEEPSTA.RST`. It should be noted that a BOD reset is read as a POR reset.

5.2 Clock-Loss Detector

The clock-loss detector can be used in safety-critical systems to detect that one of the XOSC clock sources (32-MHz XOSC or 32-kHz XOSC) has stopped. This can typically happen due to damage to the external crystal or supporting components. When the clock-loss detector is enabled, the two clocks monitor each other continuously. If one of the clocks stops toggling, a clock-loss detector reset is generated within a certain maximum time-out period. The time-out depends on which clock stops. If the 32-kHz clock stops, the time-out period is 0.5 ms. If the 32-MHz clock stops, the time-out period is 0.25 ms. When the system comes up again from reset, software can detect the cause of the reset by reading `SLEEPSTA.RST[1:0]`. After a reset, the internal RC oscillators are used. Thus, the system is able to start up again and can then be powered down gracefully. The clock-loss detector is enabled/disabled with the `CLD.EN` bit. It is assumed that the 32-MHz XOSC is selected as system clock source when using the clock-loss detector. The 32-kHz clock can be 32-kHz RCOSC (should be calibrated for accurate reset timeout) or 32-kHz XOSC.

In power modes 1 and 2, the clock-loss detector is automatically stopped and restarted when the clocks start up again.

Before entering power mode 3, switch to the 16-MHz RCOSC and disable the clock-loss detector. When entering active mode again, turn on the clock-loss detector and then switch back to the 32-MHz XOSC.

CLD (0x6290) – Clock-Loss Detection

Bit	Name	Reset	R/W	Description
7:1	–	0000 000	R0	Reserved
0	EN	0	R/W	Clock-loss detector enable

Flash Controller

The device contains flash memory for storage of program code. The flash memory is programmable from the user software and through the debug interface.

The flash controller handles writing and erasing the embedded flash memory. The embedded flash memory consists of up to 128 pages of 2048 bytes (CC2530/CC2531/CC2540) or 1024 bytes (CC2533) each.

The flash controller has the following features:

- 32-bit word programmable
- Page erase
- Lock bits for write protection and code security
- Flash-page erase timing 20 ms
- Flash-chip erase timing 20 ms
- Flash-write timing (4 bytes) 20 μ s

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6.1 Flash Memory Organization

The flash memory is divided into 2048-byte or 1024-byte flash pages. A flash page is the smallest erasable unit in the memory, whereas a 32-bit word is the smallest writable unit that can be written to the flash.

When performing write operations, the flash memory is word-addressable using a 16-bit address written to the address registers `FADDRH:FADDRL`.

When performing page-erase operations, the flash memory page to be erased is addressed through the register bits `FADDRH[7:1]` (CC2530/CC2531/CC2540) or `FADDRH[6:0]` (CC2533).

Note the difference in addressing the flash memory; when accessed by the CPU to read code or data, the flash memory is byte-addressable. When accessed by the flash controller, the flash memory is word-addressable, where a word consists of 32 bits.

The following sections describe the procedures for flash write and flash page-erase in detail.

6.2 Flash Write

The flash is programmed serially with a sequence of one or more 32-bit words (4 bytes), starting at the start address (set by `FADDRH:FADDRL`). In general, a page must be erased before writing can begin. The page-erase operation sets all bits in the page to 1. The chip-erase command (through the debug interface) erases all pages in the flash. This is the only way to set bits in the flash to 1. When writing a word to the flash, the 0-bits are programmed to 0 and the 1-bits are ignored (leaves the bit in the flash unchanged). Thus, bits are erased to 1 and can be written to 0. It is possible to write multiple times to a word. This is described in [Section 6.2.2](#).

6.2.1 Flash-Write Procedure

The flash-write sequence algorithm is as follows:

1. Set `FADDRH:FADDRL` to the start address. (This is the 16 MSBs of the 18-bit byte address).
2. Set `FCTL.WRITE` to 1. This starts the write-sequence state machine.
3. Write four times to `FWDATA` within 20 μ s (since the last time `FCTL.FULL` became 0, if not first iteration). LSB is written first. (`FCTL.FULL` goes high after the last byte.)
4. Wait until `FCTL.FULL` goes low. (The flash controller has started programming the 4 bytes written in step 3 and is ready to buffer the next 4 bytes).
5. Optional status check step:
 - If the 4 bytes were not written fast enough in step 3, the operation has timed out and `FCTL.BUSY` (and `FCTL.WRITE`) are 0 at this stage.
 - If the 4 bytes could not be written to the flash due to the page being locked, `FCTL.BUSY` (and `FCTL.WRITE`) are 0 and `FCTL.ABORT` is 1.
6. If this was the last 4 bytes then quit, otherwise go to step 3.

The write operation is performed using one of two methods:

- Using DMA transfer (preferred method)
- Using CPU, running code from SRAM

The CPU cannot access the flash, e.g., to read program code, while a flash-write operation is in progress. Therefore, the program code executing the flash write must be executed from RAM. See [Section 2.2.1](#) for a description of how to run code from RAM.

When a flash-write operation is executed from RAM, the CPU continues to execute code from the next instruction after initiation of the flash-write operation (`FCTL.WRITE = 1`).

Power mode 1, 2, or 3 must not be entered while writing to the flash. Also, the system clock source (`XOSC/RCOSC`) must not be changed while writing. Note that setting `CLKCONSTA.CLKSPD` to a high value makes it impossible to meet the timing requirement of 20- μ s write timing. With `CLKCONSTA.CLKSPD = 111`, the clock period is only 4 μ s. It is therefore recommended to keep `CLKCONSTA.CLKSPD` at 000 or 001 while writing to the flash.

6.2.2 Writing Multiple Times to a Word

The following rules apply when writing multiple times to a 32-bit word between erase:

- Writing 0 to a bit within a 32-bit flash word, which has been set to 1 by the last erase operation, changes the state of the bit to 0, subject to the last bullet below.
- It is possible to write 0 to a bit within a 32-bit word repeatedly (subject to the last bullet below) once the bit has been written with 0. This does not change the state of the bit.
- Writing 1 to a bit does not change the state of the bit, subject to the last bullet below.
- The following limitations apply to writes subsequent to the last page erase:
 - A 0 must not be written more than two times to a single bit.
 - A 32-bit word shall not be written more than 8 times.
 - A page must not be written more than 1024 times.

The state of any bit of a 32-bit flash word is nondeterministic if these limitations are violated.

This makes it possible to write up to 4 new bits to a 32-bit word 8 times. One example write sequence to a word is shown in [Table 6-1](#). Here b_n represents the 4 new bits written to the word for each update. This technique is useful to maximize the lifetime of the flash for data-logging applications.

Table 6-1. Example Write Sequence

Step	Value Written	FLASH Contents After Writing	Comment
1	(page erase)	0xFFFFFFFF	The erase sets all bits to 1.
2	0xFFFFFFFF b_0	0xFFFFFFFF b_0	Only the bits written 0 are set to 0, whereas all bits written 1 are ignored.
3	0xFFFFFFFF b_1 ,F	0xFFFFFFFF b_1 b_0	Only the bits written 0 are set to 0, whereas all bits written 1 are ignored.
4	0xFFFFF b_2 FF	0xFFFFF b_2 b_1 b_0	Only the bits written 0 are set to 0, whereas all bits written 1 are ignored.
5	0xFFFF b_3 FFF	0xFFFF b_3 b_2 b_1 b_0	Only the bits written 0 are set to 0, whereas all bits written 1 are ignored.
6	0xFFFF b_4 FFFF	0xFFFF b_4 b_3 b_2 b_1 b_0	Only the bits written 0 are set to 0, whereas all bits written 1 are ignored.
7	0xFF b_5 FFFFF	0xFF b_5 b_4 b_3 b_2 b_1 b_0	Only the bits written 0 are set to 0, whereas all bits written 1 are ignored.
8	0xF b_6 FFFFF	0xF b_6 b_5 b_4 b_3 b_2 b_1 b_0	Only the bits written 0 are set to 0, whereas all bits written 1 are ignored.
9	0xb b_7 FFFFF	0xb b_7 b_6 b_5 b_4 b_3 b_2 b_1 b_0	Only the bits written 0 are set to 0, whereas all bits written 1 are ignored.

6.2.3 DMA Flash Write

When using DMA write operations, the data to be written into flash is stored in the XDATA memory space (RAM or registers). A DMA channel is configured to read the data to be written from the memory source address and write this data to the flash write-data register (FWDATA) fixed destination address, with the DMA trigger event FLASH (TRIG[4:0] = 1 0010 in DMA configuration) enabled. Thus, the flash controller triggers a DMA transfer when the flash write-data register, FWDATA, is ready to receive new data. The DMA channel should be configured to perform single-mode, byte-size transfers with the source address set to start-of-data block and destination address to fixed FWDATA (note that the block size, LEN in configuration data, must be divisible by 4; otherwise, the last word is not written to the flash). High priority should also be ensured for the DMA channel, so it is not interrupted in the write process. If interrupted for more than 20 μ s, the write operation may time out, and the write bit, FCTL.WRITE, is set to 0.

When the DMA channel is armed, starting a flash write by setting FCTL.WRITE to 1 triggers the first DMA transfer (DMA and flash controller handle the reset of the transfer).

[Figure 6-1](#) shows an example of how a DMA channel is configured and how a DMA transfer is initiated to write a block of data from a location in XDATA to flash memory.

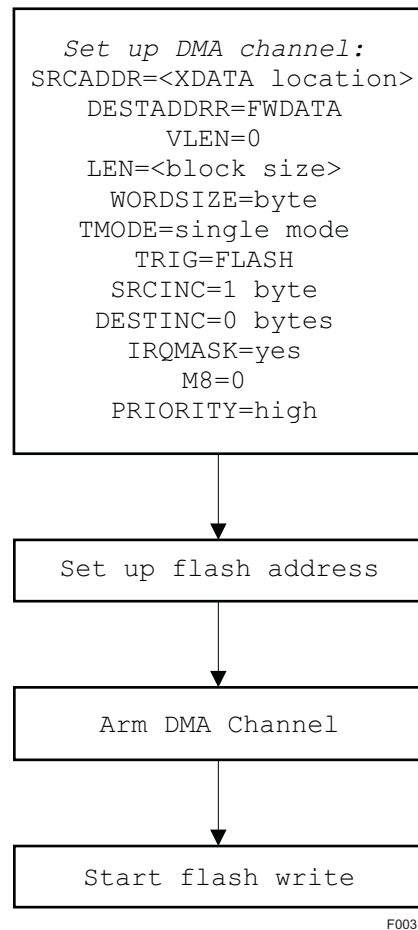


Figure 6-1. Flash Write Using DMA

6.2.4 CPU Flash Write

To write to the flash using the CPU, a program executing from SRAM must implement the steps outlined in the procedure described in [Section 6.2.1](#). Disable interrupts to ensure the operation does not time out.

6.3 Flash Page Erase

The flash page-erase operation sets all bits in the page to 1.

A page erase is initiated by setting `FCTL.ERASE` to 1. The page addressed by `FADDRH[7:1]` (CC2530/CC2531/CC2540) or `FADDRH[6:0]` (CC2533) is erased when a page erase is initiated. Note that if a page erase is initiated simultaneously with a page write, i.e., `FCTL.WRITE` is set to 1, the page erase is performed before the page-write operation starts. The `FCTL.BUSY` bit can be polled to see when the page erase has completed.

Power mode 1, 2, or 3 must not be entered while erasing a page. Also, the system clock source (XOSC/RCOSC) must not be changed while erasing.

NOTE: If a flash page-erase operation is performed from within flash memory and the Watchdog Timer is enabled, a Watchdog Timer interval must be selected that is longer than 20 ms, the duration of the flash page-erase operation, so that the CPU can clear the Watchdog Timer.

6.3.1 Performing Flash Erase From Flash Memory

Note that while executing program code from within flash memory, when a flash erase or write operation is initiated the CPU stalls, and program execution resumes from the next instruction when the flash controller has completed the operation.

The following code example of how to erase one flash page in the CC2530 is given for use with the IAR compiler:

```
#include <ioCC2530.h>

unsigned char erase_page_num = 3; /* page number to erase, here: flash page #3 */

/* Erase one flash page */
EA = 0; /* disable interrupts */
while (FCTL & 0x80); /* poll FCTL.BUSY and wait until flash controller is ready */
FADDRH = erase_page_num << 1; /* select the flash page via FADDRH[7:1] bits */
FCTL |= 0x01; /* set FCTL.ERASE bit to start page erase */
while (FCTL & 0x80); /* optional: wait until flash write has completed (~20 ms) */
EA = 1; /* enable interrupts */
```

6.3.2 Different Flash Page Size on CC2533

The flash page size has been reduced from 2 KB (2048 bytes) on CC2530/CC2531/CC2540 to 1 KB (1024 bytes) on CC2533. When performing page-erase operations on the flash memory, the page to be erased is addressed with the register bits `FADDRH[6:0]` on CC2533 as opposed to `FADDRH[7:1]` on CC2530/CC2531/CC2540. The page lock bits are still placed in the upper 16 bytes of the last accessible flash page.

6.4 Flash DMA Trigger

The flash DMA trigger is activated when flash data written to the `FWDATA` register has been written to the specified location in the flash memory, thus indicating that the flash controller is ready to accept new data to be written to `FWDATA`. Four trigger pulses are generated. In order to start the first transfer, one must set the `FCTL.WRITE` bit to 1. The DMA and the flash controller then handle all transfers automatically for the defined block of data (LEN in DMA configuration). It is further important that the DMA is armed prior to setting the `FCTL.WRITE` bit, that the trigger source is set to `FLASH` (`TRIG[4:0] = 10010`), and that the DMA has high priority so the transfer is not interrupted. If interrupted for more than 20 μ s, the write operation times out and `FCTL.WRITE` bit is cleared.

6.5 Flash Controller Registers

The flash controller registers are described in this section.

FCTL (0x6270) – Flash Control

Bit	Name	Reset	R/W	Description
7	BUSY	0	R	Indicates that write or erase is in operation. This flag is set when the WRITE or ERASE bit is set. 0: No write or erase operation active 1: Write or erase operation activated
6	FULL		R/H0	Write buffer-full status. This flag is set when 4 bytes have been written to FWDATA during flash write. The write buffer is then full and does not accept more data; i.e., writes to FWDATA are ignored when the FULL flag is set. The FULL flag is cleared when the write buffer again is ready to receive 4 more bytes. This flag is only needed when the CPU is used to write to the flash. 0: Write buffer can accept more data. 1: Write buffer full
5	ABORT	0	R/H0	Abort status. This bit is set when a write operation or page erase is aborted. An operation is aborted when the page accessed is locked. The abort bit is cleared when a write or page erase is started.
4	–	0	R	Reserved
3:2	CM[1:0]	01	R/W	Cache mode 00: Cache disabled 01: Cache enabled 10: Cache enabled, prefetch mode 11: Cache enabled, real-time mode Cache mode. Disabling the cache increases the power consumption and reduces performance. Prefetching, for most applications, improves performance by up to 33% at the expense of potentially increased power consumption. Real-time mode provides predictable flash-read access time; the execution time is equal to that in cache-disabled mode, but the power consumption is lower. <i>Note: The value read always represents the current cache mode. Writing a new cache mode starts a cache mode-change request that may take several clock cycles to complete. Writing to this register is ignored if there is a current cache-change request in progress.</i>
1	WRITE	0	R/W1/H0	Write. Start writing word at location given by FADDRH:FADDRL. The WRITE bit stays at 1 until the write completes. The clearing of this bit indicates that the erase has completed, i.e., it has timed out or aborted. If ERASE is also set to 1, a page erase of the whole page addressed by FADDRH[7:1] is performed before the write. Setting WRITE to 1 when ERASE is 1 has no effect.
0	ERASE	0	R/W1/H0	Page erase. Erase the page that is given by FADDRH[7:1] (CC2530/CC2531/CC2540) or FADDRH[6:0] (CC2533). The ERASE bit stays at 1 until the erase completes. The clearing of this bit indicates that the erase has completed successfully or aborted. Setting ERASE to 1 when WRITE is 1 has no effect.

FWDATA (0x6273) – Flash Write Data

Bit	Name	Reset	R/W	Description
7:0	FWDATA[7:0]	0x00	R0/W	Flash write data. This register can only be written to when FCTL.WRITE is 1.

FADDRH (0x6272) – Flash-Address High Byte

Bit	Name	Reset	R/W	Description
7:0	FADDRH[7:0]	0x00	R/W	Page address/high byte of flash word address Bits [7:1] (CC2530/CC2531/CC2540) or bits [6:0] (CC2533) select which page to access.

FADDRL (0x6271) – Flash-Address Low Byte

Bit	Name	Reset	R/W	Description
7:0	FADDRL[7:0]	0x00	R/W	Low byte of flash word address

I/O Ports

There are 21 digital input/output pins that can be configured as general-purpose digital I/O or as peripheral I/O signals connected to the ADC, timers, or USART peripherals. The use of the I/O ports is fully configurable from user software through a set of configuration registers.

The I/O ports have the following key features:

- 21 digital input/output pins
- General-purpose I/O or peripheral I/O
- Pullup or pulldown capability on inputs
- External interrupt capability

The external interrupt capability is available on all 21 I/O pins. Thus, external devices may generate interrupts if required. The external interrupt feature can also be used to wake the device up from sleep mode (power modes PM1/PM2/PM3).

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7.1 Unused I/O Pins

Unused I/O pins should have a defined level and not be left floating. One way to do this is to leave the pin unconnected and configure the pin as a general-purpose I/O input with pullup resistor. This is also the state of all pins during and after reset (except P1.0 and P1.1, which do not have pullup/pulldown capability). Alternatively, the pin can be configured as a general-purpose I/O output. In either case, the pin should not be connected directly to VDD or GND, in order to avoid excessive power consumption.

7.2 Low I/O Supply Voltage

In applications where the digital I/O power supply voltage pins, DVDD1 and DVDD2, are below 2.6 V, the register bit `PICCTL.PADSC` should be set to 1 in order to obtain the output dc characteristics specified in the *DC Characteristics* table in the device data sheet ([Appendix C](#)).

7.3 General-Purpose I/O

When used as general-purpose I/O, the pins are organized as three 8-bit ports, Port 0, Port 1, and Port 2; denoted P0, P1, and P2. P0 and P1 are complete 8-bit-wide ports, whereas P2 has only five usable bits. All ports are both bit- and byte-addressable through the SFR registers `P0`, `P1`, and `P2`. Each port pin can individually be set to operate as a general-purpose I/O or as a peripheral I/O.

The output drive strength is 4 mA on all outputs, except for the two high-drive outputs, P1.0 and P1.1, which each have 20-mA output drive strength.

The registers `PxSEL`, where x is the port number 0–2, are used to configure each pin in a port as either a general-purpose I/O pin or as a peripheral I/O signal. By default, after a reset, all digital input/output pins are configured as general-purpose input pins.

To change the direction of a port pin, the registers `PxDIR` are used to set each port pin to be either an input or an output. Thus, by setting the appropriate bit within `PxDIR` to 1, the corresponding pin becomes an output.

When reading the port registers `P0`, `P1`, and `P2`, the logic values on the input pins are returned regardless of the pin configuration. This does not apply during the execution of read-modify-write instructions. The read-modify-write instructions are: `ANL`, `ORL`, `XRL`, `JBC`, `CPL`, `INC`, `DEC`, `DJNZ`, `MOV`, `CLR`, and `SETB`. Operating on a port register, the following is true: When the destination is an individual bit in port register `P0`, `P1`, or `P2`, the value of the register, not the value on the pin, is read, modified, and written back to the port register.

When used as an input, the general-purpose I/O port pins can be configured to have a pullup, pulldown or three-state mode of operation. By default, after a reset, inputs are configured as inputs with pullup. To deselect the pullup or pulldown function on an input, the appropriate bit within the `PxINP` must be set to 1. The I/O port pins P1.0 and P1.1 do not have pullup/pulldown capability. Note that pins configured as peripheral I/O signals do not have pullup/pulldown capability, even if the peripheral function is an input.

In power modes PM1, PM2, and PM3, the I/O pins retain the I/O mode and output value (if applicable) that was set when PM1/PM2/PM3 was entered.

7.4 General-Purpose I/O Interrupts

General-purpose I/O pins configured as inputs can be used to generate interrupts. The interrupts can be configured to trigger on either a rising or falling edge of the external signal. Each of the `P0`, `P1`, and `P2` ports has port interrupt-enable bits common for all bits within the port located in the `IEN1–IEN2` registers as follows:

- `IEN1.P0IE`: P0 interrupt enable
- `IEN2.P1IE`: P1 interrupt enable
- `IEN2.P2IE`: P2 interrupt enable

In addition to these common interrupt enables, the bits within each port have individual interrupt enables located in SFR registers `P0IEN`, `P1IEN`, and `P2IEN`. Even I/O pins configured as peripheral I/O or general-purpose outputs have interrupts generated when enabled.

When an interrupt condition occurs on one of the I/O pins, the interrupt status flag in the corresponding P0–P2 interrupt flag register, P0IFG, P1IFG, or P2IFG, is set to 1. The interrupt status flag is set regardless of whether the pin has its interrupt enable set. When an interrupt is serviced, the interrupt status flag is cleared by writing a 0 to that flag. This flag must be cleared prior to clearing the CPU port interrupt flag (PxIF).

The SFR registers used for interrupts are described later in this section. The registers are summarized as follows:

- P0IEN: P0 interrupt enables
- P1IEN: P1 interrupt enables
- P2IEN: P2 interrupt enables
- PICTL: P0, P1, and P2 edge configuration
- P0IFG: P0 interrupt flags
- P1IFG: P1 interrupt flags
- P2IFG: P2 interrupt flags

7.5 General-Purpose I/O DMA

When used as general-purpose I/O pins, the P0 and P1 ports are each associated with one DMA trigger. These DMA triggers are IOC_0 for P0 and IOC_1 for P1, as shown in [Table 8-1](#).

The IOC_0 trigger is activated when an interrupt occurs on the P0 pins. The IOC_1 trigger is activated when an interrupt occurs on the P1 pins.

7.6 Peripheral I/O

This section describes how the digital I/O pins are configured as peripheral I/Os. For each peripheral unit that can interface with an external system through the digital input/output pins, a description of how peripheral I/Os are configured is given in the following subsections.

For USART and timer I/O, setting the appropriate PxSEL bits to 1 is required for the output signals on a digital I/O pin to be controlled by the peripheral. For peripheral inputs from digital I/O pins, this is optional. PxSEL = 1 overrides the pullup/pulldown settings of a pin, so to be able to control pullup/pulldown with the PxINP bits, the PxSEL bit should be set to 0 for that pin.

Note that peripheral units have two alternative locations for their I/O pins; see [Table 7-1](#). Priority can be set between peripherals if conflicting settings regarding I/O mapping are present (using the P2SEL.PRIxP1 and P2DIR.PRIxP0 bits). All combinations not causing conflicts can be used.

Note that a peripheral normally is present at the selected location even if it is not used, and another peripheral that is to use the pins must be given higher priority. The exception is the RTS and CTS pins of a USART in UART mode with flow control disabled and the SSN pin of a USART configured in SPI master mode.

Note also that peripheral units that have input pins receive an input from the pin regardless of the PxINP setting, and this may influence on the state of the peripheral unit. For instance, a UART should be flushed before use if there may have been activity on the RX pin prior to taking it in use as a UART pin.

Table 7-1. Peripheral I/O Pin Mapping

Periphery/ Function	P0								P1								P2				
	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0	4	3	2	1	0
ADC	A7	A6	A5	A4	A3	A2	A1	A0													T
Operational Amplifier						O	–	+													
Analog Comparator			+	–																	
USART 0 SPI			C	SS	MO	MI															
Alt. 2											M0	MI	C	SS							
USART 0 UART			RT	CT	TX	RX															

Table 7-1. Peripheral I/O Pin Mapping (continued)

Periphery/ Function	P0								P1								P2				
	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0	4	3	2	1	0
Alt. 2											TX	RX	RT	CT							
USART 1 SPI			MI	M0	C	SS															
Alt. 2									MI	M0	C	SS									
USART 1 UART			RX	TX	RT	CT															
Alt. 2									RX	TX	RT	CT									
TIMER 1		4	3	2	1	0															
Alt. 2	3	4												0	1	2					
TIMER 3												1	0								
Alt. 2									1	0											
TIMER 4															1	0					
Alt. 2																		1			0
32-kHz XOSC																	Q1	Q2			
DEBUG																			DC	DD	
OBSSEL										5	4	3	2	1	0						

7.6.1 Timer 1

PERCFG.T1CFG selects whether to use alternative 1 or alternative 2 locations.

In [Table 7-1](#), the Timer 1 signals are shown as the following:

- 0: Channel 0 capture/compare pin
- 1: Channel 1 capture/compare pin
- 2: Channel 2 capture/compare pin
- 3: Channel 3 capture/compare pin
- 4: Channel 4 capture/compare pin

P2DIR.PRI0 selects the order of precedence when assigning several peripherals to Port 0. When set to 10, Timer 1 channels 0–1 have precedence, and when set to 11, Timer 1 channels 2–3 have precedence. To have all Timer 1 channels visible in the alternative 1 location, move both USART 0 and USART 1 to the alternative 2 location.

P2SEL.PRI1P1 and P2SEL.PRI0P1 select the order of precedence when assigning several peripherals to Port 1. The Timer 1 channels have precedence when the former is set low and the latter is set high.

7.6.2 Timer 3

PERCFG.T3CFG selects whether to use alternative 1 or alternative 2 locations.

In [Table 7-1](#), the Timer 3 signals are shown as the following:

- 0: Channel 0 capture/compare pin
- 1: Channel 1 capture/compare pin

P2SEL.PRI2P1 and P2SEL.PRI3P1 select the order of precedence when assigning several peripherals to Port 1. The Timer 3 channels have precedence when both bits are set high. If P2SEL.PRI2P1 is set high and P2SEL.PRI3P1 is set low, the Timer 3 channels have precedence over USART 1, but USART 0 has precedence over the Timer 3 channels as well as over USART 1.

7.6.3 Timer 4

PERCFG.T4CFG selects whether to use alternative 1 or alternative 2 locations.

In [Table 7-1](#), the Timer 4 signals are shown as the following:

- 0: Channel 0 capture/compare pin
- 1: Channel 1 capture/compare pin

`P2SEL.PRI1P1` selects the order of precedence when assigning several peripherals to Port 1. The Timer 4 channels have precedence when the bit is set.

7.6.4 USART 0

The SFR register bit `PERCFG.U0CFG` selects whether to use alternative 1 or alternative 2 locations.

In [Table 7-1](#), the USART 0 signals are shown as follows:

UART:

- RX: RXDATA
- TX: TXDATA
- RT: RTS
- CT: CTS

SPI:

- MI: MISO
- MO: MOSI
- C: SCK
- SS: SSN

`P2DIR.PRI0` selects the order of precedence when assigning several peripherals to Port 0. When set to 00, USART 0 has precedence. Note that if UART mode is selected and hardware flow control is disabled, USART 1 or Timer 1 has precedence to use ports P0.4 and P0.5.

`P2SEL.PRI3P1` and `P2SEL.PRI0P1` select the order of precedence when assigning several peripherals to Port 1. USART 0 has precedence when both are set to 0. Note that if UART mode is selected and hardware flow control is disabled, Timer 1 or Timer 3 has precedence to use ports P1.2 and P1.3.

7.6.5 USART 1

The SFR register bit `PERCFG.U1CFG` selects whether to use alternative 1 or alternative 2 locations.

In [Table 7-1](#), the USART 1 signals are shown as follows:

UART:

- RX: RXDATA
- TX: TXDATA
- RT: RTS
- CT: CTS

SPI:

- MI: MISO
- MO: MOSI
- C: SCK
- SS: SSN

`P2DIR.PRI0` selects the order of precedence when assigning several peripherals to Port 0. When set to 01, USART 1 has precedence. Note that if UART mode is selected and hardware flow control is disabled, USART 0 or Timer 1 has precedence to use ports P0.2 and P0.3.

`P2SEL.PRI3P1` and `P2SEL.PRI2P1` select the order of precedence when assigning several peripherals to Port 1. USART 1 has precedence when the former is set to 1 and the latter is set to 0. Note that if UART mode is selected and hardware flow control is disabled, USART 0 or Timer 3 has precedence to use ports P1.4 and P1.5.

7.6.6 ADC

When using the ADC, Port 0 pins must be configured as ADC inputs. Up to eight ADC inputs can be used. To configure a Port 0 pin to be used as an ADC input, the corresponding bit in the `APCFG` register must be set to 1. The default values in this register select the Port 0 pins as non-ADC input, i.e., digital input/outputs.

The settings in the `APCFG` register override the settings in `P0SEL`.

The ADC can be configured to use the general-purpose I/O pin P2.0 as an external trigger to start conversions. P2.0 must be configured as a general-purpose I/O in input mode when being used for ADC external trigger.

7.6.7 Operational Amplifier and Analog Comparator

When using the operational amplifier and analog comparator, the corresponding Port 0 pins must be configured as ADC inputs. To configure a Port 0 pin to be used as an ADC input, the corresponding bit in the `APCFG` register must be set to 1. The default values in this register select the Port 0 pins as non-ADC input, i.e., digital input/outputs.

The settings in the `APCFG` register override the settings in `P0SEL`.

7.7 Debug Interface

Ports P2.1 and P2.2 are used for debug data and clock signals, respectively. These are shown as DD (debug data) and DC (debug clock) in [Table 7-1](#). When in debug mode, the debug interface controls the direction of these pins. Pullup/pulldown is disabled on these pins while in debug mode.

7.8 32-kHz XOSC Input

Ports P2.3 and P2.4 can be used to connect an external 32-kHz crystal. These port pins are used by the 32-kHz XOSC when `CLKCONCMD.OSC32K` is low, regardless of register settings. The port pins are set in analog mode when `CLKCONCMD.OSC32K` is low.

7.9 Radio Test Output Signals

By using the `OBSSELx` registers (`OBSSEL0`–`OBSSEL5`) the user can output different signals from the RF Core to GPIO pins. These signals can be useful for debugging of low-level protocols or control of external PA, LNA, or switches. The control registers `OBSSEL0`–`OBSSEL5` can be used to override the standard GPIO behavior and output RF Core signals (`rfc_obs_sig0`, `rfc_obs_sig1`, and `rfc_obs_sig2`) on the pins P1[0:5]. For a list of available signals, see the respective `RFC_OBS_CTRLx` registers in [Section 23.15.3](#) for CC253x or [Section 24.1](#) for CC2540.

7.10 Power-Down Signal MUX (PMUX)

The `PMUX` register can be used to output the 32-kHz clock and/or the digital regulator status.

The selected 32-kHz clock source can be output on one of the P0 pins. The enable bit `CKOEN` enables the output on P0, and the pin of P0 is selected using the `CKOPIN` (see the `PMUX` register description for details). When `CKOEN` is set, all other configurations for the selected pin are overridden. The clock is output in all power modes; however, in PM3 the clock stops (see PM3 in [Chapter 4](#)).

Furthermore, the digital regulator status can be output on one of the P1 pins. When the `DREGSTA` bit is set, the status of the digital regulator is output. `DREGSTAPIN` selects the P1 pin (see the `PMUX` register description for details). When `DREGSTA` is set, all other configurations for the selected pin are overridden. The selected pin outputs 1 when the 1.8-V on-chip digital regulator is powered up (chip has regulated power). The selected pin outputs 0 when the 1.8-V on-chip digital regulator is powered down, i.e., in PM2 and PM3.

7.11 I/O Registers

The registers for the I/O ports are described in this section. The registers are:

- P0: Port 0

- P1: Port 1
- P2: Port 2
- PERCFG: Peripheral-control register
- APCFG: Analog peripheral I/O configuration
- P0SEL: Port 0 function-select register
- P1SEL: Port 1 function-select register
- P2SEL: Port 2 function-select register
- P0DIR: Port 0 direction register
- P1DIR: Port 1 direction register
- P2DIR: Port 2 direction register
- P0INP: Port 0 input-mode register
- P1INP: Port 1 input-mode register
- P2INP: Port 2 input-mode register
- P0IFG: Port 0 interrupt-status flag register
- P1IFG: Port 1 interrupt-status flag register
- P2IFG: Port 2 interrupt-status flag register
- PICTL: Interrupt edge register
- P0IEN: Port 0 interrupt-mask register
- P1IEN: Port 1 interrupt-mask register
- P2IEN: Port 2 interrupt-mask register
- PMUX: Power-down signal-mux register
- OBSSEL0: Observation output control register 0
- OBSSEL1: Observation output control register 1
- OBSSEL2: Observation output control register 2
- OBSSEL3: Observation output control register 3
- OBSSEL4: Observation output control register 4
- OBSSEL5: Observation output control register 5

P0 (0x80) – Port 0

Bit	Name	Reset	R/W	Description
7:0	P0[7:0]	0xFF	R/W	Port 0. General-purpose I/O port. Bit-addressable from SFR. This CPU-internal register is readable, but not writable, from XDATA (0x7080).

P1 (0x90) – Port 1

Bit	Name	Reset	R/W	Description
7:0	P1[7:0]	0xFF	R/W	Port 1. General-purpose I/O port. Bit-addressable from SFR. This CPU-internal register is readable, but not writable, from XDATA (0x7090).

P2 (0xA0) – Port 2

Bit	Name	Reset	R/W	Description
7:5	–	000	R0	Reserved
4:0	P2[4:0]	1 1111	R/W	Port 2. General-purpose I/O port. Bit-addressable from SFR. This CPU-internal register is readable, but not writable, from XDATA (0x70A0).

PERCFG (0xF1) – Peripheral Control

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved
6	T1CFG	0	R/W	Timer 1 I/O location 0: Alternative 1 location 1: Alternative 2 location
5	T3CFG	0	R/W	Timer 3 I/O location 0: Alternative 1 location 1: Alternative 2 location
4	T4CFG	0	R/W	Timer 4 I/O location 0: Alternative 1 location 1: Alternative 2 location
3:2	–	00	R/W	Reserved
1	U1CFG	0	R/W	USART 1 I/O location 0: Alternative 1 location 1: Alternative 2 location
0	U0CFG	0	R/W	USART 0 I/O location 0: Alternative 1 location 1: Alternative 2 location

APCFG (0xF2) – Analog Peripheral I/O Configuration

Bit	Name	Reset	R/W	Description
7:0	APCFG[7:0]	0x00	R/W	Analog Peripheral I/O configuration . APCFG[7:0] select P0.7–P0.0 as analog I/O. 0: Analog I/O disabled 1: Analog I/O enabled

P0SEL (0xF3) – Port 0 Function Select

Bit	Name	Reset	R/W	Description
7:0	SELP0_[7:0]	0x00	R/W	P0.7 to P0.0 function select 0: General-purpose I/O 1: Peripheral function

P1SEL (0xF4) – Port 1-Function Select

Bit	Name	Reset	R/W	Description
7:0	SELP1_[7:0]	0x00	R/W	P1.7 to P1.0 function select 0: General-purpose I/O 1: Peripheral function

P2SEL (0xF5) – Port 2 Function Select and Port 1 Peripheral Priority Control

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved
6	PRI3P1	0	R/W	Port 1 peripheral priority control. This bit determines which module has priority in the case when modules are assigned to the same pins. 0: USART 0 has priority. 1: USART 1 has priority.
5	PRI2P1	0	R/W	Port 1 peripheral priority control. This bit determines the order of priority in the case when PERCFG assigns USART 1 and Timer 3 to the same pins. 0: USART 1 has priority. 1: Timer 3 has priority.
4	PRI1P1	0	R/W	Port 1 peripheral priority control. This bit determines the order of priority in the case when PERCFG assigns Timer 1 and Timer 4 to the same pins. 0: Timer 1 has priority. 1: Timer 4 has priority.
3	PRI0P1	0	R/W	Port 1 peripheral priority control. This bit determines the order of priority in the case when PERCFG assigns USART 0 and Timer 1 to the same pins. 0: USART 0 has priority. 1: Timer 1 has priority.
2	SELP2_4	0	R/W	P2.4 function select 0: General-purpose I/O 1: Peripheral function
1	SELP2_3	0	R/W	P2.3 function select 0: General-purpose I/O 1: Peripheral function
0	SELP2_0	0	R/W	P2.0 function select 0: General-purpose I/O 1: Peripheral function

P0DIR (0xFD) – Port 0 Direction

Bit	Name	Reset	R/W	Description
7:0	DIRP0_[7:0]	0x00	R/W	P0.7 to P0.0 I/O direction 0: Input 1: Output

P1DIR (0xFE) – Port 1 Direction

Bit	Name	Reset	R/W	Description
7:0	DIRP1_[7:0]	0x00	R/W	P1.7 to P1.0 I/O direction 0: Input 1: Output

P2DIR (0xFF) – Port 2 Direction and Port 0 Peripheral Priority Control

Bit	Name	Reset	R/W	Description
7:6	PRIP0[1:0]	00	R/W	Port 0 peripheral priority control. These bits determine the order of priority in the case when PERCFG assigns several peripherals to the same pins. Detailed priority list: 00: 1st priority: USART 0 2nd priority: USART 1 3rd priority: Timer 1 01: 1st priority: USART 1 2nd priority: USART 0 3rd priority: Timer 1 10: 1st priority: Timer 1 channels 0-1 2nd priority: USART 1 3rd priority: USART 0 4th priority: Timer 1 channels 2-3 11: 1st priority: Timer 1 channels 2-3 2nd priority: USART 0 3rd priority: USART 1 4th priority: Timer 1 channels 0-1
5	–	0	R0	Reserved
4:0	DIRP2_[4:0]	0 0000	R/W	P2.4 to P2.0 I/O direction 0: Input 1: Output

P0INP (0x8F) – Port 0 Input Mode

Bit	Name	Reset	R/W	Description
7:0	MDP0_[7:0]	0x00	R/W	P0.7 to P0.0 I/O input mode 0: Pullup/pulldown [see P2INP (0xF7) – Port 2 input mode] 1: 3-state

P1INP (0xF6) – Port 1 Input Mode

Bit	Name	Reset	R/W	Description
7:2	MDP1_[7:2]	0000 00	R/W	P1.7 to P1.2 I/O input mode 0: Pullup/pulldown [see P2INP (0xF7) – Port 2 input mode] 1: 3-state
1:0	–	00	R0	Reserved

P2INP (0xF7) – Port 2 Input Mode

Bit	Name	Reset	R/W	Description
7	PDUP2	0	R/W	Port 2 pullup/pulldown select. Selects function for all Port 2 pins configured as pullup/pulldown inputs. 0: Pullup 1: Pulldown
6	PDUP1	0	R/W	Port 1 pullup/down select. Selects function for all Port 1 pins configured as pullup/pulldown inputs. 0: Pullup 1: Pulldown
5	PDUP0	0	R/W	Port 0 pullup/pulldown select. Selects function for all Port 0 pins configured as pullup/pulldown inputs. 0: Pullup 1: Pulldown
4:0	MDP2_[4:0]	0 0000	R/W	P2.4 to P2.0 I/O input mode 0: Pullup/pulldown 1: 3-state

P0IFG (0x89) – Port 0 Interrupt Status Flag

Bit	Name	Reset	R/W	Description
7:0	P0IF[7:0]	0x00	R/W0	Port 0, inputs 7 to 0 interrupt status flags. When an input port pin has an interrupt request pending, the corresponding flag bit is set.

P1IFG (0x8A) – Port 1 Interrupt Status Flag

Bit	Name	Reset	R/W	Description
7:0	P1IF[7:0]	0x00	R/W0	Port 1, inputs 7 to 0 interrupt status flags. When an input port pin has an interrupt request pending, the corresponding flag bit is set.

P2IFG (0x8B) – Port 2 Interrupt Status Flag

Bit	Name	Reset	R/W	Description
7:6	–	00	R0	Reserved
5	DPIF	0	R/W0	USB D+ interrupt-status flag. This flag is set when the D+ line has an interrupt request pending and is used to detect USB resume events in USB suspend state. This flag is not set when the USB controller is not suspended.
4:0	P2IF[4:0]	0 0000	R/W0	Port 2, inputs 4 to 0 interrupt status flags. When an input port pin has an interrupt request pending, the corresponding flag bit is set.

PICTL (0x8C) – Port Interrupt Control

Bit	Name	Reset	R/W	Description
7	PADSC	0	R/W	Drive strength control for I/O pins in output mode. Selects output drive strength enhancement to account for low I/O supply voltage on pin DVDD (this to ensure the same drive strength at lower voltages as at higher). 0: Minimum drive strength enhancement. DVDD1/2 equal to or greater than 2.6 V 1: Maximum drive strength enhancement. DVDD1/2 less than 2.6 V
6:4	–	000	R0	Reserved
3	P2ICON	0	R/W	Port 2, inputs 4 to 0 interrupt configuration. This bit selects the interrupt request condition for Port 2 inputs 4 to 0. 0: Rising edge on input gives interrupt. 1: Falling edge on input gives interrupt.
2	P1ICONH	0	R/W	Port 1, inputs 7 to 4 interrupt configuration. This bit selects the interrupt request condition for the high nibble of Port 1 inputs. 0: Rising edge on input gives interrupt. 1: Falling edge on input gives interrupt
1	P1ICONL	0	R/W	Port 1, inputs 3 to 0 interrupt configuration. This bit selects the interrupt request condition for the low nibble of Port 1 inputs. 0: Rising edge on input gives interrupt. 1: Falling edge on input gives interrupt.
0	P0ICON	0	R/W	Port 0, inputs 7 to 0 interrupt configuration. This bit selects the interrupt request condition for all Port 0 inputs. 0: Rising edge on input gives interrupt. 1: Falling edge on input gives interrupt.

P0IEN (0xAB) – Port 0 Interrupt Mask

Bit	Name	Reset	R/W	Description
7:0	P0_[7:0]IEN	0x00	R/W	Port P0.7 to P0.0 interrupt enable 0: Interrupts are disabled. 1: Interrupts are enabled.

P1IEN (0x8D) – Port 1 Interrupt Mask

Bit	Name	Reset	R/W	Description
7:0	P1_[7:0]IEN	0x00	R/W	Port P1.7 to P1.0 interrupt enable 0: Interrupts are disabled. 1: Interrupts are enabled.

P2IEN (0xAC) – Port 2 Interrupt Mask

Bit	Name	Reset	R/W	Description
7:6	–	00	R0	Reserved
5	DPIEN	0	R/W	USB D+ interrupt enable 0: USB D+ interrupt disabled. 1: USB D+ interrupt enabled.
4:0	P2_[4:0]IEN	0 0000	R/W	Port P2.4 to P2.0 interrupt enable 0: Interrupts are disabled. 1: Interrupts are enabled.

PMUX (0xAE) – Power-Down Signal Mux

Bit	Name	Reset	R/W	Description
7	CKOEN	0	R/W	Clock Out Enable. When this bit is set, the selected 32-kHz clock is output on one of the P0 pins. CKOPIN selects the pin to use. This overrides all other configuration for the selected pin. The clock is output in all power modes; however, in PM3 the clock stops (see PM3 in Chapter 4).
6:4	CKOPIN[2:0]	000	R/W	Clock Out Pin. Selects which P0 pin is to be used to output the selected 32-kHz clock.
3	DREGSTA	0	R/W	Digital Regulator Status. When this bit is set, the status of the digital regulator is output on one of the P1 pins. DREGSTAPIN selects the pin. When DREGSTA is set, all other configurations for the selected pin are overridden. The selected pin outputs 1 when the 1.8-V on-chip digital regulator is powered up (chip has regulated power). The selected pin outputs 0 when the 1.8-V on-chip digital regulator is powered down.
2:0	DREGSTAPIN[2:0]	000	R/W	Digital Regulator Status Pin. Selects which P1 pin is to be used to output DREGSTA signal.

Note that registers OBSSEL0 through OBSSEL5 do not retain data in states PM2 and PM3.

OBSSEL0 (0x6243) – Observation Output Control Register 0

Bit	Name	Reset	R/W	Description
7	EN	0	R/W	Bit controlling the observation output 0 on P1[0]. 0 – Observation output disabled 1 – Observation output enabled Note: If enabled, this overwrites the standard GPIO behavior of P1.0.
6:0	SEL[6:0]	000 0000	R/W	Select output signal on observation output 0 111 1011 (123): rfc_obs_sig0 111 1100 (124): rfc_obs_sig1 111 1101 (125): rfc_obs_sig2 Others: Reserved

OBSSEL1 (0x6244) – Observation Output Control Register 1

Bit	Name	Reset	R/W	Description
7	EN	0	R/W	Bit controlling observation output 1 on P1[1]. 0 – Observation output disabled 1 – Observation output enabled Note: If enabled, this overwrites the standard GPIO behavior of P1.1.
6:0	SEL[6:0]	000 0000	R/W	Select output signal on observation output 1 111 1011 (123): rfc_obs_sig0 111 1100 (124): rfc_obs_sig1 111 1101 (125): rfc_obs_sig2 Others: Reserved

OBSSEL2 (0x6245) – Observation Output Control Register 2

Bit	Name	Reset	R/W	Description
7	EN	0	R/W	Bit controlling observation output 2 on P1[2]. 0 – Observation output disabled 1 – Observation output enabled Note: If enabled, this overwrites the standard GPIO behavior of P1.2.
6:0	SEL[6:0]	000 0000	R/W	Select output signal on observation output 2 111 1011 (123): rfc_obs_sig0 111 1100 (124): rfc_obs_sig1 111 1101 (125): rfc_obs_sig2 Others: Reserved

OBSSEL3 (0x6246) – Observation Output Control Register 3

Bit	Name	Reset	R/W	Description
7	EN	0	R/W	Bit controlling observation output 3 on P1[3]. 0 – Observation output disabled 1 – Observation output enabled Note: If enabled, this overwrites the standard GPIO behavior of P1.3.
6:0	SEL[6:0]	000 0000	R/W	Select output signal on observation output 3 111 1011 (123): rfc_obs_sig0 111 1100 (124): rfc_obs_sig1 111 1101 (125): rfc_obs_sig2 Others: Reserved

OBSSEL4 (0x6247) – Observation Output Control Register 4

Bit	Name	Reset	R/W	Description
7	EN	0	R/W	Bit controlling observation output 4 on P1[4]. 0 – Observation output disabled 1 – Observation output enabled Note: If enabled, this overwrites the standard GPIO behavior of P1.4.
6:0	SEL[6:0]	000 0000	R/W	Select output signal on observation output 4 111 1011 (123): rfc_obs_sig0 111 1100 (124): rfc_obs_sig1 11 11101 (125): rfc_obs_sig2 Others: Reserved

OBSSEL5 (0x6248) – Observation Output Control Register 5

Bit	Name	Reset	R/W	Description
7	EN	0	R/W	Bit controlling the observation output 5 on P1[5]. 0 – Observation output disabled 1 – Observation output enabled Note: If enabled, this overwrites the standard GPIO behavior of P1.5.
6:0	SEL[6:0]	000 0000	R/W	Select output signal on observation output 5 111 1011 (123): rfc_obs_sig0 111 1100 (124): rfc_obs_sig1 111 1101 (125): rfc_obs_sig2 Others: Reserved

DMA Controller

The Direct Memory Access (DMA) Controller can be used to relieve the 8051 CPU core of handling data movement operations, thus achieving high overall performance with good power efficiency. The DMA controller can move data from a peripheral unit such as ADC or RF transceiver to memory with minimum CPU intervention.

The DMA controller coordinates all DMA transfers, ensuring that DMA requests are prioritized appropriately relative to each other and to CPU memory access. The DMA controller contains a number of programmable DMA channels for memory-memory data movement.

The DMA controller controls data transfers over the entire address range in XDATA memory space. Because most of the SFR registers are mapped into the DMA memory space, these flexible DMA channels can be used to unburden the CPU in innovative ways, e.g., to feed a USART with data from memory or periodically to transfer samples between ADC and memory, etc. Use of the DMA can also reduce system power consumption by keeping the CPU in a low-power mode without having to wake up to move data to or from a peripheral unit (see [Section 4.1.1](#) for CPU low-power mode). Note that [Section 2.2.3](#) describes the SFR registers that are not mapped into XDATA memory space.

The main features of the DMA controller are as follows:

- Five independent DMA channels
- Three configurable levels of DMA channel priority
- 32 configurable transfer trigger events
- Independent control of source and destination address
- Single, block and repeated transfer modes
- Supports length field in transfer data, setting variable transfer length
- Can operate in either word-size or byte-size mode

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8.1 DMA Operation

There are five DMA channels available in the DMA controller, numbered channel 0 through channel 4. Each DMA channel can move data from one place within the DMA memory space to another, i.e., between XDATA locations.

In order to use a DMA channel, it must first be configured as described in [Section 8.2](#) and [Section 8.3](#). [Figure 8-1](#) shows the DMA state diagram.

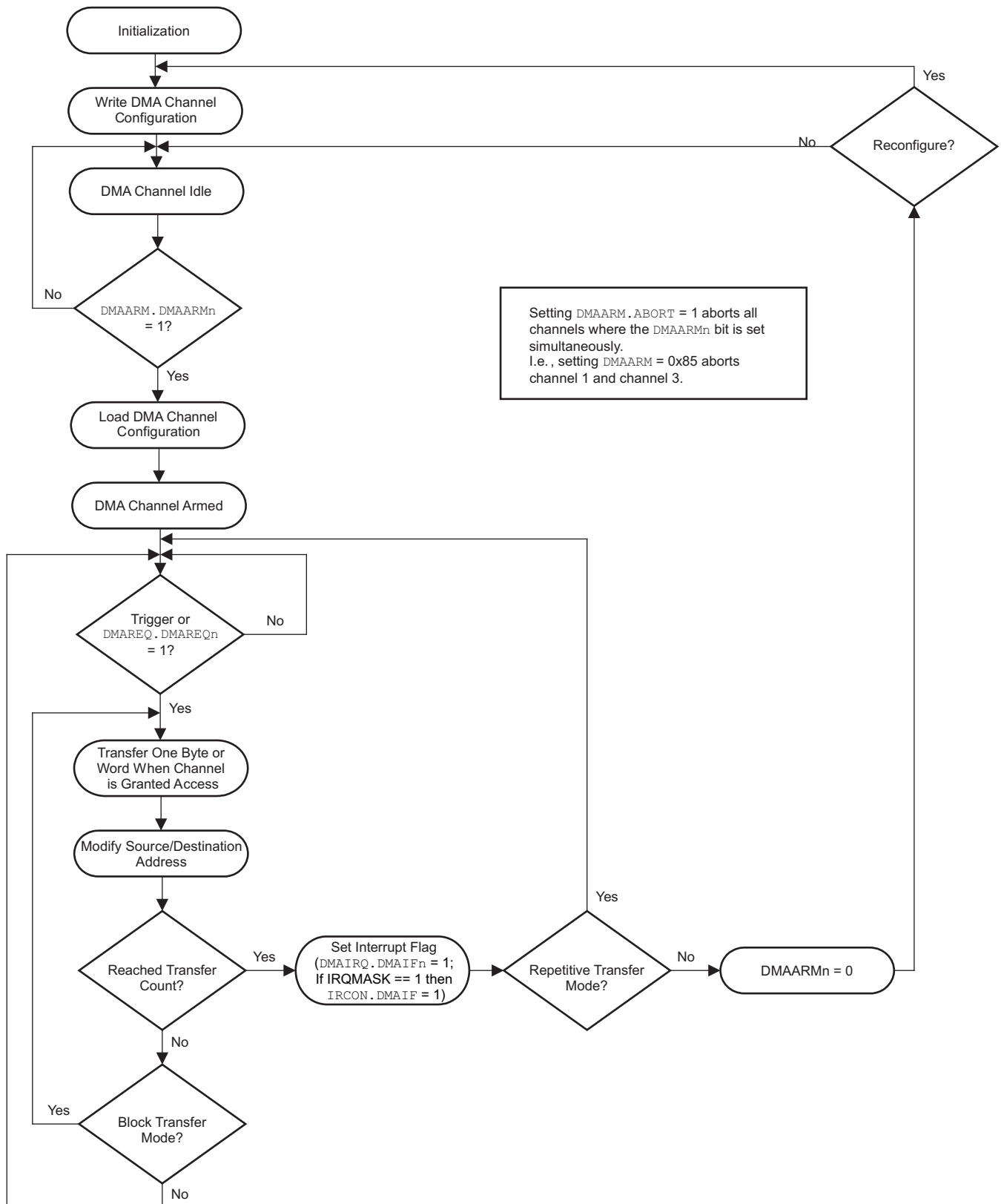
Once a DMA channel has been configured, it must be armed before any transfers are allowed to be initiated. A DMA channel is armed by setting the appropriate bit in the DMA channel-arm register `DMAARM`.

When a DMA channel is armed, a transfer begins when the configured DMA trigger event occurs. Note that the time to arm one channel (i.e., get configuration data) takes nine system clocks; thus, if the corresponding `DMAARM` bit is set and a trigger appears within the time it takes to configure the channel, the wanted trigger is lost. If two or more DMA channels are armed simultaneously, the time for all channels to be configured is longer (sequential read from memory). If all five are armed, it takes 45 system clocks, and channel 1 is ready first, then channel 2, and lastly channel 0 (all within the last eight system clocks). There are 32 possible DMA trigger events (see [Table 8-1](#)), e.g., UART transfer, timer overflow. The trigger event to be used by a DMA channel is set by the DMA channel configuration; thus, no knowledge of this is available until after the configuration has been read. The DMA trigger events are listed in [Table 8-1](#).

In addition to starting a DMA transfer through the DMA trigger events, the user software may force a DMA transfer to begin by setting the corresponding `DMAREQ` bit.

It should be noted that if the previously configured trigger source generates trigger events while DMA is being configured, these are counted as missed events, and as soon as the DMA channel is ready, the transfer is started. This occurs even though the new trigger source is not the same as the previous one. In some situations, this leads to errors in the transfer. In order to account for this, trigger source 0 should be the source between reconfigurations. This is achieved by setting up dummy source and destination addresses, using fixed length of one byte, block transfer, and trigger source 0. Enabling a software trigger (`DMAREQ`) clears missed-trigger counting, and no new triggers are generated while a new configuration is fetched from memory (unless software writes to `DMAREQ` for this channel).

A `DMAREQ` bit is cleared only when the corresponding DMA transfer occurs. The `DMAREQ` bit is not cleared when the channel is disarmed.



F0033-01

Figure 8-1. DMA Operation

8.2 DMA Configuration Parameters

Setup and control of the DMA operation is performed by the user software. This section describes the parameters which must be configured before a DMA channel can be used. [Section 8.3](#) describes how the parameters are set up in software and passed to the DMA controller.

The behavior of each of the five DMA channels is configured with the following parameters:

Source address: The first address from which the DMA channel should read data.

Destination address: The first address to which the DMA channel should write the data read from the source address. The user must ensure that the destination is writable.

Transfer count: The number of transfers to perform before rearming or disarming the DMA channel and alerting the CPU with an interrupt request. The length can be defined in the configuration or it can be defined as described next for the VLEN setting.

VLEN setting: The DMA channel is capable of variable-length transfers, using the first byte or word to set the transfer length. When doing this, various options are available regarding how to count the number of bytes to transfer.

Priority: The priority of the DMA transfers for the DMA channel with respect to the CPU and other DMA channels and access ports.

Trigger event: All DMA transfers are initiated by so-called DMA trigger events. This trigger either starts a DMA block transfer or a single DMA transfer. In addition to the configured trigger, a DMA channel can always be triggered by setting its designated `DMAREQ.DMAREQx` flag. The DMA trigger sources are described in [Table 8-1](#).

Source and destination increment: The source and destination addresses can be controlled to increment or decrement or not change.

Transfer mode: The transfer mode determines whether the transfer should be a single transfer or a block transfer, or repeated versions of these.

Byte or word transfers: Determines whether each DMA transfer should be 8-bit (byte) or 16-bit (word).

Interrupt mask: An interrupt request is generated on completion of the DMA transfer. The interrupt mask bit controls whether the interrupt generation is enabled or disabled.

M8: Decide whether to use seven or eight bits per byte for transfer length. This is only applicable when doing byte transfers.

A detailed description of all configuration parameters is given in [Section 8.2.1](#) through [Section 8.2.11](#).

8.2.1 Source Address

The address in XDATA memory where the DMA channel starts to read data. This can be any XDATA address – in RAM, in the mapped flash bank (see `MEMCTR.XBANK`), XREG, or XDATA addressed SFR.

8.2.2 Destination Address

The first address to which the DMA channel should write the data read from the source address. The user must ensure that the destination is writable. This can be any XDATA address – in RAM, XREG, or XDATA addressed SFR.

8.2.3 Transfer Count

The number of bytes/words that must be transferred for the DMA transfer to be complete. When the transfer count is reached, the DMA controller rearms or disarms the DMA channel and alerts the CPU with an interrupt request. The transfer count can be defined in the configuration or it can be defined as variable-length, as described in [Section 8.2.4](#).

8.2.4 VLEN Setting

The DMA channel is capable of using the first byte or word (for word, bits 12:0 are used) in source data as

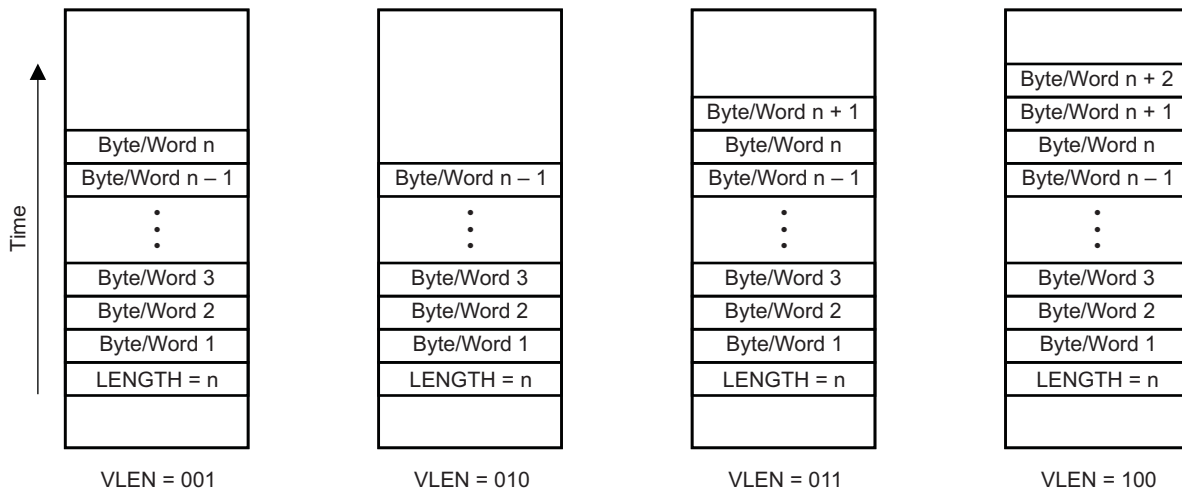
the transfer length. This allows variable-length transfers. When using variable-length transfer, various options regarding how to count number of bytes to transfer is given. In any case, the transfer-count (LEN) setting is used as a maximum transfer count. If the transfer length specified by the first byte or word is greater than LEN, then LEN bytes/words are transferred. When using variable-length transfers, then LEN should be set to the largest allowed transfer length plus one.

Note that the M8 bit (Section 8.2.11) is only used when byte-size transfers are chosen.

Options which can be set with VLEN are the following:

1. Transfer number of bytes/words commanded by first byte/word + 1 (transfers the length byte/word, and then as many bytes/words as dictated by the length byte/word)
2. Transfer number of bytes/words commanded by first byte/word
3. Transfer number of bytes/words commanded by first byte/word + 2 (transfers the length byte/word, and then as many bytes/words as dictated by the length byte/word + 1)
4. Transfer number of bytes/words commanded by first byte/word + 3 (transfers the length byte/word, and then as many bytes/words as dictated by the length byte/word + 2)

Figure 8-2 shows the VLEN options.



M0103-02

Figure 8-2. Variable Length (VLEN) Transfer Options

8.2.5 Trigger Event

Each DMA channel can be set up to sense on a single trigger. This field determines which trigger the DMA channel senses.

8.2.6 Source and Destination Increment

When the DMA channel is armed or rearmed, the source and destination addresses are transferred to internal address pointers. The possibilities for address increment are:

- *Increment by zero.* The address pointer remains fixed after each transfer.
- *Increment by one.* The address pointer increments one count after each transfer.
- *Increment by two.* The address pointer increments two counts after each transfer.
- *Decrement by one.* The address pointer decrements one count after each transfer.

where a count equals 1 byte in byte mode and 2 bytes in word mode.

8.2.7 DMA Transfer Mode

The transfer mode determines how the DMA channel behaves when it starts transferring data. There are four transfer modes described as follows:

Single: On a trigger, a single DMA transfer occurs, and the DMA channel awaits the next trigger. After the number of transfers specified by the transfer count is completed, the CPU is notified, and the DMA channel is disarmed.

Block: On a trigger, the number of DMA transfers specified by the transfer count is performed as quickly as possible, after which the CPU is notified and the DMA channel is disarmed.

Repeated single: On a trigger, a single DMA transfer occurs, and the DMA channel awaits the next trigger. After the number of transfers specified by the transfer count is completed, the CPU is notified, and the DMA channel is rearmed.

Repeated block: On a trigger, the number of DMA transfers specified by the transfer count is performed as quickly as possible, after which the CPU is notified and the DMA channel is rearmed.

8.2.8 DMA Priority

A DMA priority is configurable for each DMA channel. The DMA priority is used to determine the winner in the case of multiple simultaneous internal memory requests, and whether the DMA memory access should have priority or not over a simultaneous CPU memory access. In case of an internal tie, a round-robin scheme is used to ensure access for all. There are three levels of DMA priority:

High: Highest internal priority. DMA access always prevails over CPU access.

Normal: Second-highest internal priority. DMA access prevails over the CPU on at least every second try.

Low: Lowest internal priority. DMA access always defers to a CPU access.

8.2.9 Byte or Word Transfers

Determines whether 8-bit (byte) or 16-bit (word) transfers are done.

8.2.10 Interrupt Mask

On completing a DMA transfer, the channel can generate an interrupt to the processor. This bit masks the interrupt.

8.2.11 Mode 8 Setting

This field determines whether to use 7 or 8 bits per byte for transfer length. Only applicable when doing byte transfers.

8.3 DMA Configuration Setup

The DMA channel parameters such as address mode, transfer mode, and priority, described in the previous section, must be configured before a DMA channel can be armed and activated. The parameters are not configured directly through SFR registers, but instead they are written in a special DMA configuration data structure in memory. Each DMA channel in use requires its own DMA configuration-data structure. The DMA configuration data structure consists of eight bytes and is described in [Section 8.6](#). A DMA configuration-data structure may reside at any location decided on by the user software, and the address location is passed to the DMA controller through a set of SFRs, `DMAxCFGH:DMAxCFGL`. Once a channel has been armed, the DMA controller reads the configuration data structure for that channel, given by the address in `DMAxCFGH:DMAxCFGL`.

It is important to note that the method for specifying the start address for the DMA configuration data structure differs between DMA channel 0 and DMA channels 1–4 as follows:

`DMA0CFGH:DMA0CFGL` gives the start address for the DMA channel 0 configuration data structure.

`DMA1CFGH:DMA1CFGL` gives the start address for the DMA channel 1 configuration data structure, followed by the channel 2–4 configuration data structures.

Thus, the DMA controller expects the DMA configuration data structures for DMA channels 1–4 to lie in a contiguous area in memory starting at the address held in `DMA1CFGH:DMA1CFGL` and consisting of 32 bytes.

8.4 Stopping DMA Transfers

Ongoing DMA transfers or armed DMA channels are aborted using the `DMAARM` register to disarm the DMA channel.

One or more DMA channels are aborted by writing a 1 to the `DMAARM.ABORT` register bit, and at the same time selecting which DMA channels to abort by setting the corresponding `DMAARM.DMAARMx` bits to 1. When setting `DMAARM.ABORT` to 1, the `DMAARM.DMAARMx` bits for nonaborted channels must be written as 0.

No DMA interrupt is generated when aborting an ongoing DMA transfer (disarming a DMA channel).

8.5 DMA Interrupts

Each DMA channel can be configured to generate an interrupt to the CPU on completing a DMA transfer. This is accomplished with the `IRQMASK` bit in the channel configuration. The corresponding interrupt flag in the `DMAIRQ` SFR register is set when the interrupt is generated.

Regardless of the `IRQMASK` bit in the channel configuration, the corresponding interrupt flag in the `DMAIRQ` register is set on DMA channel completion. Thus, software should always check (and clear) this register when rearming a channel with a changed `IRQMASK` setting. Failure to do so could generate an interrupt based on the stored interrupt flag.

If a DMA transfer is aborted prior to its completion, the corresponding bit in the `DMAIRQ` register is not set, and an interrupt is not generated.

8.6 DMA Configuration Data Structure

For each DMA channel, the DMA configuration data structure consists of eight bytes. The configuration data structure is described in [Table 8-2](#).

8.7 DMA Memory Access

The DMA data transfer is affected by endian convention. Note that the DMA descriptors follow big-endian convention while the other registers follow little-endian convention. This must be accounted for in compilers.

Table 8-1. DMA Trigger Sources

DMA Trigger		Functional Unit	Description
Number	Name		
0	NONE	DMA	No trigger, setting the <code>DMAREQ.DMAREQx</code> bit starts transfer.
1	PREV	DMA	DMA channel is triggered by completion of previous channel.
2	T1_CH0	Timer 1	Timer 1, compare, channel 0
3	T1_CH1	Timer 1	Timer 1, compare, channel 1
4	T1_CH2	Timer 1	Timer 1, compare, channel 2
5	T2_EVENT1	Timer 2	Timer 2, event pulse 1
6	T2_EVENT2	Timer 2	Timer 2, event pulse 2
7	T3_CH0	Timer 3	Timer 3, compare, channel 0
8	T3_CH1	Timer 3	Timer 3, compare, channel 1
9	T4_CH0	Timer 4	Timer 4, compare, channel 0
10	T4_CH1	Timer 4	Timer 4, compare, channel 1
11	ST	Sleep Timer (not in CC2540)	Sleep Timer compare
12	IOC_0	I/O controller	Port 0 I/O pin input transition ⁽¹⁾
13	IOC_1	I/O controller	Port 1 I/O pin input transition ⁽¹⁾
14	URX0	USART 0	USART 0 RX complete

⁽¹⁾ Using this trigger source must be aligned with port interrupt-enable bits. Note that all interrupt-enabled port pins generate a trigger.

Table 8-1. DMA Trigger Sources (continued)

DMA Trigger		Functional Unit	Description
Number	Name		
15	UTX0	USART 0	USART 0 TX complete
16	URX1	USART 1	USART 1 RX complete
17	UTX1	USART 1	USART 1 TX complete
18	FLASH	Flash controller	Flash data write complete
19	RADIO	Radio (not in CC2540)	RF packet byte received (see Section 23.3 for details)
20	ADC_CHALL	ADC	ADC end of a conversion in a sequence, sample ready
21	ADC_CH11	ADC	ADC end of conversion channel 0 in sequence, sample ready
22	ADC_CH21	ADC	ADC end of conversion channel 1 in sequence, sample ready
23	ADC_CH32	ADC	ADC end of conversion channel 2 in sequence, sample ready
24	ADC_CH42	ADC	ADC end of conversion channel 3 in sequence, sample ready
25	ADC_CH53	ADC	ADC end of conversion channel 4 in sequence, sample ready
26	ADC_CH63	ADC	ADC end of conversion channel 5 in sequence, sample ready
27	ADC_CH74	ADC	ADC end of conversion channel 6 in sequence, sample ready
28	ADC_CH84	ADC	ADC end of conversion channel 7 in sequence, sample ready
29	ENC_DW	AES	AES encryption processor requests download of input data
30	ENC_UP	AES	AES encryption processor requests upload of output data
31	DBG_BW	Debug interface	Debug interface burst write

Table 8-2. DMA Configuration Data Structure

Byte Offset	Bit	Name	Description
0	7:0	SRCADDR[15:8]	DMA channel source address, high
1	7:0	SRCADDR[7:0]	DMA channel source address, low
2	7:0	DESTADDR[15:8]	DMA channel destination address, high. Note that flash memory is not directly writable.
3	7:0	DESTADDR[7:0]	DMA channel destination address, low. Note that flash memory is not directly writable.
4	7:5	VLEN[2:0]	Variable-length transfer mode. In word mode, bits 12:0 of the first word are considered as the transfer length. 000: Use LEN for transfer count 001: Transfer the number of bytes/words specified by the first byte/word + 1 (up to a maximum specified by LEN). Thus, the transfer count excludes the length byte/word. 010: Transfer the number of bytes/words specified by the first byte/word (up to a maximum specified by LEN). Thus, the transfer count includes the length byte/word. 011: Transfer the number of bytes/words specified by the first byte/word + 2 (up to a maximum specified by LEN). 100: Transfer the number of bytes/words specified by the first byte/word + 3 (up to a maximum specified by LEN). 101: Reserved 110: Reserved 111: Alternative for using LEN as the transfer count
4	4:0	LEN[12:8]	The DMA channel transfer count Used as the maximum allowable length when VLEN differs from 000 and 111. The DMA channel counts in words when in WORDSIZE mode, and in bytes otherwise.
5	7:0	LEN[7:0]	The DMA channel transfer count Used as the maximum allowable length when VLEN differs from 000 and 111. The DMA channel counts in words when in WORDSIZE mode, and in bytes otherwise.
6	7	WORDSIZE	Selects whether each DMA transfer is 8-bit (0) or 16-bit (1).

Table 8-2. DMA Configuration Data Structure (continued)

Byte Offset	Bit	Name	Description
6	6:5	TMODE[1:0]	The DMA channel transfer mode 00: Single 01: Block 10: Repeated single 11: Repeated block
6	4:0	TRIG[4:0]	Selects one of the triggers shown in Table 8-1
7	7:6	SRCINC[1:0]	Source address increment mode (after each transfer): 00: 0 bytes/words 01: 1 byte/word 10: 2 bytes/word 11: -1 byte/word
7	5:4	DESTINC[1:0]	Destination address increment mode (after each transfer): 00: 0 bytes/words 01: 1 byte/word 10: 2 bytes/words 11: -1 byte/word
7	3	IRQMASK	Interrupt mask for this channel. 0: Disable interrupt generation 1: Enable interrupt generation on DMA channel done
7	2	M8	Mode of 8th bit for VLEN transfer length; only applicable when WORDSIZE = 0 and VLEN differs from 000 and 111. 0: Use all 8 bits for transfer count 1: Use 7 LSB for transfer count
7	1:0	PRIORITY[1:0]	The DMA channel priority: 00: Low, CPU has priority. 01: Assured, DMA at least every second try 10: High, DMA has priority 11: Reserved

8.8 DMA Registers

This section describes the SFR registers associated with the DMA controller.

DMAARM (0xD6) – DMA Channel Arm

Bit	Name	Reset	R/W	Description
7	ABORT	0	R0/W	DMA abort. This bit is used to stop ongoing DMA transfers. Writing a 1 to this bit aborts all channels which are selected by setting the corresponding DMAARM bit to 1. 0: Normal operation 1: Abort all selected channels
6:5	–	00	R/W	Reserved
4	DMAARM4	0	R/W1	DMA arm channel 4 This bit must be set in order for any DMA transfers to occur on the channel. For nonrepetitive transfer modes, the bit is automatically cleared on completion.
3	DMAARM3	0	R/W1	DMA arm channel 3 This bit must be set in order for any DMA transfers to occur on the channel. For nonrepetitive transfer modes, the bit is automatically cleared on completion.
2	DMAARM2	0	R/W1	DMA arm channel 2 This bit must be set in order for any DMA transfers to occur on the channel. For nonrepetitive transfer modes, the bit is automatically cleared on completion.
1	DMAARM1	0	R/W1	DMA arm channel 1 This bit must be set in order for any DMA transfers to occur on the channel. For nonrepetitive transfer modes, the bit is automatically cleared on completion.
0	DMAARM0	0	R/W1	DMA arm channel 0 This bit must be set in order for any DMA transfers to occur on the channel. For nonrepetitive transfer modes, the bit is automatically cleared on completion.

DMAREQ (0xD7) – DMA Channel Start Request and Status

Bit	Name	Reset	R/W	Description
7:5	–	000	R0	Reserved
4	DMAREQ4	0	R/W1 H0	DMA transfer request, channel 4 When set to 1, activate the DMA channel (has the same effect as a single trigger event). This bit is cleared when DMA transfer is started.
3	DMAREQ3	0	R/W1 H0	DMA transfer request, channel 3 When set to 1, activate the DMA channel (has the same effect as a single trigger event). This bit is cleared when DMA transfer is started.
2	DMAREQ2	0	R/W1 H0	DMA transfer request, channel 2 When set to 1, activate the DMA channel (has the same effect as a single trigger event). This bit is cleared when DMA transfer is started.
1	DMAREQ1	0	R/W1 H0	DMA transfer request, channel 1 When set to 1, activate the DMA channel (has the same effect as a single trigger event). This bit is cleared when DMA transfer is started.
0	DMAREQ0	0	R/W1 H0	DMA transfer request, channel 0 When set to 1, activate the DMA channel (has the same effect as a single trigger event). This bit is cleared when DMA transfer is started.

DMA0CFGH (0xD5) – DMA Channel-0 Configuration Address High Byte

Bit	Name	Reset	R/W	Description
7:0	DMA0CFG[15:8]	0x00	R/W	The DMA channel-0 configuration address, high-order

DMA0CFGH (0xD4) – DMA Channel-0 Configuration Address Low Byte

Bit	Name	Reset	R/W	Description
7:0	DMA0CFG[7:0]	0x00	R/W	The DMA channel 0 configuration address, low-order

DMA1CFGH (0xD3) – DMA Channel 1–4 Configuration Address High Byte

Bit	Name	Reset	R/W	Description
7:0	DMA1CFG[15:8]	0x00	R/W	The DMA channel 1–4 configuration address, high-order

DMA1CFGL (0xD2) – DMA Channel 1–4 Configuration Address Low Byte

Bit	Name	Reset	R/W	Description
7:0	DMA1CFG[7:0]	0x00	R/W	The DMA channel 1–4 configuration address, low-order

DMAIRQ (0xD1) – DMA Interrupt Flag

Bit	Name	Reset	R/W	Description
7:5	–	000	R0	Reserved
4	DMAIF4	0	R/W0	DMA channel-4 interrupt flag 0: DMA channel transfer not complete 1: DMA channel transfer complete/interrupt pending
3	DMAIF3	0	R/W0	DMA channel-3 interrupt flag 0: DMA channel transfer not complete 1: DMA channel transfer complete/interrupt pending
2	DMAIF2	0	R/W0	DMA channel-2 interrupt flag 0: DMA channel transfer not complete 1: DMA channel transfer complete/interrupt pending
1	DMAIF1	0	R/W0	DMA channel-1 interrupt flag 0: DMA channel transfer not complete 1: DMA channel transfer complete/interrupt pending
0	DMAIF0	0	R/W0	DMA channel-0 interrupt flag 0: DMA channel transfer not complete 1: DMA channel transfer complete/interrupt pending

Timer 1 (16-Bit Timer)

Timer 1 is an independent 16-bit timer which supports typical timer/counter functions such as input capture, output compare, and PWM functions. The timer has five independent capture/compare channels. The timer uses one I/O pin per channel. The timer is used for a wide range of control and measurement applications, and the availability of up/down count mode with five channels allows, for example, implementation of motor-control applications.

The features of Timer 1 are as follows:

- Five capture/compare channels
- Rising, falling, or any-edge input capture
- Set, clear or toggle output compare
- Free-running, modulo, or up/down counter operation
- Clock prescaler for divide by 1, 8, 32, or 128
- Interrupt request generated on each capture/compare and terminal count
- DMA trigger function

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9.1 16-Bit Counter

The timer consists of a 16-bit counter that increments or decrements at each active clock edge. The period of the active clock edges is defined by the register bits, `CLKCONCMD.TICKSPD`, which set the global division of the system clock, giving a variable clock-tick frequency from 0.25 MHz to 32 MHz (given the use of the 32-MHz XOSC as clock source). This frequency is further divided in Timer 1 by the prescaler value set by `T1CTL.DIV`. This prescaler value can be 1, 8, 32, or 128. Thus, the lowest clock frequency used by Timer 1 is 1953.125 Hz and the highest is 32 MHz when the 32 MHz XOSC is used as system clock source. When the 16-MHz RCOSC is used as system clock source, then the highest clock frequency used by Timer 1 is 16 MHz.

The counter operates as a free-running counter, a modulo counter, or an up/down counter for use in center-aligned PWM.

It is possible to read the 16-bit counter value through the two 8-bit SFRs, `T1CNTH` and `T1CNTL`, containing the high-order byte and low-order byte, respectively. When `T1CNTL` is read, the high-order byte of the counter at that instant is buffered in `T1CNTH` so that the high-order byte can be read from `T1CNTH`. Thus, `T1CNTL` must always be read first, before reading `T1CNTH`.

All write accesses to the `T1CNTL` register reset the 16-bit counter.

The counter produces an interrupt request when the terminal count value (overflow) is reached. It is possible to start and halt the counter with `T1CTL` control register settings. The counter is started when a value other than 00 is written to `T1CTL.MODE`. If 00 is written to `T1CTL.MODE`, the counter halts at its present value.

9.2 Timer 1 Operation

In general, control register `T1CTL` is used to control the timer operation. The status register `T1STAT` holds the interrupt flags. The various modes of operation are described as follows.

9.3 Free-Running Mode

In the free-running mode of operation, the counter starts from 0x0000 and increments at each active clock edge. When the counter reaches 0xFFFF (overflow), the counter is loaded with 0x0000 and continues incrementing its value as shown in [Figure 9-1](#). When the terminal count value 0xFFFF is reached, both the `IRCON.T1IF` and `T1STAT.OVFIF` flags are set. An interrupt request is generated if the corresponding interrupt mask bit `TIMIF.OVFIM` is set together with `IEN1.T1EN`. The free-running mode can be used to generate independent time intervals and output signal frequencies.

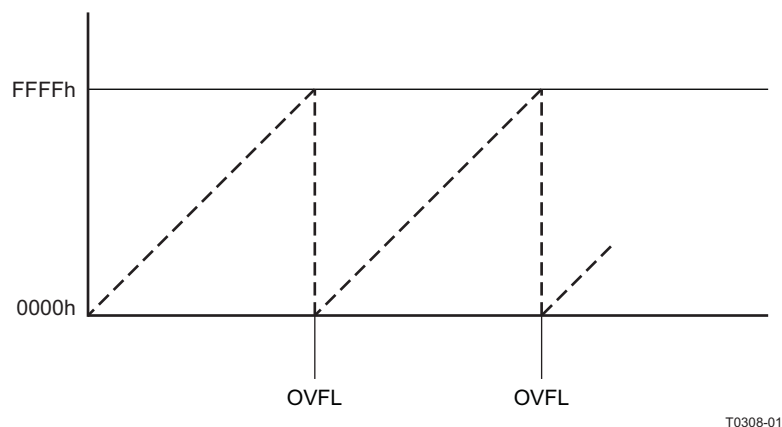


Figure 9-1. Free-Running Mode

9.4 Modulo Mode

When the timer operates in modulo mode, the 16-bit counter starts at 0x0000 and increments at each active clock edge. When the counter reaches the terminal count value `T1CC0`, held in registers

T1CC0H:T1CC0L, the counter is reset to 0x0000 and continues to increment. If the timer is started with a value above T1CC0, the IRCON.T1IF flag and the T1STAT.OVFIF flag are set when the terminal count value (0xFFFF) is reached. An interrupt request is generated if the corresponding interrupt mask bit TIMIF.OVFIM is set together with IEN1.T1EN. The modulo mode can be used for applications where a period other than 0xFFFF is required. The counter operation is shown in Figure 9-2.

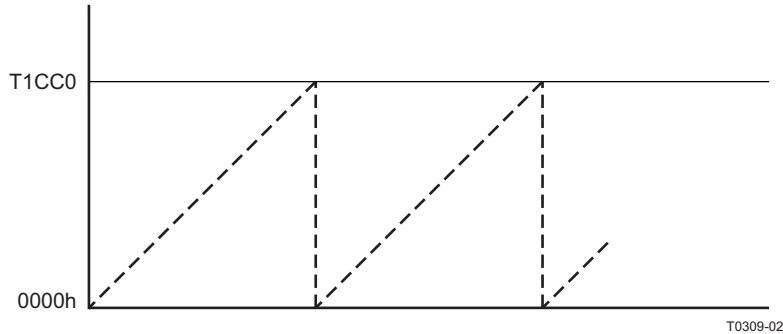


Figure 9-2. Modulo Mode

9.5 Up/Down Mode

In the up/down timer mode, the counter repeatedly starts from 0x0000 and counts up until the value held in T1CC0H:T1CC0L is reached, and then the counter counts down until 0x0000 is reached, as shown in Figure 9-3. This timer mode is used when symmetrical output pulses are required with a period other than 0xFFFF, and therefore allows implementation of center-aligned PWM output applications. Both the IRCON.T1IF and the T1STAT.OVFIF flags are set when the counter value reaches 0x0000 in the up/down mode. An interrupt request is generated if the corresponding interrupt mask bit TIMIF.OVFIM is set together with IEN1.T1EN.

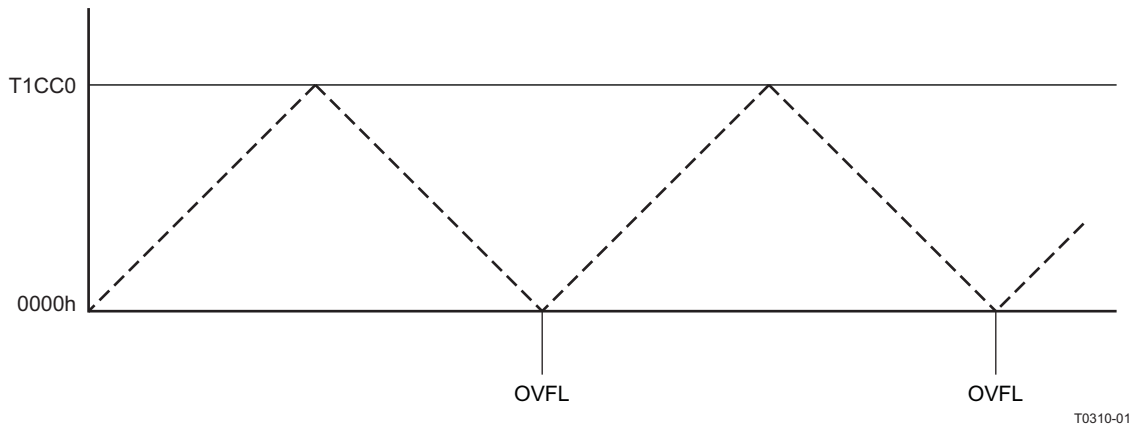


Figure 9-3. Up/Down Mode

9.6 Channel-Mode Control

The channel mode is set for each channel with its control and status register, T1CCTLn. The settings include input capture and output compare modes.

9.7 Input Capture Mode

When a channel is configured as an input capture channel, the I/O pin associated with that channel is configured as an input. After the timer has been started, a rising edge, falling edge, or any edge on the input pin triggers a capture of the 16-bit counter contents into the associated capture register. Thus, the timer is able to capture the time when an external event takes place.

NOTE: Before an I/O pin can be used by the timer, the required I/O pin must be configured as a Timer 1 peripheral pin.

The channel input pin is synchronized to the internal system clock. Thus, pulses on the input pin must have a minimum duration greater than the system clock period.

The content of the 16-bit capture register is read out from registers T1CCnH:T1CCnL.

When the capture takes place, the IRCON.T1IF flag is set, together with the interrupt flag for the channel, T1STAT.CHnIF (n is the channel number). An interrupt request is generated if the corresponding interrupt mask bit, T1CCTLn.IM, is set and IEN1.T1EN is set.

9.8 Output Compare Mode

In output compare mode, the I/O pin associated with a channel is set as an output. After the timer has been started, the contents of the counter are compared with the contents of the channel compare register T1CCnH:T1CCnL. If the compare register equals the counter contents, the output pin is set, reset, or toggled, according to the compare output mode setting of T1CCTLn.CMP. Note that all edges on output pins are glitch-free when operating in a given output compare mode. Writing to the compare register T1CCnL is buffered, so that a value written to T1CCnL does not take effect until the corresponding high-order register, T1CCnH, is written. Writing to compare registers T1CCnH:T1CCnL does not take effect on the output compare value until the counter value is 0x00.

Note that channel 0 has fewer output compare modes because T1CC0H:T1CC0L has a special function in modes 6 and 7, meaning these modes would not be useful for channel 0.

When a compare occurs, the IRCON.T1IF flag is set, together with the interrupt flag for the channel, T1STAT.CHnIF (n is the channel number). An interrupt request is generated if the corresponding interrupt mask bit, T1CCTLn.IM, is set and IEN1.T1EN is set.

Examples of output compare modes in various timer modes are given in the following figures.

Edge-aligned: PWM output signals can be generated using the timer modulo mode and channels 1 and 2 in output compare mode 6 or 7 (defined by the T1CCTLn.CMP bits, where n is 1 or 2) as shown in [Figure 9-4](#). The period of the PWM signal is determined by the setting in T1CC0, and the duty cycle is determined by T1CCn, where n is the PWM channel, 1 or 2.

The timer free-running mode may also be used. In this case, CLKCONCMD.TICKSPD and the prescaler divider value in the T1CTL.DIV bits set the period of the PWM signal. The polarity of the PWM signal is determined by whether output compare mode 6 or 7 is used.

PWM output signals can also be generated using output compare modes 4 and 5 as shown in [Figure 9-4](#), or by using modulo mode as shown in [Figure 9-5](#). Using output compare mode 4 or 5 is preferred for simple PWM.

Center-aligned: PWM outputs can be generated when the timer up/down mode is selected. The channel output compare mode 4 or 5 (defined by T1CCTLn.CMP bits, where n is 1 or 2) is selected, depending on the required polarity of the PWM signal. The period of the PWM signal is determined by T1CC0, and the duty cycle for the channel output is determined by T1CCn, where n is the PWM channel, 1 or 2.

The center-aligned PWM mode is required by certain types of motor-drive applications, and typically less noise is produced than in the edge-aligned PWM mode, because the I/O pin transitions are not lined up on the same clock edge.

In some types of applications, a defined delay or dead time is required between outputs. Typically, this is required for outputs driving an H-bridge configuration to avoid uncontrolled cross-conduction in one side of the H-bridge. The delay or dead-time can be obtained in the PWM outputs by using T1CCn as shown in the following:

Assuming that channel 1 and channel 2 are used to drive the outputs using timer up/down mode and the channels use output compare modes 4 and 5, respectively, then the timer period (in Timer 1 clock periods) is:

$$t_p = T1CC0 \times 2$$

and the dead time, i.e., the time when both outputs are low, (in Timer 1 clock periods) is given by:

$$t_d = T1CC1 - T1CC2$$

A compare output pin is initialized to the value listed in [Table 9-1](#) when:

- a value is written to T1CNTL (all Timer 1 channels)
- 0x7 is written to T1CCTLn.CMP (channel n)

Table 9-1. Initial Compare Output Values (Compare Mode)

Compare Mode (T1CCTLn.CMP)	Initial Compare Output
Set output on compare (000)	0
Clear output on compare (001)	1
Toggle output on compare (010)	0
Set output on compare-up, clear on compare down in up-down mode (011)	0
In other modes than up-down mode, set output on compare, clear on 0 (011)	0
Clear output on compare-up, set on compare down in up-down mode (100)	1
In other modes than up-down mode, clear output on compare, set on 0 (100)	1
Clear when equal T1CC0, set when equal T1CCn (101)	0
Set when equal T1CC0, clear when equal T1CCn (110)	1

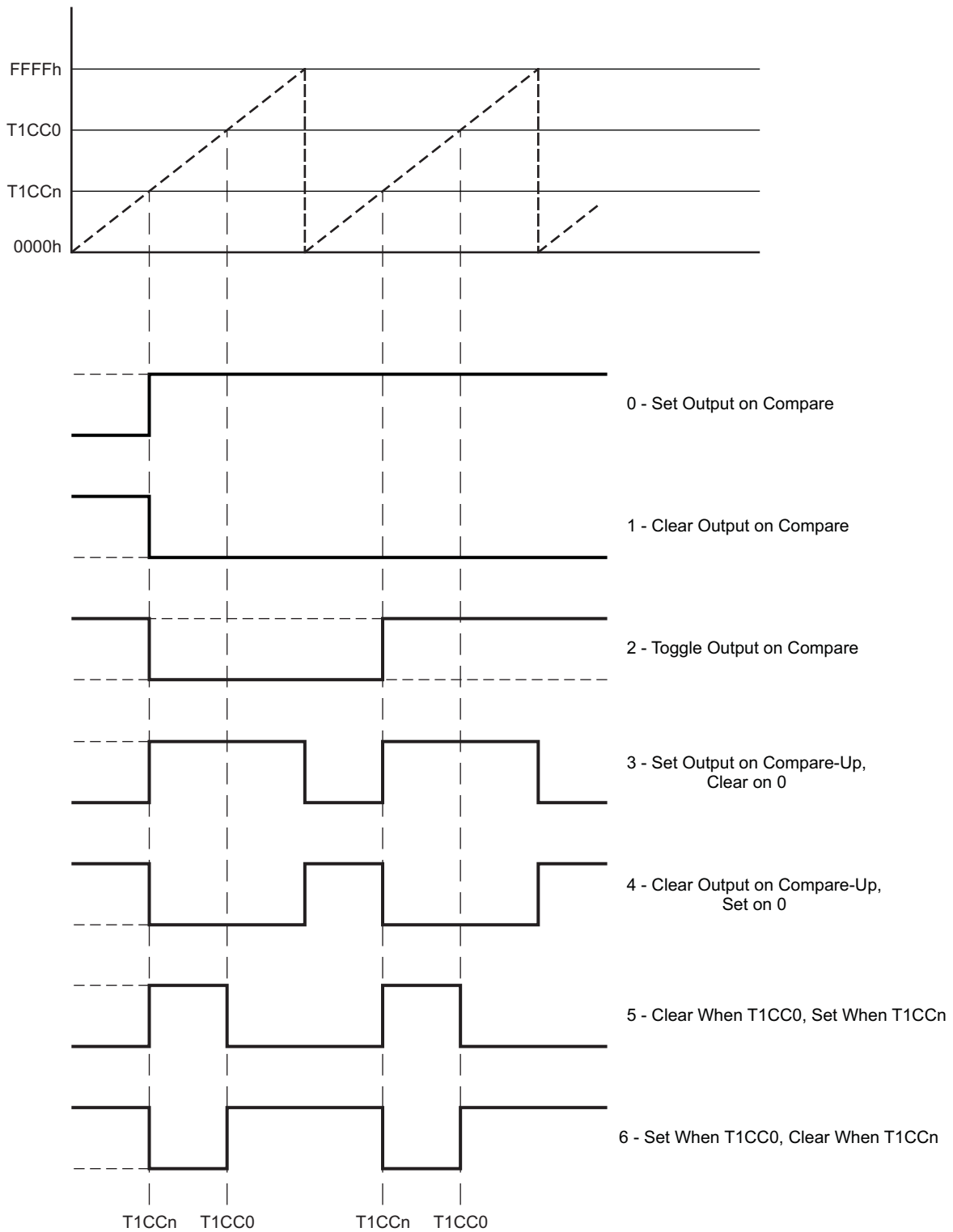
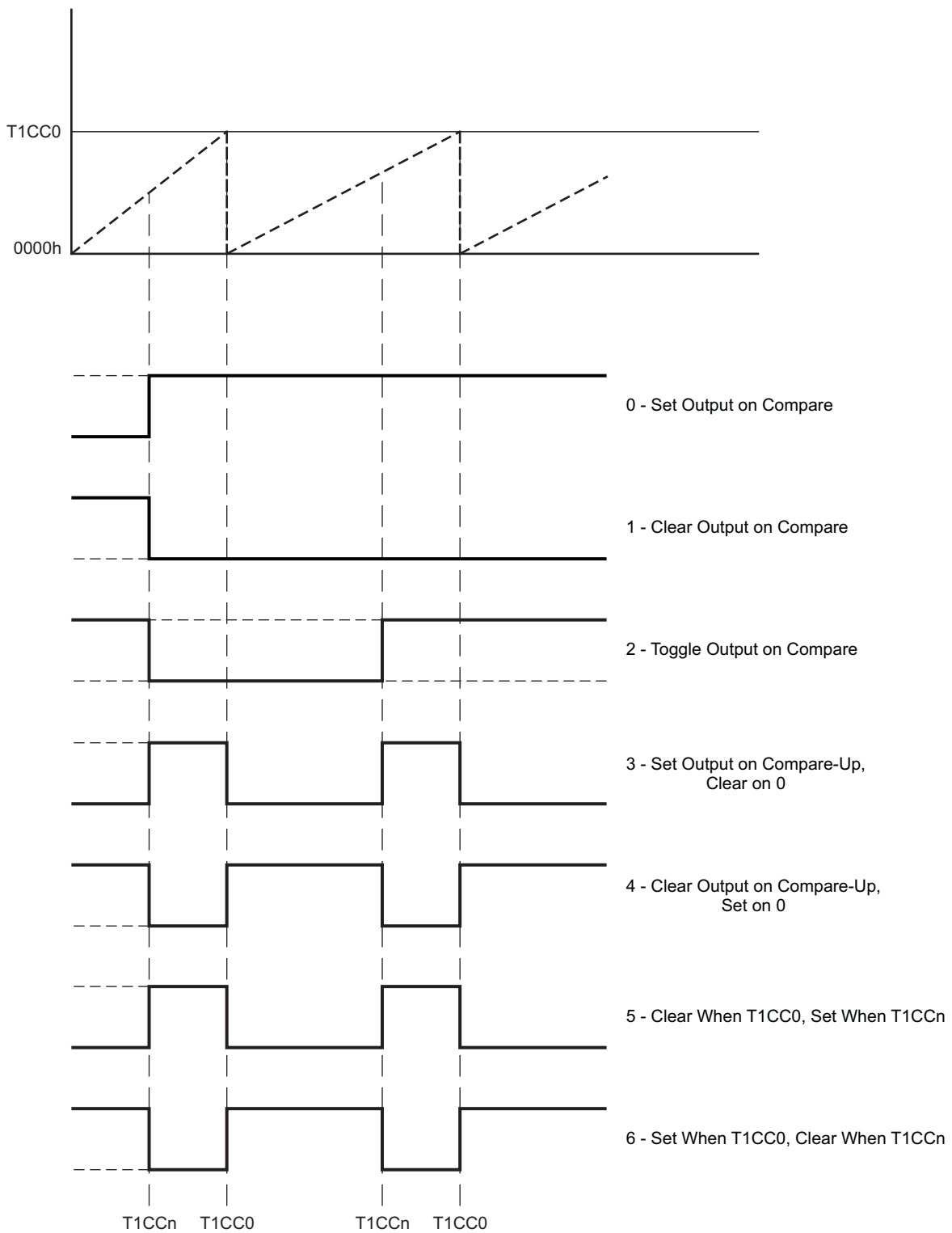


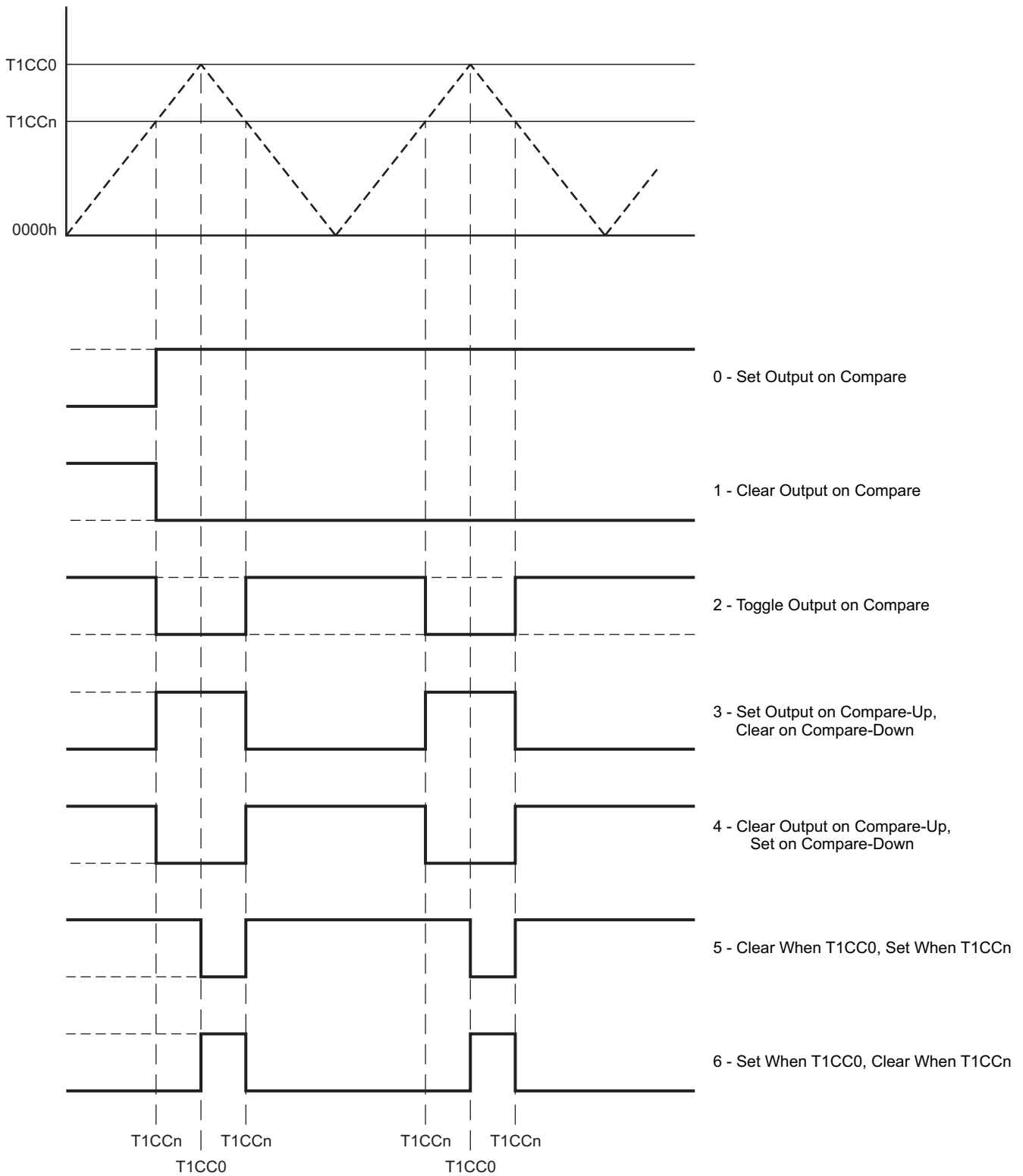
Figure 9-4. Output Compare Modes, Timer Free-Running Mode

T0311-01



T0312-01

Figure 9-5. Output Compare Modes, Timer Modulo Mode



T0313-01

Figure 9-6. Output Compare Modes, Timer Up/Down Mode

9.9 IR Signal Generation and Learning

This section describes how Timer 1 can be configured in IR generation mode, where it counts Timer 3 periods and the output is ANDed with the output of Timer 3 to generate modulated consumer IR signals with minimal CPU interaction.

9.9.1 Introduction

Generation of IR signals for remote control is generally done in one of two ways:

- Modulated codes
- Non-modulated codes (C-codes, flash codes)

The device includes flexible timer functionality to implement generation and learning of both types of IR signals with minimal CPU interaction. Most IR protocols can be implemented with only one CPU intervention per command.

9.9.2 Modulated Codes

Modulated codes can be generated using Timer 1 (16-bit) and Timer 3 (8-bit). Timer 3 in modulo mode is used to generate the carrier. Timer 3 has an individual prescaler for its input. Its period is set using T3CC0. Timer 3 channel 1 is used for PWM output. The duty cycle of the carrier is set using T3CC1. Channel 1 uses compare mode: *Clear output on compare, set on 0x00* (T3CCTL1.CMP = 100). [Table 9-2](#) shows the frequency error calculation for a 38-kHz carrier using Timer 3.

Table 9-2. Frequency Error Calculation for 38-kHz Carrier

Description	Value
System clock frequency	32,000 kHz
IR carrier frequency	38 kHz
System clock period	0.00003125 ms
IR carrier period	0.026315789 ms
Timer prescaler	4
Timer period	0.000125 ms
Ideal timer value	210.5263158
True timer value	211
True timer period	0.026375 ms
True timer frequency	37.91469194 kHz
Period error	59.21052632 ns
Frequency error	85.30805687 Hz
Frequency error %	0.2245%

The IRCTL.IRGEN register bit enables IR generation mode in Timer 1. When the IRGEN bit is set, Timer 1 takes the output of the Timer 3 channel 1 compare signal as tick instead of the system tick. The Timer 1 period is set using T1CC0 with Timer 1 in modulo mode (T1CTL.MODE = 10) and channel 0 in compare mode (T1CCTL0.MODE = 1). Channel 1 compare mode *Clear output on compare, set on 0x0000* (T1CCTL1.CMP = 100) is used for output of the gating signal.

The number of *mark* carrier periods is set by T1CC1. T1CC1 must be updated every Timer 1 period by the DMA or CPU. Note that an update to T1CC1 is buffered and does not take effect before Timer 1 reaches 0x0000.

The number of *space* carrier periods is set by T1CC0. Its value should be set to the total number of *mark* and *space* carrier periods wanted. The compare values are buffered until the timer hits 0x0000.

The output of Timer 1 channel 1 is ANDed with that of Timer 3 channel 1 to form the IR output as shown in [Figure 9-7](#)

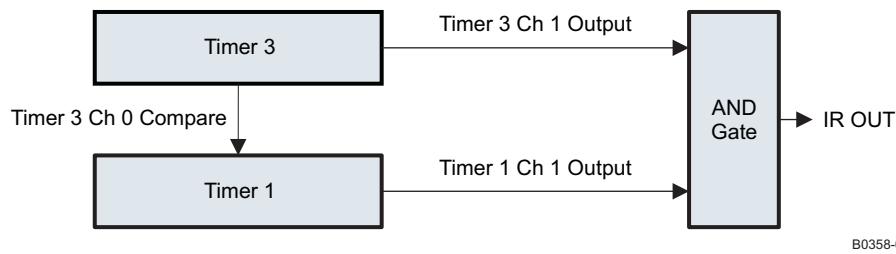


Figure 9-7. Block Diagram of Timers in IR-Generation Mode

The timing of the Timer 3 channel 1 output and Timer 1 channel 1 output signals is synchronized such that no glitches are produced on the IR Out signal.

When the `IRGEN` bit is set, the IR out signal is routed to pins instead of the normal Timer 1 channel 1 output (see also [Section 7.6.1](#)).

[Figure 9-8](#) shows the example of Timer 3 being initialized to a 33% duty cycle ($T3CC0 = 3 \times T3CC1$). Timer 1 has been initialized to 3.

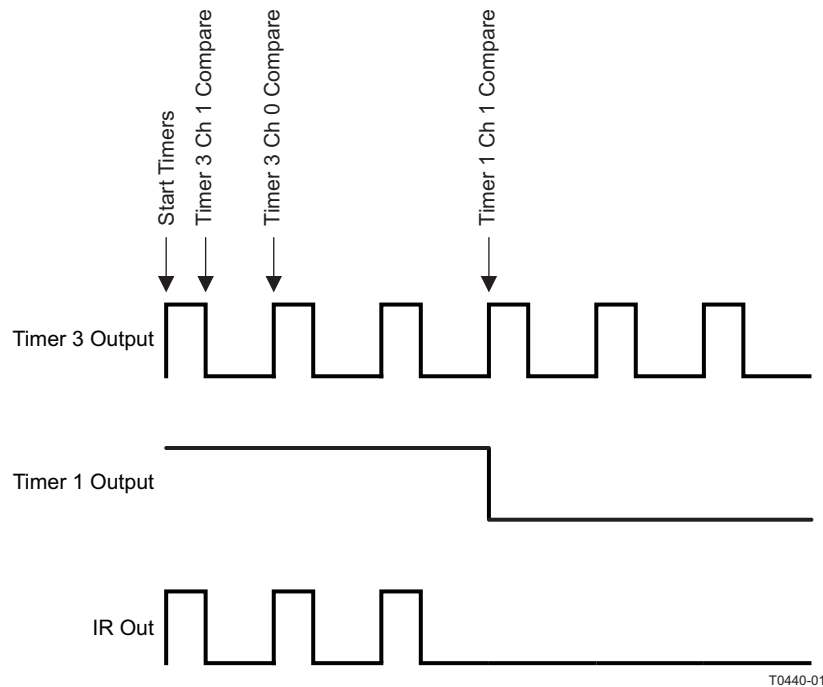


Figure 9-8. Modulated Waveform Example

To achieve a period of *space* only, `T1CC1` should be set to `0x00`.

9.9.3 Non-Modulated Codes

To generate non-modulated IR codes, Timer 1 is used in modulo mode. The period of the signal is given by `T1CC0`, and the pulse duration is given by `T1CC1`. `T1CC1` gives the length of the *mark* period, and `T1CC0` gives the total number of *mark* and *space* periods. The compare values are buffered until the timer hits `0x0000`. The compare values must be updated once every period by the DMA or CPU if they are not to be kept the same.

9.9.4 Learning

Learning is done by using the capture function of Timer 1 (16-bit) and Timer 3 (8-bit). Timer 3 can handle the carrier frequency detection and Timer 1 can handle the code learning from the demodulated signal. The circuit could be set up as described in [Figure 9-9](#)

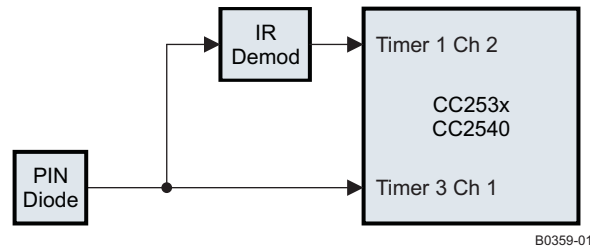


Figure 9-9. IR Learning Board Diagram

9.9.4.1 Carrier Frequency Detection

Timer 3 is used to capture and detect the carrier frequency with input directly from the IR PIN diode. The timer should sample the carrier a limited number of times. If a carrier is detected, the frequency detected should contribute to the average number, which is what can be stored in the database.

9.9.4.2 Demodulated Code Learning

The output from the IR PIN diode is demodulated by an appropriate circuit. The output from this circuit is used as input to one of the Timer 1 channels in capture mode.

9.9.5 Other Considerations

The IR output pin should be placed in the high-impedance state or pulled down during reset to avoid unnecessary power consumption from illuminating the IR LED. Note that only the P1.1 output for Timer 1 channel 1 is placed in the high-impedance state with no pullup during and after reset.

9.10 Timer 1 Interrupts

One interrupt vector is assigned to the timer. An interrupt request is generated when one of the following timer events occurs:

- Counter reaches terminal count value (overflow, or turns around zero).
- Input capture event
- Output compare event

The register status register, `T1STAT`, contains the interrupt flags for the terminal-count value event and the five channel compare/capture events. An interrupt request is only generated when the corresponding interrupt mask bit is set together with `IEN1.T1EN`. The interrupt mask bits are `T1CTLn.IM` for the `n` channels and `TIMIF.OVFIM` for the overflow event. If there are other pending interrupts, the corresponding interrupt flag must be cleared by software before a new interrupt request is generated. Also, enabling an interrupt mask bit generates a new interrupt request if the corresponding interrupt flag is set.

9.11 Timer 1 DMA Triggers

There are three DMA triggers associated with Timer 1. These are DMA triggers `T1_CH0`, `T1_CH1`, and `T1_CH2`, which are generated on timer compare events as follows:

- `T1_CH0` – Channel 0 compare
- `T1_CH1` – Channel 1 compare
- `T1_CH2` – Channel 2 compare

There are no triggers associated with channels 3 and 4.

9.12 Timer 1 Registers

This section describes the Timer 1 registers, which consist of the following registers:

- T1CNTH – Timer 1 count high
- T1CNTL – Timer 1 count low
- T1CTL – Timer 1 control
- T1STAT – Timer 1 status
- T1CCTLn – Timer 1 channel n capture/compare control
- T1CCnH – Timer 1 channel n capture/compare value high
- T1CCnL – Timer 1 channel n capture/compare value low

The TIMIF.OVFIM register bit resides in the TIMIF register, which is described together with the Timer 3 and Timer 4 registers.

T1CNTH (0xE3) – Timer 1 Counter High

Bit	Name	Reset	R/W	Description
7:0	CNT[15:8]	0x00	R	Timer count high-order byte. Contains the high byte of the 16-bit timer counter buffered at the time T1CNTL is read

T1CNTL (0xE2) – Timer 1 Counter Low

Bit	Name	Reset	R/W	Description
7:0	CNT[7:0]	0x00	R/W	Timer count low-order byte. Contains the low byte of the 16-bit timer counter. Writing anything to this register results in the counter being cleared to 0x0000 and initializes all output pins of associated channels.

T1CTL (0xE4) – Timer 1 Control

Bit	Name	Reset	R/W	Description
7:4	–	0000	R0	Reserved
3:2	DIV[1:0]	00	R/W	Prescaler divider value. Generates the active clock edge used to update the counter as follows: 00: Tick frequency/1 01: Tick frequency/8 10: Tick frequency/32 11: Tick frequency/128
1:0	MODE [1:0]	00	R/W	Timer 1 mode select. The timer operating mode is selected as follows: 00: Operation is suspended. 01: Free-running, repeatedly count from 0x0000 to 0xFFFF. 10: Modulo, repeatedly count from 0x0000 to T1CC0. 11: Up/down, repeatedly count from 0x0000 to T1CC0 and from T1CC0 down to 0x0000.

T1STAT (0xAF) – Timer 1 Status

Bit	Name	Reset	R/W	Description
7:6	–	00	R0	Reserved
5	OVFIF	0	R/W0	Timer 1 counter-overflow interrupt flag. Set when the counter reaches the terminal count value in free-running or modulo mode, and when zero is reached counting down in up-down mode. Writing a 1 has no effect.
4	CH4IF	0	R/W0	Timer 1 channel 4 interrupt flag. Set when the channel 4 interrupt condition occurs. Writing a 1 has no effect.
3	CH3IF	0	R/W0	Timer 1 channel 3 interrupt flag. Set when the channel 3 interrupt condition occurs. Writing a 1 has no effect.
2	CH2IF	0	R/W0	Timer 1 channel 2 interrupt flag. Set when the channel 2 interrupt condition occurs. Writing a 1 has no effect.
1	CH1IF	0	R/W0	Timer 1 channel 1 interrupt flag. Set when the channel 1 interrupt condition occurs. Writing a 1 has no effect.
0	CH0IF	0	R/W0	Timer 1 channel 0 interrupt flag. Set when the channel 0 interrupt condition occurs. Writing a 1 has no effect.

T1CCTL0 (0xE5) – Timer 1 Channel 0 Capture/Compare Control

Bit	Name	Reset	R/W	Description
7	RFIRQ	0	R/W	When set, use RF interrupt for capture instead of regular capture input.
6	IM	1	R/W	Channel 0 interrupt mask. Enables interrupt request when set.
5:3	CMP[2:0]	000	R/W	Channel 0 compare-mode select. Selects action on output when timer value equals compare value in T1CC0 000: Set output on compare 001: Clear output on compare 010: Toggle output on compare 011: Set output on compare-up, clear on 0 100: Clear output on compare-up, set on 0 101: Reserved 110: Reserved 111: Initialize output pin. CMP[2:0] is not changed.
2	MODE	0	R/W	Mode. Select Timer 1 channel 0 capture or compare mode 0: Capture mode 1: Compare mode
1:0	CAP[1:0]	00	R/W	Channel 0 capture-mode select 00: No capture 01: Capture on rising edge 10: Capture on falling edge 11: Capture on all edges

T1CC0H (0xDB) – Timer 1 Channel 0 Capture/Compare Value, High

Bit	Name	Reset	R/W	Description
7:0	T1CC0[15:8]	0x00	R/W	Timer 1 channel 0 capture/compare value high-order byte. Writing to this register when T1CCTL0.MODE = 1 (compare mode) causes the T1CC0[15:0] update to the written value to be delayed until T1CNT = 0x0000.

T1CC0L (0xDA) – Timer 1 Channel 0 Capture/Compare Value, Low

Bit	Name	Reset	R/W	Description
7:0	T1CC0[7:0]	0x00	R/W	Timer 1 channel 0 capture/compare value low-order byte. Data written to this register is stored in a buffer but not written to T1CC0[7:0] until, and at the same time as, a later write to T1CC0H takes effect.

T1CCTL1 (0xE6) – Timer 1 Channel 1 Capture/Compare Control

Bit	Name	Reset	R/W	Description
7	RFIRQ	0	R/W	When set, use RF interrupt for capture instead of regular capture input.
6	IM	1	R/W	Channel 1 interrupt mask. Enables interrupt request when set.
5:3	CMP[2:0]	000	R/W	Channel 1 compare-mode select. Selects action on output when timer value equals compare value in T1CC1. 000: Set output on compare 001: Clear output on compare 010: Toggle output on compare 011: Set output on compare-up, clear on compare-down in up-down mode. Otherwise set output on compare, clear on 0. 100: Clear output on compare-up, set on compare-down in up-down mode. Otherwise clear output on compare, set on 0. 101: Clear when equal T1CC0, set when equal T1CC1 110: Set when equal T1CC0, clear when equal T1CC1 111: Initialize output pin. CMP[2:0] is not changed.
2	MODE	0	R/W	Mode. Select Timer 1 channel 1 capture or compare mode 0: Capture mode 1: Compare mode
1:0	CAP[1:0]	00	R/W	Channel 1 capture-mode select 00: No capture 01: Capture on rising edge 10: Capture on falling edge 11: Capture on all edges

T1CC1H (0xDD) – Timer 1 Channel 1 Capture/Compare Value, High

Bit	Name	Reset	R/W	Description
7:0	T1CC1[15:8]	0x00	R/W	Timer 1 channel 1 capture/compare value high-order byte. Writing to this register when T1CCTL1.MODE = 1 (compare mode) causes the T1CC1[15:0] update to the written value to be delayed until T1CNT = 0x0000.

T1CC1L (0xDC) – Timer 1 Channel 1 Capture/Compare Value, Low

Bit	Name	Reset	R/W	Description
7:0	T1CC1[7:0]	0x00	R/W	Timer 1 channel 1 capture/compare value low-order byte. Data written to this register is stored in a buffer but not written to T1CC1[7:0] until, and at the same time as, a later write to T1CC1H takes effect.

T1CCTL2 (0xE7) – Timer 1 Channel 2 Capture/Compare Control

Bit	Name	Reset	R/W	Description
7	RFIRQ	0	R/W	When set, use RF interrupt for capture instead of regular capture input.
6	IM	1	R/W	Channel 2 interrupt mask. Enables interrupt request when set.
5:3	CMP[2:0]	000	R/W	Channel 2 compare mode select. Selects action on output when timer value equals compare value in T1CC2. 000: Set output on compare 001: Clear output on compare 010: Toggle output on compare 011: Set output on compare-up, clear on compare-down in up-down mode. Otherwise set output on compare, clear on 0. 100: Clear output on compare-up, set on compare-down in up-down mode. Otherwise clear output on compare, set on 0. 101: Clear when equal T1CC0, set when equal T1CC2 110: Set when equal T1CC0, clear when equal T1CC2 111: Initialize output pin. CMP[2:0] is not changed.
2	MODE	0	R/W	Mode. Select Timer 1 channel 2 capture or compare mode 0: Capture mode 1: Compare mode
1:0	CAP[1:0]	00	R/W	Channel 2 capture-mode select 00: No capture 01: Capture on rising edge 10: Capture on falling edge 11: Capture on all edges

T1CC2H (0xDF) – Timer 1 Channel 2 Capture/Compare Value, High

Bit	Name	Reset	R/W	Description
7:0	T1CC2[15:8]	0x00	R/W	Timer 1 channel 2 capture/compare value high-order byte. Writing to this register when T1CCTL2.MODE = 1 (compare mode) causes the T1CC2[15:0] update to the written value to be delayed until T1CNT = 0x0000.

T1CC2L (0xDE) – Timer 1 Channel 2 Capture/Compare Value, Low

Bit	Name	Reset	R/W	Description
7:0	T1CC2[7:0]	0x00	R/W	Timer 1 channel 2 capture/compare value low-order byte. Data written to this register is stored in a buffer but not written to T1CC2[7:0] until, and at the same time as, a later write to T1CC2H takes effect.

T1CCTL3 (0x62A3) – Timer 1 Channel 3 Capture/Compare Control

Bit	Name	Reset	R/W	Description
7	RFIRQ	0	R/W	When set, use RF interrupt for capture instead of regular capture input.
6	IM	1	R/W	Channel 3 interrupt mask. Enables interrupt request when set.
5:3	CMP[2:0]	000	R/W	Channel 3 compare mode select. Selects action on output when timer value equals compare value in T1CC3. 000: Set output on compare 001: Clear output on compare 010: Toggle output on compare 011: Set output on compare-up, clear on compare-down in up-down mode. Otherwise set output on compare, clear on 0. 100: Clear output on compare-up, set on compare down in up-down mode. Otherwise clear output on compare, set on 0. 101: Clear when equal T1CC0, set when equal T1CC3 110: Set when equal T1CC0, clear when equal T1CC3 111: Initialize output pin. CMP[2:0] is not changed.
2	MODE	0	R/W	Mode. Select Timer 1 channel 3 capture or compare mode 0: Capture mode 1: Compare mode
1:0	CAP[1:0]	00	R/W	Channel 3 capture-mode select 00: No capture 01: Capture on rising edge 10: Capture on falling edge 11: Capture on all edges

T1CC3H (0x62AD) – Timer 1 Channel 3 Capture/Compare Value, High

Bit	Name	Reset	R/W	Description
7:0	T1CC3[15:8]	0x00	R/W	Timer 1 channel 3 capture/compare value high-order byte. Writing to this register when T1CCTL3.MODE = 1 (compare mode) causes the T1CC3[15:0] update to the written value to be delayed until T1CNT = 0x0000.

T1CC3L (0x62AC) – Timer 1 Channel 3 Capture/Compare Value, Low

Bit	Name	Reset	R/W	Description
7:0	T1CC3[7:0]	0x00	R/W	Timer 1 channel 3 capture/compare value low-order byte. Data written to this register is stored in a buffer but not written to T1CC3[7:0] until, and at the same time as, a later write to T1CC3H takes effect.

T1CCTL4 (0x62A4) – Timer 1 Channel 4 Capture/Compare Control

Bit	Name	Reset	R/W	Description
7	RFIRQ	0	R/W	When set, use RF interrupt for capture instead of regular capture input.
6	IM	1	R/W	Channel 4 interrupt mask. Enables interrupt request when set.
5:3	CMP[2:0]	000	R/W	Channel 4 compare mode select. Selects action on output when timer value equals compare value in T1CC4. 000: Set output on compare 001: Clear output on compare 010: Toggle output on compare 011: Set output on compare-up, clear on compare down in up-down mode. Otherwise set output on compare, clear on 0. 100: Clear output on compare-up, set on compare down in up-down mode. Otherwise clear output on compare, set on 0. 101: Clear when equal T1CC0, set when equal T1CC4 110: Set when equal T1CC0, clear when equal T1CC4 111: Initialize output pin. CMP[2:0] is not changed.
2	MODE	0	R/W	Mode. Select Timer 1 channel 4 capture or compare mode 0: Capture mode 1: Compare mode
1:0	CAP[1:0]	00	R/W	Channel 4 capture-mode select 00: No capture 01: Capture on rising edge 10: Capture on falling edge 11: Capture on all edges

T1CC4H (0x62AF) – Timer 1 Channel 4 Capture/Compare Value, High

Bit	Name	Reset	R/W	Description
7:0	T1CC4[15:8]	0x00	R/W	Timer 1 channel 4 capture/compare value high-order byte. Writing to this register when T1CCTL4.MODE = 1 (compare mode) causes the T1CC4[15:0] update to the written value to be delayed until T1CNT = 0x0000.

T1CC4L (0x62AE) – Timer 1 Channel 4 Capture/Compare Value, Low

Bit	Name	Reset	R/W	Description
7:0	T1CC4[7:0]	0x00	R/W	Timer 1 channel 4 capture/compare value low-order byte. Data written to this register is stored in a buffer but not written to T1CC4[7:0] until, and at the same time as, a later write to T1CC4H takes effect.

IRCTL (0x6281) – Timer 1 IR Generation Control

Bit	Name	Reset	R/W	Description
7:1	–	0000 000	R/W	Reserved
0	IRGEN	0	R/W	When this bit is set, a connection between Timer 3 channel 1 and Timer 1 tick input is made so that the timers can be used to generate modulated IR codes (see also Section 9.9).

9.13 Accessing Timer 1 Registers as Array

The Timer 1 capture/compare channel registers can be accessed as a contiguous region in the XDATA memory space. This facilitates accessing the registers as a simple indexed structure. The five capture/compare control registers are mapped to 0x62A0–0x62A4. The 16-bit capture/compare values are mapped to 0x62A6–0x62AF; 0x62A5 is unused.

Timer 3 and Timer 4 (8-Bit Timers)

Timer 3 and Timer 4 are two 8-bit timers. Each timer has two independent capture/compare channels, each using one I/O pin per channel.

Features of Timer 3 and Timer 4 are as follows:

- Two capture/compare channels
- Set, clear, or toggle output compare
- Clock prescaler for divide by 1, 2, 4, 8, 16, 32, 64, 128
- Interrupt request generated on each capture/compare and terminal-count event
- DMA trigger function

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10.1 8-Bit Timer Counter

All timer functions are based on the main 8-bit counter found in Timer 3 and Timer 4. The counter increments or decrements at each active clock edge. The period of the active clock edges, as defined by the register bits `CLKCONCMD.TICKSPD[2:0]`, is further multiplied (the frequency is divided) by the prescaler value set by `TxCTL.DIV[2:0]` (where x refers to the timer number, 3 or 4). The counter operates as either a free-running counter, a down counter, a modulo counter, or an up/down counter.

It is possible to read the 8-bit counter value through the SFR register `TxCNT`, where x refers to the timer number, 3 or 4.

The possibility to clear and halt the counter is given with `TxCTL` control register settings. The counter is started when a 1 is written to `TxCTL.START`. If a 0 is written to `TxCTL.START`, the counter halts at its present value.

10.2 Timer 3/Timer 4 Mode Control

In general, the control register `TxCTL` is used to control the timer operation.

10.2.1 Free-Running Mode

In the free-running mode of operation, the counter starts from 0x00 and increments at each active clock edge. When the counter reaches 0xFF, the counter is loaded with 0x00 and continues incrementing its value. When the terminal count value 0xFF is reached (i.e., an overflow occurs), the interrupt flag `TIMIF.TxOVFIF` is set. If the corresponding interrupt mask bit `TxCTL.OVFIM` is set, an interrupt request is generated. The free-running mode can be used to generate independent time intervals and output-signal frequencies.

10.2.2 Down Mode

In the down mode, after the timer has been started, the counter is loaded with the contents in `TxCC0`. The counter then counts down to 0x00. The flag `TIMIF.TxOVFIF` is set when 0x00 is reached. If the corresponding interrupt mask bit `TxCTL.OVFIM` is set, an interrupt request is generated. The timer down mode can generally be used in applications where an event timeout interval is required.

10.2.3 Modulo Mode

When the timer operates in modulo mode, the 8-bit counter starts at 0x00 and increments at each active clock edge. When the counter reaches the terminal count value held in register `TxCC0`, the counter is reset to 0x00 and continues to increment. The flag `TIMIF.TxOVFIF` is set when the counter reaches the terminal count value. If the corresponding interrupt mask bit `TxCTL.OVFIM` is set, an interrupt request is generated. The modulo mode can be used for applications where a period other than 0xFF is required.

10.2.4 Up/Down Mode

In the up/down timer mode, the counter repeatedly starts from 0x00 and counts up until the value held in `TxCC0` is reached, and then the counter counts down until 0x00 is reached. This timer mode is used when symmetrical output pulses are required with a period other than 0xFF, allowing implementation of center-aligned PWM output applications.

Clearing the counter by writing to `TxCTL.CLR` also resets the count direction to the count-up-from-0x00 mode.

10.3 Channel Mode Control

The channel modes for each channel, 0 and 1, are set by the control and status registers `TxCCTLn`, where n is the channel number, 0 or 1. The settings include capture and compare modes.

10.4 Input Capture Mode

When a channel is configured as an input capture channel, the I/O pin associated with that channel is configured as an input. After the timer has been started, a rising edge, falling edge, or any edge on the input pin triggers a capture of the 8-bit counter contents into the associated capture register. Thus, the timer is able to capture the time when an external event takes place.

NOTE: Before an I/O pin can be used by the timer, the required I/O pin must be configured as a Timer 3/Timer 4 peripheral pin.

The channel input pin is synchronized to the internal system clock. Thus, pulses on the input pin must have a minimum duration greater than the system clock period.

The content of the 8-bit capture register for channel n is read out from register $T3CCn/T4CCn$.

When a capture occurs, the interrupt flag corresponding to the actual channel is set. This is $TIMIF.TxCHnIF$. An interrupt request is generated if the corresponding interrupt mask bit, $TxCCTLn.IM$, is set.

10.5 Output Compare Mode

In output-compare mode, the I/O pin associated with a channel must be set to an output. After the timer has been started, the content of the counter is compared with the contents of channel compare register $TxCC0n$. If the compare register equals the counter contents, the output pin is set, reset, or toggled according to the compare output mode setting of $TxCCTLn.CMP1:0$. Note that all edges on output pins are glitch-free when operating in a given compare output mode.

For simple PWM use, output compare modes 4 and 5 are preferred.

Writing to compare register $TxCC0$ or $TxCC1$ does not take effect on the output compare value until the counter value is 0x00.

When a compare occurs, the interrupt flag corresponding to the actual channel is set. This is $TIMIF.TxCHnIF$. An interrupt request is generated if the corresponding interrupt mask bit, $TxCCTLn.IM$, is set.

A compare output pin is initialized to the value listed in [Table 9-1](#) when:

- a 1 is written to $TxCNTR.CLR$ (All Timer x channels)
- 0x7 is written to $TxCCTLn.CMP$ (Timer x, channel n)

Table 10-1. Initial Compare Output Values (Compare Mode)

Compare Mode ($TxCCTLn.CMP$)	Initial Compare Output
Set output on compare (000)	0
Clear output on compare (001)	1
Toggle output on compare (010)	0
Set output on compare-up, clear on compare-down in up-down mode (011)	0
In other modes than up-down mode, set output on compare, clear on 0 (011)	0
Clear output on compare-up, set on compare-down in up-down mode (100)	1
In other modes than up-down mode, clear output on compare, set on 0 (100)	1
Set output on compare, clear on 0xFF (101)	0
Clear output on compare, set on 0x00 (110)	1

10.6 Timer 3 and Timer 4 Interrupts

One interrupt vector is assigned to each of the timers. These are T3 and T4. An interrupt request is generated when one of the following timer events occurs:

- Counter reaches terminal count value.
- Compare event

- Capture event

The SFR register `TIMIF` contains all interrupt flags for Timer 3 and Timer 4. The register bits `TIMIF.TxOVFIIF` and `TIMIF.TxCHnIF` contain the interrupt flags for the two terminal-count value events and the four channel compare events, respectively. An interrupt request is only generated when the corresponding interrupt mask bit is set. If there are other pending interrupts, the corresponding interrupt flags must be cleared by the CPU before a new interrupt request can be generated. Also, enabling an interrupt mask bit generates a new interrupt request if the corresponding interrupt flag is set.

10.7 Timer 3 and Timer 4 DMA Triggers

Two DMA triggers are associated with Timer 3, and two DMA triggers are associated with Timer 4.

- T3_CH0: Timer 3 channel 0 capture/compare
- T3_CH1: Timer 3 channel 1 capture/compare
- T4_CH0: Timer 4 channel 0 capture/compare
- T4_CH1: Timer 4 channel 1 capture/compare

10.8 Timer 3 and Timer 4 Registers

T3CNT (0xCA) – Timer 3 Counter

Bit	Name	Reset	R/W	Description
7:0	CNT[7:0]	0x00	R	Timer count byte. Contains the current value of the 8-bit counter

T3CTL (0xCB) – Timer 3 Control

Bit	Name	Reset	R/W	Description
7:5	DIV[2:0]	000	R/W	Prescaler divider value. Generates the active clock edge used to clock the timer from <code>CLKCONCMD.TICKSPD</code> as follows: 000: Tick frequency/1 001: Tick frequency/2 010: Tick frequency/4 011: Tick frequency/8 100: Tick frequency/16 101: Tick frequency/32 110: Tick frequency/64 111: Tick frequency/128
4	START	0	R/W	Start timer. Normal operation when set, suspended when cleared
3	OVFIM	1	R/W0	Overflow interrupt mask 0: Interrupt is disabled. 1: Interrupt is enabled.
2	CLR	0	R0/W1	Clear counter. Writing a 1 to CLR resets the counter to 0x00 and initializes all output pins of associated channels. Always read as 0.
1:0	MODE[1:0]	00	R/W	Timer 3 mode. Select the mode as follows: 00: Free-running, repeatedly count from 0x00 to 0xFF 01: Down, count from T3CC0 to 0x00 10: Modulo, repeatedly count from 0x00 to T3CC0 11: Up/down, repeatedly count from 0x00 to T3CC0 and down to 0x00

T3CCTL0 (0xCC) – Timer 3 Channel 0 Capture/Compare Control

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved
6	IM	1	R/W	Channel 0 interrupt mask 0: Interrupt is disabled. 1: Interrupt is enabled.
5:3	CMP[2:0]	000	R/W	Channel 0 compare output mode select. Specified action occurs on output when timer value equals compare value in T3CC0 000: Set output on compare 001: Clear output on compare 010: Toggle output on compare 011: Set output on compare-up, clear on 0 100: Clear output on compare-up, set on 0 101: Set output on compare, clear on 0xFF 110: Clear output on compare, set on 0x00 111: Initialize output pin. CMP[2:0] is not changed.
2	MODE	0	R/W	Mode. Select Timer 3 channel 0 mode 0: Capture mode 1: Compare mode
1:0	CAP[1:0]	00	R/W	Capture mode select 00: No capture 01: Capture on rising edge 10: Capture on falling edge 11: Capture on both edges

T3CC0 (0xCD) – Timer 3 Channel 0 Capture/Compare Value

Bit	Name	Reset	R/W	Description
7:0	VAL[7:0]	0x00	R/W	Timer capture/compare value channel 0. Writing to this register when T3CCTL0.MODE=1 (compare mode) causes the T3CC0.VAL[7:0] update to the written value to be delayed until T3CNT.CNT[7:0]=0x00.

T3CCTL1 (0xCE) – Timer 3 Channel 1 Capture/Compare Control

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved
6	IM	1	R/W	Channel 1 interrupt mask 0: Interrupt is disabled. 1: Interrupt is enabled.
5:3	CMP[2:0]	000	R/W	Channel 1 compare output-mode select. Specified action on output when timer value equals compare value in T3CC1 000: Set output on compare 001: Clear output on compare 010: Toggle output on compare 011: Set on compare-up, clear on compare-down in up-down mode. Otherwise, set output on compare, clear on 0. 100: Clear output on compare-up, set on compare-down in up-down mode. Otherwise clear output on compare, set on 0. 101: Set output on compare, clear on 0xFF 110: Clear output on compare, set on 0x00 111: Initialize output pin. CMP[2:0] is not changed
2	MODE	0	R/W	Mode. Select Timer 3 channel 1 mode 0: Capture mode 1: Compare mode
1:0	CAP[1:0]	00	R/W	Capture mode select 00: No capture 01: Capture on rising edge 10: Capture on falling edge 11: Capture on both edges

T3CC1 (0xCF) – Timer 3 Channel 1 Capture/Compare Value

Bit	Name	Reset	R/W	Description
7:0	VAL[7:0]	0x00	R/W	Timer 3 capture/compare value, channel 1. Writing to this register when T3CCTL1.MODE = 1 (compare mode) causes the T3CC1.VAL[7:0] update to the written value to be delayed until T3CNT.CNT[7:0] = 0x00.

T4CNT (0xEA) – Timer 4 Counter

Bit	Name	Reset	R/W	Description
7:0	CNT[7:0]	0x00	R	Timer count byte. Contains the current value of the 8-bit counter

T4CTL (0xEB) – Timer 4 Control

Bit	Name	Reset	R/W	Description
7:5	DIV[2:0]	000	R/W	Prescaler divider value. Generates the active clock edge used to clock the timer from CLKCONCMD.TICKSPD as follows: 000: Tick frequency/1 001: Tick frequency/2 010: Tick frequency/4 011: Tick frequency/8 100: Tick frequency/16 101: Tick frequency/32 110: Tick frequency/64 111: Tick frequency/128
4	START		R/W	Start timer. Normal operation when set, suspended when cleared
3	OVFIM	1	R/W0	Overflow interrupt mask
2	CLR	0	R0/W1	Clear counter. Writing a 1 to CLR resets the counter to 0x00 and initialize all output pins of associated channels. Always read as 0.
1:0	MODE[1:0]	0	R/W	Timer 4 mode. Select the mode as follows: 00: Free running, repeatedly count from 0x00 to 0xFF 01: Down, count from T4CC0 to 0x00 10: Modulo, repeatedly count from 0x00 to T4CC0 11: Up/down, repeatedly count from 0x00 to T4CC0 and down to 0x00

T4CTL0 (0xEC) – Timer 4 Channel 0 Capture/Compare Control

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved
6	IM	1	R/W	Channel 0 interrupt mask
5:3	CMP[2:0]	000	R/W	Channel 0 compare output-mode select. Specified action occurs on output when timer value equals compare value in T4CC0. 000: Set output on compare 001: Clear output on compare 010: Toggle output on compare 011: Set output on compare-up, clear on 0 100: Clear output on compare-up, set on 0 101: Set output on compare, clear on 0xFF 110: Clear output on compare, set on 0x00 111: Initialize output pin. CMP[2:0] is not changed
2	MODE	0	R/W	Mode. Select Timer 4 channel 0 mode 0: Capture mode 1: Compare mode
1:0	CAP[1:0]	00	R/W	Capture mode select. 00 – No capture, 01 – Capture on rising edge, 10 – Capture on falling edge, 11 – Capture on both edges

T4CC0 (0xED) – Timer 4 Channel 0 Capture/Compare Value

Bit	Name	Reset	R/W	Description
7:0	VAL[7:0]	0x00	R/W	Timer 4 capture/compare value, channel 0. Writing to this register when T4CTL0.MODE = 1 (compare mode) causes the T4CC0.VAL[7:0] update to the written value to be delayed until T4CNT.CNT[7:0] = 0x00.

T4CCTL1 (0xEE) – Timer 4 Channel 1 Capture/Compare Control

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved
6	IM	1	R/W	Channel 1 interrupt mask
5:3	CMP[2:0]	000	R/W	Channel 1 compare output-mode select. Specified action on output when timer value equals compare value in T4CC1 000: Set output on compare 001: Clear output on compare 010: Toggle output on compare 011: Set on compare-up, clear on compare-down in up-down mode. Otherwise, set output on compare, clear on 0. 100: Clear output on compare-up, set on compare-down in up-down mode. Otherwise clear output on compare, set on 0. 101: Set output on compare, clear on 0xFF 110: Clear output on compare, set on 0x00 111: Initialize output pin. CMP[2:0] is not changed.
2	MODE	0	R/W	Mode. Select Timer 4 channel 1 mode 0: Capture mode 1: Compare mode
1:0	CAP[1:0]	00	R/W	Capture mode select. 00 – No Capture, 01 – Capture on rising edge, 10 – Capture on falling edge, 11 – Capture on both edges

T4CC1 (0xEF) – Timer 4 Channel 1 Capture/Compare Value

Bit	Name	Reset	R/W	Description
7:0	VAL[7:0]	0x00	R/W	Timer capture/compare value, channel 1. Writing to this register when T4CCTL1.MODE = 1 (compare mode) causes the T4CC1.VAL[7:0] update to the written value to be delayed until T4CNT.CNT[7:0] = 0x00.

TIMIF (0xD8) – Timer 1/3/4 Interrupt Mask/Flag

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved
6	OVFIM	1	R/W	Timer 1 overflow interrupt mask
5	T4CH1IF	0	R/W0	Timer 4 channel 1 interrupt flag 0: No interrupt is pending. 1: Interrupt is pending.
4	T4CH0IF	0	R/W0	Timer 4 channel 0 interrupt flag 0: No interrupt is pending. 1: Interrupt is pending.
3	T4OVFIF	0	R/W0	Timer 4 overflow interrupt flag 0: No interrupt is pending. 1: Interrupt is pending.
2	T3CH1IF	0	R/W0	Timer 3 channel 1 interrupt flag 0: No interrupt is pending. 1: Interrupt is pending.
1	T3CH0IF	0	R/W0	Timer 3 channel 0 interrupt flag 0: No interrupt is pending. 1: Interrupt is pending.
0	T3OVFIF	0	R/W0	Timer 3 overflow interrupt flag 0: No interrupt is pending. 1: Interrupt is pending.

Sleep Timer

The Sleep Timer is used to set the period during which the system enters and exits low-power modes PM1 and PM2. The Sleep Timer is also used to maintain timing in Timer 2 when entering power mode PM1 or PM2.

The main features of the Sleep Timer are the following:

- 24-bit timer up-counter operating at 32-kHz clock rate
- 24-bit compare with interrupt and DMA trigger
- 24-bit capture

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11.1 General

The Sleep Timer is a 24-bit timer running on the 32-kHz clock (either RCOSC or XOSC). The timer starts running immediately after a reset and continues to run uninterrupted.

The current value of the timer can be read from SFR registers `ST2:ST1:ST0`. When `ST0` is read, the current value of the 24-bit counter is latched. Thus, the `ST0` register must be read before `ST1` and `ST2` to read a correct Sleep Timer count value.

The Sleep Timer is running when operating in all power modes except PM3. The value of the Sleep Timer is not preserved in PM3. When returning from PM1 or PM2 (where the system clock is shut down), the Sleep Timer value in `ST2:ST1:ST0` is not up-to-date until a positive edge on the 32-kHz clock has been detected after the system clock restarted. To ensure an updated value is read, wait for a positive transition on the 32-kHz clock by polling the `SLEEPSTA.CLK32K` bit, before reading the Sleep Timer value.

Note that if supply voltage drops below 2 V while in PM2, the sleep interval might be affected.

11.2 Timer Compare

A timer compare event occurs when the timer value is equal to the 24-bit compare value and there is a positive edge on the 32-kHz clock. The compare value is set by writing to registers `ST2:ST1:ST0`. Writing to `ST0` while `STLOAD.LDRDY` is 1 initiates loading of the new compare value, i.e., the most-recent values written to the `ST2`, `ST1`, and `ST0` registers. This means that when writing a compare value, `ST2` and `ST1` must be written before `ST0`. `STLOAD.LDRDY` is 0 during the load, and software must not start a new load until `STLOAD.LDRDY` has flipped back to 1.

When setting a new compare value, the value should be at least 5 more than the current sleep timer value. Otherwise, the timer compare event may be lost.

The interrupt enable bit for the ST interrupt is `IEN0.STIE`, and the interrupt flag is `IRCON.STIF`. When a timer compare event occurs, the interrupt flag `IRCON.STIF` is asserted.

In PM1 and PM2, the Sleep Timer compare event may be used to wake up the device and return to active operation in active mode. The default value of the compare value after reset is 0xFF FFFF.

The interrupt enable bit for the ST interrupt is `IEN0.STIE`, and the interrupt flag is `IRCON.STIF`.

For all devices except the CC2540, the Sleep Timer compare event can also be used as a DMA trigger (DMA trigger 11 in [Table 8-1](#)).

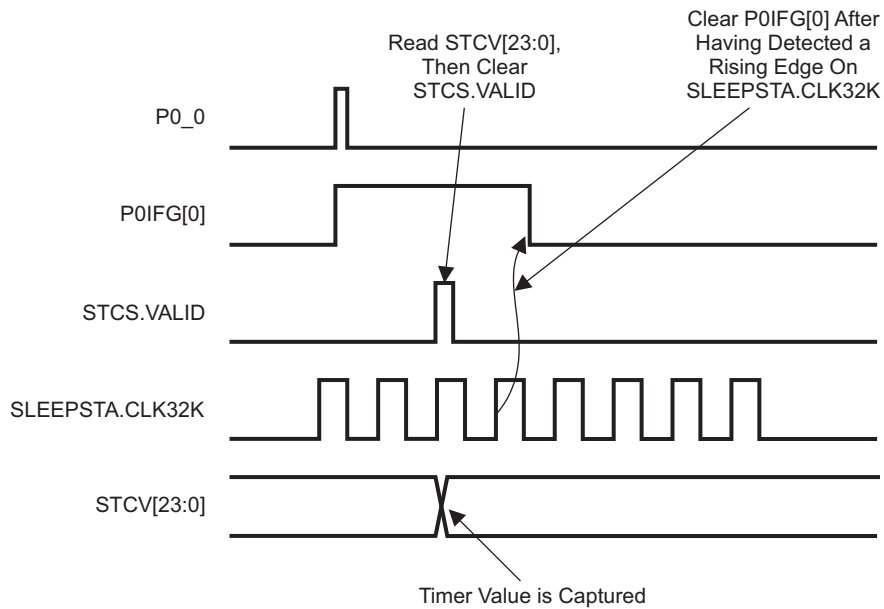
Note that if supply voltage drops below 2 V while in PM2, the sleep interval might be affected.

11.3 Timer Capture

The timer capture occurs when the interrupt flag for a selected I/O pin is set and this event has been detected by the 32-kHz clock. Sleep Timer capture is enabled by setting `STCC.PORT[1:0]` and `STCC.PIN[2:0]` to the I/O pin that is to be used to trigger the capture. When `STCS.VALID` goes high, the capture value in `STCV2:STCV1:STCV0` can be read. The captured value is one more than the value at the instant for the event on the I/O pin. Software should therefore subtract one from the captured value if absolute timing is required. To enable a new capture, follow these steps:

1. Clear `STCS.VALID`.
2. Wait until `SLEEPSTA.CLK32K` is low.
3. Wait until `SLEEPSTA.CLK32K` is high.
4. Clear the pin interrupt flag in the `P0IFG/P1IFG/P2IFG` register.

This sequence, using the rising edge on P0.0 as an example, is shown in [Figure 11-1](#). Failure to follow the procedure may cause the capture functionality to stop working until a chip reset.



T0412-01

Figure 11-1. Sleep Timer Capture (Example Using Rising Edge on P0_0)

It is not possible to switch the input-capture pin while capture is enabled. Capture must be disabled before a new input-capture pin can be selected. To disable capture, follow these steps (note that interrupts will be disabled for up to half of a 32-kHz cycle, or 15.26 μ s):

1. Disable interrupts.
2. Wait until `SLEEPSTA.CLK32K` is high.
3. Set `STCC.PORT[1:0]` to 3. This disables capture.

11.4 Sleep Timer Registers

The registers used by the Sleep Timer are:

- `ST2` – Sleep Timer 2
- `ST1` – Sleep Timer 1
- `ST0` – Sleep Timer 0
- `STLOAD` – Sleep Timer load status
- `STCC` – Sleep Timer capture control
- `STCS` – Sleep Timer capture status
- `STCV0` – Sleep Timer capture value byte 0
- `STCV1` – Sleep Timer capture value byte 1
- `STCV2` – Sleep Timer capture value byte 2

ST2 (0x97) – Sleep Timer 2

Bit	Name	Reset	R/W	Description
7:0	<code>ST2[7:0]</code>	0x00	R/W	Sleep Timer count/compare value. When read, this register returns the high bits [23:16] of the Sleep Timer count. When writing, this register sets the high bits [23:16] of the compare value. The value read is latched at the time of reading register <code>ST0</code> . The value written is latched when <code>ST0</code> is written.

ST1 (0x96) – Sleep Timer 1

Bit	Name	Reset	R/W	Description
7:0	<code>ST1[7:0]</code>	0x00	R/W	Sleep Timer count/compare value. When read, this register returns the middle bits [15:8] of the Sleep Timer count. When writing, this register sets the middle bits [15:8] of the compare value. The value read is latched at the time of reading register <code>ST0</code> . The value written is latched when <code>ST0</code> is written.

ST0 (0x95) – Sleep Timer 0

Bit	Name	Reset	R/W	Description
7:0	ST0[7:0]	0x00	R/W	Sleep Timer count/compare value. When read, this register returns the low bits [7:0] of the Sleep Timer count. When writing, this register sets the low bits [7:0] of the compare value. Writes to this register are ignored unless STLOAD.LDRDY is 1.

STLOAD (0xAD) – Sleep Timer Load Status

Bit	Name	Reset	R/W	Description
7:1	–	0000 00 0	R0	Reserved
0	LDRDY	1	R	Load ready. This bit is 0 while the Sleep Timer loads the 24-bit compare value and 1 when the Sleep Timer is ready to start loading a new compare value.

STCC (0x62B0) – Sleep Timer Capture Control

Bit	Name	Reset	R/W	Description
7:5	–	000	R0	Reserved
4:3	PORT[1:0]	11	R	Port select. Valid settings are 0–2. Capture is disabled when set to 3, i.e. an invalid setting is selected.
2:0	PIN[2:0]	111		Pin select. Valid settings are 0–7 when PORT[1:0] is 0 or 1, 0–5 when PORT[1:0] is 2. Capture is disabled when an invalid setting is selected.

STCS (0x62B1) – Sleep Timer Capture Status

Bit	Name	Reset	R/W	Description
7:1	–	0000 00 0	R0	Reserved
0	VALID	0	R/W0	Capture valid flag. Set to 1 when capture value in STCV has been updated. Clear explicitly to allow new capture.

STCV0 (0x62B2) – Sleep Timer Capture Value Byte 0

Bit	Name	Reset	R/W	Description
7:0	STCV[7:0]	0x00	R	Bits [7:0] of Sleep Timer capture value

STCV1 (0x62B3) – Sleep Timer Capture Value Byte 1

Bit	Name	Reset	R/W	Description
7:0	STCV[15:8]	0x00	R	Bits [15:8] of Sleep Timer capture value

STCV2 (0x62B4) – Sleep Timer Capture Value Byte 2

Bit	Name	Reset	R/W	Description
7:0	STCV[23:16]	0x00	R	Bits [23:16] of Sleep Timer capture value

ADC

The ADC (in the CC2530/CC2531/CC2540 only) supports 14-bit analog-to-digital conversion with up to 12 effective number of bits (ENOB). It includes an analog multiplexer with up to eight individually configurable channels and a reference voltage generator. Conversion results can be written to memory through DMA. Several modes of operation are available.

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12.1 ADC Introduction

The ADC supports up to 14-bit analog-to-digital conversion with up to 12 bits ENOB (Effective Number Of Bits). It includes an analog multiplexer with up to eight individually configurable channels and a reference voltage generator. Conversion results can be written to memory through DMA. Several modes of operation are available.

The main features of the ADC are as follows:

- Selectable decimation rates which also set the effective resolution (7 to 12 bits).
- Eight individual input channels, single-ended or differential
- Reference voltage selectable as internal, external single-ended, external differential, or AVDD5
- Interrupt request generation
- DMA triggers at end of conversions
- Temperature sensor input
- Battery measurement capability

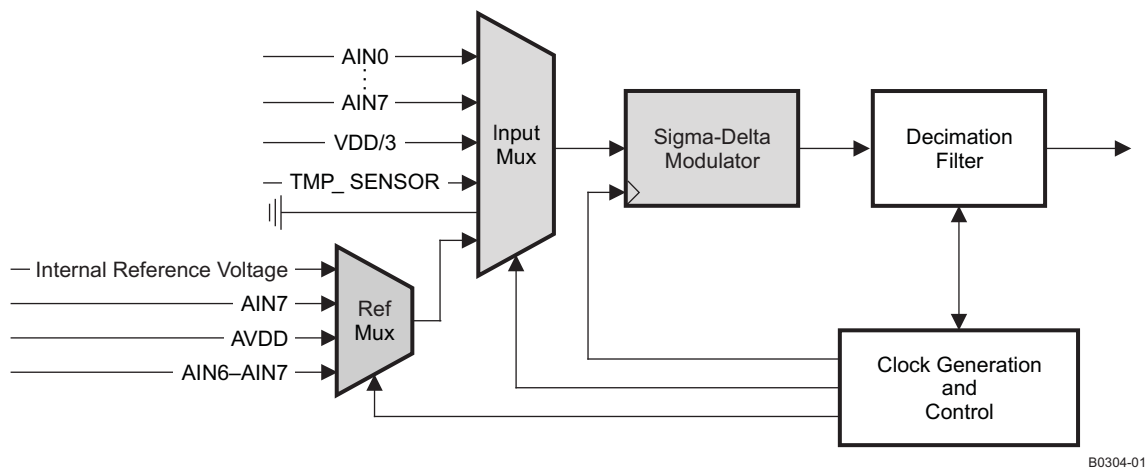


Figure 12-1. ADC Block Diagram

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12.2 ADC Operation

This section describes the general setup and operation of the ADC and describes the use of the ADC control and status registers accessed by the CPU.

12.2.1 ADC Inputs

The signals on the port-0 pins can be used as ADC inputs. In the following, these port pins are referred to as the AIN0–AIN7 pins. The input pins AIN0–AIN7 are connected to the ADC.

It is possible to configure the inputs as single-ended or differential inputs. In the case where differential inputs are selected, the differential inputs consist of the input pairs AIN0–AIN1, AIN2–AIN3, AIN4–AIN5, and AIN6–AIN7. Note that no negative supply can be applied to these pins, nor a supply higher than VDD (unregulated power). It is the difference between the pins of each pair that is converted in differential mode.

In addition to the input pins AIN0–AIN7, the output of an on-chip temperature sensor can be selected as an input to the ADC for temperature measurements. In order to do so, the registers `TR0.ADCTM` and `ATEST.ATESTCTRL` must be set as described in the register descriptions in [Section 12.2.10](#) and [Section 23.15.3](#) (CC253x) or [Section 24.1](#) (CC2540), respectively.

It is also possible to select a voltage corresponding to AVDD5/3 as an ADC input. This input allows the implementation of, e.g., a battery monitor in applications where this feature is required. Note that the reference in this case must not be dependent on the battery voltage; for instance, the AVDD5 voltage must not be used as a reference.

The single-ended inputs AIN0 through AIN7 are represented by channel numbers 0 to 7. Channel numbers 8 through 11 represent the differential inputs consisting of AIN0–AIN1, AIN2–AIN3, AIN4–AIN5, and AIN6–AIN7. Channel numbers 12 through 15 represent GND (12), temperature sensor (14), and AVDD5/3 (15), with channel 13 being reserved. These values are used in the `ADCCON2.SCH` and `ADCCON3.SCH` fields.

The ADC input is a switched capacitance stage which draws current during the conversion. As an example, the equivalent input impedance of a typical device was found to be 176 k Ω when used with an input voltage of 3 V, a 512x decimation rate, and the internal reference.

12.2.2 ADC Conversion Sequences

The ADC can perform a sequence of conversions and move the results to memory (through DMA) without any interaction from the CPU.

The conversion sequence can be influenced with the `APCFG` register (see [Section 7.6.6](#)), in that the eight analog inputs to the ADC come from I/O pins that are not necessarily programmed to be analog inputs. If a channel should normally be part of a sequence, but the corresponding analog input is disabled in the `APCFG` register, then that channel is skipped. When using differential inputs, both pins in a differential pair must set as analog input pins in the `APCFG` register.

The `ADCCON2.SCH` register bits are used to define an ADC conversion sequence from the ADC inputs. If `ADCCON2.SCH` is set to a value less than 8, the conversion sequence contains a conversion from each channel from 0 up to and including the channel number programmed in `ADCCON2.SCH`. When `ADCCON2.SCH` is set to a value between 8 and 12, the sequence consists of differential inputs, starting at channel 8 and ending at the programmed channel. For `ADCCON2.SCH` greater than or equal to 12, the sequence consists of the selected channel only.

12.2.3 Single ADC Conversion

In addition to this sequence of conversions, the ADC can be programmed to perform a single conversion from any channel. Such a conversion is triggered by writing to the `ADCCON3` register. The conversion starts immediately unless a conversion sequence is already ongoing, in which case the single conversion is performed as soon as that sequence is finished.

12.2.4 ADC Operating Modes

This section describes the operating modes and initialization of conversions.

The ADC has three control registers: `ADCCON1`, `ADCCON2`, and `ADCCON3`. These registers are used to configure the ADC and to report status.

The `ADCCON1.EOC` bit is a status bit that is set high when a conversion ends and cleared when `ADCH` is read.

The `ADCCON1.ST` bit is used to start a sequence of conversions. A sequence starts when this bit is set high, `ADCCON1.STSEL` is 11, and no conversion is currently running. When the sequence is completed, this bit is automatically cleared.

The `ADCCON1.STSEL` bits select the event that starts a new sequence of conversions. The options which can be selected are rising edge on external pin P2.0, end of previous sequence, a Timer 1 channel 0 compare event, or `ADCCON1.ST` is 1.

The `ADCCON2` register controls how the sequence of conversions is performed.

`ADCCON2.SREF` is used to select the reference voltage. The reference voltage should only be changed when no conversion is running.

The `ADCCON2.SDIV` bits select the decimation rate, thereby also the resolution and time required to complete a conversion, and hence the sample rate. The decimation rate should only be changed when no conversion is running.

The last channel of a sequence is selected with the `ADCCON2.SCH` bits as described previously.

The `ADCCON3` register controls the channel number, reference voltage, and decimation rate for a single conversion. The single conversion takes place immediately after the `ADCCON3` register is written to, or if a conversion sequence is ongoing, immediately after the sequence has ended. The coding of the register bits is exactly as for `ADCCON2`.

12.2.5 ADC Conversion Results

The digital conversion result is represented in 2s-complement form. For single-ended configurations, the result can be expected to be positive. This is because the result is the difference between the input signal and ground, which is always positively signed ($V_{conv} = V_{in} - V_{in0}$, where $V_{in0} = 0$ V). The maximum value is reached when the input signal is equal to `VREF`, the selected voltage reference. For differential configurations, the difference between two pins is converted, and this difference can be negatively signed. For example, with a decimation rate of 512 using only the 12 MSBs of the digital conversion result register, the maximum value of 2047 is reached when the analog input (V_{conv}) is equal to `VREF`, and minimum value of -2048 is reached when the analog input is equal to `-VREF`.

The digital conversion result is available in `ADCH` and `ADCL` when `ADCCON1.EOC` is set to 1. Note that the conversion result always resides in the MSB section of the combined `ADCH` and `ADCL` registers.

When the `ADCCON2.SCH` bits are read, they indicate the channel on which conversion is ongoing. The results in `ADCL` and `ADCH` normally apply to the previous conversion. If the conversion sequence has ended, `ADCCON2.SCH` has a value of one more than the last channel number, but if the channel number last written to `ADCCON2.SCH` was 12 or more, the same value is read back.

12.2.6 ADC Reference Voltage

The positive reference voltage for analog-to-digital conversions is selectable as either an internally generated voltage, the `AVDD5` pin, an external voltage applied to the `AIN7` input pin, or a differential voltage applied to the `AIN6`–`AIN7` inputs.

The accuracy of the conversion results depend on the stability and noise properties of the reference voltage. Offset from the wanted voltage introduces a gain error in the ADC proportional to the ratio of the wanted voltage and the actual voltage. Noise on the reference must be lower than quantization noise of the ADC to ensure the specified SNR is achieved.

12.2.7 ADC Conversion Timing

The ADC should only be used with the 32-MHz `XOSC`, and no system clock division should be implemented by the user. The actual ADC sampling frequency of 4 MHz is generated by fixed internal division. The time required to perform a conversion depends on the selected decimation rate. In general, the conversion time is given by:

$$T_{conv} = (\text{decimation rate} + 16) \times 0.25 \mu\text{s}.$$

12.2.8 ADC Interrupts

The ADC generates an interrupt when a single conversion triggered by writing to `ADCCON3` has completed. No interrupt is generated when a conversion from the sequence is completed.

12.2.9 ADC DMA Triggers

The ADC generates a DMA trigger every time a conversion from the sequence has completed. When a single conversion completes, no DMA trigger is generated.

There is one DMA trigger for each of the eight channels defined by the first eight possible settings for `ADCCON2.SCH`. The DMA trigger is active when a new sample is ready from the conversion for the channel. The DMA triggers are named `ADC_CHsd` in [Table 8-1](#), where **s** is single-ended channel and **d** is differential channel.

In addition, one DMA trigger, `ADC_CHALL`, is active when new data is ready from any of the channels in the ADC conversion sequence.

12.2.10 ADC Registers

This section describes the ADC registers.

ADCL (0xBA) – ADC Data, Low

Bit	Name	Reset	R/W	Description
7:2	ADC[5:0]	0000 00	R	Least-significant part of ADC conversion result
1:0	–	00	R0	Reserved. Always read as 0

ADCH (0xBB) – ADC Data, High

Bit	Name	Reset	R/W	Description
7:0	ADC[13:6]	0x00	R	Most-significant part of ADC conversion result

ADCCON1 (0xB4) – ADC Control 1

Bit	Name	Reset	R/W	Description
7	EOC	0	R/H0	End of conversion. Cleared when ADCH has been read. If a new conversion is completed before the previous data has been read, the EOC bit remains high. 0: Conversion not complete 1: Conversion completed
6	ST	0	R/W1/H0	Start conversion. Read as 1 until conversion has completed 0: No conversion in progress 1: Start a conversion sequence if ADCCON1.STSEL = 11 and no sequence is running.
5:4	STSEL[1:0]	11	R/W	Start select. Selects the event that starts a new conversion sequence 00: External trigger on P2.0 pin 01: Full speed. Do not wait for triggers 10: Timer 1 channel 0 compare event 11: ADCCON1.ST = 1
3:2	–	00	R/W	Controls the 16-bit random-number generator. See ADCCON1 (0xB4) – ADC Control 1 description in Section 14.3 .
1:0	–	11	R/W	Reserved. Always set to 11

ADCCON2 (0xB5) – ADC Control 2

Bit	Name	Reset	R/W	Description
7:6	SREF[1:0]	00	R/W	Selects reference voltage used for the sequence of conversions 00: Internal reference 01: External reference on AIN7 pin 10: AVDD5 pin 11: External reference on AIN6–AIN7 differential input
5:4	SDIV[1:0]	01	R/W	Sets the decimation rate for channels included in the sequence of conversions. The decimation rate also determines the resolution and time required to complete a conversion. 00: 64 decimation rate (7 bits ENOB setting) 01: 128 decimation rate (9 bits ENOB setting) 10: 256 decimation rate (10 bits ENOB setting) 11: 512 decimation rate (12 bits ENOB setting)
3:0	SCH[3:0]	0000	R/W	Sequence channel select. Selects the end of the sequence. A sequence can either be from AIN0 to AIN7 ($SCH \leq 7$) or from differential input AIN0–AIN1 to AIN6–AIN7 ($8 \leq SCH \leq 11$). For other settings, only one conversions is performed. When read, these bits indicate the channel number on which a conversion is ongoing. 0000: AIN0 0001: AIN1 0010: AIN2 0011: AIN3 0100: AIN4 0101: AIN5 0110: AIN6 0111: AIN7 1000: AIN0–AIN1 1001: AIN2–AIN3 1010: AIN4–AIN5 1011: AIN6–AIN7 1100: GND 1101: Reserved 1110: Temperature sensor 1111: VDD/3

ADCCON3 (0xB6) – ADC Control 3

Bit	Name	Reset	R/W	Description
7:6	EREF[1:0]	00	R/W	Selects reference voltage used for the extra conversion 00: Internal reference 01: External reference on AIN7 pin 10: AVDD5 pin 11: External reference on AIN6–AIN7 differential input
5:4	EDIV[1:0]	00	R/W	Sets the decimation rate used for the extra conversion. The decimation rate also determines the resolution and the time required to complete the conversion. 00: 64 decimation rate (7 bits ENOB) 01: 128 decimation rate (9 bits ENOB) 10: 256 decimation rate (10 bits ENOB) 11: 512 decimation rate (12 bits ENOB)
3:0	ECH[3:0]	0000	R/W	Single channel select. Selects the channel number of the single conversion that is triggered by writing to ADCCON3. 0000: AIN0 0001: AIN1 0010: AIN2 0011: AIN3 0100: AIN4 0101: AIN5 0110: AIN6 0111: AIN7 1000: AIN0–AIN1 1001: AIN2–AIN3 1010: AIN4–AIN5 1011: AIN6–AIN7 1100: GND 1101: Reserved 1110: Temperature sensor 1111: VDD/3

TR0 (0x624B) – Test Register 0

Bit	Name	Reset	R/W	Description
7:1	–	0000 000	R0	Reserved. Write as 0.
0	ADCTM	0	R/W	Set to 1 to connect the temperature sensor to the SOC_ADC. See also ATEST register description to enable the temperature sensor in Section 23.15.3 (CC253x) or Section 24.1 (CC2540).

Battery Monitor

The battery monitor (in the CC2533 only) enables simple voltage monitoring in the devices that do not include an ADC. It is designed such that it is accurate in the voltage areas around 2 V, with lower resolution at higher voltages. The registers `BATTMON` and `MONMUX` are used to access and control the functionality of the battery monitor.

The battery monitor can also be used to do simple temperature monitoring by connecting it to the chip internal temperature sensor instead of the supply voltage. The input is controlled using the `MONMUX` register.

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13.1 Functionality and Usage of the Battery Monitor

The battery monitor makes it possible to check whether the supply voltage (AVDD5) is above or below a certain programmable level. Its usage is controlled by the BATTMON register in the following manner:

BATTMON_VOLTAGE is used to set the trigger point for the battery monitor. Note the fact that the step size is different for different voltage ranges (see the register description in [Section 13.3](#) for details). This is done to achieve good accuracy in the voltage areas around 2 V, with lower resolution at higher voltages.

BATTMON_PD is used to enable/disable the battery monitor.

After enabling the battery monitor by setting BATTMON_PD = 0 and waiting for at least 2 μ s, the value of BATTMON_OUT indicates whether the voltage is above or below the trigger point (set by BATTMON_VOLTAGE).

NOTE: One should turn the battery monitor off (BATTMON_PD = 1) after reading the measurement BATTMON_OUT in order to save power, as the battery monitor consumes power when enabled (= 0).

Recommended usage of the battery monitor can be summarized in the following way:

1. Set BATTMON_VOLTAGE to the value to be monitored.
2. Enable the battery monitor by setting BATTMON_PD = 0.
3. Wait for at least 2 μ s.
4. Read the BATTMON_OUT result to see whether the voltage level is above or below the value set in BATTMON_VOLTAGE.
5. Disable the battery monitor (BATTMON_PD = 1) to avoid unnecessary current consumption.

13.2 Using the Battery Monitor for Temperature Monitoring

The battery monitor can also be used to do some simple temperature monitoring. When the battery monitor is connected to the internal temperature sensor instead of the supply voltage AVDD5 (see the description of MONMUX in [Section 13.3](#)), it can indicate whether the temperature is above or below a certain level. This is done by comparing the voltage coming from the temperature sensor to the voltage trigger point of the battery monitor. The controls for this measurement are the same as for the normal use of the battery monitor (see the description of BATTMON in [Section 13.3](#)).

It is important to understand that due to the nature of the battery monitor (optimized for voltages around 2 V) and the output voltage range of the temperature sensor, there are only about 8 temperature trigger values in the temperature range of -40°C to 125°C (see [Table 13-1](#)). As a result, the battery monitor gives only a rough indication of the temperature range, but this is useful for doing temperature compensation on analog components in a system. See the device's data sheet ([Appendix C](#)) for performance characteristics details.

Table 13-1. Values Showing How Different Temperatures Relate to BATTMON_VOLTAGE for a Typical Device

Temperature	BATTMON_VOLTAGE
-40°C	22
-26°C	21
-11°C	20
7°C	19
25°C	18
47°C	17
70°C	16
97°C	15
128°C	14

The temperature sensor is inversely proportional to `BATTMON_VOLTAGE`. The temperature (in °C) corresponding to a given `BATTMON_VOLTAGE` is given by:

$$\text{Temp} = \frac{A}{\text{BATTMON_VOLTAGE}\langle 4:0 \rangle} - B \quad (1)$$

Assuming `BATTMON_VOLTAGE` < 27, and only valid for $-40^{\circ}\text{C} < \text{Temp} < 125^{\circ}\text{C}$, A and B for a typical device are given in [Table 13-2](#).

**Table 13-2. Values for A and B (for a Typical Device)
When Using the Battery monitor for Temperature
Monitoring**

Constant	Typ
A	6470
B	334

Note that A should be relatively constant for all devices, but B is not. Information that can be used to calculate B for a given chip is included in the chip's information page (see [Section 2.2.3](#) for info about the information page).

Example:

Find the `BATTMON_VOLTAGE` setting that tells whether the temperature is above or below 75°C.

$$\text{BATTMON_VOLTAGE}\langle 4:0 \rangle = \frac{6470}{75 + 334} = 15.82 \quad (2)$$

The closest setting is 16, which corresponds to $\sim 70^{\circ}\text{C}$ (see [Table 13-1](#)). By writing 16 to `BATTMON_VOLTAGE`, an output of `BATTMON_OUT` = 1 tells that the temperature is above 70°C, whereas `BATTMON_OUT` = 0 tells that it is below 70°C.

13.3 Battery Monitor Registers

This section describes the battery monitor registers.

BATTMON (0x6264) – Battery Monitor

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Always read 0
6	BATTMON_OUT	0	R	Result from the battery monitor. 1: Voltage is above value set in BATTMON_VOLTAGE . 0: Voltage is below the value set in BATTMON_VOLTAGE . Note that the value of BATTMON_OUT is undefined except when BATTMON_PD is 0 and has been 0 for 2 us.
5:1	BATTMON_VOLTAGE	11100	R/W	Controls the trigger point for the battery monitor. The step size is 24 mV for the first 23 settings, and then 169 mV (unless temperature-sense mode is enabled; see Section 13.2 for details). Range to be used: 3–31 3: 1.93 V 4: $1.93\text{ V} + (4 - 3) \times 0.024\text{ V} = 1.954\text{ V}$ 5: $1.93\text{ V} + (5 - 3) \times 0.024\text{ V} = 1.978\text{ V}$ 6: $1.93\text{ V} + (6 - 3) \times 0.024\text{ V} = 2.002\text{ V}$ 7: $1.93\text{ V} + (7 - 3) \times 0.024\text{ V} = 2.026\text{ V}$ 8: $1.93\text{ V} + (8 - 3) \times 0.024\text{ V} = 2.050\text{ V}$ 9: $1.93\text{ V} + (9 - 3) \times 0.024\text{ V} = 2.074\text{ V}$ 10: $1.93\text{ V} + (10 - 3) \times 0.024\text{ V} = 2.098\text{ V}$ 11: $1.93\text{ V} + (11 - 3) \times 0.024\text{ V} = 2.122\text{ V}$ 12: $1.93\text{ V} + (12 - 3) \times 0.024\text{ V} = 2.146\text{ V}$ 13: $1.93\text{ V} + (13 - 3) \times 0.024\text{ V} = 2.170\text{ V}$ 14: $1.93\text{ V} + (14 - 3) \times 0.024\text{ V} = 2.194\text{ V}$ 15: $1.93\text{ V} + (15 - 3) \times 0.024\text{ V} = 2.218\text{ V}$ 16: $1.93\text{ V} + (16 - 3) \times 0.024\text{ V} = 2.242\text{ V}$ 17: $1.93\text{ V} + (17 - 3) \times 0.024\text{ V} = 2.266\text{ V}$ 18: $1.93\text{ V} + (18 - 3) \times 0.024\text{ V} = 2.290\text{ V}$ 19: $1.93\text{ V} + (19 - 3) \times 0.024\text{ V} = 2.314\text{ V}$ 20: $1.93\text{ V} + (20 - 3) \times 0.024\text{ V} = 2.338\text{ V}$ 21: $1.93\text{ V} + (21 - 3) \times 0.024\text{ V} = 2.362\text{ V}$ 22: $1.93\text{ V} + (22 - 3) \times 0.024\text{ V} = 2.386\text{ V}$ 23: $1.93\text{ V} + (23 - 3) \times 0.024\text{ V} = 2.410\text{ V}$ 24: $1.93\text{ V} + (24 - 3) \times 0.024\text{ V} = 2.434\text{ V}$ 25: $1.93\text{ V} + (25 - 3) \times 0.024\text{ V} = 2.458\text{ V}$ 26: $1.93\text{ V} + (26 - 3) \times 0.024\text{ V} = 2.482\text{ V}$ 27: $2.482\text{ V} + (27 - 26) \times 0.169\text{ V} = 2.651\text{ V}$ 28: $2.482\text{ V} + (28 - 26) \times 0.169\text{ V} = 2.820\text{ V}$ 29: $2.482\text{ V} + (29 - 26) \times 0.169\text{ V} = 2.989\text{ V}$ 30: $2.482\text{ V} + (30 - 26) \times 0.169\text{ V} = 3.158\text{ V}$ 31 : $2.48\text{ V} + (31 - 26) \times 0.169\text{ V} = 3.327\text{ V}$
0	BATTMON_PD	1	R/W	Turns on the battery monitor. Wait at least 2 μs before reading BATTMON_OUT. 0: Enable the battery monitor. 1: Disable the battery monitor. One should turn the battery monitor off (BATTMON_PD = 1) after reading out the measurement BATTMON_OUT in order to save power, as the battery monitor consumes power when enabled (BATTMON_PD = 0).

MONMUX (0x61A6) – Monitor MUX

Bit	Name	Reset	R/W	Description
7:1	–	-	-	Reserved
0	BATTMON_INPUT	0	R/W	Determines the input to the battery moitor: 0: Supply voltage (AVDD5) 1: Voltage from the temperature sensor, which needs to be enabled using the ATEST.ATESTCTRL register; described in Section 23.15.3

Random-Number Generator

This chapter provides more information about the random-number generator and its usage.

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14.1 Introduction

The random-number generator has the following features.

- Generates pseudorandom bytes which can be read by the CPU or used directly by the command strobe processor (see [Section 23.14](#)).
- Calculates CRC16 of bytes that are written to RNDH.
- Seeded by value written to RNDL.

The random-number generator is a 16-bit linear-feedback shift register (LFSR) with polynomial $X^{16} + X^{15} + X^2 + 1$ (i.e., CRC16). It uses different levels of unrolling depending on the operation it performs. The basic version (no unrolling) is shown in [Figure 14-1](#).

The random-number generator is turned off when `ADCCON1.RCTRL = 11`.

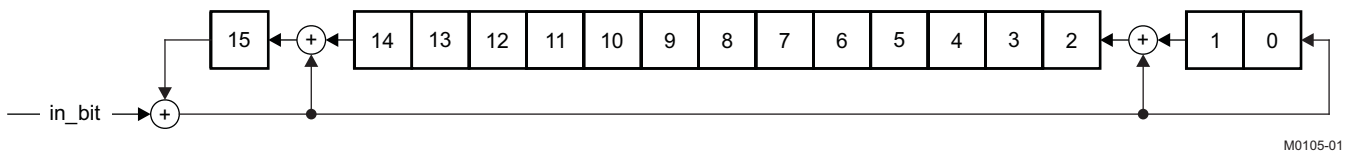


Figure 14-1. Basic Structure of the Random-Number Generator

14.2 Random-Number-Generator Operation

The operation of the random-number generator is controlled by the `ADCCON1.RCTRL` bits (see also [Section 12.2.10](#)). The current value of the 16-bit shift register in the LFSR can be read from the `RNDH` and `RNDL` registers.

14.2.1 Pseudorandom Sequence Generation

The default operation (`ADCCON1.RCTRL` is 00) is to clock the LFSR once (13x unrolling; where clocking with 13x unrolling means performing an operation equivalent to doing 13 shifts with feedback) each time the command strobe processor ([Section 23.14](#)) reads the random value. This leads to the availability of a fresh pseudorandom byte from the LSB end of the LFSR.

Another way to update the LFSR is to set `ADCCON1.RCTRL` to 01. This clocks the LFSR once (13x unrolling), and the `ADCCON1.RCTRL` bits are automatically cleared when the operation has completed.

14.2.2 Seeding

The LFSR can be seeded by writing to the `RNDL` register twice. Each time the `RNDL` register is written, the 8 LSBs of the LFSR are copied to the 8 MSBs and the 8 LSBs are replaced with the new data byte that was written to `RNDL`.

For the CC253x, when a random value is required, the LFSR should be seeded by writing `RNDL` with random bits from the `IF_ADC` in the RF receive path. To use this seeding method, the radio must first be powered on. The radio should be placed in the infinite RX state to avoid possible sync detect in the RX state. The random bits from the `IF_ADC` are read from the least significant bit position of the RF register `RFRND`. These bits should be concatenated over time to form the bytes needed for the random-number-generator seed. See [Section 23.12](#) for a description of the randomness of these numbers. Note that this cannot be done while the radio is in use for normal tasks.

Note that a seed value of 0x0000 or 0x8003 always leads to an unchanged value in the LFSR after clocking, as no values are pushed in via `in_bit` (see [Figure 14-1](#)); hence, neither of these seed values should not be used for random-number generation.

14.2.3 CRC16

The LFSR can also be used to calculate the CRC value of a sequence of bytes. Writing to the `RNDH` register triggers a CRC calculation. The new byte is processed from the MSB end and an 8x unrolling is used, so that a new byte can be written to `RNDH` every clock cycle.

Note that the LFSR must be properly seeded by writing to RNDL before the CRC calculations start. Usually, the seed value for CRC calculations should be 0x0000 or 0xFFFF.

14.3 Random-Number-Generator Registers

This section describes the random-number-generator registers.

RNDL (0xBC) – Random-Number-Generator Data, Low Byte

Bit	Name	Reset	R/W	Description
7:0	RNDL[7:0]	0xFF	R/W	<p>Random value/seed or CRC result, low byte</p> <p>When used for random-number generation, writing to this register twice seeds the random-number generator. Writing to this register copies the 8 LSBs of the LFSR to the 8 MSBs and replaces the 8 LSBs with the data value written.</p> <p>The value returned when reading from this register is the 8 LSBs of the LFSR.</p> <p>When used for random-number generation, reading this register returns the 8 LSBs of the random number. When used for CRC calculations, reading this register returns the 8 LSBs of the CRC result.</p>

RNDH (0xBD) – Random-Number-Generator Data, High Byte

Bit	Name	Reset	R/W	Description
7:0	RNDH[7:0]	0xFF	R/W	<p>Random value or CRC result/input data, high byte</p> <p>When written, a CRC16 calculation is triggered, and the data value written is processed starting with the MSB.</p> <p>The value returned when reading from this register is the 8 MSBs of the LFSR.</p> <p>When used for random-number generation, reading this register returns the 8 MSBs of the random number. When used for CRC calculations, reading this register returns the 8 MSBs of the CRC result.</p>

ADCCON1 (0xB4) – ADC Control 1 (see also [Section 12.2.10](#))

Bit	Name	Reset	R/W	Description
7:4	–	0011	–	For CC2533, these bits are reserved. For the other devices, see the ADCCON1 (0xB4) – ADC Control 1 description in Section 12.2.10 .
3:2	RCTRL[1:0]	00	R/W	<p>Controls the 16-bit random-number generator (Chapter 14). When 01 is written, the setting automatically returns to 00 when the operation has completed.</p> <p>00: Normal operation. (13x unrolling)</p> <p>01: Clock the LFSR once (13x unrolling)</p> <p>10: Reserved</p> <p>11: Stopped. Random-number generator is turned off.</p>
1:0	–	11	R/W	Reserved. Always set to 11

AES Coprocessor

The Advanced Encryption Standard (AES) coprocessor allows encryption/decryption to be performed with minimal CPU usage.

The coprocessor has the following features:

- Supports all security suites in IEEE 802.15.4
- ECB, CBC, CFB, OFB, CTR, and CBC-MAC modes
- Hardware support for CCM mode
- 128-bit key and IV/nonce
- DMA transfer trigger capability

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15.1 AES Operation

To encrypt a message, the following procedure must be followed (ECB, CBC):

- Load key
- Load initialization vector (IV)
- Download and upload data for encryption/decryption.

The AES coprocessor works on blocks of 128 bits. A block of data is loaded into the coprocessor, encryption is performed, and the result must be read out before the next block can be processed. Before each block is loaded, a dedicated start command must be sent to the coprocessor.

15.2 Key and IV

Before a key or IV/nonce load starts, an appropriate load key or IV/nonce command must be issued to the coprocessor. When loading the IV, it is important also to set the correct mode.

A key load or IV load operation aborts any processing that could be running. The key, once loaded, stays valid until a key reload takes place.

The IV must be downloaded before the beginning of each message (not each block).

Both the key and IV values are cleared by a reset of the device and when PM2 or PM3 is entered.

15.3 Padding of Input Data

The AES coprocessor works on blocks of 128 bits. If the last block contains less than 128 bits, it must be padded with zeros when written to the coprocessor.

15.4 Interface to CPU

The CPU communicates with the coprocessor using three SFR registers:

- ENCCS, encryption control and status register
- ENCDI, encryption input register
- ENCDO, encryption output register

Read/write to the status register is done directly by the CPU, whereas access to the input/output registers should be performed using direct memory access (DMA).

When using DMA with the AES coprocessor, two DMA channels must be used, one for input data and one for output data. The DMA channels must be initialized before a start command is written to ENCCS. Writing a start command generates a DMA trigger, and the transfer is started. After each block is processed, an interrupt is generated. The interrupt is used to issue a new start command to ENCCS.

15.5 Modes of Operation

When using CFB, OFB, or CTR mode, the 128-bit blocks are divided into four 32-bit blocks. The 32 bits are loaded into the AES coprocessor, and the resulting 32 bits are read out. This continues until all 128 bits have been encrypted. The only time one must consider this is if data is loaded/read directly using the CPU. When using DMA, this is handled automatically by the DMA triggers generated by the AES coprocessor; thus, DMA is preferred.

Both encryption and decryption are performed similarly.

The CBC-MAC mode is a variant of the CBC mode. See [Section 15.6](#) for an explanation.

CCM is a combination of CBC-MAC and CTR. Parts of the CCM must therefore be done in software. The following section gives a short explanation of the necessary steps to be done.

15.6 CBC-MAC

When performing CBC-MAC encryption, data is downloaded to the coprocessor in CBC-MAC mode one block at a time, except for the last block. Before the last block is loaded, the mode is changed to CBC. The last block is downloaded and the block uploaded is the message MAC.

CBC-MAC decryption is similar to encryption. The message MAC uploaded must be compared with the MAC to be verified.

15.7 CCM Mode

To encrypt a message in CCM mode, the following sequence can be conducted (key is already loaded):

Message Authentication Phase

This phase takes place during the following steps 1–6.

1. The software loads the IV with zeros.
2. The software creates block B0. The layout of block B0 is shown in [Figure 15-1](#).

Name		Designation														
B0		First Block for Authentication in CCM Mode														
Byte	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
Name	Flag	Nonce									L_M					

Figure 15-1. Message Authentication Phase Block B0

There is no restriction on the nonce value. L_M is the message length in bytes.

For 802.15.4, nonce is 13 bytes and L_M is 2 bytes.

The content of the authentication flag byte is described in [Figure 15-2](#).

L is set to 6 in this example. So, L – 1 is set to 5. M and A_Data can be set to any value.

Name		Designation						
FLAG/B0		Authentication Flag Field for CCM mode						
Bit	7	6	5	4	3	2	1	0
Name	Reserved	A_Data	(M – 2)/2			L – 1		
Value	0	x	x	x	x	1	0	1

Figure 15-2. Authentication Flag Byte

3. If some additional authentication data (denoted a, following) is needed (that is, A_Data = 1), the software creates the A_Data length field, called L(a) by:
 - (a) If $l(a) = 0$, (that is, A_Data = 0), then L(a) is the empty string. Note that $l(a)$ is the length of a in octets.
 - (b) If $0 < l(a) < 2^{16} - 2^8$, then L(a) is the 2-octet encoding of $l(a)$.

The additional authentication data is appended to the A_Data length field L(a). The additional authentication blocks are padded with zeros until the last additional authentication block is full. There is no restriction on the length of a.

AUTH-DATA = L(a) + Authentication Data + (zero padding)

4. The last block of the message is padded with zeros until full (that is, if its length is not an integral multiple of 128 bits).
5. The software concatenates block B0, the additional authentication blocks if any, and the message; Input message = B0 + AUTH-DATA + Message + (zero padding of message)
6. Once the input message authentication by CBC-MAC is finished, the software leaves the uploaded buffer contents unchanged ($M = 16$), or keeps only the higher-M bytes of the buffer unchanged, while setting the lower bits to 0 ($M \neq 16$).

The result is called T.

Message Encryption

7. The software creates the key stream block A0. Note that L = 6, with the current example of the CTR generation. The content is shown in [Figure 15-3](#).

Note that when encrypting authentication data T to generate U in OFB mode, the CTR value must be zero. When encrypting message blocks using CTR mode, the CTR value must be any value but zero.

The content of the encryption-flag byte is described in [Figure 15-4](#).

Name A0		Designation First CTR Value for CCM Mode														
Byte	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
Name	Flag	Nonce											CTR			

Figure 15-3. Message Encryption Phase Block

Name FLAG/A0		Designation Encryption Flag Field for CCM Mode						
Bit	7	6	5	4	3	2	1	0
Name	Reserved		—				L – 1	
Value	0	0	0	0	0	1	0	1

Figure 15-4. Encryption Flag Byte

8. The software loads A0 by selecting a Load IV/nonce command. To do so, it sets the mode to CFB or OFB at the same time it selects the Load IV/nonce command.
9. The software calls a CFB or an OFB encryption on the authenticated data T. The uploaded buffer contents stay unchanged ($M = 16$), or only its first M bytes stay unchanged, the others being set to 0 ($M - 16$). The result is U, which is used later.
10. The software calls a CTR-mode encryption immediately on the still-padded message blocks. It must reload the IV when the CTR value is any value but zero.
11. The encrypted authentication data U is appended to the encrypted message. This gives the final result, c.
 Result C = encrypted message(m) + U

Message Decryption

CCM Mode Decryption

In the coprocessor, the automatic generation of CTR works on 32 bits; therefore, the maximum length of a message is 128×2^{32} bits, that is 2^{36} bytes, which can be written in a 6-bit word. So, the value L is set to 6. To decrypt a CCM-mode processed message, the following sequence can be conducted (key is already loaded).

Message Parsing Phase

1. The software parses the message by separating the M rightmost octets, namely U, and the other octets, namely string C.
2. C is padded with zeros until it can fill an integral number of 128-bit blocks.
3. U is padded with zeros until it can fill a 128-bit block.
4. The software creates the key stream block A0. It is done the same way as for CCM encryption.
5. The software loads A0 by selecting a Load IV/nonce command. To do so, it sets the mode to CFB or OFB at the same time as it selects the IV load.
6. The software calls a CFB or an OFB encryption on the encrypted authenticated data U. The uploaded buffer contents stay unchanged (M = 16), or only its first M bytes stay unchanged, the others being set to 0 (M != 16). The result is T.
7. The software calls a CTR-mode decryption immediately on the encrypted message blocks C. Reloading the IV/CTR is not necessary.

Reference Authentication Tag Generation

This phase is identical to the authentication phase of CCM encryption. The only difference is that the result is named MACTag (instead of T).

Message Authentication Checking Phase

The software compares T with MACTag.

15.8 AES Interrupts

The AES interrupt, ENC, is produced when encryption or decryption of a block is completed. The interrupt enable bit is `IEN0.ENCIE`, and the interrupt flag is `SOCON.ENCIF`.

15.9 AES DMA Triggers

Two DMA triggers are associated with the AES coprocessor. These are ENC_DW, which is active when input data must be downloaded to the `ENCDI` register, and ENC_UP, which is active when output data must be uploaded from the `ENCDO` register.

The `ENCDI` and `ENCDO` registers should be set as destination and source locations for DMA channels used to transfer data to or from the AES coprocessor.

15.10 AES Registers

The AES coprocessor registers have the layout shown in this section.

The registers return to their reset value when the chip enters PM2 or PM3.

ENCCS (0xB3) – Encryption Control and Status

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved, always read as 0
6:4	MODE[2:0]	000	R/W	Encryption/decryption mode 000: CBC 001: CFB 010: OFB 011: CTR 100: ECB 101: CBC MAC 110: Reserved 111: Reserved
3	RDY	1	R	Encryption/decryption ready status 0: Encryption/decryption in progress 1: Encryption/decryption is completed.
2:1	CMD[1:0]	0	R/W	Command to be performed when a 1 is written to ST 00: Encrypt block 01: Decrypt block 10: Load key 11: Load IV/nonce
0	ST	0	R/W1 H0	Start processing command set by CMD. Must be issued for each command or 128-bit block of data. Cleared by hardware.

ENCDI (0xB1) – Encryption Input Data

Bit	Name	Reset	R/W	Description
7:0	DIN[7:0]	0x00	R/W	Encryption input data

ENCDO (0xB2) – Encryption Output Data

Bit	Name	Reset	R/W	Description
7:0	DOU[7:0]	0x00	R/W	Encryption output data

Watchdog Timer

The Watchdog Timer (WDT) is intended as a recovery method in situations where the CPU may be subjected to a software upset. The WDT resets the system when software fails to clear the WDT within the selected time interval. The watchdog can be used in applications that are subject to electrical noise, power glitches, electrostatic discharge, etc., or where high reliability is required. If the watchdog function is not needed in an application, it is possible to configure the Watchdog Timer to be used as an interval timer that can be used to generate interrupts at selected time intervals.

The features of the Watchdog Timer are as follows:

- Four selectable timer intervals
- Watchdog mode
- Timer mode
- Interrupt request generation in timer mode

The WDT is configured as either a Watchdog Timer or as a timer for general-purpose use. The operation of the WDT module is controlled by the `WDCTL` register. The Watchdog Timer consists of a 15-bit counter clocked by the 32-kHz clock source. Note that the contents of the 15-bit counter are not user-accessible. The contents of the 15-bit counter are retained during all power modes, and the Watchdog Timer continues counting when entering active mode again.

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16.1 Watchdog Mode

The WDT is disabled after a system reset. To start the WDT in watchdog mode, the `WDCTL.MODE[1:0]` bits must be set to 10. The Watchdog Timer counter then starts incrementing from 0. When the timer is enabled in watchdog mode, it is not possible to disable the timer. Therefore, writing 00 or 01 to `WDCTL.MODE[1:0]` has no effect if the WDT is already operating in Watchdog mode.

The WDT operates with a Watchdog Timer clock frequency of 32.768 kHz (when the 32-kHz XOSC is used). This clock frequency gives time-out periods equal to 1.9 ms, 15.625 ms, 0.25 s, and 1 s, corresponding to the count value settings 64, 512, 8192, and 32,768, respectively.

If the counter reaches the selected timer interval value, the Watchdog Timer generates a reset signal for the system. If a watchdog clear sequence is performed before the counter reaches the selected timer interval value, the counter is reset to 0 and continues incrementing its value. The watchdog clear sequence consists of writing 0xA to `WDCTL.CLR[3:0]`, followed by writing 0x5 to the same register bits within one watchdog clock period. If this complete sequence is not performed before the end of the watchdog period, the Watchdog Timer generates a reset signal for the system.

When the WDT has been enabled in watchdog mode, it is not possible to change the mode by writing to the `WDCTL.MODE[1:0]` bits, and the timer interval value cannot be changed.

In watchdog mode, the WDT does not produce interrupt requests.

16.2 Timer Mode

To start the WDT in timer mode, the `WDCTL.MODE[1:0]` bits must be set to 11. The timer is started and the counter starts incrementing from 0. When the counter reaches the selected interval value, the timer produces an interrupt request (`IRCON2.WDTIF/IEN2.WDTIE`).

In timer mode, it is possible to clear the timer contents by writing a 1 to `WDCTL.CLR[0]`. When the timer is cleared, the content of the counter is set to 0. Writing 00 to `WDCTL.MODE[1:0]` stops the timer and clears it to 0.

The timer interval is set by the `WDCTL.INT[1:0]` bits. The interval cannot be changed during timer operation, and should be set when the timer is started. In timer mode, a reset is not produced when the timer interval has been reached.

Note that if the watchdog mode is selected, the timer mode cannot be selected before the chip is reset.

16.3 Watchdog Timer Register

This section describes the register, `WDCTL`, for the Watchdog Timer.

WDCTL (0xC9) – Watchdog Timer Control

Bit	Name	Reset	R/W	Description
7:4	CLR[3:0]	0000	R0/W	Clear timer. In watchdog mode, when 0xA followed by 0x5 is written to these bits, the timer is cleared (i.e. loaded with 0). Note that the timer is only cleared when 0x5 is written within one watchdog clock period after 0xA was written. Writing these bits when the Watchdog Timer is IDLE has no effect. When operating in timer mode, the timer can be cleared to 0x0000 (but not stopped) by writing 1 to CLR[0] (the other 3 bits are don't care).
3:2	MODE[1:0]	00	R/W	Mode select. These bits are used to start the WDT in watchdog mode or timer mode. Setting these bits to IDLE stops the timer when in timer mode. Note: to switch to watchdog mode when operating in timer mode, first stop the WDT - then start the WDT in Watchdog mode. When operating in Watchdog mode, writing these bits has no effect. 00: IDLE 01: Reserved 10: Watchdog mode 11: Timer mode
1:0	INT[1:0]	00	R/W	Timer interval select. These bits select the timer interval, which is defined as a given number of 32-kHz oscillator periods. Note that the interval can only be changed when the WDT is IDLE, so the interval must be set at the same time as the timer is started. 00: Clock period × 32,768 (~1 s) when running the 32-kHz XOSC 01: Clock period × 8192 (~0.25 s) 10: Clock period × 512 (~15.625 ms) 11: Clock period × 64 (~1.9 ms) When clock division is enabled through CLKCONCMD.CLKSPD, the length of the watchdog timer interval is reduced by a factor equal to the current oscillator clock frequency divided by the set clock speed. E.g., if 32-MHz crystal is selected and clock speed is set to 4 MHz, then the watchdog timeout is reduced by a factor of 32 MHz/4 MHz = 8. If the watchdog interval set by WDCTL.INT was 1 s, nominally it is 1/8 s with this clock division factor.

USART

USART 0 and USART 1 are serial communications interfaces that can be operated separately in either asynchronous UART mode or in synchronous SPI mode. The two USARTs have identical function, and are assigned to separate I/O pins. See [Section 7.6](#) for I/O configuration.

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17.1 UART Mode

For asynchronous serial interfaces, the UART mode is provided. In the UART mode, the interface uses a two-wire or four-wire interface consisting of the pins RXD and TXD, and optionally RTS and CTS. The UART mode of operation includes the following features:

- 8 or 9 payload bits
- Odd, even, or no parity
- Configurable start- and stop-bit levels
- Configurable LSB- or MSB-first transfer
- Independent receive and transmit interrupts
- Independent receive and transmit DMA triggers
- Parity and framing error status

The UART mode provides full-duplex asynchronous transfers, and the synchronization of bits in the receiver does not interfere with the transmit function. A UART byte transfer consists of a start bit, eight data bits, an optional ninth data or parity bit, and one or two stop bits. Note that the data transferred is referred to as a byte, although the data can actually consist of eight or nine bits.

The UART operation is controlled by the USART control and status registers, `UxCSR`, and the UART control registers, `UxUCR`, where `x` is the USART number, 0 or 1.

The UART mode is selected when `UxCSR.MODE` is set to 1.

17.1.1 UART Transmit

A UART transmission is initiated when the USART receive/transmit data buffers, `UxDBUF`, are written. The byte is transmitted on the TXD_x output pins. The `UxDBUF` registers are double-buffered.

The `UxCSR.ACTIVE` bit goes high when the byte transmission starts and low when it ends. When the transmission ends, the `UxCSR.TX_BYTE` bit is set to 1. An interrupt request is generated when the `UxDBUF` register is ready to accept new transmit data. This happens immediately after the transmission has been started; hence, a new data byte value can be loaded into the data buffer while the byte is being transmitted.

17.1.2 UART Receive

Data reception on the UART is initiated when a 1 is written to the `UxCSR.RE` bit. The UART then searches for a valid start bit on the RXD_x input pin and sets the `UxCSR.ACTIVE` bit high. When a valid start bit has been detected, the received byte is shifted into the receive register. The `UxCSR.RX_BYTE` bit is set and a receive interrupt is generated when the operation has completed. At the same time, `UxCSR.ACTIVE` goes low.

The received data byte is available through the `UxDBUF` register. When `UxDBUF` is read, `UxCSR.RX_BYTE` is cleared by hardware.

NOTE: When the application has read `UxDBUF`, it is important that it does not clear `UxCSR.RX_BYTE`. Clearing `UxCSR.RX_BYTE` implicitly makes the UART believe that the UART RX shift register is empty, even though it might hold pending data (typically due to back-to-back transmission). Consequently, the UART asserts (TTL low) the RT/RTS line, which allows flow into the UART, leading to potential overflow. Hence, the `UxCSR.RX_BYTE` flag integrates closely with the automatic RT/RTS function and must therefore be controlled solely by the SoC UART itself. Otherwise, the application could typically experience that the RT/RTS line remains asserted (TTL low), even though a back-to-back transmission clearly suggests it ought to intermittently pause the flow.

17.1.3 UART Hardware Flow Control

Hardware flow control is enabled when the `UxUCR.FLOW` bit is set to 1. The RTS output is driven low when the receive register is empty and reception is enabled. Transmission of a byte does not occur before the CTS input goes low.

17.1.4 UART Character Format

If the `BIT9` and `PARITY` bits in register `UxUCR` are set high, parity generation and detection is enabled. The parity is computed and transmitted as the ninth bit, and during reception, the parity is computed and compared to the received ninth bit. If there is a parity error, the `UxCSR.ERR` bit is set high. This bit is cleared when `UxCSR` is read.

The number of stop bits to be transmitted is set to one or two bits, as determined by the register bit `UxUCR.SPB`. The receiver always checks for one stop bit. If the first stop bit received during reception is not at the expected stop bit level, a framing error is signaled by setting register bit `UxCSR.FE` high. `UxCSR.FE` is cleared when `UxCSR` is read. The receiver checks both stop bits when `UxUCR.SPB` is set. Note that the RX interrupt is set when the first stop bit is checked OK. If second stop bit is not OK, there is a delay in setting the framing error bit, `UxCSR.FE`. This delay is baud-rate dependent (bit duration).

17.2 SPI Mode

This section describes the SPI mode of operation for synchronous communication. In SPI mode, the USART communicates with an external system through a three-wire or four-wire interface. The interface consists of the pins `MOSI`, `MISO`, `SCK`, and `SS_N`. See [Section 7.6](#) for a description of how the USART pins are assigned to the I/O pins.

The SPI mode includes the following features:

- Three-wire (master) and four-wire SPI interface
- Master and slave modes
- Configurable `SCK` polarity and phase
- Configurable LSB- or MSB-first transfer

The SPI mode is selected when `UxCSR.MODE` is set to 0.

In SPI mode, the USART can be configured to operate either as a SPI master or as a SPI slave by writing the `UxCSR.SLAVE` bit.

17.2.1 SPI Master Operation

A SPI byte transfer in master mode is initiated when the `UxDBUF` register is written. The USART generates the `SCK` serial clock using the baud-rate generator (see [Section 19.2](#)) and shifts the provided byte from the transmit register onto the `MOSI` output. At the same time, the receive register shifts in the received byte from the `MISO` input pin.

The `UxCSR.ACTIVE` bit goes high when the transfer starts and low when the transfer ends. When the transfer ends, the `UxCSR.TX_BYTE` bit is set to 1.

The polarity and clock phase of the serial clock `SCK` is selected by `UxGCR.CPOL` and `UxGCR.CPHA`. The order of the byte transfer is selected by the `UxGCR.ORDER` bit.

At the end of the transfer, the received data byte is available for reading from the `UxDBUF`. A receive interrupt is generated when this new data is ready in the `UxDBUF` USART receive/transmit data register.

A transmit interrupt is generated when the unit is ready to accept another data byte for transmission. Because `UxDBUF` is double-buffered, this happens just after the transmission has been initiated. Note that data should not be written to `UxDBUF` until `UxCSR.TX_BYTE` is 1. For DMA transfers, this is handled automatically. For back-to-back transmits using DMA, the `UxGDR.CPHA` bit must be set to zero; if not, transmitted bytes can become corrupted. For systems requiring setting of `UxGDR.CPHA`, polling `UxCSR.TX_BYTE` is needed.

Also, note the difference between transmit interrupt and receive interrupt, as the former arrives approximately eight bit-periods prior to the latter.

SPI master-mode operation as described previously is a three-wire interface. No select input is used to enable the master. If the external slave requires a slave-select signal, this can be implemented through software using a general-purpose I/O pin.

17.2.2 SPI Slave Operation

A SPI byte transfer in slave mode is controlled by the external system. The data on the MOSI input is shifted into the receive register controlled by the serial clock, SCK, which is an input in slave mode. At the same time, the byte in the transmit register is shifted out onto the MISO output.

The `UxCSR.ACTIVE` bit goes high when the transfer starts and low when the transfer ends. Then the `UxCSR.RX_BYTE` bit is set and a receive interrupt is generated.

The expected polarity and clock phase of SCK is selected by `UxGCR.CPOL` and `UxGCR.CPHA`. The expected order of the byte transfer is selected by the `UxGCR.ORDER` bit.

At the end of the transfer, the received data byte is available for reading from `UxDBUF`.

The transmit interrupt is generated at the start of the operation.

17.3 SSN Slave-Select Pin

When the USART is operating in SPI mode, configured as a SPI slave, a four-wire interface is used with the slave-select (SSN) pin as an input to the SPI. When SSN is low, the SPI slave is active, receives data on the MOSI input, and outputs data on the MISO output. When SSN is high, the SPI slave is inactive and does not receive data. The MISO output is in the high-impedance state when SSN is high. Also note that the release of SSN (SSN going high) must be aligned to the end of the byte received or sent. If released during a byte, the next received byte is not received properly, as information about the previous byte is present in the SPI system. A USART flush can be used to remove this information.

In SPI master mode, the SSN pin is not used. When the USART operates as a SPI master and a slave-select signal is required by an external SPI slave device, then a general-purpose I/O pin should be used to implement the slave-select signal function in software.

17.4 Baud-Rate Generation

An internal baud-rate generator sets the UART baud rate when operating in UART mode and the SPI master clock frequency when operating in SPI mode.

The `UxBAUD.BAUD_M[7:0]` and `UxGCR.BAUD_E[4:0]` registers define the baud rate used for UART transfers and the rate of the serial clock for SPI transfers. The baud rate is given by the following equation:

$$\text{Baud Rate} = \frac{(256 + \text{BAUD_M}) \times 2^{\text{BAUD_E}}}{2^{28}} \times f \quad (3)$$

where f is the system clock frequency, 16 MHz for the RCOSC or 32 MHz for the XOSC.

The register values required for standard baud rates are shown in [Table 17-1](#) for a typical system clock set to 32 MHz. The table also gives the difference in actual baud rate to standard baud rate value as a percentage error.

The maximum baud rate for the UART mode is $f/16$ when `BAUD_E` is 16 and `BAUD_M` is 0, and where f is the system clock frequency.

See the device data sheet for the maximum baud rate in SPI mode.

Note that the baud rate must be set through the `UxBAUD` and `UxGCR` registers before any other UART or SPI operations take place. If the baud rate is changed while in UART mode, it may take up to one bit period of the old baud rate before the change takes effect.

Table 17-1. Commonly Used Baud-Rate Settings for 32 MHz System Clock

Baud Rate (bps)	UxBAUD.BAUD_M	UxGCR.BAUD_E	Error (%)
2400	59	6	0.14
4800	59	7	0.14
9600	59	8	0.14
14,400	216	8	0.03

**Table 17-1. Commonly Used Baud-Rate Settings for 32 MHz System Clock
(continued)**

Baud Rate (bps)	UxBAUD.BAUD_M	UxGCR.BAUD_E	Error (%)
19,200	59	9	0.14
28,800	216	9	0.03
38,400	59	10	0.14
57,600	216	10	0.03
76,800	59	11	0.14
115,200	216	11	0.03
230,400	216	12	0.03

17.5 USART Flushing

The current operation can be aborted by setting the `UxUCR.FLUSH` register bit. This event stops the current operation and clears all data buffers. It should be noted that when setting the flush bit in the middle of a TX/RX bit, the flushing does not take place until this bit has ended (buffers are cleared immediately, but timers keeping knowledge of bit duration are not). Thus, using the flush bit should either be aligned with USART interrupts or use a wait time of one bit duration at the current baud rate before updated data or configuration can be received by the USART.

17.6 USART Interrupts

Each USART has two interrupts. These are the RX complete interrupt (URXx) and the TX interrupt (UTXx). The TX interrupt is triggered when transmission starts and the data buffer is offloaded.

The USART interrupt enable bits are found in the `IEN0` and `IEN2` registers. The interrupt flags are located in the `TCON` and `IRCON2` registers. See [Section 2.5](#) for details of these registers. The interrupt enables and flags are summarized as follows.

Interrupt enables:

- USART0 RX: `IEN0.URX0IE`
- USART1 RX: `IEN0.URX1IE`
- USART0 TX: `IEN2.UTX0IE`
- USART1 TX: `IEN2.UTX1IE`

Interrupt flags:

- USART0 RX: `TCON.URX0IF`
- USART1 RX: `TCON.URX1IF`
- USART0 TX: `IRCON2.UTX0IF`
- USART1 TX: `IRCON2.UTX1IF`

17.7 USART DMA Triggers

There are two DMA triggers associated with each USART. The DMA triggers are activated by RX complete and TX complete events, i.e., the same events as the USART interrupt requests. A DMA channel can be configured using a USART receive/transmit buffer, `UxDBUF`, as source or destination address.

See [Table 8-1](#) for an overview of the DMA triggers.

17.8 USART Registers

The registers for the USART are described in this section. For each USART there are five registers consisting of the following (x refers to the USART number, i.e., 0 or 1):

- `UxCSR`, USART x control and status
- `UxUCR`, USART x UART control
- `UxGCR`, USART x generic control

- UxDBUF, USART x receive/transmit data buffer
- UxBAUD, USART x baud-rate control

U0CSR (0x86) – USART 0 Control and Status

Bit	Name	Reset	R/W	Description
7	MODE	0	R/W	USART mode select 0: SPI mode 1: UART mode
6	RE	0	R/W	UART receiver enable. Note: Do not enable receive before UART is fully configured. 0: Receiver disabled 1: Receiver enabled
5	SLAVE	0	R/W	SPI master or slave mode select 0: SPI master 1: SPI slave
4	FE	0	R/W0	UART framing error status. This bit is automatically cleared on a read of the U0CSR register or bits in the U0CSR register. 0: No framing error detected 1: Byte received with incorrect stop-bit level
3	ERR	0	R/W0	UART parity error status. This bit is automatically cleared on a read of the U0CSR register or bits in the U0CSR register. 0: No parity error detected 1: Byte received with parity error
2	RX_BYTE	0	R/W0	Receive byte status. UART mode and SPI slave mode. This bit is automatically cleared when reading U0DBUF; clearing this bit by writing 0 to it effectively discards the data in U0DBUF. 0: No byte received 1: Received byte ready
1	TX_BYTE	0	R/W0	Transmit byte status. UART mode and SPI master mode 0: Byte not transmitted 1: Last byte written to data-buffer register has been transmitted
0	ACTIVE	0	R	USART transmit/receive active status. In SPI slave mode, this bit equals slave select. 0: USART idle 1: USART busy in transmit or receive mode

U0UCR (0xC4) – USART 0 UART Control

Bit	Name	Reset	R/W	Description
7	FLUSH	0	R0/W1	Flush unit. When set, this event stops the current operation and returns the unit to the idle state.
6	FLOW	0	R/W	UART hardware flow enable. Selects use of hardware flow control with RTS and CTS pins 0: Flow control disabled 1: Flow control enabled
5	D9	0	R/W	If parity is enabled (see <i>PARITY</i> , bit 3 in this register), then this bit sets the parity level as follows: 0: Odd parity 1: Even parity
4	BIT9	0	R/W	Set this bit to 1 in order to enable the parity bit transfer (as 9th bit). The content of this 9th bit is given by <i>D9</i> , if parity is enabled by <i>PARITY</i> . 0: 8-bit transfer 1: 9-bit transfer
3	PARITY	0	R/W	UART parity enable. One must set <i>BIT9</i> in addition to setting this bit for parity to be calculated. 0: Parity disabled 1: Parity enabled
2	SPB	0	R/W	UART number of stop bits. Selects the number of stop bits to transmit 0: 1 stop bit 1: 2 stop bits
1	STOP	1	R/W	UART stop-bit level must be different from the start-bit level 0: Low stop bit 1: High stop bit
0	START	0	R/W	UART start-bit level. Ensure that the polarity of the start bit is opposite the level of the idle line. 0: Low start bit 1: High start bit

U0GCR (0xC5) – USART 0 Generic Control

Bit	Name	Reset	R/W	Description
7	CPOL	0	R/W	SPI clock polarity 0: Negative clock polarity 1: Positive clock polarity
6	CPHA	0	R/W	SPI clock phase 0: Data is output on <i>MOSI</i> when <i>SCK</i> goes from CPOL inverted to CPOL , and data input is sampled on <i>MISO</i> when <i>SCK</i> goes from CPOL to CPOL inverted. 1: Data is output on <i>MOSI</i> when <i>SCK</i> goes from CPOL to CPOL inverted, and data input is sampled on <i>MISO</i> when <i>SCK</i> goes from CPOL inverted to CPOL .
5	ORDER	0	R/W	Bit order for transfers 0: LSB first 1: MSB first
4:0	BAUD_E[4:0]	0 0000	R/W	Baud rate exponent value. <i>BAUD_E</i> along with <i>BAUD_M</i> determines the UART baud rate and the SPI master <i>SCK</i> clock frequency.

U0DBUF (0xC1) – USART 0 Receive/Transmit Data Buffer

Bit	Name	Reset	R/W	Description
7:0	DATA[7:0]	0x00	R/W	USART receive and transmit data. When writing this register, the data written is written to the internal transmit-data register. When reading this register, the data from the internal read-data register is read.

U0BAUD (0xC2) – USART 0 Baud-Rate Control

Bit	Name	Reset	R/W	Description
7:0	BAUD_M[7:0]	0x00	R/W	Baud-rate mantissa value. <i>BAUD_E</i> along with <i>BAUD_M</i> decides the UART baud rate and the SPI master <i>SCK</i> clock frequency.

U1CSR (0xF8) – USART 1 Control and Status

Bit	Name	Reset	R/W	Description
7	MODE	0	R/W	USART mode select 0: SPI mode 1: UART mode
6	RE	0	R/W	UART receiver enable. Note: Do not enable receive before UART is fully configured. 0: Receiver disabled 1: Receiver enabled
5	SLAVE	0	R/W	SPI master- or slave-mode select 0: SPI master 1: SPI slave
4	FE	0	R/W0	UART framing error status. This bit is automatically cleared on a read of the U1CSR register or bits in the U1CSR register. 0: No framing error detected 1: Byte received with incorrect stop-bit level
3	ERR	0	R/W0	UART parity error status. This bit is automatically cleared on a read of the U1CSR register or bits in the U1CSR register. 0: No parity error detected 1: Byte received with parity error
2	RX_BYTE	0	R/W0	Receive byte status. UART mode and SPI slave mode. This bit is automatically cleared when reading U1DBUF; clearing this bit by writing 0 to it effectively discards the data in U1DBUF. 0: No byte received 1: Received byte ready
1	TX_BYTE	0	R/W0	Transmit byte status. UART mode and SPI master mode 0: Byte not transmitted 1: Last byte written to data buffer register has been transmitted
0	ACTIVE	0	R	USART transmit/receive active status. In SPI slave mode, this bit equals slave select. 0: USART idle 1: USART busy in transmit or receive mode

U1UCR (0xFB) – USART 1 UART Control

Bit	Name	Reset	R/W	Description
7	FLUSH	0	R0/W1	Flush unit. When set, this event stops the current operation and returns the unit to the idle state.
6	FLOW	0	R/W	UART hardware flow enable. Selects use of hardware flow control with RTS and CTS pins 0: Flow control disabled 1: Flow control enabled
5	D9	0	R/W	If parity is enabled (see PARITY, bit 3 in this register), then this bit sets the parity level as follows. 0: Odd parity 1: Even parity
4	BIT9	0	R/W	Set this bit to 1 in order to enable the parity bit transfer (as 9th bit). The content of this 9th bit is given by D9, if parity is enabled by PARITY. 0: 8-bit transfer 1: 9-bit transfer
3	PARITY	0	R/W	UART parity enable. One must set BIT9 in addition to setting this bit for parity to be calculated. 0: Parity disabled 1: Parity enabled
2	SPB	0	R/W	UART number of stop bits. Selects the number of stop bits to transmit 0: 1 stop bit 1: 2 stop bits
1	STOP	1	R/W	UART stop-bit level must be different from start-bit level. 0: Low stop bit 1: High stop bit
0	START	0	R/W	UART start-bit level. Ensure that the polarity of the start bit is opposite the level of the idle line. 0: Low start bit 1: High start bit

U1GCR (0xFC) – USART 1 Generic Control

Bit	Name	Reset	R/W	Description
7	CPOL	0	R/W	SPI clock polarity 0: Negative clock polarity 1: Positive clock polarity
6	CPHA	0	R/W	SPI clock phase 0: Data is output on <i>MOSI</i> when <i>SCK</i> goes from CPOL inverted to CPOL , and data input is sampled on <i>MISO</i> when <i>SCK</i> goes from CPOL to CPOL inverted. 1: Data is output on <i>MOSI</i> when <i>SCK</i> goes from CPOL to CPOL inverted, and data input is sampled on <i>MISO</i> when <i>SCK</i> goes from CPOL inverted to CPOL .
5	ORDER	0	R/W	Bit order for transfers 0: LSB first 1: MSB first
4:0	BAUD_E[4:0]	0 0000	R/W	Baud rate exponent value. BAUD_E along with BAUD_M determines the UART baud rate and the SPI master SCK clock frequency.

U1DBUF (0xF9) – USART 1 Receive/Transmit Data Buffer

Bit	Name	Reset	R/W	Description
7:0	DATA[7:0]	0x00	R/W	USART receive and transmit data. When writing this register, the data written is written to the internal transmit-data register. When reading this register, the data from the internal read-data register is read.

U1BAUD (0xFA) – USART 1 Baud-Rate Control

Bit	Name	Reset	R/W	Description
7:0	BAUD_M[7:0]	0x00	R/W	Baud rate mantissa value. BAUD_E along with BAUD_M determines the UART baud rate and the SPI master SCK clock frequency.

Operational Amplifier

The operational amplifier (in the CC2530, CC2531, and CC2540) has the following features:

- Low offset
- Ideal for use in combination with the onboard ADC in sensor applications

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18.1 Description

The operational amplifier is connected to the I/O pins as follows:

- The positive input pin is connected to P0_0.
- The negative input pin is connected to P0_1.
- The output is connected to P0_2.

The pins used by the operational amplifier must be configured as analog pins, by setting bits `APCFG[2:0]` to 1. The `OPAMPC.EN` bit is used to enable/disable the operational amplifier. When power mode 2/3 is entered, the operational amplifier is shut down automatically and must be restarted when entering PM0 again.

18.2 Calibration

The operational amplifier must be calibrated. A calibration is started by writing 1 to `OPAMPC.CAL`. During calibration, `OPAMPS.CAL_BUSY` is 1. A new calibration is not accepted before `OPAMPS.CAL_BUSY` goes low. Every time after enabling the operational amplifier, calibration must be performed.

18.3 Clock Source

The operational amplifier uses a divided version of the system clock. The division factor depends on which clock source is used, HSOSC or XOSC. While the operational amplifier is enabled, the clock source should not be changed.

18.4 Registers

This section describes the registers for the operational amplifier.

OPAMPMC (CC2530/CC2531: 0x61A6. CC2540: 0x61AD) – Operational Amplifier Mode Control

Bit	Name	Reset	R/W	Description
7:2	–	0000 00	R/W	Reserved. Always write 0000 00.
1:0	MODE	00	R/W	Operational amplifier mode 00 and 01: Non-chop mode – Higher offset (~500 μ V), but no chopper ripple. Use in conjunction with Mode 10 if offset cancellation is required. Offset for these two modes is the opposite of the offset seen in Mode 10. 10: Non-chop mode – Higher offset (~500 μ V), but no chopper ripple. Use in conjunction with Mode 00 or Mode 01 to double sample and correct for the offset by averaging the two samples. 11: Chop mode – Very low offset (~ 50 μ V), and very low noise (1/f noise shifted to 1 MHz due to chopping), and 1 MHz ripple

OPAMPC (0x62C0) – Operational Amplifier Control

Bit	Name	Reset	R/W	Description
7:2	–	0000 00	R0	Reserved
1	CAL	0	W1/R0	Start calibration. Calibration only starts if <code>OPAMPC.EN</code> is 1.
0	EN	0	R/W	Operational amplifier enable

OPAMPS (0x62C1) – Operational Amplifier Status

Bit	Name	Reset	R/W	Description
7:1	–	0000 000	R0	Reserved
0	CAL_BUSY	0	R	Calibration in progress

Analog Comparator

The analog comparator (in the CC2530, CC2531, and CC2540) has the following features:

- Low-power operation
- Wake-up source

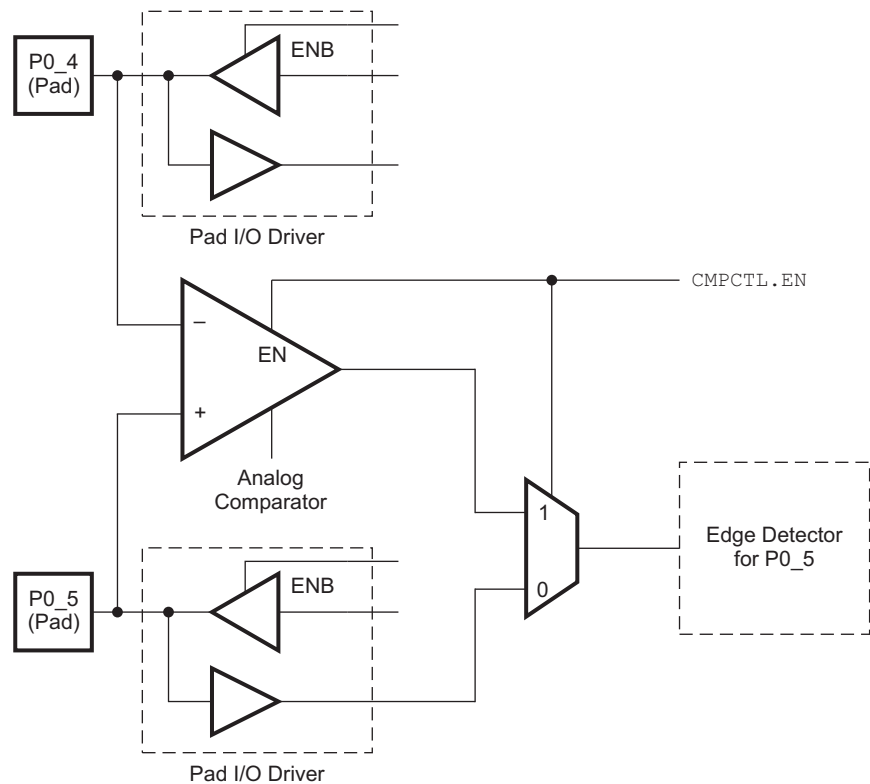
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19.1 Description

The analog comparator is connected to the I/O pins as follows:

- The positive input pin is connected to P0_5.
- The negative input pin is connected to P0_4.
- The output can be read from `CMPCTL.OUTPUT`.

The comparator pins must be configured as analog pins by setting bits `APCFG[5:4]` to 1. The `CMPCTL.EN` bit is used to enable/disable the comparator. The output from the comparator is connected internally to the edge detector that controls `P0IFG[5]`. This makes it possible to associate an I/O interrupt with a rising/falling edge on the comparator output. When enabled, the comparator remains active while in power mode 2 or 3. Thus, it is possible to wake up from power mode 2/3 on a rising or falling edge on the comparator output.



S0385-01

Figure 19-1. Analog Comparator

19.2 Register

This section describes the registers for the analog comparator.

CMPCTL (0x62D0) – Analog Comparator Control and Status

Bit	Name	Reset	R/W	Description
7:2	–	0000 00	R0	Reserved
1	EN	0	R/W	Comparator enable
0	OUTPUT	0	R	Comparator output

The I²C module (in the CC2533 only) provides an interface between the device and I²C-compatible devices connected by the two-wire I²C serial bus. External components attached to the I²C bus serially transmit and/or receive serial data to/from the I²C module through the two-wire I²C interface.

The I²C module features include:

- Compliance with the I²C specification v2.1 (published by Philips Semiconductor)
- 7-bit device addressing modes
- General call
- START/RESTART/STOP
- Multi-master transmitter/receiver mode
- Slave receiver/transmitter mode
- Standard mode up to 100-kbps and fast mode up to 400-kbps support

Figure 20-1 shows the block diagram of the I²C module.

On the CC2533, the I²C module is connected to pins 2 and 3 and uses the P2 interrupt to the CPU. Pins 2 and 3 can alternatively be controlled as two GPIO pins if they are not used by the I²C module.

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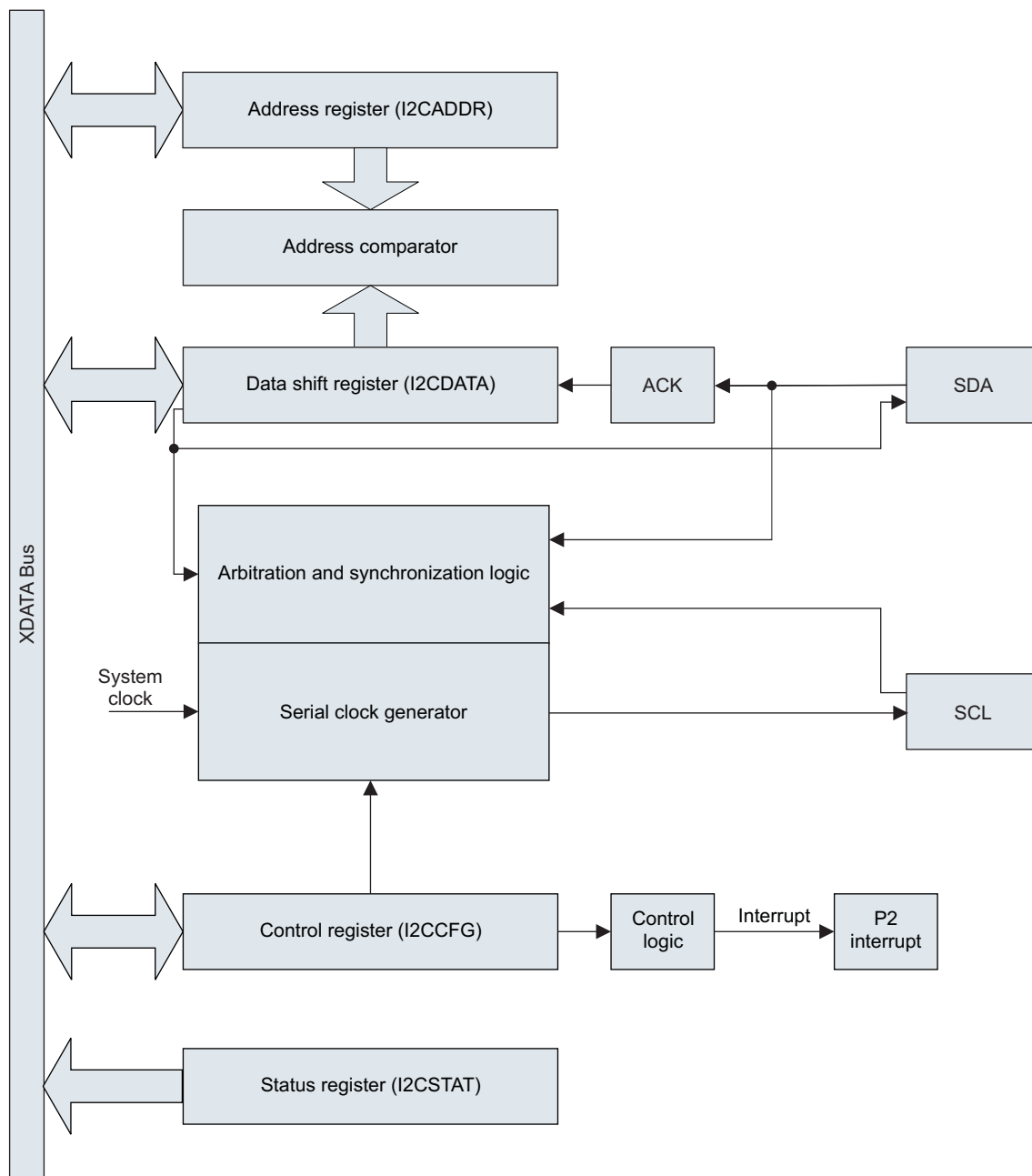


Figure 20-1. Block Diagram of the I²C Module

20.1 Operation

The I²C module supports any slave or master I²C-compatible device. Figure 20-2 shows an example of an I²C bus. Each I²C device is recognized by a unique address and can operate as either a transmitter or a receiver. A device connected to the I²C bus can be considered as the master or the slave when performing data transfers. A master initiates a data transfer and generates the clock signal, SCL. Any device addressed by a master is considered a slave.

I²C data is communicated using the serial data (SDA) pin and the serial clock (SCL) pin. Both SDA and SCL are bidirectional and must be connected to a positive supply voltage using a pullup resistor.

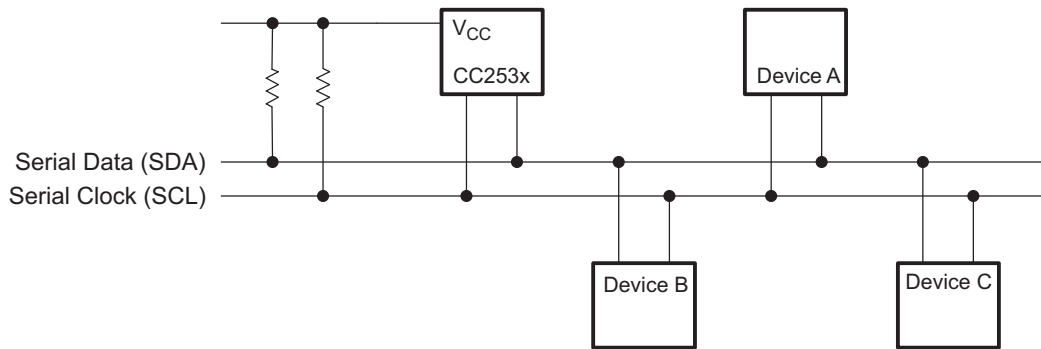


Figure 20-2. I²C Bus Connection Diagram

20.1.1 I²C Initialization and Reset

The I²C module is enabled by setting the `I2CCFG.ENS1` bit. It is then in the not-addressed slave state.

The I²C configuration and state is not retained in power modes PM2 and PM3. It must be reconfigured after coming out of sleep mode.

The I²C module is not reset when disabled, and retains its internal state until the next time `I2CCFG.ENS1` is set.

20.1.2 I²C Serial Data

One clock pulse is generated by the master device for each data bit transferred. The I²C module operates with byte data. Data is transferred MSB first as shown in Figure 20-3.

The first byte after a START condition consists of a 7-bit slave address and the R/\overline{W} bit. When $R/\overline{W} = 0$, the master transmits data to a slave. When $R/\overline{W} = 1$, the master receives data from a slave. The ACK bit is sent from the receiver after each byte on the ninth SCL clock.

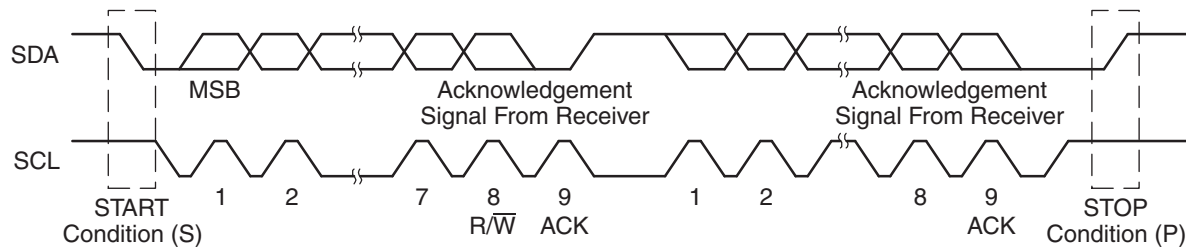
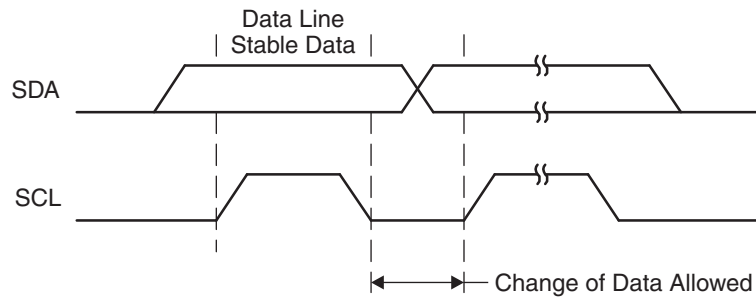


Figure 20-3. I²C Module Data Transfer

START and STOP conditions are generated by the master and are shown in Figure 20-3. A START condition is a high-to-low transition on the SDA line while SCL is high. A STOP condition is a low-to-high transition on the SDA line while SCL is high.

Data on SDA must be stable during the high period of SCL (see Figure 20-4). The state of SDA can only change when SCL is low, otherwise a START or STOP condition is generated.

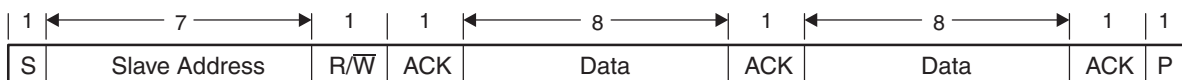

Figure 20-4. Bit Transfer on I²C Bus

20.1.3 I²C Addressing Modes

The I²C module supports 7-bit addressing mode.

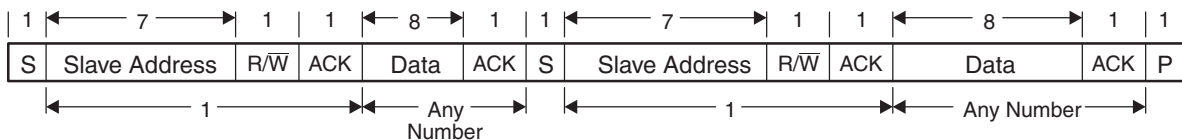
20.1.3.1 7-Bit Addressing

In the 7-bit addressing format (see [Figure 20-5](#)), the first byte is the 7-bit slave address and the R/W bit. The ACK bit is sent from the receiver after each byte.


Figure 20-5. I²C Module 7-Bit Addressing Format

20.1.3.2 Repeated Start Conditions

The direction of data flow on SDA can be changed by the master, without first stopping a transfer, by issuing a repeated START condition. This is called a RESTART. After a RESTART is issued, the slave address is again sent out with the new data direction specified by the R/W bit. The RESTART condition is shown in [Figure 20-6](#).


Figure 20-6. I²C Module Addressing Format With Repeated START Condition

20.1.4 I²C Module Operating Modes

The I²C module can operate in master transmitter, master receiver, slave transmitter, or slave receiver mode. The modes are discussed in the following sections.

20.1.4.1 Slave Mode

Initially, the I²C module is configured in receiver mode by setting the I2CCFG.ENS1 bit to receive the I²C address. Afterwards, transmit and receive operations are controlled automatically, depending on the R/W bit received, together with the slave address.

The I²C slave address is programmed with the I2CADDR.ADDR bits. The value of the I2CADDR.GC bit determines whether the slave responds to a general call.

When a START condition is detected on the bus, the I²C module receives the transmitted address and compares it against its own address stored in I2CADDR.ADDR. If the compare is successful, an interrupt is generated and the I2CCFG.SI bit is set. The same is done for a general call address match if the I2CADDR.GC bit is set.

20.1.4.1.1 I²C Slave Transmitter Mode

Slave transmitter mode is entered when the slave address transmitted by the master is identical to this device's own address with a set R/W bit. The slave transmitter shifts the serial data out on SDA with the clock pulses that are generated by the master device. The slave device does not generate the clock, but it does hold SCL low while intervention of the CPU is required after a byte has been transmitted.

If the master requests data from the slave, the I²C module is automatically configured as a transmitter, and I2CCFG.SI is set. The SCL line is held low until the first data to be sent is written into the data buffer I2CDATA. Then the address is acknowledged and the data is transmitted. After the data is acknowledged by the master, the bus is stalled during the acknowledge cycle by holding SCL low until new data is written into I2CDATA. If the master sends a NACK the I²C module returns to the not-addressed slave state.

Table 20-1 provides more details regarding the slave transmitter operation.

Table 20-1. Slave Transmitter Mode

Status Code (Value of I2CSTAT.STAC)	Status of the I ² C	Application Software Response					Next Action Taken by I ² C Hardware
		To/From I2CDATA	To I2CCFG				
			STA	STO	SI	AA	
0xA8	Own SLA+R has been received; ACK has been returned.	Load data byte or load data byte	X X	0 0	0 0	0 1	Last data byte is transmitted and ACK is received. Data byte is transmitted; ACK is received.
0xB0	Arbitration lost in SLA+R/W as master; own SLA+R has been received; ACK has been returned.	Load data byte or load data byte	X X	0 0	0 0	0 1	Last data byte is transmitted and ACK is received. Data byte is transmitted; ACK is received.
0xB8	Data byte has been transmitted; ACK has been received.	Load data byte or load data byte	X X	0 0	0 0	0 1	Last data byte is transmitted and ACK is received. Data byte is transmitted; ACK is received.
0xC0	Data byte has been transmitted; not-ACK has been received.	No action or no action or no action or no action	0 0 1 1	0 0 0 0	0 0 0 0	0 1 0 1	Switched to not-addressed SLV mode; no recognition of own SLA or general call address Switched to not-addressed SLV mode; own SLA or general call address is recognized. Switched to not-addressed SLV mode; no recognition of own SLA or general call address; START condition is transmitted when the bus becomes free. Switched to not-addressed SLV mode; own SLA or general-call address is recognized; START condition is transmitted when the bus becomes free.

Table 20-1. Slave Transmitter Mode (continued)

Status Code (Value of I2CSTAT.STAC)	Status of the I ² C	Application Software Response					Next Action Taken by I ² C Hardware
		To/From I2CDATA	To I2CCFG				
			STA	STO	SI	AA	
0xC8	Last data byte has been transmitted; ACK has been received.	No action	0	0	0	0	Switched to not-addressed SLV mode; no recognition of own SLA or general call address
		or no action	0	0	0	1	Switched to not-addressed SLV mode; own SLA or general call address is recognized.
		or no action	1	0	0	0	Switched to not-addressed SLV mode; no recognition of own SLA or general call address; START condition is transmitted when the bus becomes free.
		or no action	1	0	0	1	Switched to not-addressed SLV mode; own SLA or general call address is recognized; START condition is transmitted when the bus becomes free.

20.1.4.1.2 I²C Slave Receiver Mode

Slave receiver mode is entered when the slave address transmitted by the master is identical to its own address and a cleared R/ \bar{W} bit is received. In slave receiver mode, serial data bits received on SDA are shifted in with the clock pulses that are generated by the master device. The slave device does not generate the clock, but it can hold SCL low if intervention of the CPU is required after a byte has been received.

If the slave interrupt is triggered from the master, the I²C module is automatically configured as a receiver and I2CCFG.SI is set. After the first data byte is received, the interrupt flag I2CCFG.SI is set again. The I²C module automatically acknowledges the received data.

While the I2CCFG.SI flag is set, the bus is stalled by holding SCL low.

When the master generates a STOP condition, the I2CCFG.STO flag is set.

If the master generates a repeated START condition, the I²C state machine returns to its address reception state.

Table 20-2 provides more details regarding slave receiver operation.

Table 20-2. Slave Receiver Mode

Status Code (Value of I2CSTAT.STAC)	Status of the I ² C	Application Software Response					Next Action Taken by I ² C Hardware
		To/From I2CDATA	To I2CCFG				
			STA	STO	SI	AA	
0x60	Own SLA+W has been received; ACK has been returned.	No action	X	0	0	0	Data byte is received and not-ACK is returned
		or no action	X	0	0	1	Data byte is received and ACK is returned.
0x68	Arbitration lost in SLA+R/ \bar{W} as master; own SLA+W has been received, ACK returned.	No action	X	0	0	0	Data byte is received and not-ACK is returned.
		or no action	X	0	0	1	Data byte is received and ACK is returned.
0x70	General-call address (0x00) has been received; ACK has been returned	No action	X	0	0	0	Data byte is received and not-ACK is returned.
		or no action	X	0	0	1	Data byte is received and ACK is returned.

Table 20-2. Slave Receiver Mode (continued)

Status Code (Value of I2CSTAT.STAC)	Status of the I ² C	Application Software Response				Next Action Taken by I ² C Hardware	
		To/From I2CDATA	To I2CCFG				
			STA	STO	SI		AA
0x78	Arbitration lost in SLA+R/W as master; general-call address has been received, ACK returned.	No action	X	0	0	0	Data byte is received and not-ACK is returned.
		or no action	X	0	0	1	Data byte is received and ACK is returned.
0x80	Previously addressed with own SLV address; DATA has been received, ACK returned.	Read data byte	X	0	0	0	Data byte is received and not-ACK is returned.
		or read data byte	X	0	0	1	Data byte is received and ACK is returned.
0x88	Previously addressed with own SLA; DATA byte has been received, not-ACK returned.	Read data byte	0	0	0	0	Switched to not-addressed SLV mode; no recognition of own SLA or general-call address
		or read data byte	0	0	0	1	Switched to not-addressed SLV mode; own SLA or general call address is recognized.
		or read data byte	1	0	0	0	Switched to not-addressed SLV mode; no recognition of own SLA or general-call address; START condition is transmitted when the bus becomes free.
		or read data byte	1	0	0	1	Switched to not-addressed SLV mode; own SLA or general-call address is recognized; START condition is transmitted when the bus becomes free.
0x90	Previously addressed with general-call address; DATA has been received, ACK returned.	Read data byte	X	0	0	0	Data byte is received and not-ACK is returned.
		or read data byte	X	0	0	1	Data byte is received and ACK is returned.
0x98	Previously addressed with own SLA; DATA byte has been received, not-ACK returned.	Read data byte	0	0	0	0	Switched to not-addressed SLV mode; no recognition of own SLA or general-call address
		or read data byte	0	0	0	1	Switched to not-addressed SLV mode; own SLA or general-call address is recognized.
		or read data byte	1	0	0	0	Switched to not-addressed SLV mode; no recognition of own SLA or general-call address; START condition is transmitted when the bus becomes free.
		or read data byte	1	0	0	1	Switched to not-addressed SLV mode; own SLA or general-call address is recognized; START condition is transmitted when the bus becomes free.
0xA0	A STOP condition or repeated START condition has been received while still addressed as SLV/REC or SLV/TRX.	No action	0	0	0	0	Switched to not-addressed SLV mode; no recognition of own SLA or general-call address
		or no action	0	0	0	1	Switched to not-addressed SLV mode; own SLA or general-call address is recognized.
		or no action	1	0	0	0	Switched to not-addressed SLV mode; no recognition of own SLA or general-call address; START condition is transmitted when the bus becomes free.
		or no action	1	0	0	1	Switched to not-addressed SLV mode; own SLA or general-call address is recognized; START condition is transmitted when the bus becomes free.

20.1.4.2 Master Mode

The I²C module is configured as an I²C master by setting the I2CCFG.ENS1 and I2CCFG.STA bits. When the master is part of a multi-master system, its own address must be programmed into the I2CADDR.ADDR register. The value of the I2CADDR.GC bit determines whether the I²C module responds to a general call.

20.1.4.2.1 I²C Master Transmitter Mode

To enable master transmit mode, set the I2CCFG.ENS1 and I2CCFG.STA bits. The I²C module then waits until the I²C bus is free. When the I²C bus is free, it generates a START condition, sends the slave address, and transfers a transmit direction bit. It then generates an interrupt, and the first byte of data can be written to the I2CDATA register. The I²C core sends I2CDATA content if arbitration is not lost, and then generates another interrupt. The I2CSTAT register contains a value of 0x18 or 0x20, depending on the received ACK bit (see Table 20-3). If a not-ACK is received from the slave, the master must react with either a repeated START condition or a STOP condition. Setting I2CCFG.STA during transmission causes a repeated START condition to be transmitted. Setting I2CCFG.STO during transmission causes a STOP condition to be transmitted and the I2CCFG.STO bit to be reset.

Table 20-3 provides more details regarding the master transmitter operation.

Table 20-3. Master Transmitter Mode

Status Code (Value of I2CSTAT.STAC)	Status of the I ² C	Application Software Response					Next Action Taken by I ² C Hardware
		To/From I2CDATA	To I2CCFG				
			STA	STO	SI	AA	
0x08	A START condition has been transmitted.	Load SLA+W	X	0	0	X	SLA+W is transmitted. ACK is received.
0x10	A repeated START condition has been transmitted.	Load SLA+W or load SLA+R	X X	0 0	0 0	X X	As for START condition (0x08) SLA+W is transmitted; I ² C is switched to MST/REC mode.
0x18	SLA+W has been transmitted; ACK has been received.	Load data byte or no action or no action or no action	0 1 0 1	0 0 1 1	0 0 0 0	X X X X	Data byte is transmitted; ACK is received. Repeated START is transmitted. STOP condition is transmitted; STO flag is reset. STOP condition followed by a START condition is transmitted; STO flag is reset.
0x20	SLA+W has been transmitted; not-ACK has been received.	Load data byte or no action or no action or no action	0 1 0 1	0 0 1 1	0 0 0 0	X X X X	Data byte is transmitted; ACK is received. Repeated START is transmitted. STOP condition is transmitted; STO flag is reset. STOP condition followed by a START condition is transmitted; STO flag is reset.
0x28	Data byte is transmitted; ACK is received.	Load data byte or no action or no action or no action	0 1 0 1	0 0 1 1	0 0 0 0	X X X X	Data byte is transmitted; ACK is received. Repeated START is transmitted. STOP condition is transmitted; STO flag is reset. STOP condition followed by a START condition is transmitted; STO flag is reset.

Table 20-3. Master Transmitter Mode (continued)

Status Code (Value of I2CSTAT.STAC)	Status of the I ² C	Application Software Response					Next Action Taken by I ² C Hardware
		To/From I2CDATA	To I2CCFG				
			STA	STO	SI	AA	
0x30	Data byte in I2CDATA has been transmitted.	Data byte	0	0	0	X	Data byte is transmitted; ACK is received.
		or no action	1	0	0	X	Repeated START is transmitted.
		or no action	0	1	0	X	STOP condition is transmitted; STO flag is reset.
		or no action	1	1	0	X	STOP condition followed by a START condition is transmitted; STO flag is reset.
0x38	Arbitration lost in SLA+R/W or data bytes	No action	0	0	0	X	I ² C bus is released; not-addressed slave is entered.
		or no action	1	0	0	X	A START condition is transmitted when the bus becomes free.

20.1.4.2.2 I²C Master Receiver Mode

To enable master receive mode, set the I2CCFG.ENS1 and the I2CCFG.STA bits. The I²C module then waits until the I²C bus is free. When the I²C bus is free, it generates a START condition, sends the slave address, and transfers a receive direction bit. It then generates an interrupt, and the first byte is received.

Table 20-4 provides more details regarding the master receiver operation.

Table 20-4. Master Receiver Mode

Status Code (Value of I2CSTAT.STAC)	Status of the I ² C	Application Software Response					Next Action Taken by I ² C Hardware
		To/From I2CDATA	To I2CCFG				
			STA	STO	SI	AA	
0x08	A START condition has been transmitted.	Load SLA+R	X	0	0	X	SLA+R is transmitted. ACK is received.
0x10	A repeated START condition has been transmitted.	Load SLA+R	X	0	0	X	As above
		or load SLA+W	X	0	0	X	SLA+W is transmitted; I ² C is switched to MST/TRX mode.
0x38	Arbitration lost in not-ACK bit.	No action	0	0	0	X	I ² C bus is released; I ² C enters slave mode.
		or no action	1	0	0	X	A start condition is transmitted when the bus becomes free.
0x40	SLA+R has been transmitted; ACK has been received.	No action	0	0	0	0	Data byte is received; not-ACK is returned.
		or no action	0	0	0	1	Data byte is received; ACK is returned.
0x48	SLA+R has been transmitted; not-ACK has been received.	No action	1	0	0	X	Repeated START condition is transmitted.
		or no action	0	1	0	X	STOP condition is transmitted; STO flag is reset.
		or no action	1	1	0	X	STOP condition followed by a START condition is transmitted; STO flag is reset.
0x50	Data byte has been received; ACK has been returned.	Read data byte	0	0	0	0	Data byte is received; not-ACK is returned.
		or read data byte	0	0	0	1	Data byte is received; ACK is returned

Table 20-4. Master Receiver Mode (continued)

Status Code (Value of I2CSTAT.STAC)	Status of the I2C	Application Software Response					Next Action Taken by I ² C Hardware
		To/From I2CDATA	To I2CCFG				
			STA	STO	SI	AA	
0x58	Data byte has been received; not-ACK has been returned.	Read data byte	1	0	0	X	Repeated START condition is transmitted. STOP condition is transmitted; STO flag is reset.
		or read data byte	0	1	0	X	
		or read data byte	1	1	0	X	STOP condition followed by a START condition is transmitted; STO flag is reset.

20.1.4.3 Arbitration

If two or more master transmitters simultaneously start a transmission on the bus, an arbitration procedure is invoked. [Figure 20-7](#) shows the arbitration procedure between two devices. The arbitration procedure uses the data presented on SDA by the competing transmitters. The first master transmitter that generates a logic high is overruled by the opposing master generating a logic low. The arbitration procedure gives priority to the device that transmits the serial data stream with the lowest binary value. The master transmitter that lost arbitration switches to the slave receiver mode. If two or more devices send identical first bytes, arbitration continues on the subsequent bytes.

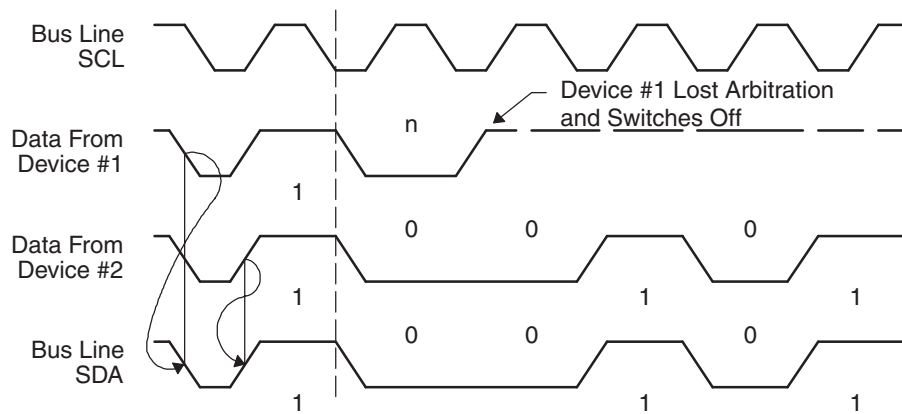


Figure 20-7. Arbitration Procedure Between Two Master Transmitters

20.1.5 I²C Clock Generation and Synchronization

The I²C clock SCL is provided by the master on the I²C bus. When the I²C module is in master mode, the serial clock generator generates the SCL clock from the system clock. The serial clock generator is switched off when the I²C module is in slave mode.

The frequency of the SCL is determined by the system clock frequency, and the division factor given by the I2CCFG.CR_x bits. Example frequencies for a 32-MHz system clock are given in the I2CCFG register description.

During the arbitration procedure, the clocks from the different masters must be synchronized. A device that first generates a low period on SCL overrules the other devices, forcing them to start their own low periods. SCL is then held low by the device with the longest low period. The other devices must wait for SCL to be released before starting their high periods. [Figure 20-8](#) shows the clock synchronization. This allows a slow slave to slow down a fast master.

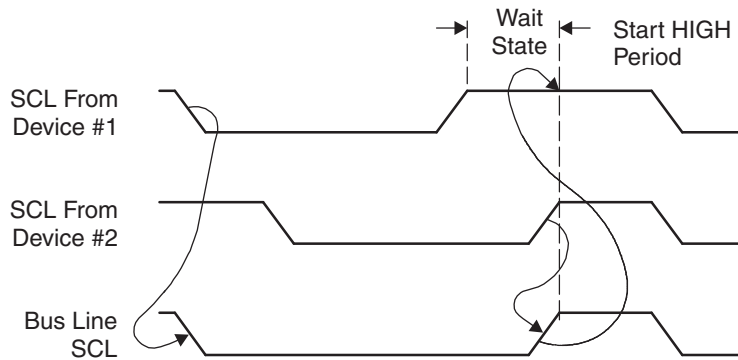


Figure 20-8. Synchronization of Two I²C Clock Generators During Arbitration

20.1.6 Bus Error

When an incorrect format of a frame is detected, a bus error condition is entered. The cause is that a START or STOP condition was detected during transfer of an address, data, or an acknowledge bit. When a bus error condition is entered, an interrupt is requested. The core leaves the bus error state when the I2CCFG.STO flag is set and the interrupt request is cleared. It goes into the slave mode and the I2CCFG.STO flag is automatically reset. The SDA and SCL lines are released (the STOP condition is not transmitted).

Table 20-5. Miscellaneous States

Status Code (Value of I2CSTAT.STAC)	Status of the I ² C	Application Software Response				Next Action Taken by I ² C Hardware	
		To/From I2CDATA	To I2CCFG				
			STA	STO	SI		AA
0x00	Bus error during MST or selected slave modes	No action	0	1	0	X	Only the internal hardware is affected in the MST or addressed SLV modes. In all cases, the bus is released and I ² C is switched to the not-addressed SLV mode. The Sto flag is reset.

20.1.7 I²C Interrupt

The I²C module has an interrupt line to the CPU to signal that it requires service. The I²C module uses interrupt #6, which is also shared with Port 2 inputs; hence, the interrupt routine must also handle Port 2 interrupts if they are enabled.

For an interrupt request to be generated, IEN2.P2IE must be set to 1. When an interrupt request has been generated, the CPU starts executing the ISR if there are no higher-priority interrupts pending.

An interrupt is generated from the I²C module when one of the 26 out of 27 possible I²C component states is entered. The only state that does not cause an interrupt to be generated is state 0xF8, which indicates that no relevant state information is available. The corresponding I2CCFG.SI flag must be cleared by software at the end of the ISR.

20.1.8 I²C Pins

The SCL and SDA pins of the I²C module are connected to pins 2 and 3, respectively, on the CC2533. These pins are pulled up during reset to avoid floating pins. After reset, they are controlled by the I²C module and use an internal pullup resistor of 20 kΩ to hold bus signals high. If these pins are not to be used for I²C, they can be used as GPIO by setting the I2CWC.OVR bit. In this mode, pins 2 and 3 can be set up as outputs, as inputs with optional pullup, or as 4-mA drive-strength outputs like the other GPIO pads on the device by using the configuration bits in I2CWC. Their values are read or controlled using the I2CIO register. These pins cannot be configured to generate GPIO interrupts.

20.2 I²C Registers

This section describes all I²C registers used for control and status of the I²C module.

The registers return to their reset values when the chip enters PM2 or PM3.

I2CCFG (0x6230) – I²C Control

Bit	Name	Reset	R/W	Description
7	CR2	0	R/W	Clock rate bit 2
6	ENS1	0	R/W	Enable bit. 0: I ² C module disabled. SCL and SDA are set to high impedance inputs. The inputs are ignored by the I ² C module. Note that setting ENS1 = 0 disables the I ² C module but does not reset its state. 1: I ² C module enabled.
5	STA	0	R/W	START flag. When set, HW detects when I ² C is free and generates a START condition.
4	STO	0	R/W1	STOP flag. When set and in master mode, a STOP condition is transmitted on the I ² C bus. HW is cleared when transmit has completed successfully.
3	SI	0	R/W0	Interrupt flag
2	AA	0	R/W	Assert acknowledge flag for the I ² C module. When set (AA = 1), an acknowledge is returned when: <ul style="list-style-type: none"> • Slave address is recognized • General call is recognized, when the I²C module is enabled • Data byte received while in master/slave receive mode When not set (AA = 0), an acknowledge is returned when: <ul style="list-style-type: none"> • Data byte is received while in master/slave receive mode
1	CR1	0	R/W	Clock rate bit 1
0	CR0	0	R/W	Clock rate bit 0

Table 20-6. Clock Rates Defined at 32 MHz

CR2	CR1	CR0	Bit Frequency (kHz)	Clock Divided by
0	0	0	123	256
0	0	1	144	244
0	1	0	165	192
0	1	1	197	160
1	0	0	33	960
1	0	1	267	120
1	1	0	533	60
1	1	1	Reserved	N/A

I2CSTAT (0x6231) – I²C Status

Bit	Name	Reset	R/W	Description
7:3	STAC	1111 1	R	Status code. Contains the state of the I ² C core. 27 states are defined: 0 to 25 and 31. Interrupt is only requested when in states 0 to 25. The value 0xF8 indicates that there is no relevant state information available and that I2CCFG.SI = 0.
2:0	–	000	R0	Reserved

I2CDATA (0x6232) – I²C Data

Bit	Name	Reset	R/W	Description
7:0	SD	0000 00 00	R/W	Serial data in/out (MSB is bit 7, LSB is bit 0). Contains data byte to be transmitted or byte which has just been received. Can be read or written while not in the process of shifting a byte. The register is not shadowed or double buffered, so it should only be accessed upon an interrupt.

I2CADDR (0x6233) – I²C Own Slave Address

Bit	Name	Reset	R/W	Description
7:1	ADDR	0000 00 0	R/W	Own slave address
0	GC	0	R/W	General-call address acknowledge. If set, the general-call address is recognized.

I2CWC (0x6234) – Wrapper control

Bit	Name	Reset	R/W	Description
7	OVR	0	R/W	Override enable: 0: I ² C functionality (ignore other bits in this register) 1: GPIO functionality.-
6:4	–	000	R0	Reserved
3	SCLPUE	1	R/W	SCL pin pullup enable
2	SDAPUE	1	R/W	SDA pin pullup enable
1	SCLOE	0	R/W	SCL pin output enable
0	SDAOE	0	R/W	SDA pin output enable

I2CIO (0x6235) – GPIO

Bit	Name	Reset	R/W	Description
7:2	–	000	R0	Reserved
1	SCLD	0	R/W	SCL data value When I2CWC . SCLOE is set, reading SCLD reads the output register, not the pin. When I2CWC . SCLOE is cleared, reading SCLD reads the pin. Writing SCLD writes to the output register.
0	SDAD	0	R/W	SDA data value When I2CWC . SDAOE is set, reading SDAD reads the output register, not the pin. When I2CWC . SDAOE is cleared, reading SDAD reads the pin. Writing SDAD writes to the output register.

USB Controller

This section focuses on describing the functionality of the USB controller (in the CC2531/CC2540 only), and it is assumed that the reader has a good understanding of USB and is familiar with the terms and concepts used. See the Universal Serial Bus Specification for details [3].

Standard USB nomenclature is used regarding IN and OUT. I.e., IN is always into the host (PC) and OUT is out of the host.

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21.1 USB Introduction

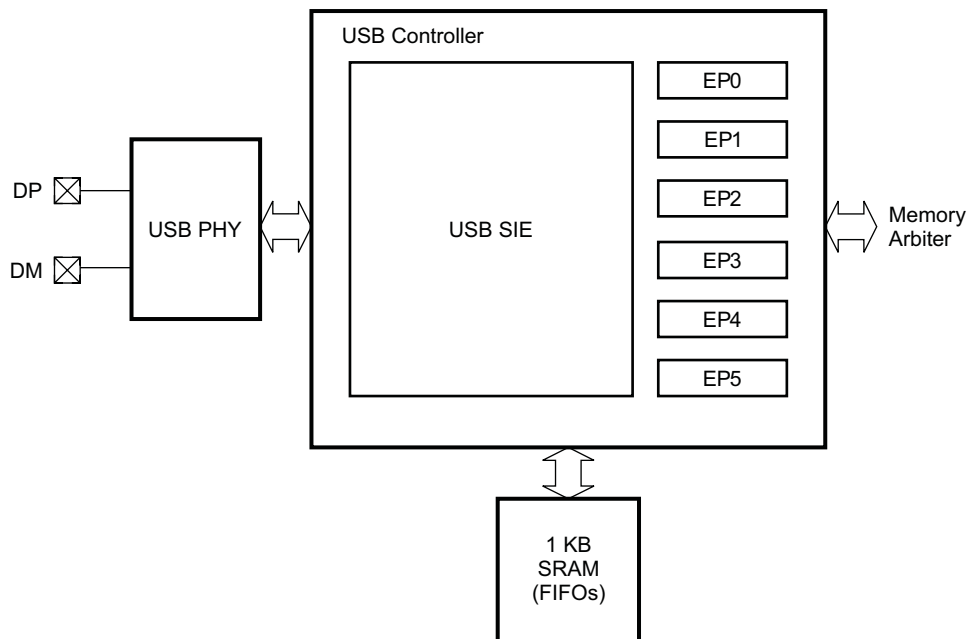
The USB controller monitors the USB for relevant activity and handles packet transfers.

Appropriate response to USB interrupts and loading/unloading of packets into/from endpoint FIFOs is the responsibility of the firmware. The firmware must be able to reply correctly to all standard requests from the USB host and work according to the protocol implemented in the driver on the PC.

The USB controller has the following features:

- Full-speed operation (up to 12 Mbps)
- Five endpoints (in addition to endpoint 0) that can be used as IN, OUT, or IN/OUT and can be configured as bulk/interrupt or isochronous.
- 1-KB SRAM FIFO available for storing USB packets
- Endpoints supporting packet sizes from 8–512 bytes
- Support for double buffering of USB packets

Figure 21-1 shows a block diagram of the USB controller. The USB PHY is the physical interface with input and output drivers. The USB SIE is the serial-interface engine, which controls the packet transfer to/from the endpoints. The USB controller is connected to the rest of the system through the memory arbiter.



B0305-01

Figure 21-1. USB Controller Block Diagram

21.2 USB Enable

The USB is enabled by setting `USBCTRL.USB_EN` to 1. Setting `USBCTRL.USB_EN` to 0 resets the USB controller.

21.3 48-MHz USB PLL

The 48-MHz internal USB PLL must be powered up and stable for the USB controller to operate correctly. It is important that the crystal oscillator is selected as source and is stable before the USB PLL is enabled. The USB PLL is enabled by setting the `USBCTRL.PLL_EN` bit and waiting for the `USBCTRL.PLL_LOCKED` status flag to go high. When the PLL has locked, it is safe to use the USB controller.

Note: The PLL must be disabled before exiting active mode and re-enabled after entering active mode.

21.4 USB Interrupts

There are three interrupt flag registers with associated interrupt-enable mask registers.

Table 21-1. USB Interrupt Flags Interrupt-Enable Mask Registers

Interrupt Flag	Description	Associated Interrupt Enable Mask Register
USBCIF	Contains flags for common USB interrupts	USBCIE
USBIIF	Contains interrupt flags for endpoint 0 and all the IN endpoints	USBIIE
USBOIF	Contains interrupt flags for all OUT endpoints	USBOIE

Note: All interrupts except SOF and suspend are initially enabled after reset.

The USB controller uses interrupt #6 for USB interrupts. This interrupt number is shared with Port 2 inputs; hence, the interrupt routine must also handle Port 2 interrupts if they are enabled. For an interrupt request to be generated, `IEN2.P2IE` must be set to 1 together with the desired interrupt enable bits from the `USBCIE`, `USBIIE`, and `USBOIE` registers. When an interrupt request has been generated, the CPU starts executing the ISR if there are no higher-priority interrupts pending. The interrupt routine should read all the interrupt flag registers and take action depending on the status of the flags. The interrupt flag registers are cleared when they are read, and the status of the individual interrupt flags should therefore be saved in memory (typically in a local variable on the stack) to allow them to be accessed multiple times.

At the end of the ISR, after the interrupt flags have been read, the interrupt flags should be cleared to allow for new USB and P2 interrupts to be detected. The Port 2 interrupt status flags in the `P2IFG` register should be cleared prior to clearing `IRCON2.P2IF`.

When waking up from suspend (typically in PM1), the USB D+ interrupt flag, `P2IFG.DPIF`, is set. The D+ interrupt flag indicates that there has been a falling edge on the D+ USB data pin. This is a resume event.

21.5 Endpoint 0

Endpoint 0 (EP0) is a bidirectional control endpoint, and during the enumeration phase all communication is performed across this endpoint. Before the `USBADDR` register has been set to a value other than 0, the USB controller is only able to communicate through endpoint 0. Setting the `USBADDR` register to a value between 1 and 127 brings the USB function out of the default state in the enumeration phase and into the address state. All configured endpoints are then available for the application.

The EP0 FIFO is only used as either IN or OUT, and double buffering is not provided for endpoint 0. The maximum packet size for endpoint 0 is fixed at 32 bytes.

Endpoint 0 is controlled through the `USBCS0` register by setting the `USBINDEX` register to 0. The `USBCNT0` register contains the number of bytes received.

21.6 Endpoint-0 Interrupts

The following events may generate an EP0 interrupt request:

- A data packet has been received (`USBCS0.OUTPKT_RDY = 1`)
- A data packet that was loaded into the EP0 FIFO has been sent to the USB host. (`USBCS0.INPKT_RDY` should be set to 1 when a new packet is ready to be transferred. This bit is cleared by hardware when the data packet has been sent.)
- An IN transaction has been completed (the interrupt is generated during the status stage of the transaction).
- A STALL has been sent (`USBCS0.SENT_STALL = 1`)
- A control transfer ends due to a premature end-of-control transfer (`USBCS0.SETUP_END = 1`)

Any of these events causes `USBIIF.EP0IF` to be asserted, regardless of the status of the EP0 interrupt mask bit `USBIIE.EP0IE`. If the EP0 interrupt mask bit is set to 1, the CPU interrupt flag `IRCON2.P2IF` is also asserted. An interrupt request is only generated if `IEN2.P2IE` and `USBIIE.EP0IE` are both set to 1.

21.6.1 Error Conditions

When a protocol error occurs, the USB controller sends a STALL handshake. The `USBCS0.SENT_STALL` bit is asserted, and an interrupt request is generated if the endpoint-0 interrupt is properly enabled. A protocol error can be any of the following:

- An OUT token is received after `USBCS0.DATA_END` has been set to complete the OUT data stage (the host tries to send more data than expected).
- An IN token is received after `USBCS0.DATA_END` has been set to complete the IN data stage (the host tries to receive more data than expected).
- The USB host tries to send a packet that exceeds the maximum packet size during the OUT data stage.
- The size of the DATA1 packet received during the status stage is not 0.

The firmware can also terminate the current transaction by setting the `USBCS0.SEND_STALL` bit to 1. The USB controller then sends a STALL handshake in response to the next request from the USB host.

If an EP0 interrupt is caused by the assertion of the `USBCS0.SENT_STALL` bit, this bit should be de-asserted, and firmware should consider the transfer as aborted (and consequently free the memory buffers, etc.).

If EP0 receives an unexpected token during the data stage, the `USBCS0.SETUP_END` bit is asserted, and an EP0 interrupt is generated (if enabled properly). EP0 then switches to the IDLE state. Firmware should then set the `USBCS0.CLR_SETUP_END` bit to 1 and abort the current transfer. If `USBCS0.OUTPKT_RDY` is asserted, this indicates that another setup packet has been received that firmware should process.

21.6.2 SETUP Transactions (IDLE State)

The control transfer consists of two or three stages of transactions (setup – data – status or setup – status). The first transaction is a setup transaction. A successful setup transaction comprises three sequential packets (a token packet, a data packet, and a handshake packet), where the data field (payload) of the data packet is exactly 8 bytes long and is referred to as the setup packet. In the setup stage of a control transfer, EP0 is in the IDLE state. The USB controller rejects the data packet if the setup packet is not 8 bytes. Also, the USB controller examines the contents of the setup packet to determine whether or not there is a data stage in the control transfer. If there is a data stage, EP0 switches state to TX (IN transaction) or RX (OUT transaction) when the `USBCS0.CLR_OUTPKT_RDY` bit is set to 1 (if `USBCS0.DATA_END = 0`).

When a packet is received, the `USBCS0.OUTPKT_RDY` bit is asserted and an interrupt request is generated (EP0 interrupt) if the interrupt has been enabled. Firmware should perform the following when a setup packet has been received:

1. Unload the setup packet from the EP0 FIFO
2. Examine the contents and perform the appropriate operations
3. Set the `USBCS0.CLR_OUTPKT_RDY` bit to 1. This denotes the end of the setup stage. If the control transfer has no data stage, the `USBCS0.DATA_END` bit must also be set. If there is no data stage, the USB controller stays in the IDLE state.

21.6.3 IN Transactions (TX State)

If the control transfer requires data to be sent to the host, the setup stage is followed by one or more IN transactions in the data stage. In this case, the USB controller is in the TX state and only accepts IN tokens. A successful IN transaction comprises two or three sequential packets (a token packet, a data packet, and a handshake packet⁽¹⁾). If more than 32 bytes (maximum packet size) is to be sent, the data must be split into a number of 32-byte packets followed by a residual packet. If the number of bytes to send is a multiple of 32, the residual packet is a zero-length data packet, because a packet size less than 32 bytes denotes the end of the transfer.

Firmware should load the EP0 FIFO with the first data packet and set the `USBCS0.INPKT_RDY` bit as

⁽¹⁾ For isochronous transfers there would not be a handshake packet from the host.

soon as possible after the `USBCS0.CLR_OUTPKT_RDY` bit has been set. The `USBCS0.INPKT_RDY` is cleared and an EP0 interrupt is generated when the data packet has been sent. Firmware might then load more data packets as necessary. An EP0 interrupt is generated for each packet sent. Firmware must set `USBCS0.DATA_END` in addition to `USBCS0.INPKT_RDY` when the last data packet has been loaded. This starts the status stage of the control transfer.

EP0 switches to the IDLE state when the status stage has completed. The status stage may fail if the `USBCS0.SEND_STALL` bit is set to 1. The `USBCS0.SEND_STALL` bit is then asserted, and an EP0 interrupt is generated.

If `USBCS0.INPKT_RDY` is not set when receiving an IN token, the USB controller replies with a NAK to indicate that the endpoint is working, but temporarily has no data to send.

21.6.4 OUT Transactions (RX State)

If the control transfer requires data to be received from the host, the setup stage is followed by one or more OUT transactions in the data stage. In this case, the USB controller is in the RX state and only accepts OUT tokens. A successful OUT transaction comprises two or three sequential packets (a token packet, a data packet, and a handshake packet⁽²⁾). If more than 32 bytes (maximum packet size) is to be received, the data must be split into a number of 32-byte packets followed by a residual packet. If the number of bytes to receive is a multiple of 32, the residual packet is a zero-length data packet, because a data packet with payload less than 32 bytes denotes the end of the transfer.

The `USBCS0.OUTPKT_RDY` bit is set and an EP0 interrupt is generated when a data packet has been received. The firmware should set `USBCS0.CLR_OUTPKT_RDY` when the data packet has been unloaded from the EP0 FIFO. When the last data packet has been received (packet size less than 32 bytes) firmware should also set the `USBCS0.DATA_END` bit. This starts the status stage of the control transfer. The size of the data packet is kept in the `USBCNT0` registers. Note that this value is only valid when `USBCS0.OUTPKT_RDY = 1`.

EP0 switches to the IDLE state when the status stage has completed. The status stage may fail if the DATA1 packet received is not a zero-length data packet or if the `USBCS0.SEND_STALL` bit is set to 1. The `USBCS0.SEND_STALL` bit then is asserted and an EP0 interrupt is generated.

21.7 Endpoints 1–5

Each endpoint can be used as an IN only, an OUT only, or IN/OUT. For an IN/OUT endpoint, there are basically two endpoints, an IN endpoint and an OUT endpoint associated with the endpoint number. Configuration and control of IN endpoints is performed through the `USBCSIL` and `USBCSIH` registers. The `USBCSOL` and `USBCSOH` registers are used to configure and control OUT endpoints. Each IN and OUT endpoint can be configured as either an isochronous (`USBCSIH.ISO = 1` and/or `USBCSOH.ISO = 1`) or bulk/interrupt (`USBCSIH.ISO = 0` and/or `USBCSOH.ISO = 0`) endpoint. Bulk and interrupt endpoints are handled identically by the USB controller but have different properties from a firmware perspective.

The `USBINDEX` register must have the value of the endpoint number before the indexed endpoint registers are accessed.

21.7.1 FIFO Management

Each endpoint has a certain number of FIFO memory bytes available for incoming and outgoing data packets. [Table 21-2](#) shows the FIFO size for endpoints 1–5. The firmware is responsible for setting the `USBMAXI` and `USBMAXO` registers correctly for each endpoint to prevent data from being overwritten.

When both the IN and OUT endpoints of an endpoint number do not use double buffering, the sum of `USBMAXI` and `USBMAXO` must not exceed the FIFO size for the endpoint. [Figure 21-2 a\)](#) shows how the IN and OUT FIFO memory for an endpoint is organized with single buffering. The IN FIFO grows down from the top of the endpoint memory region, whereas the OUT FIFO grows up from the bottom of the endpoint memory region.

⁽²⁾ For isochronous transfers, there is no handshake packet from the device.

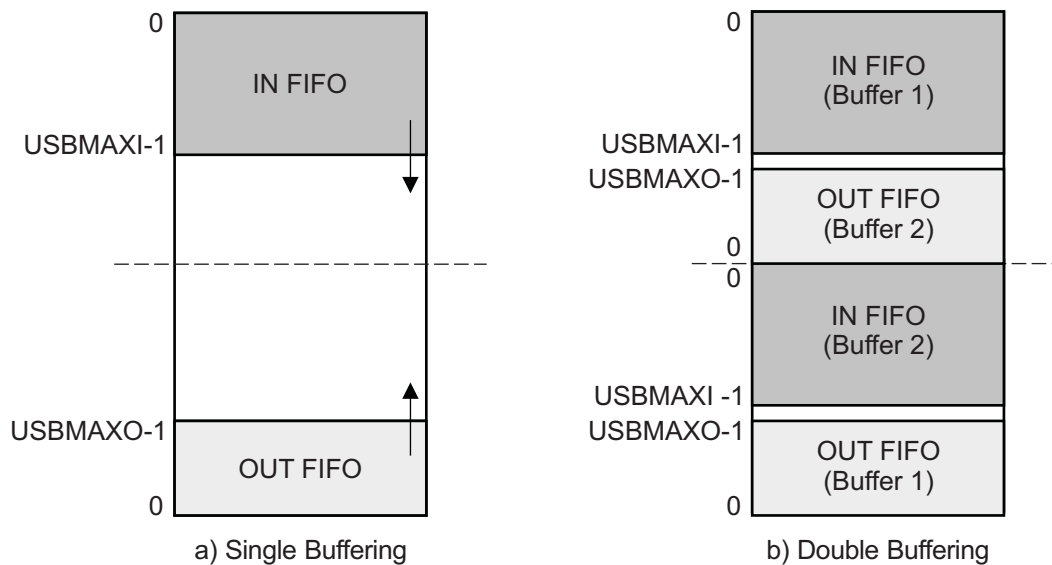
When the IN or OUT endpoint of an endpoint number uses double buffering, the sum of `USBMAXI` and `USBMAXO` must not exceed half the FIFO size for the endpoint. Figure 21-2 b) illustrates the IN and OUT FIFO memory for an endpoint that uses double buffering. Notice that the second OUT buffer starts from the middle of the memory region and grows upwards. The second IN buffer also starts from the middle of the memory region but grows downwards.

To configure an endpoint as IN-only, set `USBMAXO` to 0, and to configure an endpoint as OUT-only, set `USBMAXI` to 0.

For unused endpoints, both `USBMAXO` and `USBMAXI` should be set to 0.

Table 21-2. FIFO Sizes for EP 1–5

EP Number	FIFO Size (in Bytes)
1	32
2	64
3	128
4	256
5	512



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Figure 21-2. IN/OUT FIFOs

21.7.2 Double Buffering

To enable faster transfer and reduce the need for retransmissions, double buffering can be used. This allows two packets to be buffered in the FIFO in each direction. This is highly recommended for isochronous endpoints, which are expected to transfer one data packet every USB frame without any retransmission. For an isochronous endpoint, one data packet is sent/received every USB frame. However, the data packet may be sent/received at any time during the USB frame period, and there is a chance that two data packets may be sent/received at a few-microseconds interval. For isochronous endpoints, an incoming packet is lost if there is no buffer available, and a zero-length data packet is sent if there is no data packet ready for transmission when the USB host requests data. Double buffering is not as critical for bulk and interrupt endpoints as it is for isochronous endpoints, because packets are not lost. Double buffering, however, may improve the effective data rate for bulk endpoints.

To enable double buffering for an IN endpoint, `USBCSIH.IN_DBL_BUF` must be set to 1. To enable double buffering for an OUT endpoint, set `USBCSOH.OUT_DBL_BUF` to 1.

21.7.3 FIFO Access

The endpoint FIFOs are accessed by reading and writing to the registers USBF0–USBF6. Writing to a register causes the byte written to be inserted into the IN FIFO. Reading a register causes the next byte in the OUT FIFO to be extracted and the value of this byte to be returned.

When a data packet has been written to an IN FIFO, the `USBCSIL.INPKT_RDY` bit must be set to 1. If double buffering is enabled, the `USBCSIL.INPKT_RDY` bit is cleared immediately after it has been written, and another data packet can be loaded. This does not generate an IN endpoint interrupt, because an interrupt is only generated when a packet has been sent. When double buffering is used, firmware should check the status of the `USBCSIL.PKT_PRESENT` bit before writing to the IN FIFO. If this bit is 0, two data packets can be written. Double-buffered isochronous endpoints should only load two packets the first time the IN FIFO is loaded. After that, one packet is loaded for every USB frame. To send a zero-length data packet, `USBCSIL.INPKT_RDY` should be set to 1 without loading a data packet into the IN FIFO.

A data packet can be read from the OUT FIFO when the `USBCSOL.OUTPKT_RDY` bit is 1. An interrupt is generated when this occurs, if enabled. The size of the data packet is kept in the `USBCNTH:USBCNTL` registers. Note that this value is only valid when `USBCSOL.OUTPKT_RDY = 1`. When the data packet has been read from the OUT FIFO, the `USBCSOL.OUTPKT_RDY` bit must be cleared. If double buffering is enabled, there may be two data packets in the FIFO. If another data packet is ready when the `USBCSOL.OUTPKT_RDY` bit is cleared, the `USBCSOL.OUTPKT_RDY` bit is asserted immediately, and an interrupt is generated (if enabled) to signal that a new data packet has been received. The `USBCSOL.FIFO_FULL` bit is set when there are two data packets in the OUT FIFO.

The AutoClear feature is supported for OUT endpoints. When enabled, the `USBCSOL.OUTPKT_RDY` bit is cleared automatically when `USBMAXO` bytes have been read from the OUT FIFO. The AutoClear feature is enabled by setting `USBCSOH.AUTOCLEAR = 1`. The AutoClear feature can be used to reduce the time the data packet occupies the OUT FIFO buffer and is typically used for bulk endpoints.

A complementary AutoSet feature is supported for IN endpoints. When enabled, the `USBCSIL.INPKT_RDY` bit is set automatically when `USBMAXI` bytes have been written to the IN FIFO. The AutoSet feature is enabled by setting `USBCSIH.AUTOSSET = 1`. The AutoSet feature can reduce the overall time it takes to send a data packet and is typically used for bulk endpoints.

21.7.4 Endpoint 1–5 Interrupts

The following events may generate an IN EPx interrupt request (x indicates the endpoint number):

- A data packet that was loaded into the IN FIFO has been sent to the USB host. (`USBCSIL.INPKT_RDY` should be set to 1 when a new packet is ready to be transferred. This bit is cleared by hardware when the data packet has been sent.)
- A STALL has been sent (`USBCSIL.SENT_STALL = 1`). Only bulk/interrupt endpoints can be stalled
- The IN FIFO is flushed due to the `USBCSIH.FLUSH_PACKET` bit being set to 1.

Any of these events causes `USBIIF.INEPxIF` to be asserted, regardless of the status of the IN EPx interrupt mask bit `USBIIE.INEPxIE`. If the IN EPx interrupt mask bit is set to 1, the CPU interrupt flag `IRCON2.P2IF` is also asserted. An interrupt request is only generated if `IEN2.P2IE` and `USBIIE.INEPxIE` are both set to 1. The x in the register name refers to the endpoint number, 1–5)

The following events may generate an OUT EPx interrupt request:

- A data packet has been received (`USBCSOL.OUTPKT_RDY = 1`).
- A STALL has been sent (`USBCSIL.SENT_STALL = 1`). Only bulk/interrupt endpoints can be stalled.

Any of these events causes `USBOIF.OUTEPxIF` to be asserted, regardless of the status of the OUT EPx interrupt mask bit `USBOIE.OUTEPxIE`. If the OUT EPx interrupt mask bit is set to 1, the CPU interrupt flag `IRCON2.P2IF` is also asserted. An interrupt request is only generated if `IEN2.P2IE` and `USBOIE.OUTEPxIE` are both set to 1.

21.7.5 Bulk/Interrupt IN Endpoint

Interrupt IN transfers occur at regular intervals, whereas bulk IN transfers use available bandwidth not allocated to isochronous, interrupt, or control transfers.

Interrupt IN endpoints may set the `USBCSIH.FORCE_DATA_TOG` bit. When this bit is set, the data toggle bit is continuously toggled, regardless of whether an ACK was received or not. This feature is typically used by interrupt IN endpoints that are used to communicate rate feedback for isochronous endpoints.

A bulk/interrupt IN endpoint can be stalled by setting the `USBCSIL.SEND_STALL` bit to 1. When the endpoint is stalled, the USB controller responds with a STALL handshake to IN tokens. The `USBCSIL.SENT_STALL` bit is then set, and an interrupt is generated, if enabled.

A bulk transfer longer than the maximum packet size is performed by splitting the transfer into a number of data packets of maximum size followed by a smaller data packet containing the remaining bytes. If the transfer length is a multiple of the maximum packet size, a zero-length data packet is sent last. This means that a packet with a size less than the maximum packet size denotes the end of the transfer. The AutoSet feature can be useful in this case, because many data packets are of maximum size.

21.7.6 Isochronous IN Endpoint

An isochronous IN endpoint is used to transfer periodic data from the USB controller to the host (one data packet every USB frame).

If there is no data packet loaded in the IN FIFO when the USB host requests data, the USB controller sends a zero-length data packet, and the `USBCSIL.UNDERRUN` bit is asserted.

Double buffering requires that a data packet is loaded into the IN FIFO during the frame preceding the frame where it should be sent. If the first data packet is loaded before an IN token is received, the data packet is sent during the same frame as it was loaded and hence violates the double-buffering strategy. Thus, when double buffering is used, the `USBPOW.ISO_WAIT_SOF` bit should be set to 1 to avoid this. Setting this bit ensures that a loaded data packet is not sent until the next SOF token has been received.

The AutoSet feature typically is not used for isochronous endpoints, because the packet size increases or decreases from frame to frame.

21.7.7 Bulk/Interrupt OUT Endpoint

Interrupt OUT transfers occur at regular intervals, whereas bulk OUT transfers use available bandwidth not allocated to isochronous, interrupt, or control transfers.

A bulk/interrupt OUT endpoint can be stalled by setting the `USBCSOL.SEND_STALL` bit to 1. When the endpoint is stalled, the USB controller responds with a STALL handshake when the host is done sending the data packet. The data packet is discarded and is not placed in the OUT FIFO. The USB controller asserts the `USBCSOL.SENT_STALL` bit when the STALL handshake is sent and generates an interrupt request if the OUT endpoint interrupt is enabled.

As the AutoSet feature is useful for bulk IN endpoints, the AutoClear feature is useful for OUT endpoints, because many packets are of maximum size.

21.7.8 Isochronous OUT Endpoint

An isochronous OUT endpoint is used to transfer periodic data from the host to the USB controller (one data packet every USB frame).

If there is no buffer available when a data packet is being received, the `USBCSOL.OVERRUN` bit is asserted and the packet data is lost. Firmware can reduce the chance for this to happen by using double buffering and using DMA to unload data packets effectively.

An isochronous data packet in the OUT FIFO may have bit errors. The hardware detects this condition and sets `USBCSOL.DATA_ERROR`. Firmware should therefore always check this bit when unloading a data packet.

The AutoClear feature typically is not used for isochronous endpoints, because the packet size increases or decreases from frame to frame.

21.8 DMA

DMA should be used to fill the IN endpoint FIFOs and empty the OUT endpoint FIFOs. Using DMA improves the read/write performance significantly compared to using the CPU. It is therefore highly recommended to use DMA unless timing is not critical or only a few bytes are to be transferred.

There are no DMA triggers for the USB controller, meaning that DMA transfers must be triggered by firmware.

Byte-size transfer should be used.

21.9 USB Reset

When reset signaling is detected on the bus, the `USBCIF.RSTIF` flag is asserted. If `USBCIE.RSTIE` is enabled, `IRCON2.P2IF` is also asserted, and an interrupt request is generated if `IEN2.P2IE = 1`. The firmware should take appropriate action when a USB reset occurs. A USB reset should place the device in the default state, where it only responds to address 0 (the default address). One or more resets normally take place during the enumeration phase, immediately after the USB cable is connected.

The following actions are performed by the USB controller when a USB reset occurs:

- `USBADDR` is set to 0.
- `USBINDEX` is set to 0.
- All endpoint FIFOs are flushed.
- `USBMAXI`, `USBCS0`, `USBCSIL`, `USBCSIH`, `USBMAXO`, `USBCSOL`, `USBCSOH`, `USBCNT0`, `USBCNTL`, and `USBCNTH` are cleared.
- All interrupts, except SOF and suspend, are enabled.
- An interrupt request is generated (if `IEN2.P2IE = 1` and `USBCIE.RSTIE = 1`).

Firmware should close all pipes and wait for a new enumeration phase when USB reset is detected.

21.10 Suspend and Resume

The USB controller asserts `USBCIF.SUSPENDIF` and enters suspend mode when the USB has been continuously idle for 3 ms, provided that `USBPOW.SUSPEND_EN = 1`. `IRCON2.P2IF` is asserted if `USBCIE.SUSPENDIE` is enabled, and an interrupt request is generated if `IEN2.P2IE = 1`.

While in suspend mode, only limited current can be sourced from the USB. See the USB 2.0 Specification [3] for details about this. To be able to meet the suspend-current requirement, the device should be taken down to PM1 when suspend is detected. The device should not enter PM2 or PM3, because this resets the USB controller. Before entering PM1, the 48-MHz USB PLL must be turned off. This is done by setting `USBCTRL.PLL_EN` to 0 and waiting for `USBCTRL.PLL_LOCKED` to be cleared.

Any valid nonidle signaling on the USB causes `USBCIF.RESUMEIF` to be asserted and an interrupt request to be generated, and wakes up the system if the USB resume interrupt is enabled.

When the system wakes up (enters active mode) from suspend, no USB registers except `USBCTRL` can be accessed before the 48-MHz USB PLL has been activated. This is done by setting `USBCTRL.PLL_EN` to 1 and waiting until `USBCTRL.PLL_LOCKED` is set.

A USB reset also wakes up the system from suspend. A USB resume interrupt request is generated if the interrupt is enabled, but the `USBCIF.RSTIF` interrupt flag is set instead of the `USBCIF.RESUMEIF` interrupt flag.

21.11 Remote Wake-Up

The USB controller can resume from suspend by signaling resume to the USB hub. Resume is performed by setting `USBPOW.RESUME` to 1 for approximately 10 ms. According to the USB 2.0 Specification [3], the resume signaling must be present for at least 1 ms and no more than 15 ms. It is, however, recommended to keep the resume signaling for approximately 10 ms. Notice that support for remote wakeup must be declared in the USB descriptor, and that the USB host must grant the device the privilege to perform remote wakeup (through a `SET_FEATURE` request).

21.12 USB Registers

This section describes all USB registers used for control and status for the USB. The USB registers reside in XDATA memory space in the region 0x6200–0x622B. These registers can be divided into three groups: The common USB registers, the indexed endpoint registers, and the endpoint FIFO registers. The indexed endpoint registers represent the currently selected endpoint. The `USBINDEX` register is used to select the endpoint.

The registers return to their reset values and the FIFOs are cleared when the chip enters PM2 or PM3.

USBADDR (0x6200) – Function Address

Bit	Name	Reset	R/W	Description
7	UPDATE	0	R	This bit is set when the USBADDR register is written and cleared when the address becomes effective.
6:0	USBADDR[6:0]	000 000 0	R/W	Device address

USBPOW (0x6201) – Power/Control Register

Bit	Name	Reset	R/W	Description
7	ISO_WAIT_SOF	0	R/W	When this bit is set to 1, the USB controller sends zero-length data packets from the time <code>INPKT_RDY</code> is asserted and until the first SOF token has been received. This only applies to isochronous endpoints.
6:4	–	000	R0	Reserved
3	RST	0	R	During reset signaling, this bit is set to 1.
2	RESUME	0	R/W	Drives resume signaling for remote wakeup. According to the USB Specification, the duration of driving resume must be at least 1 ms and no more than 15 ms. It is recommended to keep this bit set for approximately 10 ms.
1	SUSPEND	0	R	Suspend mode entered. This bit is only used when <code>SUSPEND_EN</code> = 1. Reading the <code>USBCIF</code> register or asserting <code>RESUME</code> clears this bit.
0	SUSPEND_EN	0	R/W	Suspend enable. When this bit is set to 1, suspend mode is entered when the USB has been idle for 3 ms.

USBIIF (0x6202) – IN Endpoints and EP0 Interrupt Flags

Bit	Name	Reset	R/W	Description
7:6	–	00	R0	Reserved
5	INEP5IF	0	R, H0	Interrupt flag for IN endpoint 5. Cleared by hardware when read
4	INEP4IF	0	R, H0	Interrupt flag for IN endpoint 4. Cleared by hardware when read
3	INEP3IF	0	R, H0	Interrupt flag for IN endpoint 3. Cleared by hardware when read
2	INEP2IF	0	R, H0	Interrupt flag for IN endpoint 2. Cleared by hardware when read
1	INEP1IF	0	R, H0	Interrupt flag for IN endpoint 1. Cleared by hardware when read
0	EP0IF	0	R, H0	Interrupt flag for endpoint 0. Cleared by hardware when read

USBOIF (0x6204) – OUT-Endpoint Interrupt Flags

Bit	Name	Reset	R/W	Description
7:6	–	–	R0	Reserved
5	OUTEP5IF	0	R, H0	Interrupt flag for OUT endpoint 5. Cleared by hardware when read
4	OUTEP4IF	0	R, H0	Interrupt flag for OUT endpoint 4. Cleared by hardware when read
3	OUTEP3IF	0	R, H0	Interrupt flag for OUT endpoint 3. Cleared by hardware when read
2	OUTEP2IF	0	R, H0	Interrupt flag for OUT endpoint 2. Cleared by hardware when read
1	OUTEP1IF	0	R, H0	Interrupt flag for OUT endpoint 1. Cleared by hardware when read
0	–	–	R0	Reserved

USBCIF (0x6206) – Common USB Interrupt Flags

Bit	Name	Reset	R/W	Description
7:4	–	–	R0	Reserved
3	SOFIF	0	R, H0	Start-of-frame interrupt flag. Cleared by hardware when read
2	RSTIF	0	R, H0	Reset interrupt flag. Cleared by hardware when read
1	RESUMEIF	0	R, H0	Resume interrupt flag. Cleared by hardware when read
0	SUSPENDIF	0	R, H0	Suspend interrupt flag. Cleared by hardware when read

USBIIE (0x6207) – IN Endpoints and EP0 Interrupt-Enable Mask

Bit	Name	Reset	R/W	Description
7:6		00	R/W	Reserved. Always write 00
5	INEP5IE	1	R/W	IN endpoint-5 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
4	INEP4IE	1	R/W	IN endpoint- 4 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
3	INEP3IE	1	R/W	IN endpoint-3 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
2	INEP2IE	1	R/W	IN endpoint-2 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
1	INEP1IE	1	R/W	IN endpoint-1 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
0	EPOIE	1	R/W	Endpoint-0 interrupt enable 0: Interrupt disabled 1: Interrupt enabled

USBOIE (0x6209) – Out Endpoints Interrupt Enable Mask

Bit	Name	Reset	R/W	Description
7:6		00	R/W	Reserved. Always write 00
5	OUTEP5IE	1	R/W	OUT endpoint 5 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
4	OUTEP4IE	1	R/W	OUT endpoint 4 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
3	OUTEP3IE	1	R/W	OUT endpoint 3 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
2	OUTEP2IE	1	R/W	OUT endpoint 2 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
1	OUTEP1IE	1	R/W	OUT endpoint 1 interrupt enable 0: Interrupt disabled 1: Interrupt enabled
0	–	1	R0	Reserved

USBCIE (0x620B) – Common USB Interrupt-Enable Mask

Bit	Name	Reset	R/W	Description
7:4		–	R0	Reserved
3	SOFIE	0	R/W	Start-of-frame interrupt enable 0: Interrupt disabled 1: Interrupt enabled
2	RSTIE	1	R/W	Reset interrupt enable 0: Interrupt disabled 1: Interrupt enabled
1	RESUMEIE	1	R/W	Resume interrupt enable 0: Interrupt disabled 1: Interrupt enabled
0	SUSPENDIE	0	R/W	Suspend interrupt enable 0: Interrupt disabled 1: Interrupt enabled

USBFRLM (0x620C) – Current Frame Number (Low Byte)

Bit	Name	Reset	R/W	Description
7:0	FRAME[7:0]	0x00	R	Low byte of 11-bit frame number

USBFRLH (0x620D) – Current Frame Number (High Byte)

Bit	Name	Reset	R/W	Description
7:3	–	–	R0	Reserved
2:0	FRAME[10:8]	000	R	3 MSBs of 11-bit frame number

USBINDEX (0x620E) – Current-Endpoint Index Register

Bit	Name	Reset	R/W	Description
7:4	–	–	R0	Reserved
3:0	USBINDEX[3:0]	0000	R/W	Endpoint selected. Must be set to a value in the range 0–5

USBCTRL (0x620F) – USB Control Register

Bit	Name	Reset	R/W	Description
7	PLL_LOCKED	0	R	PLL locked status
6:3	–	–	R0	Reserved
2	–	0	R/W	Reserved. Always write 0
1	PLL_EN	0	R/W	48-MHz USB PLL enable. When this bit is set, the 48-MHz PLL is started. However, the USB must not be accessed before the PLL has locked, i.e., PLL_LOCKED is 1. This bit can only be set when USB_EN = 1. Note: The PLL must be disabled before exiting active mode and re-enabled after entering active mode.
0	USB_EN	0	R/W	USB enable. The USB controller is reset when writing 0 to this bit.

USBMAXI (0x6210) – Max. Packet Size for IN Endpoint{1–5}

Bit	Name	Reset	R/W	Description
7:0	USBMAXI[7:0]	0x00	R/W	Maximum packet size, in units of 8 bytes, for IN endpoint selected by USBINDEX register. The value of this register should correspond to the <i>wMaxPacketSize</i> field in the standard endpoint descriptor for the endpoint. This register must not be set to a value greater than the available FIFO memory for the endpoint.

USBCS0 (0x6211) – EP0 Control and Status (USBINDEX = 0)

Bit	Name	Reset	R/W	Description
7	CLR_SETUP_END	0	R/W H0	Set this bit to 1 to de-assert the SETUP_END bit of this register. This bit is cleared automatically.
6	CLR_OUTPKT_RDY	0	R/W H0	Set this bit to 1 to de-assert the OUTPKT_RDY bit of this register. This bit is cleared automatically.
5	SEND_STALL	0	R/W H0	Set this bit to 1 to terminate the current transaction. The USB controller sends the STALL handshake and this bit is de-asserted.
4	SETUP_END	0	R	This bit is set if the control transfer ends due to a premature end-of-control transfer. The FIFO is flushed and an interrupt request (EP0) is generated if the interrupt is enabled. Setting CLR_SETUP_END = 1 de-asserts this bit.
3	DATA_END	0	R/W H0	This bit is used to signal the end of a data transfer and must be asserted in the following three situations: <ol style="list-style-type: none"> 1: When the last data packet has been loaded and USBCS0 . INPKT_RDY is set to 1 2: When the last data packet has been unloaded and USBCS0 . CLR_OUTPKT_RDY is set to 1 3: When USBCS0 . INPKT_RDY has been asserted without having loaded the FIFO (for sending a zero-length data packet). The USB controller clears this bit automatically.
2	SENT_STALL	0	R/W H1	This bit is set when a STALL handshake has been sent. An interrupt request (EP0) is generated if the interrupt is enabled. This bit must be cleared from firmware.
1	INPKT_RDY	0	R/W H0	Set this bit when a data packet has been loaded into the EP0 FIFO to notify the USB controller that a new data packet is ready to be transferred. When the data packet has been sent, this bit is cleared, and an interrupt request (EP0) is generated if the interrupt is enabled.
0	OUTPKT_RDY	0	R	Data packet received. This bit is set when an incoming data packet has been placed in the OUT FIFO. An interrupt request (EP0) is generated if the interrupt is enabled. Set CLR_OUTPKT_RDY = 1 to de-assert this bit.

USBCSIL (0x6211) – IN EP{1–5} Control and Status, Low

Bit	Name	Reset	R/W	Description
7	–	–	R0	Reserved
6	CLR_DATA_TOG	0	R/W H0	Setting this bit resets the data toggle to 0. Thus, setting this bit forces the next data packet to be a DATA0 packet. This bit is automatically cleared.
5	SENT_STALL	0	R/W	This bit is set when a STALL handshake has been sent. The FIFO is flushed and the INPKT_RDY bit in this register is de-asserted. An interrupt request (IN EP{1–5}) is generated if the interrupt is enabled. This bit must be cleared from firmware.
4	SEND_STALL	0	R/W	Set this bit to 1 to make the USB controller reply with a STALL handshake when receiving IN tokens. Firmware must clear this bit to end the STALL condition. It is not possible to stall an isochronous endpoint; thus, this bit only has an effect if the IN endpoint is configured as bulk/interrupt.
3	FLUSH_PACKET	0	R/W H0	Set to 1 to flush next packet that is ready to transfer from the IN FIFO. The INPKT_RDY bit in this register is cleared. If there are two packets in the IN FIFO due to double buffering, this bit must be set twice to completely flush the IN FIFO. This bit is automatically cleared.
2	UNDERRUN	0	R/W	In isochronous mode, this bit is set if an IN token is received when INPKT_RDY = 0, and a zero-length data packet is transmitted in response to the IN token. In bulk/interrupt mode, this bit is set when a NAK is returned in response to an IN token. Firmware should clear this bit.
1	PKT_PRESENT	0	R	This bit is 1 when there is at least one packet in the IN FIFO.
0	INPKT_RDY	0	R/W H0	Set this bit when a data packet has been loaded into the IN FIFO to notify the USB controller that a new data packet is ready to be transferred. When the data packet has been sent, this bit is cleared, and an interrupt request (IN EP{1–5}) is generated if the interrupt is enabled.

USBCSIH (0x6212) – IN EP{1–5} Control and Status, High

Bit	Name	Reset	R/W	Description
7	AUTOSET	0	R/W	When this bit is 1, the USBCSIL.INPKT_RDY bit is automatically asserted when a data packet of maximum size (specified by USBMAXI) has been loaded into the IN FIFO.
6	ISO	0	R/W	Selects IN endpoint type 0: Bulk/interrupt 1: Isochronous
5:4		10	R/W	Reserved. Always write 10
3	FORCE_DATA_TOG	0	R/W	Setting this bit forces the IN endpoint data toggle to switch and the data packet to be flushed from the IN FIFO, even though an ACK was received. This feature can be useful when reporting rate feedback for isochronous endpoints.
2:1		–	R0	Reserved
0	IN_DBL_BUF	0	R/W	Double buffering enable (IN FIFO) 0: Double buffering disabled 1: Double buffering enabled

USBMAXO (0x6213) – Max. Packet Size for OUT EP{1–5}

Bit	Name	Reset	R/W	Description
7:0	USBMAXO[7:0]	0x00	R/W	Maximum packet size, in units of 8 bytes, for OUT endpoint selected by USBINDEX register. The value of this register should correspond to the wMaxPacketSize field in the standard endpoint descriptor for the endpoint. This register must not be set to a value greater than the available FIFO memory for the endpoint.

USBCSOL (0x6214) – OUT EP{1–5} Control and Status, Low

Bit	Name	Reset	R/W	Description
7	CLR_DATA_TOG	0	R/W H0	Setting this bit resets the data toggle to 0. Thus, setting this bit forces the next data packet to be a DATA0 packet. This bit is automatically cleared.
6	SENT_STALL	0	R/W	This bit is set when a STALL handshake has been sent. An interrupt request (OUT EP{1–5}) is generated if the interrupt is enabled. This bit must be cleared from firmware.
5	SEND_STALL	0	R/W	Set this bit to 1 to make the USB controller reply with a STALL handshake when receiving OUT tokens. Firmware must clear this bit to end the STALL condition. It is not possible to stall an isochronous endpoint; thus, this bit only has an effect if the IN endpoint is configured as bulk/interrupt.
4	FLUSH_PACKET	0	R/W H0	Set to 1 to flush the next packet that is to be read from the OUT FIFO. The OUTPKT_RDY bit in this register is cleared. If there are two packets in the OUT FIFO due to double buffering, this bit must be set twice to completely flush the OUT FIFO. This bit is automatically cleared after a write to 1.
3	DATA_ERROR	0	R	This bit is set if there is a CRC or bit-stuff error in the packet received. Cleared when OUTPKT_RDY is cleared. This bit is only valid if the OUT endpoint is isochronous.
2	OVERRUN	0	R/W	This bit is set when an OUT packet cannot be loaded into the OUT FIFO. Firmware should clear this bit. This bit is only valid in isochronous mode.
1	FIFO_FULL	0	R	This bit is asserted when no more packets can be loaded into the OUT FIFO because it is full.
0	OUTPKT_RDY	0	R/W	This bit is set when a packet has been received and is ready to be read from the OUT FIFO. An interrupt request (OUT EP{1–5}) is generated if the interrupt is enabled. This bit should be cleared when the packet has been unloaded from the FIFO.

USBCSOH (0x6215) – OUT EP{1–5} Control and Status, High

Bit	Name	Reset	R/W	Description
7	AUTOCLEAR	0	R/W	When this bit is set to 1, the USBCSOL.OUTPKT_RDY bit is automatically cleared when a data packet of maximum size (specified by USBMAXO) has been unloaded to the OUT FIFO.
6	ISO	0	R/W	Selects OUT endpoint type 0 Bulk/interrupt 1 Isochronous
5:4		00	R/W	Reserved. Always write 00
3:1		–	R0	Reserved
0	OUT_DBL_BUF	0	R/W	Double buffering enable (OUT FIFO) 0 Double buffering disabled 1 Double buffering enabled

USBCNT0 (0x6216) – Number of Received Bytes in EP0 FIFO (USBINDEX = 0)

Bit	Name	Reset	R/W	Description
7:6	–	–	R0	Reserved
5:0	USBCNT0[5:0]	00 0000	R	Number of received bytes into EP 0 FIFO. Only valid when OUTPKT_RDY is asserted

USBCNTL (0x6216) – Number of Bytes in EP{1–5} OUT FIFO, Low

Bit	Name	Reset	R/W	Description
7:0	USBCNT[7:0]	0x00	R	8 lsbs of number of received bytes in OUT FIFO selected by USBINDEX register. Only valid when USBCSOL.OUTPKT_RDY is asserted.

USBCNTH (0x6217) – Number of Bytes in EP{1–5} OUT FIFO, High

Bit	Name	Reset	R/W	Description
7:3	–	–	R0	Reserved
2:0	USBCNT[10:8]	000	R	3 msbs of number of received bytes in OUT FIFO selected by USBINDEX register. Only valid when USBCSOL.OUTPKT_RDY is set

USBF0 (0x6220) – Endpoint-0 FIFO

Bit	Name	Reset	R/W	Description
7:0	USBF0[7:0]	0x00	R/W	Endpoint 0 FIFO. Reading this register unloads one byte from the EP0 FIFO. Writing to this register loads one byte into the EP0 FIFO. <i>Note: The FIFO memory for EP0 is used for both incoming and outgoing data packets.</i>

USBF1 (0x6222) – Endpoint-1 FIFO

Bit	Name	Reset	R/W	Description
7:0	USBF1[7:0]	0x00	R/W	Endpoint 1 FIFO register. Reading this register unloads one byte from the EP1 OUT FIFO. Writing to this register loads one byte into the EP1 IN FIFO.

USBF2 (0x6224) – Endpoint-2 FIFO

Bit	Name	Reset	R/W	Description
7:0	USBF2[7:0]	0x00	R/W	Endpoint 2 FIFO register. Reading this register unloads one byte from the EP2 OUT FIFO. Writing to this register loads one byte into the EP2 IN FIFO.

USBF3 (0x6226) – Endpoint-3 FIFO

Bit	Name	Reset	R/W	Description
7:0	USBF3[7:0]	0x00	R/W	Endpoint 3 FIFO register. Reading this register unloads one byte from the EP3 OUT FIFO. Writing to this register loads one byte into the EP3 IN FIFO.

USBF4 (0x6228) – Endpoint-4 FIFO

Bit	Name	Reset	R/W	Description
7:0	USBF4[7:0]	0x00	R/W	Endpoint 4 FIFO register. Reading this register unloads one byte from the EP4 OUT FIFO. Writing to this register loads one byte into the EP4 IN FIFO.

USBF5 (0x622A) – Endpoint-5 FIFO

Bit	Name	Reset	R/W	Description
7:0	USBF5[7:0]	0x00	R/W	Endpoint 5 FIFO register. Reading this register unloads one byte from the EP5 OUT FIFO. Writing to this register loads one byte into the EP5 IN FIFO.

Timer 2 (MAC Timer)

Timer 2 is mainly used to provide timing for 802.15.4 CSMA-CA algorithms and for general timekeeping in the 802.15.4 MAC layer on CC253x devices, and for timekeeping in the BLE link layer on CC2540. Timer 2 must not be used by the application on the CC2540 when the BLE stack is running. When Timer 2 is used together with the Sleep Timer, the timing function is provided even when the system enters low-power modes PM1 and PM2. The timer runs at a speed according to the system clock. If Timer 2 is to be used with the Sleep Timer, the system clock source must be the 32-MHz crystal whenever Timer 2 is running, and an external 32-kHz XOSC should be used for accurate results.

The main features of Timer 2 are the following:

- 16-bit timer up-counter providing, for example, a symbol/frame period of 16 μ s/320 μ s
- Adjustable period with accuracy of 31.25 ns
- 2 \times 16-bit timer compare function
- 24-bit overflow count
- 2 \times 24-bit overflow compare function
- Start-of-frame-delimiter capture function
- Timer start/stop synchronous with 32-kHz clock and timekeeping maintained by Sleep Timer.
- Interrupts generated on compare and overflow
- DMA trigger capability
- Possible to adjust timer value while counting by introducing delay

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22.1 Timer Operation

This section describes the operation of the timer.

22.1.1 General

After a reset, the timer is in the timer IDLE mode, where it is stopped. The timer starts running when `T2CTRL.RUN` is set to 1. The timer then enters the timer RUN mode. Either the entry is immediate, or it is performed synchronously with the 32-kHz clock. See [Section 22.4](#) for a description of the synchronous start and stop mode.

Once the timer is running in RUN mode, it can be stopped by writing a 0 to `T2CTRL.RUN`. The timer then enters the timer IDLE mode. The stopping of the timer is performed either immediately or synchronously with the 32-kHz clock.

22.1.2 Up Counter

Timer 2 contains a 16-bit timer, which increments on each clock cycle. The counter value can be read from registers `T2M1:T2M0` with register `T2MSEL.T2MSEL` set to 000. Note that the register content in `T2M1` is latched when `T2M0` is read, meaning that `T2M0` must always be read first.

When the timer is idle, the counter can be modified by writing to registers `T2M1:T2M0` with register `T2MSEL.T2MSEL` set to 000. `T2M0` must be written first.

22.1.3 Timer Overflow

At the same time as the timer counts to a value that is equal to the set timer period, a timer overflow occurs. When the timer overflow occurs, the timer is set to 0x0000. If the overflow interrupt mask bit `T2IRQM.TIMER2_PERM` is 1, an interrupt request is generated. The interrupt flag bit `T2IRQF.TIMER2_PERF` is set to 1, regardless of the interrupt mask value.

22.1.4 Timer Delta Increment

The timer period may be adjusted once during a timer period by writing a timer delta value. When the timer is running and a timer delta value is written to multiplexed registers `T2M1:T2M0` with `T2MSEL.T2MSEL` set to 000, the 16-bit timer halts at its current value and a delta counter starts counting. The `T2M0` register must be written before `T2M1`. The delta counter starts counting from the delta value written, down to zero. Once the delta counter reaches zero, the 16-bit timer starts counting again.

The delta counter decrements at the same rate as the timer. When the delta counter has reached zero, it does not start counting again until a delta value is written once again. In this way, a timer period may be increased by the delta value in order to make adjustments to the timer overflow events over time.

22.1.5 Timer Compare

A timer compare occurs at the same time as the timer counts to a value that is equal to one of the 16-bit compare values set. When a timer compare occurs, the interrupt flag `T2IRQF.TIMER2_COMPARE1F` or `T2IRQF.TIMER2_COMPARE2F` is set to 1, depending of which compare value is reached. An interrupt request is also generated if the corresponding interrupt mask in `T2IRQM.TIMER2_COMPARE1M` or `T2IRQM.TIMER2_COMPARE2M` is set to 1.

22.1.6 Overflow Count

At each timer overflow, the 24-bit overflow counter is incremented by 1. The overflow counter value is read through registers `T2MOV2:T2MOV1:T2MOV0` with register `T2MSEL.T2MOVEFSEL` set to 000. The registers are latched as in the following description.

If one wants a unique timestamp, where both timer and overflow counter are latched at the same time, do the following: Read `T2M0` with `T2MSEL.T2MSEL` set to 000 and `T2CTRL.LATCH_MODE` set to 1. This returns the low byte of the timer value, and also latches the high byte of the timer and the entire overflow counter, so the rest of the timestamp is ready to be read.

If one wants to read just the overflow counter without reading timer first, read `T2MOVF0` with `T2MSEL.T2MOVFSSEL` set to 000 and `T2CTRL.LATCH_MODE` set to 0. This returns the low byte of the overflow counter, and latches the two most-significant bytes of the overflow counter so the values are ready to be read.

22.1.7 Overflow-Count Update

The overflow count value can be updated by writing to registers `T2MOVF2:T2MOVF1:T2MOVF0` with `T2MSEL.T2MOVFSSEL` set to 000. Always write the least-significant byte first, and always write all three bytes. The write takes effect once the high byte is written.

22.1.8 Overflow-Count Overflow

At the same time as the overflow counter counts to a value that is equal to the overflow period setting, an overflow period event occurs. When the period event occurs, the overflow counter is set to 0x00 0000. If the overflow interrupt mask bit `T2IRQM.TIMER2_OVF_PERM` is 1, an interrupt request is generated. The interrupt flag bit `T2IRQF.TIMER2_OVF_PERF` is set to 1, regardless of the interrupt mask value.

22.1.9 Overflow-Count Compare

Two compare values may be set for the overflow counter. The compare values are set by writing to `T2MOVF2:T2MOVF1:T2MOVF0` with register `T2MSEL.T2MOVFSSEL` set to 011 or 100. At the same time as the overflow counter counts to a value equal to one of the overflow count compare values, an overflow count compare event occurs. If the corresponding overflow compare interrupt mask bit `T2IRQM.TIMER2_OVF_COMPARE1M` or `T2IRQM.TIMER2_OVF_COMPARE2M` is 1, an interrupt request is generated. The interrupt flags bit `T2IRQF.TIMER2_OVF_COMPARE1F` and `T2IRQF.TIMER2_OVF_COMPARE2F` are set to 1, regardless of the interrupt mask value.

22.1.10 Capture Input

Timer 2 has a timer capture function, which captures the time when the start-of-frame delimiter (SFD) status in the radio goes high.

When the capture event occurs, the current timer value is captured in the capture register. The capture value can be read from registers `T2M1:T2M0` if register `T2MSEL.T2MSEL` is set to 001. The value of the overflow count is also captured at the time of the capture event and can be read from registers `T2MOVF2:T2MOVF1:T2MOVF0` if `T2MSEL.T2MOVFSSEL` is set to 001.

22.2 Interrupts

The timer has six individually maskable interrupt sources. These are the following:

- Timer overflow
- Timer compare 1
- Timer compare 2
- Overflow-count overflow
- Overflow-count compare 1
- Overflow-count compare 2

The interrupt flags are given in the `T2IRQF` registers. The interrupt flag bits are set only by hardware and can be cleared only by writing to the SFR register.

Each interrupt source can be masked by its corresponding mask bit in the `T2IRQM` register. An interrupt is generated when the corresponding mask bit is set; otherwise, the interrupt is not generated. The interrupt flag bit is set, however, regardless of the state of the interrupt mask bit.

22.3 Event Outputs (DMA Trigger and Radio Events)

Timer 2 has two event outputs, `T2_EVENT1` and `T2_EVENT2`. These can be used as DMA triggers, as inputs to the radio, for conditions in conditional instructions in the CSP on CC253x, or for use by the BLE stack on CC2540. The event outputs can be configured individually to any of the following events:

- Timer overflow
- Timer compare 1
- Timer compare 2
- Overflow-count overflow
- Overflow-count compare 1
- Overflow-count compare 2

The DMA triggers are configured using `T2EVTCFG.TIMER2_EVENT1_CFG` and `T2EVTCFG.TIMER2_EVENT2_CFG`.

22.4 Timer Start/Stop Synchronization

This section describes the synchronized timer start and stop.

22.4.1 General

The timer can be started and stopped synchronously with the 32-kHz clock rising edge. Note that this event is derived from a 32-kHz clock signal, but is synchronous with the 32-MHz system clock and thus has a period approximately equal to that of the 32-kHz clock period. Synchronous starting and stopping must not be attempted unless both the 32-kHz clock and 32-MHz XOSC are running and stable.

At the time of a synchronous start, the timer is reloaded with new calculated values for the timer and overflow count such that it appears that the timer has not been stopped.

22.4.2 Timer Synchronous Stop

After the timer has started running, i.e., entered timer RUN mode, it is stopped synchronously by writing 0 to `T2CTRL.RUN` when `T2CTRL.SYNC` is 1. After `T2CTRL.RUN` has been set to 0, the timer continues running until the 32-kHz clock rising edge is sampled as 1. When this occurs, the timer is stopped, the current Sleep Timer value is stored, and `T2CTRL.STATE` goes from 1 to 0.

22.4.3 Timer Synchronous Start

When the timer is in the IDLE mode, it is started synchronously by writing 1 to `T2CTRL.RUN` when `T2CTRL.SYNC` is 1. After `T2CTRL.RUN` has been set to 1, the timer remains in the IDLE mode until the 32-kHz clock rising edge is detected. When this occurs, the timer first calculates new values for the 16-bit timer value and for the 24-bit timer overflow count, based on the current and stored Sleep Timer values and the current 16-bit timer values. The new Timer 2 and overflow count values are loaded into the timer, and the timer enters the RUN mode. `T2CTRL.STATE = 1` indicates that the module is running. This synchronous start process takes 86 clock cycles from the time when the 32-kHz clock rising edge is sampled high. The synchronous start-and-stop function requires that the system clock frequency is selected to be 32 MHz. If the 16-MHz clock is selected, an offset is added to the new calculated value.

If a synchronous start is done without a previous synchronuous stop, the timer is loaded with unpredictable values. To avoid this, do the first start of the timer asynchronously, then enable synchronous mode for subsequent stops and starts.

The method for calculating the new Timer 2 value and overflow-count value is given as follows. Because the Timer 2 and Sleep Timer clocks are asynchronous with a noninteger clock ratio, there is an error of maximum ± 1 in the calculated timer value compared to the ideal timer value, not taking clock inaccuracies into account.

Calculation of New Timer Value and Overflow Count Value
 N_c = Current Sleep Timer value

 N_{ST} = Stored Sleep Timer value

 K_{ck} = Clock ratio = 976.5625⁽¹⁾
 stw = Sleep Timer width = 24

 P_T = Timer 2 period

 P_{OVF} = Overflow period

 O_{ST} = Stored overflow-count value

 O_{TICK} = Overflow tics while sleeping

 t_{ST} = Stored timer value

 T_{OH} = Overhead = 86

 $N_t = N_c - N_{ST}$
 $N_t \leq 0 \rightarrow N_d = 2^{stw} + N_t; N_t > 0 \rightarrow N_d = N_t$
 $C = N_d \times K_{ck} + T_{ST} + T_{OH}$ (rounded to nearest integer value)

 $T = C \bmod P_T$

Timer2Value = T

$$O_{TICK} = \frac{(C - T)}{P_T}$$

 $O = (O_{TICK} + O_{ST}) \bmod P_{OVF}$

Timer2OverflowCount = O

⁽¹⁾ Clock ratio of Timer 2 clock frequency (32 MHz) and Sleep Timer clock frequency (32 kHz)

For a given Timer 2 period value, P_T , there is a maximum duration between Timer 2 synchronous stop and start for which the timer value is correctly updated after starting. The maximum value is given in terms of the number of Sleep Timer clock periods, i.e., 32-kHz clock periods, $t_{ST(max)}$.

$$t_{ST(max)} \leq \frac{(2^{24} - 1) \times P_T + T_{OH}}{K_{ck}}$$

22.5 Timer 2 Registers

The SFR registers associated with Timer 2 are listed in this section. These registers are the following:

- T2MSEL – Timer 2 multiplexed register control
- T2M1 – Timer 2 multiplexed count high
- T2M0 – Timer 2 multiplexed count low
- T2MOV2 – Timer 2 multiplexed overflow count 2
- T2MOV1 – Timer 2 multiplexed overflow count 1
- T2MOV0 – Timer 2 multiplexed overflow count 0
- T2IRQF – Timer 2 interrupt flags
- T2IRQM – Timer 2 interrupt masks
- T2CSPCNF – Timer 2 event output configuration
- T2CTRL – Timer 2 configuration

Timer 2 has several multiplexed registers. This is to be able to fit all the registers into the limited SFR address space. The internal registers listed in [Table 22-1](#) can be accessed indirectly through T2M0, T2M1, T2MOV0, T2MOV1, and T2MOV2.

Table 22-1. Internal Registers

Register Name	Reset	R/W	Function
t2tim[15:0]	0x0000	R/W	Holds the 16-bit upcounter
t2_cap[15:0]	0x0000	R	Holds the last captured value of the upcounter
t2_per[15:0]	0x0000	R/W	Holds the period of the upcounter
t2_cmp1[15:0]	0x0000	R/W	Holds compare value 1 for the upcounter
t2_cmp2[15:0]	0x0000	R/W	Holds compare value 2 for the upcounter
t2ovf[23:0]	0x00 0000	R/W	Holds the 24-bit overflow counter
t2ovf_cap[23:0]	0x00 0000	R	Holds the last captured value of the overflow counter
t2ovf_per[23:0]	0x00 0000	R/W	Holds the period of the overflow counter
t2ovf_cmp1[23:0]	0x00 0000	R/W	Holds compare value 1 for the overflow counter
t2ovf_cmp2[23:0]	0x00 0000	R/W	Holds compare value 2 for the overflow counter

The registers listed in the remainder of this section are directly accessible in the SFR address space.

T2MSEL (0xC3) – Timer 2 Multiplex Select

Bit No.	Name	Reset	R/W	Function
7:0	–	0	R0	Reserved. Read as 0
6:4	T2MOVFSSEL	0	R/W	The value of this register selects the internal registers that are modified or read when accessing T2MOVF0, T2MOVF1, and T2MOVF2. 000: t2ovf (overflow counter) 001: t2ovf_cap (overflow capture) 010: t2ovf_per (overflow period) 011: t2ovf_cmp1 (overflow compare 1) 100: t2ovf_cmp2 (overflow compare 2) 101 to 111: Reserved
3	–	0	R0	Reserved. Read as 0
2:0	T2MSEL	0	R/W	The value of this register selects the internal registers that are modified or read when accessing T2M0 and T2M1. 000: t2tim (timer count value) 001: t2_cap (timer capture) 010: t2_per (timer period) 011: t2_cmp1 (timer compare 1) 100: t2_cmp2 (timer compare 2) 101 to 111: Reserved

T2M0 (0xA2) – Timer 2 Multiplexed Register 0

Bit No.	Name	Reset	R/W	Function
7:0	T2M0	0	R/W	Indirectly returns/modifies bits [7:0] of an internal register depending on the T2MSEL . T2MSEL value. When reading the T2M0 register with T2MSEL . T2MSEL set to 000 and T2CTRL . LATCH_MODE set to 0, the timer (t2tim) value is latched. When reading the T2M0 register with T2MSEL . T2MSEL set to 000 and T2CTRL . LATCH_MODE set to 1, the timer (t2tim) and overflow counter (t2ovf) values are latched.

T2M1 (0xA3) – Timer 2 Multiplexed Register 1

Bit No.	Name	Reset	R/W	Function
7:0	T2M1	0	R/W	Indirectly returns/modifies bits [15:8] of an internal register, depending on T2MSEL.T2MSEL value. When reading the T2M0 register with T2MSEL.T2MSEL set to 000, the timer (t2tim) value is latched. Reading this register with T2MSEL.T2MSEL set to 000 returns the latched value of t2tim [15:8].

T2MOVFO (0xA4) – Timer 2 Multiplexed Overflow Register 0

Bit No.	Name	Reset	R/W	Function
7:0	T2MOVFO	0	R/W	Indirectly returns/modifies bits [7:0] of an internal register, depending on the T2MSEL.T2MOVFSSEL value. When reading the T2MOVFO register with T2MSEL.T2MOVFSSEL set to 000 and T2CTRL.LATCH_MODE set to 0, the overflow counter value (t2ovf) is latched. When reading the T2M0 register with T2MSEL.T2MOVFSSEL set to 000 and T2CTRL.LATCH_MODE set to 1, the overflow counter value (t2ovf) is latched.

T2MOVF1 (0xA5) – Timer 2 Multiplexed Overflow Register 2

Bit No.	Name	Reset	R/W	Function
7:0	T2MOVF1	0	R/W	Indirectly returns/modifies bits [15:8] of an internal register, depending on the T2MSEL.T2MSEL value. Reading this register with T2MSEL.T2MOVFSSEL set to 000 returns the latched value of t2ovf [15:8].

T2MOVF2 (0xA6) – Timer 2 Multiplexed Overflow Register 2

Bit No.	Name	Reset	R/W	Function
7:0	T2MOVF2	0	R/W	Indirectly returns/modifies bits [23:16] of an internal register, depending on the T2MSEL.T2MOVFSSEL value. Reading this register with T2MSEL.T2MOVFSSEL set to 000 returns the latched value of t2ovf [23:16].

T2IRQF (0xA1) – Timer 2 Interrupt Flags

Bit No.	Name	Reset	R/W	Function
7:6	–	0	R0	Reserved. Read as 0
5	TIMER2_OVF_COMPARE2F	0	R/W0	Set when the Timer 2 overflow counter counts to the value set at t2ovf_cmp2
4	TIMER2_OVF_COMPARE1F	0	R/W0	Set when the Timer 2 overflow counter counts to the value set at Timer 2 t2ovf_cmp1
3	TIMER2_OVF_PERF	0	R/W0	Set when the Timer 2 overflow counter would have counted to a value equal to t2ovf_per , but instead wraps to 0
2	TIMER2_COMPARE2F	0	R/W0	Set when the Timer 2 counter counts to the value set at t2_cmp2
1	TIMER2_COMPARE1F	0	R/W0	Set when the Timer 2 counter counts to the value set at t2_cmp1
0	TIMER2_PERF	0	R/W0	Set when the Timer 2 counter would have counted to a value equal to t2_per , but instead wraps to 0.

T2IRQM (0xA7) – Timer 2 Interrupt Mask

Bit No.	Name	Reset	R/W	Function
7:6	–	0	R0	Reserved. Read as 0
5	TIMER2_OVF_COMPARE2M	0	R/W	Enables the TIMER2_OVF_COMPARE2 interrupt
4	TIMER2_OVF_COMPARE1M	0	R/W	Enables the TIMER2_OVF_COMPARE1 interrupt
3	TIMER2_OVF_PERM	0	R/W	Enables the TIMER2_OVF_PER interrupt
2	TIMER2_COMPARE2M	0	R/W	Enables the TIMER2_COMPARE2 interrupt
1	TIMER2_COMPARE1M	0	R/W	Enables the TIMER2_COMPARE1 interrupt
0	TIMER2_PERM	0	R/W	Enables the TIMER2_PER interrupt

T2CTRL (0x94) – Timer 2 Control Register

Bit No.	Name	Reset	R/W	Function
7:4	–	0	R0	Reserved. Read as 0
3	LATCH_MODE	0	R/W	0: Reading T2M0 with T2MSEL.T2MSEL = 000 latches the high byte of the timer, making it ready to be read from T2M1. Reading T2MOVF0 with T2MSEL.T2MOVFSSEL = 000 latches the two most-significant bytes of the overflow counter, making it possible to read these from T2MOVF1 and T2MOVF2. 1: Reading T2M0 with T2MSEL.T2MSEL = 000 latches the high byte of the timer and the entire overflow counter at once, making it possible to read the values from T2M1, T2MOVF0, T2MOVF1, and T2MOVF2.
2	STATE	0	R	State of Timer 2 0: Timer idle 1: Timer running
1	SYNC	1	R/W	0: Starting and stopping of timer is immediate, i.e., synchronous with clk_rf_32m. 1: Starting and stopping of timer happens at the first positive edge of the 32-kHz clock. Read Section 22.4 for more details regarding timer start and stop.
0	RUN	0	R/W	Write 1 to start timer, write 0 to stop timer. When read, it returns the last written value.

T2EVTCFG (0x9C) – Timer 2 Event Configuration

Bit No.	Name	Reset	R/W	Function
7	–	0	R0	Reserved. Read as 0
6:4	TIMER2_EVENT2_CFG	0	R/W	Selects the event that triggers a T2_EVENT2 pulse 000: t2_per_event 001: t2_cmp1_event 010: t2_cmp2_event 011: t2ovf_per_event 100: t2ovf_cmp1_event 101: t2ovf_cmp2_event 110: Reserved 111: No event
3	–	0	R0	Reserved. Read as 0
2:0	TIMER2_EVENT1_CFG	0	R/W	Selects the event that triggers a T2_EVENT1 pulse 000: t2_per_event 001: t2_cmp1_event 010: t2_cmp2_event 011: t2ovf_per_event 100: t2ovf_cmp1_event 101: t2ovf_cmp2_event 110: Reserved 111: No event

CC253x Radio

The **RF Core** controls the analog radio modules. In addition, it provides an interface between the MCU and the radio which makes it possible to issue commands, read status, and automate and sequence radio events.

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23.1 RF Core

The **RF Core** controls the analog radio modules. In addition, it provides an interface between the MCU and the radio which makes it possible to issue commands, read status, and automate and sequence radio events.

The **FSM** submodule controls the RF transceiver state, the transmitter and receiver FIFOs, and most of the dynamically controlled analog signals, such as power up/down of analog modules. The FSM is used to provide the correct sequencing of events (such as performing an FS calibration before enabling the receiver/transmitter). Also, it provides step-by-step processing of incoming frames from the demodulator: reading the frame length, counting the number of bytes received, checking the FCS, and finally, optionally handling automatic transmission of ACK frames after successful frame reception. It performs similar tasks in TX, including performing an optional CCA before transmission and automatically going to RX after the end of transmission to receive an ACK frame. Finally, the FSM controls the transfer of data between modulator/demodulator and the TXFIFO/RXFIFO in RAM.

The **modulator** transforms raw data into I/Q signals to the transmitter DAC. This is done in compliance with the IEEE 802.15.4 standard.

The **demodulator** is responsible for retrieving the over-the-air data from the received signal.

The amplitude information from the demodulator is used by the **automatic gain control (AGC)**. The AGC adjusts the gain of the analog LNA so that the signal level within the receiver is approximately constant.

The **frame filtering and source matching** supports the FSM in the RF Core by performing all operations needed in order to do frame filtering and source address matching, as defined by IEEE 802.15.4.

The **frequency synthesizer (FS)** generates the carrier wave for the RF signal.

The **command strobe processor (CSP)** processes all commands issued by the CPU. It also has a short program memory of 24 bytes, making it possible to automate CSMA-CA algorithms.

The **radio RAM** holds a FIFO for transmit data (TXFIFO) and a FIFO for receive data (RXFIFO). Both FIFOs are 128 bytes long. In addition, the RAM holds parameters for frame filtering and source matching, and for which 128 bytes are reserved.

Timer 2 (MAC Timer) is used for timing of radio events and to capture time stamps of incoming packets. This timer keeps counting even in power modes PM1 and PM2.

23.1.1 Interrupts

The radio is associated with two **interrupt** vectors on the CPU. These are the RFERR interrupt (interrupt 0) and the RF interrupt (interrupt 12) with the following functions.

- RFERR: Error situations in the radio are signaled using this interrupt.
- RF: Interrupts coming from normal operation are signaled using this interrupt.

The RF interrupt vector combines the interrupts in RFIF. Note that these RF interrupts are rising-edge triggered. Thus, an interrupt is generated when, e.g., the SFD status flag goes from 0 to 1. The RFIF interrupt flags are described in [Section 23.1.2](#).

23.1.2 Interrupt Registers

Two of the main interrupt control SFR registers are used to enable the RF and RFERR interrupts. These are the following:

- RFERR: `IEN0.RFERRIE`
- RF: `IEN2.RFIE`

Two main interrupt flag SFR registers hold the RF and RFERR interrupt flags. These are the following:

- RFERR: `TCON.RFERRIF`
- RF: `S1CON.RFIF`

The two interrupts generated by the RF Core are a combination of several sources within the RF Core. Each of the individual sources has its own enable and interrupt flags in the RF Core. Flags can be found in `RFIRQF0`, `RFIRQF1`, and `RFIERRF`. Interrupt masks can be found in `RFIRQM0`, `RFIRQM1`, and `RFERRM`.

The interrupt-enable bits in the mask registers are used to enable individual interrupt sources for the two RF interrupts. Note that masking an interrupt source does not affect the updating of the status in the flag registers.

Due to the use of individual interrupt masks in the RF Core, the interrupts coming from RF Core have two-layered masking, and care must be taken when processing these interrupts. The procedure is described as follows.

To clear an interrupt from the RF Core, one must clear two flags, both the flag set in RF Core and the one set in `S1CON` or `TCON` (depending on which interrupt is triggered). If a flag is cleared in the RF Core and there are other unmasked flags standing, another interrupt is generated.

RFIRQF0 (0xE9) RF Interrupt Flags

Bit	Name	Reset	R/W	Description
7	RXMASKZERO	0	R/W0	The <code>RXENABLE</code> register has gone from a nonzero state to an all-zero state. 0: No interrupt pending 1: Interrupt pending
6	RXPKTDONE	0	R/W0	A complete frame has been received. 0: No interrupt pending 1: Interrupt pending
5	FRAME_ACCEPTED	0	R/W0	Frame has passed frame filtering. 0: No interrupt pending 1: Interrupt pending
4	SRC_MATCH_FOUND	0	R/W0	Source match found 0: No interrupt pending 1: Interrupt pending
3	SRC_MATCH_DONE	0	R/W0	Source matching complete 0: No interrupt pending 1: Interrupt pending
2	FIFOP	0	R/W0	The number of bytes in the <code>RXFIFO</code> is above the threshold. Also raised when a complete frame has been received, and when a packet has been read out completely and there are more complete packets available. 0: No interrupt pending 1: Interrupt pending
1	SFD	0	R/W0	SFD has been received or transmitted. 0: No interrupt pending 1: Interrupt pending
0	ACT_UNUSED	0	R/W0	Reserved 0: No interrupt pending 1: Interrupt pending

RFIRQF1 (0x91) RF Interrupt Flags

Bit	Name	Reset	R/W	Description
7:6	–	00	R0	Reserved. Read as 0
5	CSP_WAIT	0	R/W0	Execution continued after a wait instruction in CSP. 0: No interrupt pending 1: Interrupt pending
4	CSP_STOP	0	R/W0	CSP has stopped program execution. 0: No interrupt pending 1: Interrupt pending
3	CSP_MANINT	0	R/W0	Manual interrupt generated from CSP. 0: No interrupt pending 1: Interrupt pending
2	RFIDLE	0	R/W0	Radio state machine has entered the idle state. 0: No interrupt pending 1: Interrupt pending
1	TXDONE	0	R/W0	A complete frame has been transmitted. 0: No interrupt pending 1: Interrupt pending
0	TXACKDONE	0	R/W0	An acknowledgement frame has been completely transmitted. 0: No interrupt pending 1: Interrupt pending

RFERRF (0xBF) – RF Error Interrupt Flags

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6	STROBEERR	0	R/W0	A command strobe was issued at a time it could not be processed. Triggered if trying to disable radio when already disabled, or when trying to do a SACK, SACKPEND, or SNACK command when not in active RX. 0: No interrupt pending 1: Interrupt pending
5	TXUNDERF	0	R/W0	TXFIFO underflowed 0: No interrupt pending 1: Interrupt pending
4	TXOVERF	0	R/W0	TXFIFO overflowed 0: No interrupt pending 1: Interrupt pending
3	RXUNDERF	0	R/W0	RXFIFO underflowed 0: No interrupt pending 1: Interrupt pending
2	RXOVERF	0	R/W0	RXFIFO overflowed 0: No interrupt pending 1: Interrupt pending
1	RXABO	0	R/W0	Reception of a frame was aborted. 0: No interrupt pending 1: Interrupt pending
0	NLOCK	0	R/W0	Frequency synthesizer failed to achieve lock after timeout, or lock is lost during reception. Receiver must be restarted to clear this error situation. 0: No interrupt pending 1: Interrupt pending

RFIRQM0 (0x61A3) – RF Interrupt Masks

Bit	Name	Reset	R/W	Description
7	RXMASKZERO	0	R/W	The RXENABLE register has gone from a nonzero state to an all-zero state. 0: Interrupt disabled 1: Interrupt enabled
6	RXPKTDONE	0	R/W	A complete frame has been received. 0: Interrupt disabled 1: Interrupt enabled
5	FRAME_ACCEPTED	0	R/W	Frame has passed frame filtering. 0: Interrupt disabled 1: Interrupt enabled
4	SRC_MATCH_FOUND	0	R/W	Source match found 0: Interrupt disabled 1: Interrupt enabled
3	SRC_MATCH_DONE	0	R/W	Source matching complete 0: Interrupt disabled 1: Interrupt enabled
2	FIFOP	0	R/W	The number of bytes in the RXFIFO is above the threshold. Also raised when a complete frame has been received, or when a complete packet has been read out and there are more complete packets available. 0: Interrupt disabled 1: Interrupt enabled
1	SFD	0	R/W	SFD has been received or transmitted. 0: Interrupt disabled 1: Interrupt enabled
0	ACT_UNUSED	0	R/W	Reserved 0: Interrupt disabled 1: Interrupt enabled

RFIRQM1 (0x61A4) – RF Interrupt Masks

Bit	Name	Reset	R/W	Description
7:6	–	00	R0	Reserved. Read as 0
5	CSP_WAIT	0	R/W	Execution continued after a wait instruction in CSP. 0: Interrupt disabled 1: Interrupt enabled
4	CSP_STOP	0	R/W	CSP has stopped program execution. 0: Interrupt disabled 1: Interrupt enabled
3	CSP_MANINT	0	R/W	Manual interrupt generated from CSP. 0: Interrupt disabled 1: Interrupt enabled
2	RFIDLE	0	R/W	Radio state machine has entered the idle state. 0: Interrupt disabled 1: Interrupt enabled
1	TXDONE	0	R/W	A complete frame has been transmitted. 0: Interrupt disabled 1: Interrupt enabled
0	TXACKDONE	0	R/W	An acknowledgement frame has been completely transmitted. 0: Interrupt disabled 1: Interrupt enabled

RFERRM (0x61A5) – RF Error Interrupt Masks

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
7:6	STROBEERR	0	R/W	A command strobe was issued at a time it could not be processed. Triggered if trying to disable radio when already disabled, or when trying to do a SACK, SACKPEND, or SNACK command when not in active RX. 0: Interrupt disabled 1: Interrupt enabled
5	TXUNDERF	0	R/W	TXFIFO underflowed 0: Interrupt disabled 1: Interrupt enabled
4	TXOVERF	0	R/W	TXFIFO overflowed 0: Interrupt disabled 1: Interrupt enabled
3	RXUNDERF	0	R/W	RXFIFO underflowed 0: Interrupt disabled 1: Interrupt enabled
2	RXOVERF	0	R/W	RXFIFO overflowed 0: Interrupt disabled 1: Interrupt enabled
1	RXABO	0	R/W	Reception of a frame was aborted. 0: Interrupt disabled 1: Interrupt enabled
0	NLOCK	0	R/W	Frequency synthesizer failed to achieve lock after timeout, or lock is lost during reception. Receiver must be restarted to clear this error situation. 0: Interrupt disabled 1: Interrupt enabled

23.2 FIFO Access

The TXFIFO and RXFIFO may be accessed through the SFR register `RFD` (0xD9). Data is written to the TXFIFO when writing to the `RFD` register. Data is read from the RXFIFO when the `RFD` register is read.

The XREG registers `RXFIFOCNT` and `TXFIFOCNT` provide information on the amount of data in the FIFOs. The FIFO contents can be cleared by issuing `SFLUSHRX` and `SFLUSHTX`.

RFD (0xD9) – RF Data

Bit	Name	Reset	R/W	Description
7:0	<code>RFD[7:0]</code>	0x00	R/W	Data written to the register is written to the TXFIFO. When reading this register, data from the RXFIFO is read.

23.3 DMA

It is possible to use direct memory access (DMA) to move data between memory and the radio. The DMA controller is described in [Chapter 8](#). See this section for a detailed description on how to set up and use DMA transfers.

To support the DMA controller, there is one DMA trigger associated with the radio, the RADIO DMA trigger (DMA trigger 19). The RADIO DMA trigger is activated by two events. The first event to cause a RADIO DMA trigger is when the first data is present in the RXFIFO, i.e. when the RXFIFO goes from the empty state to a nonempty state. The second event that causes a RADIO DMA trigger is when data is read from the RXFIFO (through `RFD`) and there is still more data available in the RXFIFO.

23.4 Memory Map

The RF Core contains 384 bytes of physical RAM located at addresses 0x6000 to 0x0617F. The configuration and status registers of the RF Core are located at addresses from 0x6180 to 0x61EF. Configuration registers, RXFIFO, and TXFIFO are all preserved during sleep modes.

23.4.1 RXFIFO

The RXFIFO memory area is located at addresses 0x6000 to 0x607F and is thus 128 bytes. Although this memory area is intended for the RXFIFO, it is not protected in any way, so it is still accessible in the XREG memory space. Normally, only the designated instructions should be used to manipulate the contents of the RXFIFO. The RXFIFO can contain more than one frame at a time.

23.4.2 TXFIFO

The TXFIFO memory area is located at addresses 0x6080 to 0x60FF and is thus 128 bytes. Although this memory area is intended for the TXFIFO, it is not protected in any way, so it is still accessible in the XREG memory space. Normally, only the designated instructions should be used to manipulate the contents of the TXFIFO. The TXFIFO can only contain one frame at a time.

23.4.3 Frame-Filtering and Source-Matching Memory Map

The frame-filtering and source-address-matching functions use a 128 byte block of the RF Core RAM to store local-address information and source-matching configuration and results; this is located in the area 0x6100 to 0x617F. This memory space is described in [Table 23-1](#). Values that do not fill an entire byte/word are in the least-significant part of the byte/word. Note that the values in these registers are unknown after reset. However, the values are retained during power modes.

Table 23-1. Frame Filtering and Source Matching Memory Map

ADDRESS	REGISTER/VARIABLE	ENDIAN	DESCRIPTION
RESERVED			
0x6176–0x617F	Temporary storage		Memory space used for temporary storage of variables
LOCAL ADDRESS INFORMATION			
0x6174–0x6175	SHORT_ADDR	LE	The short address used during destination address filtering
0x6172–0x6173	PAN_ID	LE	The PAN ID used during destination address filtering
0x616A–0x6171	EXT_ADD	LE	The IEEE extended address used during destination address filtering
SOURCE ADDRESS MATCHING CONTROL			
0x6169	SRCSHORTPENDEN2		8 MSBs of the 24-bit mask that enables/disables automatic pending for each of the 24 short addresses
0x6168	SRCSHORTPENDEN1		
0x6167	SRCSHORTPENDEN0		8 LSBs of the 24-bit mask that enables/disables automatic pending for each of the 24 short addresses
0x6166	SRCEXTPENDEN2		8 MSBs of the 24-bit mask that enables/disables automatic pending for each of the 12 extended addresses. Entry n is mapped to SRCEXTPENDEN[2n]. All SRCEXTPENDEN[2n + 1] bits are don't care.
0x6165	SRCEXTPENDEN1		
0x6164	SRCEXTPENDEN0		8 LSBs of the 24-bit mask that enables/disables automatic pending for each of the 12 extended addresses. Entry n is mapped to SRCEXTPENDEN[2n]. All SRCEXTPENDEN[2n + 1] bits are don't care.
SOURCE ADDRESS MATCHING RESULT			
0x6163	SRCRESINDEX		The bit index of the least-significant 1 in SRCRESMASK, or 0x3F when there is no source match. On a match, bit 5 is 0 when the match is on a short address and 1 when it is on an extended address. On a match, bit 6 is 1 when the conditions for automatic pending bit in acknowledgment have been met (see the description of SRCMATCH.AUTOPEND). The bit gives no indication of whether or not the acknowledgment actually is transmitted, and does not take the PENDING_OR register bit and the SACK/SACKPEND/SNACK strobes into account.
0x6162	SRCRESMASK2		24-bit mask that indicates source address match for each individual entry in the source address table
0x6161	SRCRESMASK1		Short address matching. When there is a match on entry panid_n + short_n, bit n is set in SRCRESMASK.

Table 23-1. Frame Filtering and Source Matching Memory Map (continued)

ADDRESS	REGISTER/VARIABLE	ENDIAN	DESCRIPTION		
0x6160	SRCRESMASK0		Extended address matching. When there is a match on entry ext_n, bits 2n and 2n + 1 are set in SRCRESMASK.		
SOURCE ADDRESS TABLE					
0x615E–0x615F	short_23	ext_11	LE	LE	Two individual short-address entries (combination of 16-bit PAN ID and 16-bit short address) or one extended address entry
0x615C–0x615D	panid_23		LE		
0x615A–0x615B	short_22		LE		
0x6158–0x6159	panid_22		LE		
...
0x610E–0x610F	short_03	ext_01	LE	LE	Two individual short address entries (combination of 16-bit PAN ID and 16-bit short address) or one extended address entry
0x610C–0x610D	panid_03		LE		
0x610A–0x610B	short_02		LE		
0x6108–0x6109	panid_02		LE		
0x6106–0x6107	short_01	ext_00	LE	LE	Two individual short address entries (combination of 16-bit PAN ID and 16-bit short address) or one extended address entry
0x6104–0x6105	panid_01		LE		
0x6102–0x6103	short_00		LE		
0x6100–0x6101	panid_00		LE		

23.5 Frequency and Channel Programming

The carrier frequency is set by programming the 7-bit frequency word located in `FREQCTRL.FREQ[6:0]`. Changes take effect after the next recalibration. Carrier frequencies in the range from 2394 MHz to 2507 MHz are supported. The carrier frequency f_c , in MHz, is given by $f_c = (2394 + \text{FREQCTRL.FREQ}[6:0])$ MHz, and is programmable in 1-MHz steps.

IEEE 802.15.4-2006 specifies 16 channels within the 2.4-GHz band. They are numbered 11 through 26 and are 5 MHz apart. The RF frequency of channel k is given by [Equation 4](#).

$$f_c = 2405 + 5(k - 11) \text{ [MHz]} \quad k \in [11, 26] \tag{4}$$

For operation in channel k, the `FREQCTRL.FREQ` register should therefore be set to `FREQCTRL.FREQ = 11 + 5 (k - 11)`.

23.6 IEEE 802.15.4-2006 Modulation Format

This section is meant as an introduction to the 2.4-GHz direct-sequence spread-spectrum (DSSS) RF modulation format defined in IEEE 802.15.4-2006. For a complete description, see the standard document [1].

The modulation and spreading functions are illustrated at the block level in [Figure 23-1](#). Each byte is divided into two symbols, 4 bits each. The least-significant symbol is transmitted first. For multibyte fields, the least-significant byte is transmitted first, except for security-related fields, where the most-significant byte is transmitted first.

Each symbol is mapped to one out of 16 pseudorandom sequences, 32 chips each. The symbol-to-chip mapping is shown in [Table 23-2](#). The chip sequence is then transmitted at 2 Mchips/s, with the least-significant chip (C_0) transmitted first for each symbol. The transmitted bit stream and the chip sequences are observable on GPIO pins P1[0:5]. See [Chapter 7](#) for details on how to configure the GPIO to do this.

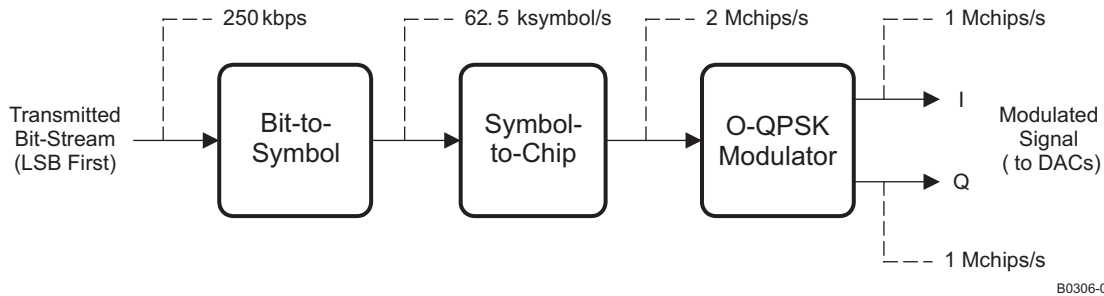


Figure 23-1. Modulation

Table 23-2. IEEE 802.15.4-2006 Symbol-to-Chip Mapping

Symbol	Chip Sequence (C0, C1, C2, ... , C31)
0	1 1 0 1 1 0 0 1 1 1 0 0 0 0 1 1 1 0 1 0 1 0 0 1 0 0 0 1 0 1 1 1 0
1	1 1 1 0 1 1 0 1 1 0 0 1 1 1 0 0 0 0 1 1 0 1 0 1 0 0 1 0 0 0 1 0
2	0 0 1 0 1 1 1 0 1 1 0 1 1 0 0 1 1 1 0 0 0 0 1 1 0 1 0 1 0 0 1 0
3	0 0 1 0 0 0 1 0 1 1 1 0 1 1 0 1 1 0 0 1 1 1 0 0 0 0 1 1 0 1 0 1
4	0 1 0 1 0 0 1 0 0 0 1 0 1 1 1 0 1 1 0 1 1 0 0 1 1 1 0 0 0 0 1 1
5	0 0 1 1 0 1 0 1 0 0 1 0 0 0 1 0 1 1 1 0 1 1 0 1 1 0 0 1 1 1 0 0
6	1 1 0 0 0 0 1 1 0 1 0 1 0 0 1 0 0 0 1 0 1 1 1 0 1 1 0 1 1 0 0 1
7	1 0 0 1 1 1 0 0 0 0 1 1 0 1 0 1 0 0 1 0 0 0 1 0 1 1 1 0 1 1 0 1
8	1 0 0 0 1 1 0 0 1 0 0 1 0 1 1 0 0 0 0 0 0 1 1 1 0 1 1 1 1 0 1 1
9	1 0 1 1 1 0 0 0 1 1 0 0 1 0 0 1 0 1 1 0 0 0 0 0 0 1 1 1 0 1 1 1
10	0 1 1 1 1 0 1 1 1 0 0 0 1 1 0 0 1 0 0 1 0 1 1 0 0 0 0 0 0 1 1 1
11	0 1 1 1 0 1 1 1 1 0 1 1 1 0 0 0 1 1 0 0 1 0 0 1 0 1 1 0 0 0 0 0
12	0 0 0 0 0 1 1 1 0 1 1 1 1 0 1 1 1 0 0 0 1 1 0 0 1 0 0 1 0 1 1 0
13	0 1 1 0 0 0 0 0 0 1 1 1 0 1 1 1 1 0 1 1 1 0 0 0 1 1 0 0 1 0 0 1
14	1 0 0 1 0 1 1 0 0 0 0 0 0 1 1 1 0 1 1 1 1 0 1 1 1 0 0 0 1 1 0 0
15	1 1 0 0 1 0 0 1 0 1 1 0 0 0 0 0 0 1 1 1 0 1 1 1 1 0 1 1 1 0 0 0

The modulation format is offset – quadrature phase shift keying (O-QPSK) with half-sine chip shaping. This is equivalent to MSK modulation. Each chip is shaped as a half-sine, transmitted alternately in the I and Q channels with one-half chip-period offset. This is illustrated for the zero-symbol in Figure 23-2.

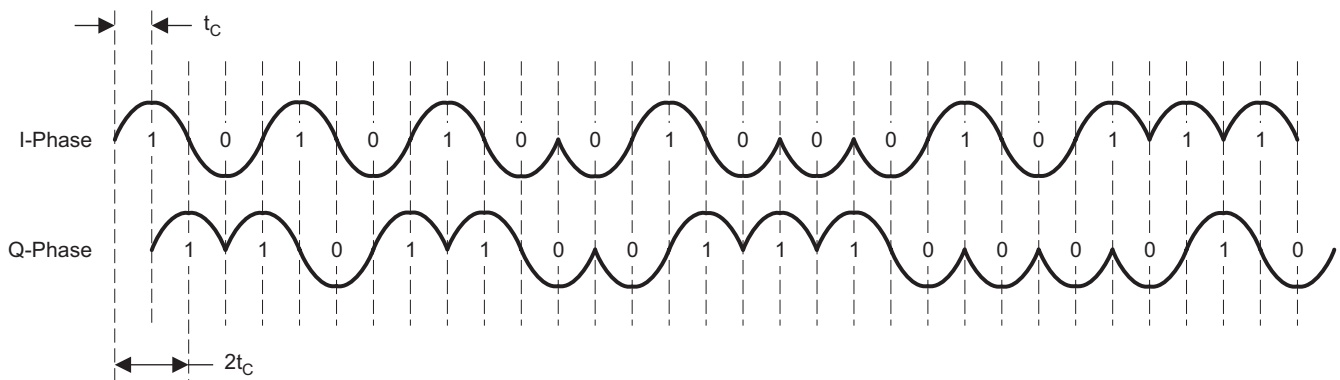


Figure 23-2. I/Q Phases When Transmitting a Zero-Symbol Chip Sequence, $t_c = 0.5 \mu s$

23.7 IEEE 802.15.4-2006 Frame Format

This section gives a brief summary of the IEEE 802.15.4 frame format [1]. The radio has built-in support for processing of parts of the frame. This is described in the following sections.

Figure 23-3 shows a schematic view of the IEEE 802.15.4 frame format. Similar figures describing specific frame formats (data frames, beacon frames, acknowledgment frames, and MAC command frames) are included in the standard document [1].

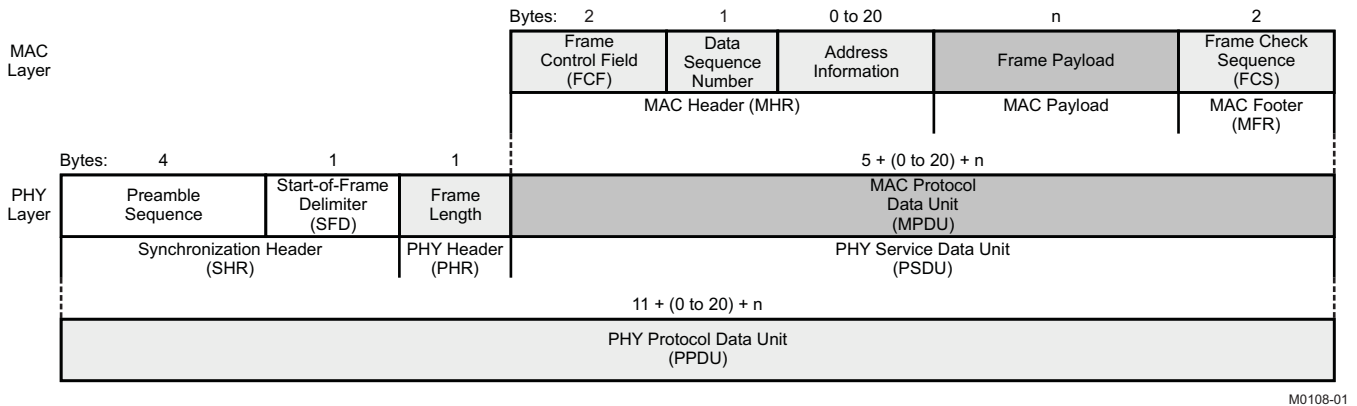


Figure 23-3. Schematic View of the IEEE 802.15.4 Frame Format [1]

23.7.1 PHY Layer

Synchronization Header

The synchronization header (SHR) consists of the preamble sequence followed by the start-of-frame delimiter (SFD). In the IEEE 802.15.4 specification [1], the preamble sequence is defined to be 4 bytes of 0x00. The SFD is one byte with value 0xA7.

PHY Header

The PHY header consists only of the frame-length field. The frame-length field defines the number of bytes in the MPDU. Note that the value of the frame-length field does not include the frame-length field itself. It does, however, include the frame-check sequence (FCS), even if this is inserted automatically by the hardware.

The frame-length field is 7 bits long and has a maximum value of 127. The most-significant bit in the frame-length field is reserved, and should always be set to zero.

PHY Service Data Unit

The PHY service data unit (PSDU) contains the MAC protocol data unit (MPDU). It is the MAC layer's function to generate/interpret the MPDU, and the radio has built-in support for processing of some of the MPDU subfields.

23.7.2 MAC Layer

The FCF, data sequence number, and address information follow the frame-length field as shown in Figure 23-3. Together with the MAC data payload and frame check sequence, they form the MPDU. The format of the FCF is shown in Figure 23-4. For full details, see the IEEE 802.15.4 specification [1].

Bits: 0–2	3	4	5	6	7–9	10–11	12–13	14–15
Frame type	Security enabled	Frame pending	Acknowledge request	Intra PAN	Reserved	Destination addressing mode	Reserved	Source addressing mode

Figure 23-4. Format of the Frame Control Field (FCF)

Frame-Check Sequence

A 2-byte frame-check sequence (FCS) follows the last MAC payload byte as shown in [Figure 23-3](#). The FCS is calculated over the MPDU, i.e., the frame-length field is not part of the FCS.

The FCS polynomial defined in [1] is

$$G(s) = x^{16} + x^{12} + x^5 + 1$$

The radio supports automatic calculation/verification of the FCS. See [Section 23.8.10](#) for details.

23.8 Transmit Mode

This section describes how to control the transmitter, how to control the integrated frame processing, and how to use the TXFIFO.

23.8.1 TX Control

The radio has many built-in features for frame processing and status reporting. Note that the radio provides features that make it easy to have precise control of the timing of outgoing frames. This is very important in an IEEE 802.15.4/ ZigBee® system, because there are strict timing requirements to such systems.

Frame transmission is started by the following actions:

- The STXON command strobe
 - The SAMPLED_CCA signal is not updated.
- The STXONCCA command strobe, provided that the CCA signal is high.
 - Aborts ongoing transmission/reception and forces a TX calibration followed by transmission.
 - The SAMPLED_CCA signal is updated.

Clear channel assessment is described in detail in [Section 23.8.12](#).

Frame transmission is aborted by the following command actions:

- The SRXON command strobe
 - Aborts ongoing transmission and forces an RX calibration
- The SRFOFF command strobe
 - Aborts ongoing transmission/reception and forces the FSM to the IDLE state.
- The STXON command strobe
 - Aborts ongoing transmission and forces an RX calibration

To enable the receiver after transmission with STXON, the `FRMCTRL1.SET_RXENMASK_ON_TX` bit should be set. This sets bit 6 in `RXENABLE` when STXON is executed. When transmitting with STXONCCA, the receiver is on before the transmission and is turned back on afterwards (unless the `RXENABLE` registers have been cleared in the meantime).

23.8.2 TX State Timing

Transmission of preamble begins 192 μ s after the STXON or STXONCCA command strobe. This is referred to as *TX turnaround time* in [1]. There is an equal delay when returning to receive mode.

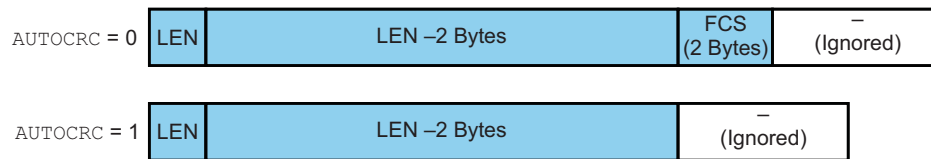
When returning to idle or receive mode, there is a 2- μ s delay while the modulator ramps down the signals to the DACs. The down ramping happens automatically after the complete MPDU (as defined by the length byte) has been transmitted or if TX underflow occurs. This affects:

- The SFD signal, which is stretched by 2 μ s.
- The radio FSM transition to the IDLE state, which is delayed by 2 μ s.

23.8.3 TXFIFO Access

The TXFIFO can hold 128 bytes and only one frame at a time. The frame can be buffered before or after the TX command strobe is executed, as long as it does not generate TX underflow (see the error conditions listed in [Section 23.8.5](#)).

Figure 23-5 illustrates what must be written to the TXFIFO (marked blue). Additional bytes are ignored, unless TX overflow occurs (see the error conditions listed in Section 23.8.5).



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Figure 23-5. Frame Data Written to the TXFIFO

There are two ways to write to the TXFIFO.

- Write to the `RFD` register.
- Frame buffering always begins at the start of the TXFIFO memory. By enabling the `FRMCTRL1.IGNORE_TX_UNDERF` bit, it is possible to write directly into the RAM area in the radio memory, which holds the TXFIFO. Note that it is recommended to use the `RFD` register for writing data to the TXFIFO.

The number of bytes in the TXFIFO is stored in the `TXFIFOCNT` register.

The TXFIFO can be emptied manually with the `SFLUSHTX` command strobe. TX underflow occurs if the FIFO is emptied during transmission.

23.8.4 Retransmission

In order to support simple retransmission of frames, the radio does not delete the TXFIFO contents as they are transmitted. After a frame has been successfully transmitted, the FIFO contents are left unchanged. To retransmit the same frame, simply restart TX by issuing an `STXON` or `STXONCCA` command strobe. Note that a retransmission of a packet is only possible if the packet has been completely transmitted; i.e., a packet cannot be aborted and then be retransmitted.

If a different frame is to be transmitted, issue an `ISFLUSHTX` strobe and then write the new frame to the TXFIFO.

23.8.5 Error Conditions

There are two error conditions associated with the TXFIFO:

- Overflow happens when the TXFIFO is full and another byte write is attempted.
- Underflow happens when the TXFIFO is empty and the radio attempts to fetch another byte for transmission.

TX overflow is indicated by the `TX_OVERFLOW` interrupt flag being set. When this error occurs, the writing is aborted, i.e., the data byte that caused the overflow is lost. The error condition must be cleared with the `SFLUSHTX` strobe.

TX underflow is indicated by the `TX_UNDERFLOW` interrupt flag being set. When this error occurs, the ongoing transmission is aborted. The error condition must be cleared with the `SFLUSHTX` strobe.

The `TX_UNDERFLOW` exception can be disabled by setting the `FRMCTRL1.IGNORE_TX_UNDERF` bit. In this case, the radio continues transmitting the bytes that happen to be in the TXFIFO memory, until the number of bytes given by the first byte (i.e., the length byte) has been transmitted.

23.8.6 TX Flow Diagram

Figure 23-6 summarizes the previous sections in a flow diagram:

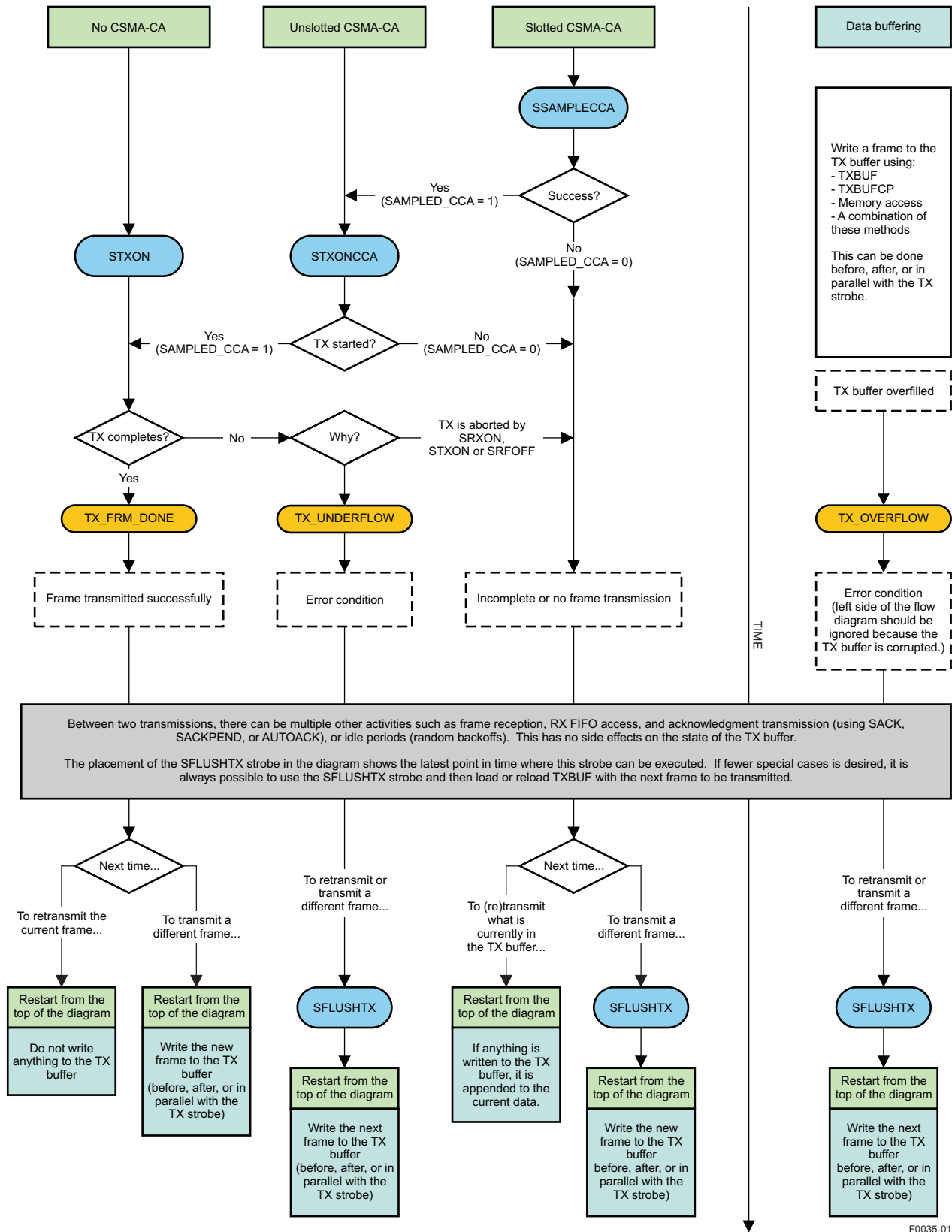
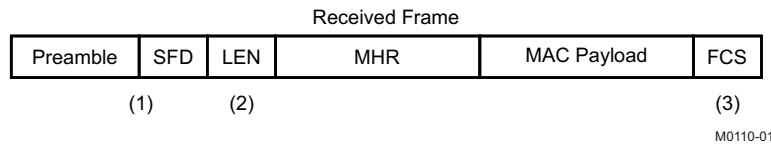


Figure 23-6. TX Flow

23.8.7 Frame Processing

The radio performs the following frame generation tasks for TX frames:



- (1) Generation and automatic transmission of the PHY layer synchronization header, which consists of the preamble and the SFD
- (2) Transmission of the number of bytes specified by the frame-length field
- (3) Calculation of and automatic transmission of the FCS (can be disabled)

The recommended usage is to write the frame-length field followed by the MAC header and MAC payload to the TXFIFO and let the radio handle the rest. Note that the frame-length field must include the two FCS bytes, even though the radio adds these automatically.

23.8.8 Synchronization Header

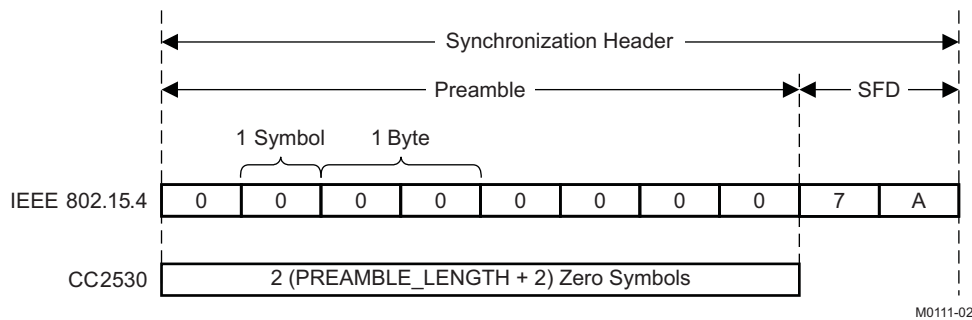


Figure 23-7. Transmitted Synchronization Header

The radio has programmable preamble length. The default value is compliant with [1], and changing the value makes the system noncompliant to IEEE 802.15.4.

The preamble sequence length is set by `MDMCTRL0.PREAMBLE_LENGTH`. [Figure 23-7](#) shows how the synchronization header relates to the IEEE 802.15.4 specification.

When the required number of preamble bytes has been transmitted, the radio automatically transmits the 1-byte SFD. The SFD is fixed, and it is not possible to change this value from software.

23.8.9 Frame-Length Field

When the SFD has been transmitted, the modulator starts to read data from the TXFIFO. It expects to find the frame-length field followed by the MAC header and MAC payload. The frame-length field is used to determine how many bytes are to be transmitted.

Note that the minimum frame length is 3 bytes when `AUTOCRC = 1` and 1 byte when `AUTOCRC = 0`.

23.8.10 Frame Check Sequence

When the `FRMCTRL0.AUTOCRC` control bit is set, the FCS field is automatically generated and appended to the transmitted frame at the position defined by the frame-length field. The FCS is not written to the TXFIFO, but stored in a separate 16-bit register. It is recommended always to have `AUTOCRC` enabled, except possibly for debug purposes. If `FRMCTRL0.AUTOCRC = 0`, then the modulator expects to find the FCS in the TXFIFO, so software must generate the FCS and write it to the TXFIFO along with the rest of the MPDU.

The hardware implementation of the FCS calculator is shown in [Figure 23-8](#). See [1] for further details.

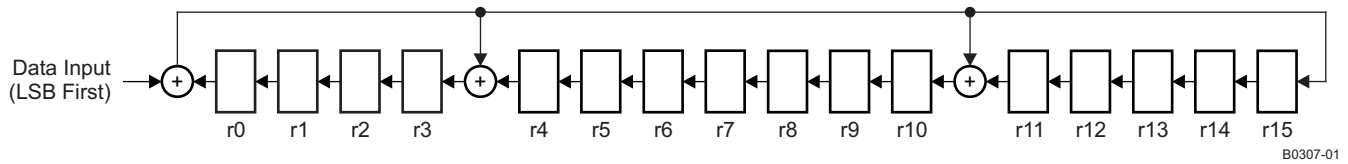


Figure 23-8. FCS Hardware Implementation

23.8.11 Interrupts

The SFD interrupt is raised when the SFD field of the frame has been transmitted. At the end of the frame, the TX_FRM_DONE interrupt is raised when the complete frame has been successfully transmitted.

Note that there is a second SFD signal available on GPIO (through radio observation mux) that should not be confused with the SFD interrupt.

23.8.12 Clear-Channel Assessment

The clear-channel assessment (CCA) status signal indicates whether the channel is available for transmission or not. The CCA function is used to implement the CSMA-CA functionality specified in the IEEE 802.15.4 specification [1]. The CCA signal is valid when the receiver has been enabled for at least eight symbol periods. The RSSI_VALID status signal can be used to verify this.

The CCA is based on the RSSI value and a programmable threshold. The exact behavior is configurable in the CCACTRL0 and CCACTRL1 registers.

There are two variations of the CCA signal, one that is updated at every new RSSI sample and one that is only updated on SSAMPLECCA/ISAMPLECCA and STXONCCA/ISTXONCCA command strobes. They are both available in the FSMSTAT1 register.

Note that the CCA signal is updated four clock cycles (system clock) after the RSSI_VALID signal has been set.

23.8.13 Output Power Programming

The RF output power is controlled by the 7-bit value in the TXPOWER register. The device data sheet (Appendix C) shows typical output power and current consumption for recommended settings when the center frequency is set to 2.440 GHz. Note that the recommended settings are only a small subset of all the possible register settings.

23.8.14 Tips and Tricks

- Note that there is no requirement to have the complete frame in the TXFIFO before starting a transmission. Bytes may be added to the TXFIFO during transmission.
- It is possible to transmit non-IEEE 802.15.4 compliant frames by setting `MDMTEST1.MODULATION_MODE = 1`.

23.9 Receive Mode

This section describes how to control the receiver, control the integrated RX frame processing, and how to use the RXFIFO.

23.9.1 RX Control

The receiver is turned on and off with the SRXON and SRFOFF command strobes, and with the RXENABLE registers. The command strobes provide a *hard* on/off mechanism, whereas RXENABLE manipulation provides a *soft* on/off mechanism.

The receiver is turned on by the following actions:

- The SRXON strobe:
 - Sets `RXENABLE[7]`

- Aborts ongoing transmission/reception by forcing a transition to RX calibration.
- The STXON strobe, when `FRMCTRL1.SET_RXENMASK_ON_TX` is enabled:
 - Sets `RXENABLE[6]`
 - The receiver is enabled after transmission completes.
- Setting `RXENABLE != 0x00` by writing to `RXENMASKOR`:
 - Does not abort ongoing transmission/reception.

The receiver is turned off by the following actions:

- The SRFOFF strobe:
 - Clears `RXENABLE[7:0]`
 - Aborts ongoing transmission/reception by forcing the transition to IDLE mode.
- Setting `RXENABLE = 0x00` by writing to `RXENMASKAND`
 - Does not abort ongoing transmission/reception. Once the ongoing transmission/reception is finished, the radio returns to the IDLE state.

There are several ways to manipulate the `RXENABLE` registers:

- The `SRXMASKBITSET` and `SRXMASKBITCLR` strobes (affecting `RXENABLE[5]`)
- The `SRXON`, `SRFOFF` and `STXON` strobes, including the `FRMCTRL1.SET_RXMASK_ON_TX` setting

23.9.2 RX State Timing

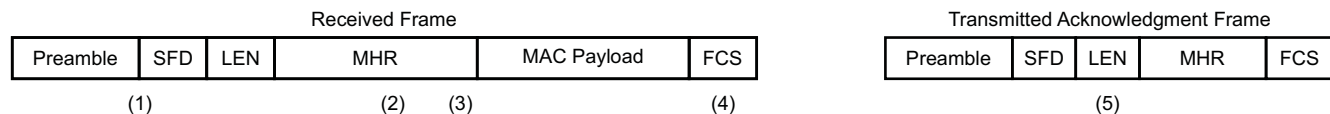
The receiver is ready 192 μ s after RX has been enabled by one of the methods described in [Section 23.9.1](#). This is referred to as *RX turnaround time* in [1].

When returning to receive mode after frame reception, there is by default an interval of 192 μ s where SFD detection is disabled. This interval can be disabled by clearing `FSMCTRL.RX2RX_TIME_OFF`.

23.9.3 Frame Processing

The radio integrates critical portions of the RX requirements in IEEE 802.15.4-2003 and -2006 in hardware. This reduces the CPU interruption rate, simplifies the software that handles frame reception, and provides the results with minimum latency.

During reception of a single frame, the following frame-processing steps are performed:

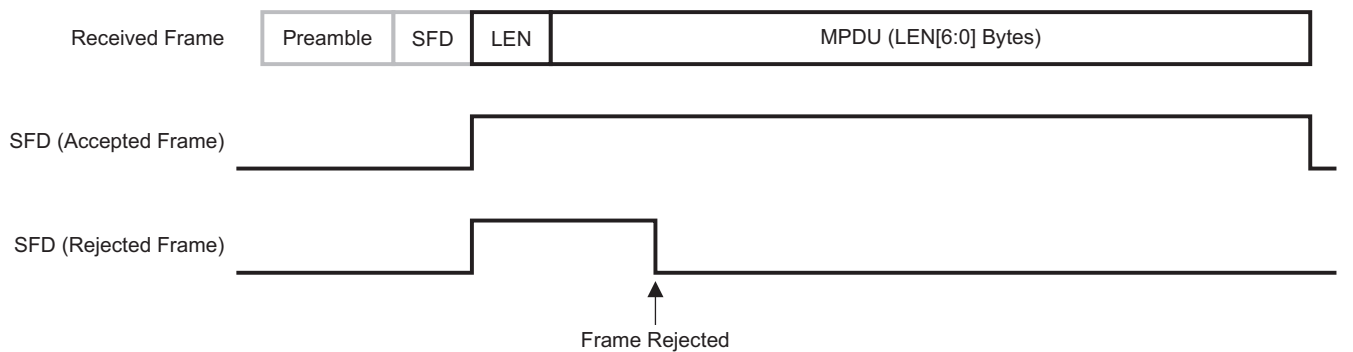


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- (1) Detection and removal of the received PHY synchronization header (preamble and SFD), and reception of the number of bytes specified by the frame-length field.
- (2) Frame filtering as specified by [1], section 7.5.6.2, third filtering level.
- (3) Matching of the source address against a table containing up to 24 short addresses or 12 extended IEEE addresses. The source address table is stored in the radio RAM.
- (4) Automatic FCS checking, and attaching this result and other status values (RSSI, correlation and source match result) to received frames.
- (5) Automatic acknowledgment transmission with correct timing, and correct setting of the frame pending bit, based on the results from source address matching and FCS checking.

23.9.4 Synchronization Header and Frame-Length Fields

Frame reception starts with detection of a start-of-frame delimiter (SFD), followed by the length byte, which determines when the reception is complete. The SFD signal, which can be output on GPIO, can be used to capture the start of received frames:



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Figure 23-9. SFD Signal Timing

Preamble and SFD are not written to the RXFIFO.

The radio uses a correlator to detect the SFD. The correlation threshold value in `MDMCTRL1.CORR_THR` determines how closely the received SFD must match an *ideal* SFD. The threshold must be adjusted with care:

- If set too high, the radio misses many actual SFDs, effectively reducing the receiver sensitivity.
- If set too low, the radio detects many false SFDs. Although this does not reduce the receiver sensitivity, the effect is similar, because false frames might overlap with the SFDs of actual frames. It also increases the risk of receiving false frames with correct FCS.

In addition to SFD detection, it is also possible to require a number of valid preamble symbols (also above the correlation threshold) prior to SFD detection. See the register descriptions of `MDMCTRL0` and `MDMCTRL1` for available options and recommended settings.

23.9.5 Frame Filtering

The frame filtering function rejects nonintended frames as specified by [1], section 7.5.6.2, third filtering level. In addition, it provides filtering on:

- The eight different frame types (see the `FRMFILT1` register)
- The reserved bits in the frame control field (FCF)

The function is controlled by:

- The `FRMFILT0` and `FRMFILT1` registers
- The `PAN_ID`, `SHORT_ADDR` and `EXT_ADDR` values in RAM

Filtering Algorithm

The `FRMFILT0.FRAME_FILTER_EN` bit controls whether frame filtering is applied or not. When disabled, the radio accepts all received frames. When enabled (which is the default setting), the radio only accepts frames that fulfill all of the following requirements:

- The length byte must be equal to or higher than the minimum frame length, which is derived from the source- and destination-address mode and PAN ID compression subfields of the FCF.
- The reserved FCF bits [9:7] ANDed together with `FRMFILT0.FCF_RESERVED_BITMASK` must equal 000b.
- The value of the frame version subfield of the FCF cannot be higher than `FRMFILT0.MAX_FRAME_VERSION`.
- The source and destination address modes cannot be reserved values (1).
- Destination address:
 - If a destination PAN ID is included in the frame, it must match `PAN_ID` or must be the broadcast PAN identifier (0xFFFF).
 - If a short destination address is included in the frame, it must match either `SHORT_ADDR` or the broadcast address (0xFFFF).
 - If an extended destination address is included in the frame, it must match `EXT_ADDR`.

- Frame type:
 - Beacon frames (0) are only accepted when:
 - `FRMFILT1.ACCEPT_FT0_BEACON = 1`
 - Length byte ≥ 9
 - The destination address mode is 0 (no destination address).
 - The source address mode is 2 or 3 (i.e., a source address is included).
 - The source PAN ID matches `PAN_ID`, or `PAN_ID` equals `0xFFFF`.
 - Data (1) frames are only accepted when:
 - `FRMFILT1.ACCEPT_FT1_DATA = 1`
 - Length byte ≥ 9
 - A destination address and/or source address is included in the frame. If no destination address is included in the frame, the `FRMFILT0.PAN_COORDINATOR` bit must be set, and the source PAN ID must equal `PAN_ID`.
 - Acknowledgment (2) frames are only accepted when:
 - `FRMFILT1.ACCEPT_FT2_ACK = 1`
 - Length byte = 5
 - MAC command (3) frames are only accepted when:
 - `FRMFILT1.ACCEPT_FT3_MAC_CMD = 1`
 - Length byte ≥ 9
 - A destination address and/or source address is included in the frame. If no destination address is included in the frame, the `FRMFILT0.PAN_COORDINATOR` bit must be set, and the source PAN ID must equal `PAN_ID` for the frame to be accepted.
 - Reserved frame types (4, 5, 6, and 7) are only accepted when
 - `FRMFILT1.ACCEPT_FT4TO7_RESERVED = 1` (default is 0)
 - Length byte ≥ 9

The following operations are performed before the filtering begins, with no effect on the frame data stored in the RXFIFO:

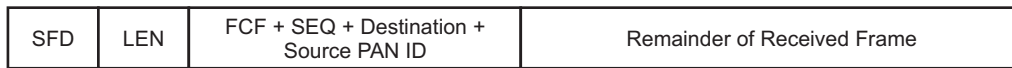
- Bit 7 of the length byte is masked out (don't care).
- If `FRMFILT1.MODIFY_FT_FILTER` is not equal to zero, the MSB of the frame type subfield of the FCF is either inverted or forced to 0 or 1.

If a frame is rejected, the radio only starts searching for a new frame after the rejected frame has been completely received (as defined by the frame-length field) to avoid detecting false SFDs within the frame. Note that a rejected frame can generate RX overflow if it occurs before the frame is rejected.

Interrupts

When frame filtering is enabled and the filtering algorithm accepts a received frame, an `RX_FRM_ACCEPTED` interrupt is generated. It is not generated if frame filtering is disabled or `RX_OVERFLOW` or `RX_FRM_ABORTED` is generated before the filtering result is known.

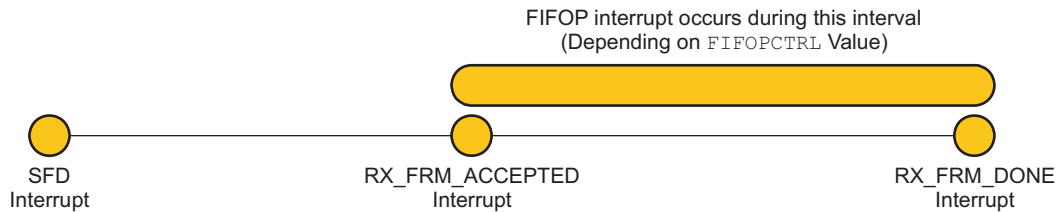
[Figure 23-10](#) illustrates the three different scenarios (not including the overflow and abort-error conditions).



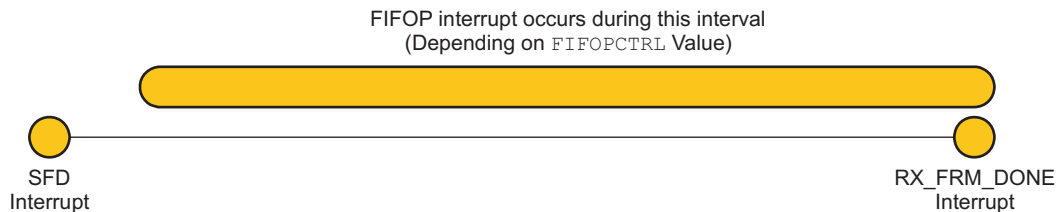
Filtering is Enabled, Frame Rejected



Filtering is Enabled, Frame Accepted



Filtering is Disabled



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Figure 23-10. Filtering Scenarios (Exceptions Generated During Reception)

The `FSMSTAT1.SFD` register bit goes high when a start-of-frame delimiter is completely received and remains high until either the last byte in MPDU is received or the received frame has failed to pass address recognition and been rejected.

Tips and Tricks

The following register settings must be configured correctly:

- `FRMFILT0.PAN_COORDINATOR` must be set if the device is a PAN coordinator, and cleared if not.
- `FRMFILT0.MAX_FRAME_VERSION` must correspond to the supported version(s) of the IEEE 802.15.4 standard.
- The local address information must be loaded into RAM.

To avoid completely the receiving of frames during energy-detection scanning, set `FRMCTRL0.RX_MODE = 11b` and then (re)start RX. This disables symbol search and thereby prevents SFD detection.

To resume normal RX mode, set `FRMCTRL0.RX_MODE = 00b` and (re)start RX.

During operation in a busy IEEE 802.15.4 environment, the radio receives large numbers of nonintended acknowledgment frames. To block reception of these frames effectively, use the `FRMFILT1.ACCEPT_FT2_ACK` bit to control when acknowledgment frames should be received:

- Set `FRMFILT1.ACCEPT_FT2_ACK` after successfully starting a transmission with acknowledgment request, and clear the bit again after the acknowledgment frame has been received or the time-out has been reached.

- Keep the bit cleared otherwise.

It is not necessary to turn off the receiver while changing the values of the `FRMFILT0/1` registers and the local address information stored in RAM. However, if the changes take place between reception of the SFD byte and the source PAN ID (i.e., between the *SFD and RX_FRM_ACCEPTED* exceptions), the modified values must be considered as don't care for that particular frame (the radio uses either the old or the new value).

Note that it is possible to make the radio ignore all IEEE 802.15.4 incoming frames by setting `MDMTEST1.MODULATION_MODE = 1`.

23.9.6 Source Address Matching

The radio supports matching of the source address in received frames against a table stored in the on-chip memory. The table is 96 bytes long, and hence it can contain up to:

- 24 short addresses (2 byte pan id + 2 byte short address).
- 12 IEEE extended addresses (8 bytes each).

Source address matching is only performed when frame filtering is also enabled and the received frame has been accepted. The function is controlled by:

- The `SRCMATCH`, `SRCSHORTEN0`, `SRCSHORTEN1`, `SRCSHORTEN2`, `SRCEXTEN0`, `SRCEXTEN1`, and `SRCEXTEN2` registers
- The source address table in RAM

Applications

Automatic acknowledgment transmission with correct setting of the frame-pending bit: When using indirect frame transmission, the devices send data requests to poll frames stored on the coordinator. To indicate whether it actually has a frame stored for the device, the coordinator must set or clear the frame-pending bit in the returned acknowledgment frame. On most 8- and 16-bit MCUs, however, there is not enough time to determine this, and so the coordinator ends up setting the pending bit regardless of whether there are pending frames for the device (as required by IEEE 802.15.4 [1]). This is wasteful in terms of power consumption, because the polling device must keep its receiver enabled for a considerable period of time, even if there are no frames for it. By loading the destination addresses in the indirect frame queue into the source address table and enabling the `AUTOPEND` function, the radio sets the pending bit in outgoing acknowledgment frames automatically. This way, the operation is no longer timing-critical, as the effort done by the microcontroller is when adding or removing frames in the indirect frame queue and updating the source address table accordingly.

Security material look-up: To reduce the time needed to process secured frames, the source address table can be set up so the entries match the table of security keys on the CPU. A second level of masking on the table entries allows this application to be combined with automatic setting of the pending bit in acknowledgment frames.

Other applications: The two previous applications are the main targets for the source-address matching function. However, for proprietary protocols that only rely on the basic IEEE 802.15.4 frame format, there are several other useful applications. For instance, it is possible to create firewall functionality where only a specified set of nodes is to be acknowledged.

The Source Address Table

The source address table begins at address `0x6100` in RAM. The space is shared between short and extended addresses, and the `SRCSHORTEN0/1/2` and `SRCEXTEN0/1/2` registers are used to control which entries are enabled. All values in the table are little-endian (as in the received frames).

- A *short address entry* starts with the 16-bit PAN ID followed by the 16-bit short address. These entries are stored at address `0x6100 + (4 × n)`, where `n` is a number between 0 and 23.
- An *extended address entry* consists only of the 64-bit IEEE extended address. These entries are stored at address `0x6100 + (8 × n)`, where `n` is a number between 0 and 11.

Address Enable Registers

Software is responsible for allocating table entries and for making sure that active short and extended address entries do not overlap. There are separate enable bits for short and extended addresses:

- Short address entries are enabled in the `SRCSHORTEN0`, `SRCSHORTEN1`, and `SRCSHORTEN2` registers. Register bit `n` corresponds to short address entry `n`.

- Extended address entries are enabled in the SRCEXTEN0, SRCEXTEN1, and SRCEXTEN2 registers. In this case, register bit **2n** corresponds to extended address entry **n**. This mapping is convenient when creating a combined bit vector (of short and extended enable bits) to find unused entries. Moreover, when read, register bit **2n + 1** always has the same value as register bit **2n**, because an extended address occupies the same memory as two short-address entries.

Matching Algorithm

The SRCMATCH.SRC_MATCH_EN bit controls whether source address matching is enabled or not. When enabled (which is the default setting) and a frame passes the filtering algorithm, the radio applies one of the algorithms outlined in Figure 23-13, depending on which type of source address is present.

The result is reported in two different forms:

- A 24-bit vector called SRCRESMASK contains a 1 for each enabled short entry with a match, or two 1s for each enabled extended entry with a match (the bit mapping is the same as for the address-enable registers on read access).
- A 7-bit value called SRCRESINDEX:
 - When no source address is present in the received frame, or there is no match on the received source address:
 - Bits 6:0: 011 1111
 - If there is a match on the received source address:
 - Bits 4:0: The index of the first entry (i.e., the one with the lowest index number) with a match, 0–23 for short addresses or 0–11 for extended addresses.
 - Bit 5: 0 if the match is on a short address, 1 if the match is on an extended address
 - Bit 6: The result of the AUTOPEND function

Short Source Address (Mode 2)	Extended Source Address (Mode 3)
<p>The received source PAN ID is called srcPanid. The received short address is called srcShort.</p> <pre> SRCRESMASK = 0x000000; SRCRESINDEX = 0x3F; for (n = 0; n < 24; n++) { bitVector = 0x000001 << n; if (SRCSHORTEN & bitVector) { if ((panid[n] == srcPanid) && (short[n] == srcShort)) { SRCRESMASK = bitVector; if (SRCRESINDEX == 0x3F) { SRCRESINDEX = n; } } } } </pre>	<p>The received extended address is called srcExt.</p> <pre> SRCRESMASK = 0x000000; SRCRESINDEX = 0x3F; for (n = 0; n < 12; n++) { bitVector = 0x000003 << (2*n); if (SRCEXTEN & bitVector) { if (ext[n] == srcExt) { SRCRESMASK = bitVector; if (SRCRESINDEX == 0x3F) { SRCRESINDEX = n 0x20; } } } } </pre>

Figure 23-11. Matching Algorithm for Short and Extended Addresses

SRCRESMASK and SRCRESINDEX are written to RF Core memory as soon as the result is available.

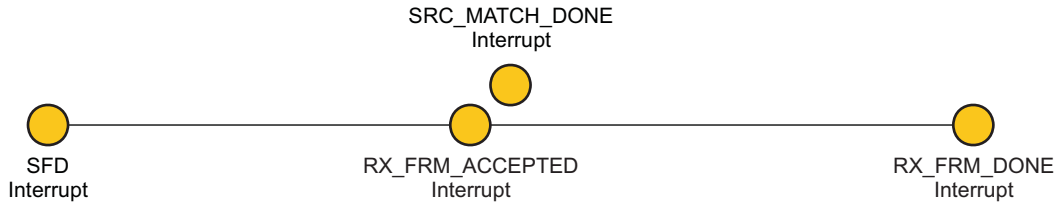
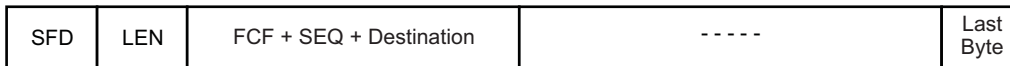
SRCRESINDEX is also appended to received frames if the FRMCTRL0.AUTOCRC and FRMCTRL0.APPEND_DATA_MODE bits have been set. The value then replaces the 7-bit correlation value of the 16-bit status word.

Interrupts

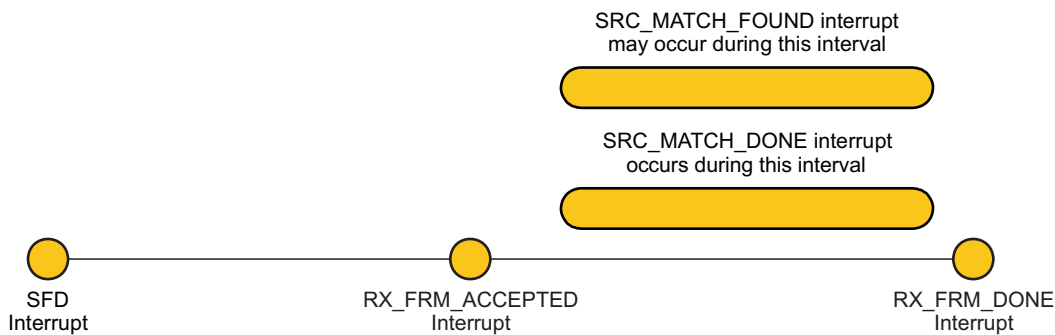
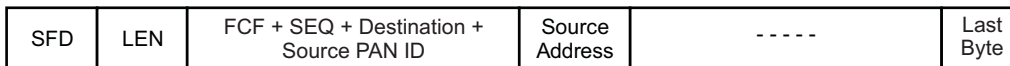
When source address matching is enabled and the matching algorithm completes, the SRC_MATCH_DONE interrupt flag is set, regardless of the result. If a match is found, the SRC_MATCH_FOUND flag is also set immediately before SRC_MATCH_DONE.

Figure 23-12 illustrates the timing of the setting of flags:

When There Is No Source Address:



When There Is a Source Address:



M0113-01

Figure 23-12. Interrupts Generated by Source Address Matching

Tips and Tricks

- The source address table can be modified safely during frame reception. If one address replaces another while the receiver is active, the corresponding enable bit should be turned off during the modification. This prevents the RF Core from using a combination of old and new values, because it only considers entries that are enabled throughout the whole source matching process.

The following measures can be taken to avoid the next received frame overwriting the results from source address matching:

- Use the appended SRCRESINDEX result instead of the value written to RAM (this is the recommended approach).
- Read the results from RAM before RX_FRM_ACCEPTED occurs in the next received frame. For the shortest frame type, this happens after the sequence number, so the total available time (absolute worst-case with a small safety margin) becomes:
 - 16 μs (required preamble) + 32 μs (SFD) + 128 μs (4 bytes) = 176 μs
- To increase the available time, clear the FSMCTRL.RX2RX_TIME_OFF bit. This adds another 192 μs, for a total of 368 μs. This also reduces the risk of RX overflow.

23.9.7 Frame-Check Sequence

In receive mode, the FCS is verified by hardware if `FRMCTRL0.AUTOCRC` is enabled. The user is normally only interested in the correctness of the FCS, not the FCS sequence itself. The FCS sequence itself is therefore not written to the RXFIFO during receive. Instead, when `FRMCTRL0.AUTOCRC` is set, the two FCS bytes are replaced by other more-useful values. The values that are substituted for the FCS sequence are configurable in the `FRMCTRL0` register.

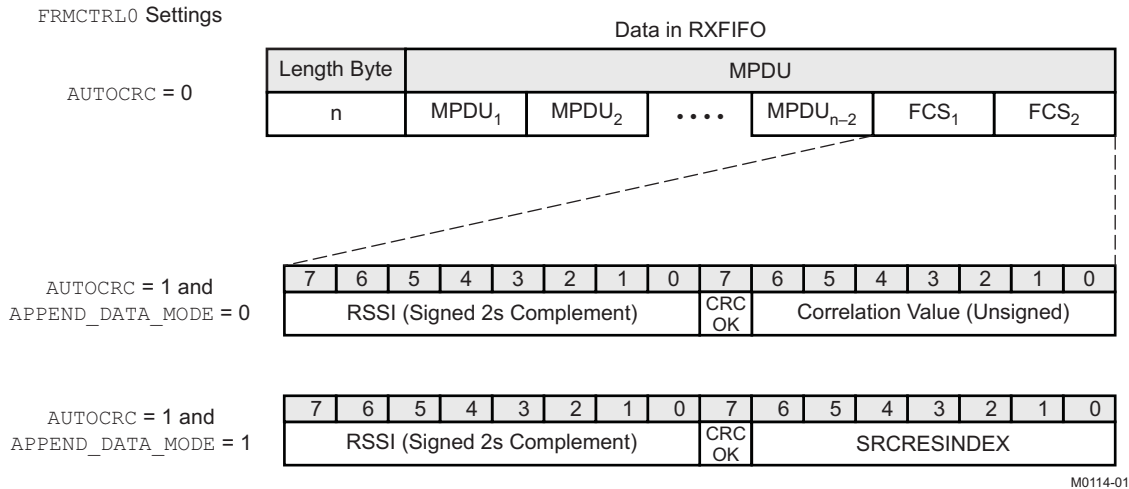


Figure 23-13. Data in RXFIFO for Different Settings

Field Descriptions:

- The *RSSI* value is measured over the first eight symbols following the SFD.
- The *CRC_OK* bit indicates whether the FCS is correct (1) or incorrect (0). When incorrect, software is responsible for discarding the frame.
- The *correlation value* is the average correlation value over the first eight symbols following the SFD.
- *SRCRESINDEX* is the same value that is written to RAM after completion of source address matching.

Calculation of the LQI value used by IEEE 802.15.4 is described in [Section 23.10.4](#).

23.9.8 Acknowledgement Transmission

The radio includes hardware support for acknowledgment transmission after successful frame reception (i.e., the FCS of the received frame must be correct). [Figure 23-14](#) shows the format of the acknowledgment frame.

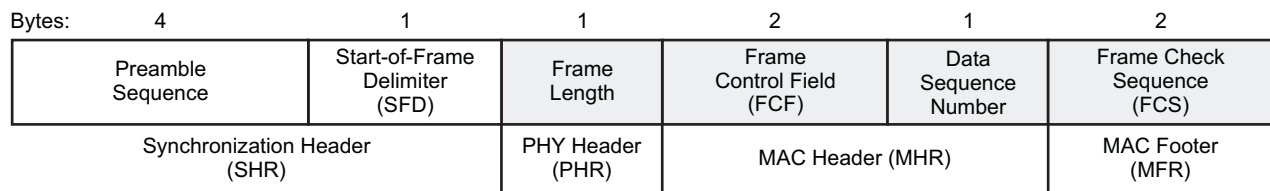


Figure 23-14. Acknowledge Frame Format

There are three variable fields in the generated acknowledgment frame:

- The pending bit, which may be controlled with command strobes and the AUTOPEND feature (in the FCF field)
- The data sequence number (DSN), which is taken automatically from the last received frame
- The FCS, which is given implicitly

There are three different sources for setting the pending bit in an ACK frame (i.e., the SACKPEND strobe, the `PENDING_OR` register bit, and the AUTOPEND feature). The pending bit is set if one or more of these sources are set.

Transmission Timing

Acknowledgment frames can only be transmitted immediately after frame reception. The transmission timing is controlled by the `FSMCTRL.SLOTTED_ACK` bit.

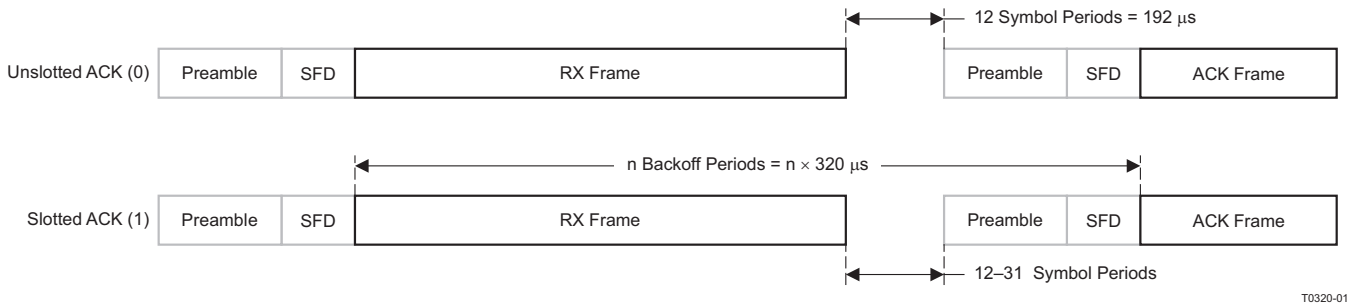


Figure 23-15. Acknowledgement Timing

The IEEE 802.15.4 requires unslotted mode in nonbeacon-enabled PANs, and slotted mode for beacon-enabled PANs.

Manual Control

The SACK, SACKPEND, and SNACK command strobes can only be issued during frame reception. If the strobes are issued at any other time, they have no effect but generating a `STROBE_ERROR` interrupt.

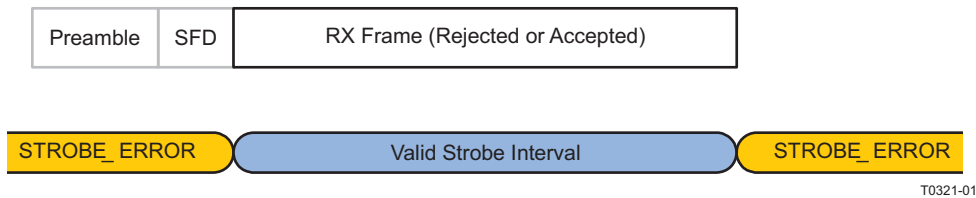


Figure 23-16. Command Strobe Timing

The command strobes may be issued several times during reception; however, only the last strobe has an effect:

- No strobe / SNACK / incorrect FCS: No acknowledgment transmission
- SACK: Acknowledgment transmission with the frame pending-bit cleared
- SACKPEND: Acknowledgment transmission with the frame pending-bit set

Automatic Control (AUTOACK)

When `FRMFILTO.FRM_FILTER_EN` and `FRMCTRL0.AUTOACK` are both enabled, the radio determines automatically whether or not to transmit acknowledgment frames:

- The RX frame must be accepted by frame filtering (indicated by the `RX_FRM_ACCEPTED` exception).
- The acknowledgment request bit must be set in the RX frame.
- The RX frame must not be a beacon or an acknowledgment frame.
- The FCS of the RX frame must be correct.

Automatic acknowledgments can be overridden by the SACK, SACKPEND, and SNACK command strobes. For instance, if the microcontroller is low on memory resources and cannot store a received frame, the SNACK strobe can be issued during reception and prevent acknowledging the discarded frame.

By default, the AUTOACK feature never sets the frame-pending bit in the acknowledgment frames. Apart from manual override with command strobes, there are two options:

- Automatic control, using the AUTOPEND feature
- Manual control, using the `FRMCTRL1.PENDING_OR` bit

Automatic Setting of the Frame Pending Field (AUTOPEND)

When the `SRCMATCH.AUTOPEND` bit is set, the result from source address matching determines the value of the frame-pending field. On reception of a frame, the frame-pending field in the (possibly) returned acknowledgment is set, given that:

- `FRMFILTO.FRAME_FILTER_EN` is set.
- `SRCMATCH.SRC_MATCH_EN` is set.
- `SRCMATCH.AUTOPEND` is set.
- The received frame matches the current `SRCMATCH.PEND_DATAREQ_ONLY` setting.
- The received source address matches at least one source-match table entry, which is enabled in both `SRCSHORTEN` and `SRCSHORTPENDEN`, or `SRCEXTEN` and `SRCEXTPENDEN`.

If the source-matching table runs full, the `FRMCTRL1.PENDING_OR` bit may be used to override the AUTOPEND feature and temporarily acknowledge all frames with the frame-pending field set.

23.10 RXFIFO Access

The RXFIFO can hold one or more received frames, provided that the total number of bytes is 128 or less. There are two ways to determine the number of bytes in the RXFIFO:

- Reading the `RXFIFOCNT` register
- Using the `FIFOP` and `FIFO` signals in combination with the `FIFOPCTRL.FIFOPTHR` setting

The RXFIFO is accessed through the `RFD` register.

The data in the RXFIFO can also be accessed by accessing the radio RAM directly. The FIFO pointers are readable in `RXFIRST_PTR`, `RXLAST_PTR`, and `RXP1_PTR`. This can be useful if one wants to access quickly a certain byte within a frame without having to read out the entire frame first. Note that when using this direct accessing, no FIFO pointers are updated.

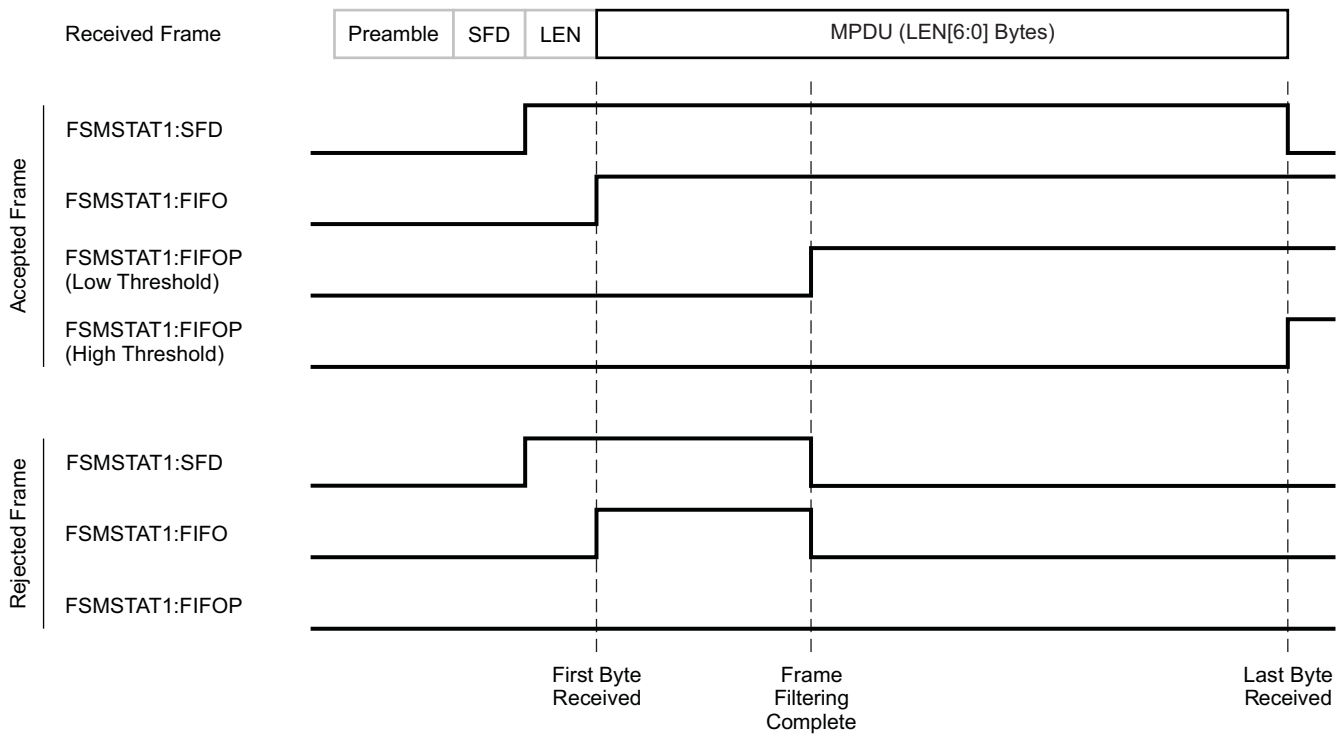
The `ISFLUSHRX` command strobe resets the RXFIFO, resetting all FIFO pointers and clearing all counters, status signals, and sticky error conditions. However, if the receiver is actively receiving a frame when the FIFO is flushed, the `RFERRF.ABO` flag is asserted.

The `SFLUSHRX` command strobe resets the RXFIFO, removing all received frames and clearing all counters, status signals, and sticky-error conditions.

23.10.1 Using the FIFO and FIFOP

The `FIFO` and `FIFOP` signals are useful when reading out received frames in small portions while the frame is received:

- `FSMSTAT1.FIFO` goes high when one or more bytes are in the RXFIFO, but low when RX overflow has occurred.
- The `FSMSTAT1.FIFOP` signal goes high when:
 - The number of valid bytes in the RXFIFO exceeds the `FIFOP` threshold value programmed into `FIFOPCTRL`. When frame filtering is enabled, the bytes in the frame header are not considered valid until the frame has been accepted.
 - The last byte of a new frame is received, even if the `FIFOP` threshold is not exceeded. If so, `FIFOP` goes back to low at the next RXFIFO read access.



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Figure 23-17. Behavior of FIFO and FIFOP Signals

When using the FIFOP as an interrupt source for the microcontroller, the FIFOP threshold should be adjusted by the interrupt service routine to prepare for the next interrupt. When preparing for the last interrupt for a frame, the threshold should match the number of bytes remaining.

23.10.2 Error Conditions

There are two error conditions associated with the RXFIFO:

- Overflow, in which case the RXFIFO is full when another byte is received
- Underflow, in which case software attempts to read a byte from an empty RXFIFO

RX overflow is indicated by the `RFERRF.RXOVERF` flag being set and by the signal values `FSMSTAT1.FIFO = 0` and `FSMSTAT1.FIFOP = 1`. When the error occurs, frame reception is halted. The frames currently stored in the RXFIFO may be read out before the condition is cleared with the `ISFLUSHRX` strobe. Note that rejected frames can generate RX overflow if the condition occurs before the frame is rejected.

RX underflow is indicated by the `RFERRF.RXUNDERF` flag being set. RX underflow is a serious error condition that should not occur in error-free software, and the `RXUNDERF` event should only be used for debugging or in a *watchdog* function. Note that the `RXUNDERF` error is not generated when the read operation occurs simultaneously with the reception of a new byte.

23.10.3 RSSI

The radio has a built-in received signal-strength indication (RSSI), which calculates an 8-bit signed digital value that can be read from a register or automatically appended to received frames. The RSSI value is the result of averaging the received power over eight symbol periods (128 μ s) as specified by IEEE 802.15.4 [1].

The RSSI value is a 2s-complement signed number on a logarithmic scale with 1-dB steps.

The status bit `RSSI_VALID` should be checked before reading the `RSSI` value register. `RSSI_VALID` indicates that the `RSSI` value in the register is in fact valid, which means that the receiver has been enabled for at least eight symbol periods.

To find the actual signal power P at the RF pins with reasonable accuracy, an offset must be added to the `RSSI` value.

$$P = \text{RSSI} - \text{OFFSET} \text{ [dBm]}$$

For example, with an offset of 73 dB, reading an `RSSI` value of -10 from the `RSSI` register means that the RF input power is approximately -83 dBm. For the correct offset value to use, see the data sheet ([Appendix C](#)).

There are two ways the radio can update the `RSSI` register after it has first become valid. If `FRMCTRL0.ENERGY_SCAN = 0` (default), the `RSSI` register contains the latest value available, but if this bit is set to 1, a peak search is performed, and the `RSSI` register contains the largest value since the energy scan was enabled.

23.10.4 Link Quality Indication

The link quality indication (LQI) is a measurement of the strength and/or quality of the received frame as defined by the IEEE 802.15.4 standard [1]. The LQI value is required by the IEEE 802.15.4 standard [1] to be limited to the range 0 through 255, with at least eight unique values. The radio does not provide an LQI value directly, but reports several measurements that can be used by the microcontroller to calculate an LQI value.

The `RSSI` value can be used by the MAC software to calculate the LQI value. This approach has the disadvantage that, e.g., a narrowband interferer inside the channel bandwidth can increase the `RSSI` and thus the LQI value, although the true link quality actually decreases. The radio therefore also provides an average correlation value for each incoming frame, based on the first eight symbols following the SFD. This unsigned 7-bit value can be looked on as a measurement of the *chip error rate*, although the radio does not do chip decision.

As described in [Section 23.9.7](#), the average correlation value for the first eight symbols is appended to each received frame, together with the `RSSI` and CRC OK/not OK, when `FRMCTRL0.AUTOCRC` is set. A correlation value of ~ 110 indicates a maximum-quality frame, whereas a value of ~ 50 is typically the lowest-quality frame detectable by the radio.

Software must convert the correlation value to the range 0–255 as defined by [1], for instance by calculating:

$$\text{LQI} = (\text{CORR} - a)b$$

limited to the range 0–255, where a and b are found empirically based on PER measurements as a function of the correlation value.

A combination of `RSSI` and correlation values may also be used to generate the LQI value.

23.11 Radio Control State Machine

The FSM module is responsible for maintaining the TXFIFO and RXFIFO pointers, control of analog *dynamic* signals such as power up/power down, control of the data flow within the RF Core, generation of automatic acknowledgement frames, and control of all analog RF calibration.

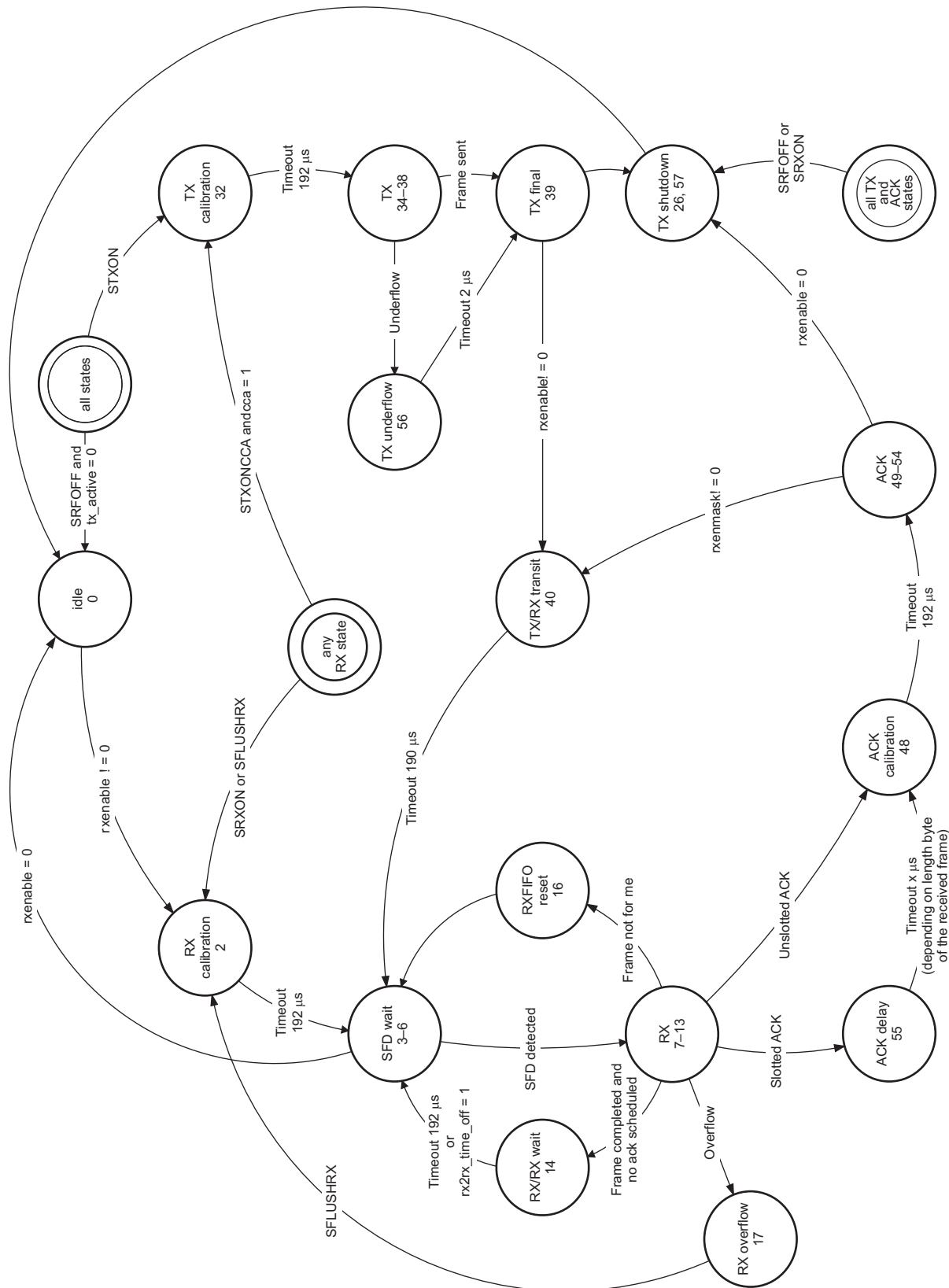


Figure 23-18. Main FSM

Table 23-3 shows the mapping from FSM state to the number which can be read from the `FSMSTAT0` register. Note that although it is possible to read the state of the FSM, this information should not be used to control the program flow in the application software. The states may change very quickly (every 32-MHz clock cycle), and an 8-MHz SPI is not able to capture all the activities.

Table 23-3. FSM State Mapping

State Name	State Number, Decimal	Number, Hex	TX_ACTIVE	RX_ACTIVE
Idle	0	0x00	0	0
RX calibration	2	0x02	0	1
SFD wait	3–6	0x03–0x06	0	1
RX	7–13	0x07–0x0D	0	1
RX/RX wait	14	0x0E	0	1
RXFIFO reset	16	0x10	0	1
RX overflow	17	0x11	0	0
TX calibration	32	0x20	1	0
TX	34–38	0x22–0x26	1	0
TX final	39	0x27	1	0
TX/RX transit	40	0x28	1	0
ACK calibration	48	0x30	1	0
ACK	49–54	0x31–0x36	1	0
ACK delay	55	0x37	1	0
TX underflow	56	0x38	1	0
TX shutdown	26, 57	0x1A, 0x39	1	0

23.12 Random-Number Generation

The RF Core can generate random bits. The chip should be in RX when generation of random bits is required. One must also make sure that the chip has been in RX long enough for the transients to have died out. A convenient way to do this is to wait for the RSSI-valid signal to go high.

Single random bits from either the I or Q channel can be read from the register `RFRND`.

Randomness tests show good results for this module. However, a slight dc component exists. In a simple test where the `RFRND`.`IRND` register was read a number of times and the data grouped into bytes, about 20 million bytes were read. When interpreted as unsigned integers between 0 and 255, the mean value was 127.6518, which indicates that there is a dc component.

The FFT of the first 2^{14} bytes is shown in [Figure 19](#). Note that the dc component is clearly visible. A histogram (32 bins) of the 20 million values is shown in [Figure 20](#).

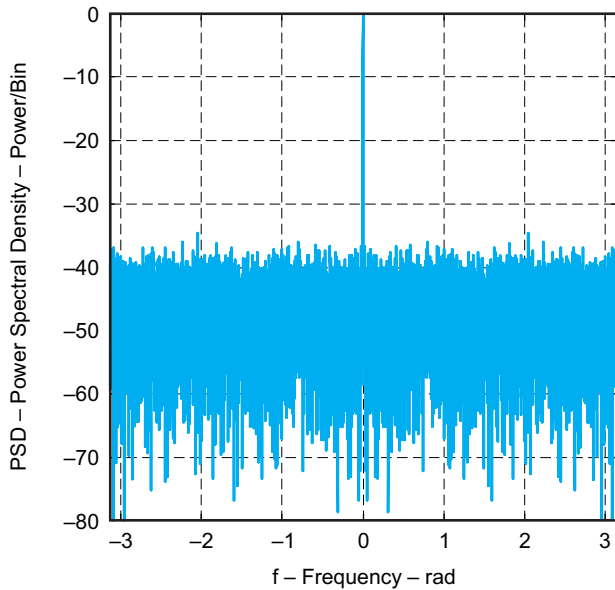


Figure 19. FFT of the Random Bytes

G001

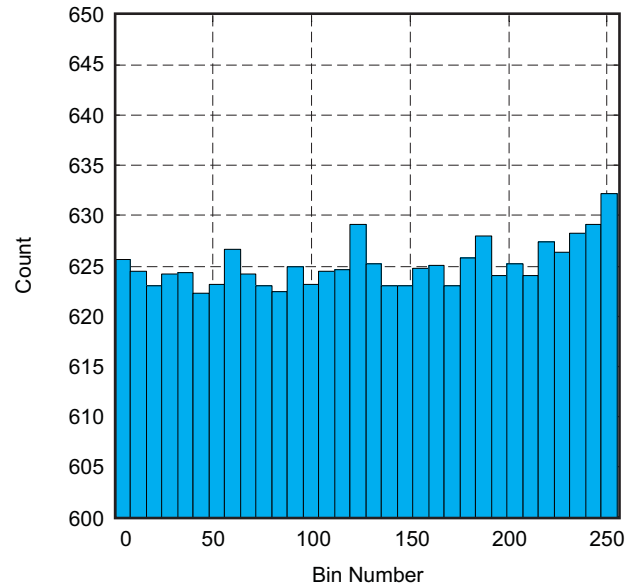


Figure 20. Histogram of 20 Million Bytes Generated With the RANDOM Instruction

G002

For the first 20 million individual bits, the probability of a one is $P(1) = 0.500602$ and $P(0) = 1 - P(1) = 0.499398$.

Note that to fully qualify the random generator as *true random*, much more elaborate tests are required. There are software packages available on the internet that may be useful in this respect [8], [9].

23.13 Packet Sniffing and Radio Test Output Signals

Packet sniffing is a nonintrusive way of observing data that is either being transmitted or received. The packet sniffer outputs a clock and a data signal, which should be sampled on the rising edges of the clock. The two packet sniffer signals are observable as GPIO outputs. For accurate time stamping, the SFD signal should also be output.

Because the radio has a data rate of 250 kbps, the packet sniffer clock frequency is 250 kHz. The data is output serially, with the MSB of each byte first, which is opposite of the actual RF transmission, but more convenient when processing the data. It is possible to use a SPI slave to receive the data stream.

When sniffing frames in TX mode, the data that is read from the TXFIFO by the modulator is the same data that is output by the packet sniffer. However, if automatic CRC generation is enabled, the packet sniffer does NOT output these 2 bytes. Instead, it replaces the CRC bytes with 0x8080. This value can never occur as the last two bytes of a received frame (when automatic CRC checking is enabled), and thus it provides a way for the receiver of the sniffed data to separate frames that were transmitted and frames that were received.

When sniffing frames in RX mode, the data that is written to the RXFIFO by the demodulator is the same data that is output by the packet sniffer. In other words, the last two bytes are either the received CRC value or the CRC OK/RSSI/correlation/SRCRESINDEX value that may automatically replace the CRC value, depending on configuration settings.

To set up the packet sniffer signals or some of the other RF Core observation outputs (in total maximum 3; `rfc_obs_sig0`, `rfc_obs_sig1`, and `rfc_obs_sig2`), the user must perform the following steps:

Step1: Determine which signal (`rfc_obs_sig`) to output on which GPIO pin (P1[0:5]). This is done using the OBSSELx control registers (OBSSEL0–OBSSEL5) that control the observation output to pins P1[0:5] (overriding the standard GPIO behavior for those pins).

Step2: Set the RFC_OBS_CTRL control registers (RFC_OBS_CTRL0–RFC_OBS_CTRL2) to select the correct signals (`rfc_obs_sig`); e.g., for packet sniffing one needs the `rfc_sniff_data` for the packet sniffer data signal and `rfc_sniff_clk` for the corresponding clock signal.

Step3: For packet sniffing, the packet sniffer module must be enabled in the MDMTEST1 register.

23.14 Command Strobe/CSMA-CA Processor

The command strobe/CSMA-CA processor (CSP) provides the control interface between the CPU and the radio.

The CSP interfaces with the CPU through the SFR register `RFST` and the XREG registers `CSPX`, `CSPY`, `CSPZ`, `CSPT`, `CSPSTAT`, `CSPCTRL`, and `CSPPROG<n>` (where `n` is in the range 0 to 23). The CSP produces interrupt requests to the CPU. In addition, the CSP interfaces with the MAC Timer by observing MAC Timer events.

The CSP allows the CPU to issue command strobes to the radio, thus controlling the operation of the radio.

The CSP has two modes of operation, which are described as follows.

- Immediate command strobe execution
- Program execution

Immediate command strobes are written as Immediate Command Strobe instructions to the CSP, which are issued instantly to the radio module. The Immediate Command Strobe instructions are also used to control the CSP. The Immediate Command Strobe instructions are described in [Section 23.14.8](#).

Program execution mode means that the CSP executes a sequence of instructions, comprising a short user-defined program, from a program memory or instruction memory. The available instructions are from a set of 20 instructions. The instruction set is defined in [Section 23.14.8](#). The required program is first loaded into the CSP by the CPU, and then the CPU instructs the CSP to start executing the program.

The program execution mode, together with the MAC Timer, allows the CSP to automate CSMA-CA algorithms and thus act as a coprocessor for the CPU.

The operation of the CSP is described in detail in the following sections. The command strobes and other instructions supported by the CSP are given in [Section 23.14.9](#).

RFST (0xE1) – RF CSMA-CA/Strobe Processor

Bit	Name	Reset	R/W	Description
7:0	INSTR[7:0]	0xD0	R/W	Data written to this register is written to the CSP instruction memory. Reading this register returns the CSP instruction currently being executed.

23.14.1 Instruction Memory

The CSP executes single-byte program instructions which are read from a 24-byte instruction memory. Writes to the instruction memory are sequential, written through SFR register `RFST`. An instruction write pointer is maintained within the CSP to hold the location within the instruction memory where the next instruction written to `RFST` is to be stored. For debugging purposes, the program currently loaded into the CSP can be read from the XREG registers `CSPPROG<n>`. Following a reset, the write pointer is reset to location 0. During each `RFST` register write, the write pointer is incremented by 1 until the end of memory is reached, at which time the write pointer stops incrementing. The first instruction written to `RFST` is stored in location 0, the location where program execution starts. Thus, a complete 24-instruction program is written to the instruction memory by writing each instruction in the desired order to the `RFST` register.

The write pointer can be reset to 0 by writing the immediate command strobe instruction `ISSTOP`. In addition, the write pointer is reset to 0 when the command strobe `SSTOP` is executed in a program.

Following a reset, the instruction memory is filled with `SNOP` (No Operation) instructions (opcode value `0xC0`). The immediate strobe `ISCLEAR` clears the instruction memory, filling it with `SNOP` instructions.

While the CSP is executing a program, there must be no attempts to write instructions to the instruction memory by writing to `RFST`. Failure to observe this rule can lead to incorrect program execution and corrupt instruction memory contents. However, Immediate Command Strobe instructions may be written to `RFST` (see [Section 23.14.3](#)).

23.14.2 Data Registers

The CSP has three data registers, `CSPT`, `CSPX`, `CSPY`, and `CSPZ`, which are read/write accessible for the CPU as XREG registers. These registers are read or modified by some instructions, thus allowing the CPU to set parameters to be used by a CSP program, or allowing the CPU to read CSP program status.

The `CSPT` data register is not modified by any instruction. The `CSPT` data register is used to set a MAC Timer overflow-compare value. Once program execution has started on the CSP, the content of this register is decremented by 1 each time the MAC Timer overflows. When `CSPT` reaches zero, program execution is halted and the interrupt `IRQ_CSP_STOP` is asserted. The `CSPT` register is not decremented if the CPU writes `0xFF` to this register.

NOTE: If the `CSPT` register compare function is not used, this register must be set to `0xFF` before the program execution is started.

23.14.3 Program Execution

After the instruction memory has been filled, program execution is started by writing the immediate command strobe instruction `ISSTART` to the `RFST` register. Program execution continues until the instruction at the last location has been executed, the `CSPT` data register content is zero, an `SSTOP` instruction has been executed, an immediate `ISSTOP` instruction is written to `RFST`, or a `SKIP` instruction returns a location beyond the last location in the instruction memory. The CSP runs at the set system clock frequency, which must be set to 32 MHz for correct radio operation.

Immediate command strobe instructions may be written to `RFST` while a program is being executed. In this case, the immediate instruction is executed before the instruction in the instruction memory, which is executed once the immediate instruction has been completed.

During program execution, reading `RFST` returns the current instruction being executed. An exception to this is the execution of immediate command stobes, during which `RFST` returns `0xD0`.

23.14.4 Interrupt Requests

The CSP has three interrupt flags which can produce the RF interrupt vector. These are the following:

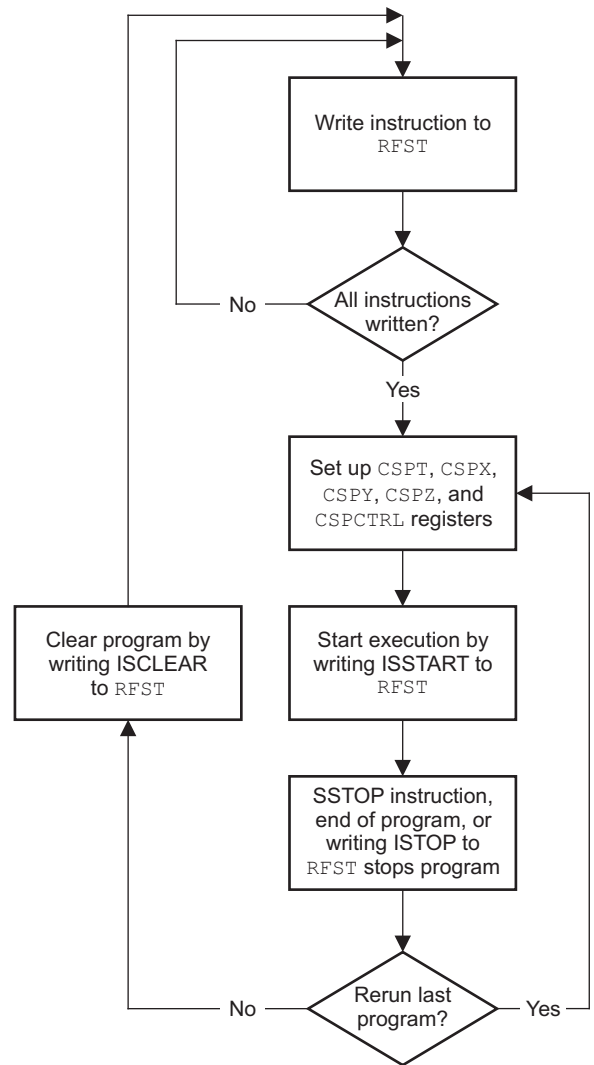
- `IRQ_CSP_STOP`: asserted when the processor has executed the last instruction in memory or when the processor stops due to an `SSTOP` or `ISSTOP` instruction or the `CSPT` register being equal to zero
- `IRQ_CSP_WT`: asserted when the processor continues executing the next instruction after a `WAIT W` or `WAITX` instruction
- `IRQ_CSP_INT`: asserted when the processor executes an `INT` instruction

23.14.5 Random Number Instruction

There is a delay in the update of the random number used by the `RANDXY` instruction. Therefore, if the instruction `RANDXY`, which uses this value, is issued immediately after a previous `RANDXY` instruction, the random value read may be the same in both cases.

23.14.6 Running CSP Programs

The basic flow for loading and running a program on the CSP is shown in [Figure 23-21](#). When program execution stops at the end of the program, the current program remains in program memory so that the same program can be run again by starting execution once again with the `ISSTART` command. To clear the program contents, use the `ISCLEAR` instruction.



F0037-01

Figure 23-21. Running a CSP Program

23.14.7 Registers

CSPROG<N> (N Ranging From 0 to 23) (0x61C0 + N) – CSP Program

Bit	Name	Reset	R/W	Description
7:0	CSP_INSTR	0xD0	R	Byte N of the CSP program memory

CSPCTRL (0x61E0) – CSP Control Bit

Bit	Name	Reset	R/W	Description
7:1	—	0000 000	R0	Reserved. Read as 0
0	MCU_CTRL	0	R/W	CSP MCU control input

CSPSTAT (0x61E1) – CSP Status Register

Bit	Name	Reset	R/W	Description
7:6	—	00	R0	Reserved. Read as 0
5	CSP_RUNNING	0	R	1: CSP is running. 0: CSP is idle.
4:0	CSP_PC	0 0000	R	CSP program counter

CSPX (0x61E2) – CSP X Register

Bit	Name	Reset	R/W	Description
7:0	CSPX	0x00	R/W	CSP X data register. Used by CSP instructions WAITX, RANDXY, INCX, DECX, and conditional instructions

CSPY (0x61E3) – CSP Y Register

Bit	Name	Reset	R/W	Description
7:0	CSPY	0x00	R/W	CSP Y data register. Used by CSP instructions RANDXY, INCY, DECY, and conditional instructions

CSPZ (0x61E4) – CSP Z Register

Bit	Name	Reset	R/W	Description
7:0	CSPZ	0x00	R/W	CSP Z data register. Used by CSP instructions INCZ, DECZ, and conditional instructions

CSPT (0x61E5) – CSP T Register

Bit	Name	Reset	R/W	Description
7:0	CSPT	0xFF	R/W	CSP T data register. Content is decremented each time the MAC Timer overflows while the CSP program is running. The SCP program stops when decremented to 0. Setting CSPT = 0xFF prevents the register from being decremented.

23.14.8 Instruction Set Summary

This section gives an overview of the instruction set. This is intended as a summary and definition of instruction opcodes. See [Section 23.14.9](#) for a description of each instruction. Each instruction consists of one byte, which is written to the `RFST` register to be stored in the instruction memory.

The Immediate Strobe instructions (`ISxxx`) are not used in a program. When these instructions are written to the `RFST` register, they are executed immediately. If the CSP is already executing a program, the current instruction is delayed until the immediate strobe instruction has completed.

For undefined opcodes, the behavior of the CSP is defined as a no-operation strobe command (`SNOP`).

Table 23-4. Instruction Set Summary

Mnemonic	7	6	5	4	3	2	1	0	Description
SKIP <C>, <S>	0	S2	S1	S0	N	C2	C1	C0	<p>Skip S instructions on condition C. When condition (C XOR N) is true, skip the next S instructions, else execute the next instruction. If S = 0, re-execute the conditional jump (i.e., busy loop until condition is false). Skipping past the last instruction in the command buffer results in an implicit STOP command. The conditions are:</p> <p>C = 0 CCA true</p> <p>C = 1 Synchronization word received and still receiving packet or synchronization word transmitted and still transmitting packet (SFD found, not yet frame end)</p> <p>C = 2 MCU control bit is 1.</p> <p>C = 3 Reserved</p> <p>C = 4 Register X = 0</p> <p>C = 5 Register Y = 0</p> <p>C = 6 Register Z = 0</p> <p>C = 7 RSSI_VALID = 1</p>
WAIT <W>	1	0	0	W4	W3	W2	W1	W0	Wait for MAC Timer to overflow W times. Waits until the MAC Timer has overflowed W times (W = 0 waits 32 times), then continues execution. Generates an IRQ_CSP_WAIT interrupt request when execution continues.
RPT <C>	1	0	1	0	N	C2	C1	C0	<p>Repeat loop while condition C. If condition C is true, go to the instruction following the last LABEL instruction (address in loop-start register); if the condition is false or no LABEL instruction has been executed, go to the next instruction.</p> <p>Note condition C is as defined for SKIP, defined previously in this table. It is not possible to have a RPT instruction placed at index 23 of the command buffer.</p>
WEVENT1	1	0	1	1	1	0	0	0	Wait for mact_event1 to go high, and then continue execution.
WEVENT2	1	0	1	1	1	0	0	1	Wait for mact_event2 to go high, and then continue execution.
INT	1	0	1	1	1	0	1	0	Generate an IRQ_CSP_MANINT. Issues an IRQ_CSP_MANINT interrupt request.
LABEL	1	0	1	1	1	0	1	1	Set the next instruction as the start of a repeat loop. Enters the address of the next instruction into the loop-start register.
WAITX	1	0	1	1	1	1	0	0	Wait for MAC Timer to overflow [X] times, where [X] is the value of register X. Each time a MAC Timer overflow is detected, X is decremented. Execution continues as soon as X = 0. (If X = 0 when instruction is run, no wait is performed and execution continues directly). An IRQ_CSP_WAIT interrupt request is generated when execution continues.
RANDXY	1	0	1	1	1	1	0	1	Load the [Y] LSBs of register X with random value.
SETCMP1	1	0	1	1	1	1	1	0	Set the output csp_mact_setcmp1 high. This sets the compare value of the MAC Timer to the current timer value.
INCX	1	1	0	0	0	0	0	0	Increment register X.
INCY	1	1	0	0	0	0	0	1	Increment register Y.
INCZ	1	1	0	0	0	0	1	0	Increment register Z.
DECX	1	1	0	0	0	0	1	1	Decrement register X.
DECY	1	1	0	0	0	1	0	0	Decrement register Y.
DECZ	1	1	0	0	0	1	0	1	Decrement register Z.
INCMAXY <M>	1	1	0	0	1	M2	M1	M0	Register Y ≤ min(Y + 1, M). Increment Y, but not beyond M.
Sxxx	1	1	0	1	S3	S2	S1	S0	<p>Execute command strobe S. Send command strobe S to FFCTRL. Up to 32 command strobes are supported. In addition to the regular command strobes, two additional command strobes that only apply to the command strobe processor are supported:</p> <p>SNOP: Do nothing.</p> <p>SSTOP: Stops the command strobe processor execution and invalidates any set label. An IRQ_CSP_STOP interrupt request is issued.</p>

Table 23-4. Instruction Set Summary (continued)

Mnemonic	7	6	5	4	3	2	1	0	Description
ISxxx	1	1	1	0	S3	S2	S1	S0	Execute command strobe S immediately. Send command strobe S to FFCTRL immediately, bypassing the instructions in the command buffer. If the current buffer instruction is a strobe, it is delayed. In addition to the regular command strobes, two additional command strobes that only apply to the command strobe processor are supported: ISSTART: The command strobe processor starts execution at the first instruction in the command buffer. Do not issue an ISSTART instruction if the CSP is already running. ISSTOP: Stops the command strobe processor execution and invalidates any set label. An IRQ_CSP_STOP interrupt request is issued.
ISCLEAR	1	1	1	1	1	1	1	1	Clear the CSP program. Reset PC.

23.14.9 Instruction Set Definition

There are 20 basic instruction types. Furthermore, the command-strobe and immediate-strobe instructions can each be divided into 16 subinstructions, giving an effective number of 42 different instructions. The following subsections describe each instruction in detail.

Note: the following definitions are used in this section

- PC = CSP program counter
- X = RF register CSPX
- Y = RF register CSPY
- Z = RF register CSPZ
- T = RF register CSP T

23.14.9.1 DECZ

- Function:** Decrement Z
- Description:** The Z register is decremented by 1. An original value of 0x00 underflows to 0xFF.
- Operation:** $Z = Z - 1$

Opcode: 0xC5

7	6	5	4	3	2	1	0
1	1	0	0	0	1	0	1

23.14.9.2 DECY

- Function:** Decrement Y
- Description:** The Y register is decremented by 1. An original value of 0x00 underflows to 0xFF.
- Operation:** $Y = Y - 1$

Opcode: 0xC4

7	6	5	4	3	2	1	0
1	1	0	0	0	1	0	0

23.14.9.3 DECX

Function: Decrement X
Description: The X register is decremented by 1. An original value of 0x00 underflows to 0xFF.
Operation: $X = X - 1$

Opcode: 0xC3

7	6	5	4	3	2	1	0
1	1	0	0	0	0	1	1

23.14.9.4 INCZ

Function: Increment Z
Description: The X register is incremented by 1. An original value of 0xFF overflows to 0x00.
Operation: $Z = Z + 1$

Opcode: 0xC2

7	6	5	4	3	2	1	0
1	1	0	0	0	0	1	0

23.14.9.5 INCY

Function: Increment Y
Description: The Y register is incremented by 1. An original value of 0xFF overflows to 0x00.
Operation: $Y = Y + 1$

Opcode: 0xC1

7	6	5	4	3	2	1	0
1	1	0	0	0	0	0	1

23.14.9.6 INCX

Function: Increment X
Description: The X register is incremented by 1. An original value of 0xFF overflows to 0x00.
Operation: $X = X + 1$

Opcode: 0xC0

7	6	5	4	3	2	1	0
1	1	0	0	0	0	0	0

23.14.9.7 INCMAXY

Function: Increment Y not greater than M.
Description: The Y register is incremented by 1 if the result is less than M; otherwise, Y register is loaded with value M.
Operation: $Y = \min(Y + 1, M)$

Opcode: 0xC8 | M (M = 0–7)

7	6	5	4	3	2	1	0
1	1	0	0	1	M		

23.14.9.8 RANDXY

Function: Load random value into X.

Description: The [Y] LSBs of the X register are loaded with a random value. Note that if a second RANDXY instruction is issued immediately (within 13 clock cycles) after the first, the same random value is used in both cases. If Y equals zero or is greater than 7, then an 8-bit random value is loaded into X.

Operation: $X[(Y - 1):0] = \text{RNG_DOUT}[(Y - 1):0]$, $X[7:Y] = 0$

Opcode: 0xBD

7	6	5	4	3	2	1	0
1	0	1	1	1	1	0	1

23.14.9.9 INT

Function: Interrupt

Description: The interrupt IRQ_CSP_INT is asserted when this instruction is executed.

Operation: $\text{IRQ_CSP_INT} = 1$

Opcode: 0xBA

7	6	5	4	3	2	1	0
1	0	1	1	1	0	1	0

23.14.9.10 WAITX

Function: Wait for X MAC Timer overflows

Description: Wait for MAC Timer to overflow [X] times, where [X] is the value of register X. Each time a MAC Timer overflow is detected, the value in register X is decremented. Program execution continues as soon as $X = 0$. (If $X = 0$ when instruction is run, no wait is performed and execution continues directly.) An IRQ_CSP_WAIT interrupt request is generated when execution continues. **Note:** The difference compared to WAIT W is that W is a fixed value, whereas X is a register value (which could potentially be changed, such that the number of overflows actually does not correspond to the value of X at the time WAITX instruction is run).

Operation: $X = X - 1$ when MAC Timer overflow = true
 $\text{PC} = \text{PC}$ while $X > 0$
 $\text{PC} = \text{PC} + 1$ when $X = 0$

Opcode: 0xBC

7	6	5	4	3	2	1	0
1	0	1	1	1	1	0	0

23.14.9.11 SETCMP1

- Function:** Set the compare value of the MAC Timer to the current timer value.
Description: Set the compare value of the MAC Timer to the current timer value.
Operation: Csp_mact_setcmp1 = 1

Opcode: 0xBE

7	6	5	4	3	2	1	0
1	0	1	1	1	1	1	0

23.14.9.12 WAIT W

- Function:** Wait for W MAC Timer overflows
Description: Wait until MAC Timer overflows a number of times equal to the value of W. If W = 0, the instruction waits for 32 overflows. Program execution continues with the next instruction, and the interrupt flag IRQ_CSP_WT is asserted when the wait condition is true.
Operation: PC = PC while number of MAC Timer overflows < W
PC = PC + 1 when number of MAC Timer overflows = W

Opcode: 0x80 | W (W = 0–31)

7	6	5	4	3	2	1	0
1	0	0	W				

23.14.9.13 WEVENT1

- Function:** Wait until MAC Timer event 1
Description: Wait until next MAC Timer event. Program execution continues with the next instruction when the wait condition is true.
Operation: PC = PC while MAC Timer compare = false
PC = PC + 1 when MAC Timer compare = true

Opcode: 0xB8

7	6	5	4	3	2	1	0
1	0	1	1	1	0	0	0

23.14.9.14 WEVENT2

- Function:** Wait until MAC Timer event 2
Description: Wait until next MAC Timer event. Program execution continues with the next instruction when the wait condition is true.
Operation: PC = PC while MAC Timer compare = false
PC = PC + 1 when MAC Timer compare = true

Opcode: 0xB9

7	6	5	4	3	2	1	0
1	0	1	1	1	0	0	1

23.14.9.15 LABEL

Function: Set loop label

Description: Sets next instruction as start of loop. If the current instruction is the last instruction in the instruction memory, then the current PC is set as start of loop. If several label instructions are executed, the last label executed is the active label. Earlier labels are removed, which means that only one level of loops is supported.

Operation: LABEL = PC + 1

Opcode: 0xBB

7	6	5	4	3	2	1	0
1	0	1	1	1	0	1	1

23.14.9.16 RPT C

Function: Conditional repeat

Description: If condition C is true, then jump to the instruction defined by the last LABEL instruction, i.e., jump to start of loop. If the condition is false or if a LABEL instruction has not been executed, then execution continues from next instruction. The condition C may be negated by setting N = 1 and is described in the following table.

Condition Code C	Description	Function
000	CCA is true	CCA = 1
001	Synchronization word received and still receiving packet or synchronization word transmitted and still transmitting packet	SFD = 1
010	CPU control true	CSPCTRL.CPU_CTRL = 1
011	Reserved	
100	Register X = 0	X = 0
101	Register Y = 0	Y = 0
110	Register Z = 0	Z = 0
111	RSSI is valid	RSSI_VALID = 1

Operation: PC = LABEL when (C XOR N) = true
 PC = PC + 1 when (C XOR N) = false or LABEL = not set

Opcode: 0xA0 | N | C (N = 0, 8; C = 0–7)

7	6	5	4	3	2	1	0
1	0	1	0	N	C		

23.14.9.17 SKIP S, C

Function: Conditional skip instruction

Description: Skip S instructions on condition C (where condition C may be negated; N = 1). When condition (C xor N) is true, skip the next S instructions, else execute the next instruction. If S = 0, re-execute the conditional jump (i.e., busy loop until condition is false). Skipping past the last instruction in the command buffer results in an implicit STOP command.

Condition Code C	Description	Function
000	CCA is true	CCA = 1
001	Synchronization word received and still receiving packet or synchronization word transmitted and still transmitting packet	SFD = 1
010	CPU control true	CSPCTRL.CPU_CTRL = 1
011	Reserved	
100	Register X = 0	X = 0
101	Register Y = 0	Y = 0
110	Register Z = 0	Z = 0
111	RSSI is valid	RSSI_VALID = 1

Operation: PC = PC + S + 1 when (C XOR N) = true
 PC = PC + 1 when (C XOR N) = false

Opcode: 0x00 | S | N | C

7	6	5	4	3	2	1	0
0	S			N	C		

23.14.9.18 STOP

Function: Stop program execution
Description: The SSTOP instruction stops the CSP program execution.
Operation: Stop execution

Opcode: 0xD2

7	6	5	4	3	2	1	0
1	1	0	1	0	0	1	0

23.14.9.19 SNOP

Function: No operation
Description: Operation continues at the next instruction.
Operation: PC = PC + 1

Opcode: 0xD0

7	6	5	4	3	2	1	0
1	1	0	1	0	0	0	0

23.14.9.20 SRXON

Function: Enable and calibrate frequency synthesizer for RX
Description: The SRXON instruction asserts the output FFCTL_SRXON_STRB to enable and calibrate the frequency synthesizer for RX. The instruction waits for the radio to acknowledge the command before executing the next instruction.
Operation: SRXON

Opcode: 0xD3

7	6	5	4	3	2	1	0
1	1	0	1	0	0	1	1

23.14.9.21 STXON

Function: Enable TX after calibration

Description: The STXON instruction enables TX after calibration. The instruction waits for the radio to acknowledge the command before executing the next instruction. Sets a bit in `RXENABLE` if `SET_RXENMASK_ON_TX` is set

Operation: STXON

Opcode: 0xD9

7	6	5	4	3	2	1	0
1	1	0	1	1	0	0	1

23.14.9.22 STXONCCA

Function: Enable calibration and TX if CCA indicates a clear channel

Description: The STXONCCA instruction enables TX after calibration if CCA indicates a clear channel.

Operation: STXONCCA

Opcode: 0xDA

7	6	5	4	3	2	1	0
1	1	0	1	1	0	1	0

23.14.9.23 SSAMPLECCA

Function: Sample the current CCA value to `SAMPLED_CCA`

Description: The current CCA value is written to `SAMPLED_CCA` in XREG.

Operation: SSAMPLECCA

Opcode: 0xDB

7	6	5	4	3	2	1	0
1	1	0	1	1	0	1	1

23.14.9.24 SRFOFF

Function: Disable RX/TX and frequency synthesizer.

Description: The SRFOFF instruction disables RX/TX and the frequency synthesizer.

Operation: SRFOFF

Opcode: 0xDF

7	6	5	4	3	2	1	0
1	1	0	1	1	1	1	1

23.14.9.25 SFLUSHRX

- Function:** Flush RXFIFO buffer and reset demodulator
- Description:** The SFLUSHRX instruction flushes the RXFIFO buffer and resets the demodulator. The instruction waits for the radio to acknowledge the command before executing the next instruction.
- Operation:** SFLUSHRX

Opcode: 0xDD

7	6	5	4	3	2	1	0
1	1	0	1	1	1	0	1

23.14.9.26 SFLUSHTX

- Function:** Flush TXFIFO buffer
- Description:** The SFLUSHTX instruction flushes the TXFIFO buffer. The instruction waits for the radio to acknowledge the command before executing the next instruction.
- Operation:** SFLUSHTX

Opcode: 0xDE

7	6	5	4	3	2	1	0
1	1	0	1	1	1	1	0

23.14.9.27 SACK

- Function:** Send acknowledge frame with pending field cleared
- Description:** The SACK instruction sends an acknowledge frame. The instruction waits for the radio to acknowledge the command before executing the next instruction.
- Operation:** SACK

Opcode: 0xD6

7	6	5	4	3	2	1	0
1	1	0	1	0	1	1	0

23.14.9.28 SACKPEND

- Function:** Send acknowledge frame with the pending field set
- Description:** The SACKPEND instruction sends an acknowledge frame with the pending field set. The instruction waits for the radio to acknowledge the command before executing the next instruction.
- Operation:** SACKPEND

Opcode: 0xD7

7	6	5	4	3	2	1	0
1	1	0	1	0	1	1	1

23.14.9.29 SNACK

- Function:** Abort sending of acknowledge frame
- Description:** The SACKPEND instruction aborts sending acknowledge to the frame currently being received.
- Operation:** SNACK

Opcode: 0xD8

7	6	5	4	3	2	1	0
1	1	0	1	1	0	0	0

23.14.9.30 SRXMASKBITSET

- Function:** Set bit in `RXENABLE`
- Description:** The SRXMASKBITSET instruction sets bit 5 in the `RXENABLE` register.
- Operation:** SRXMASKBITSET

Opcode: 0xD4

7	6	5	4	3	2	1	0
1	1	0	1	0	1	0	0

23.14.9.31 SRXMASKBITCLR

- Function:** Clear bit in `RXENABLE`
- Description:** The SRXMASKBITCLR instruction clears bit 5 in the `RXENABLE` register.
- Operation:** SRXMASKBITCLR

Opcode: 0xD5

7	6	5	4	3	2	1	0
1	1	0	1	0	1	0	1

23.14.9.32 ISSTOP

- Function:** Stop program execution
- Description:** The ISSTOP instruction stops the CSP program execution and the `IRQ_CSP_STOP` interrupt flag is asserted.
- Operation:** Stop execution

Opcode: 0xE2

7	6	5	4	3	2	1	0
1	1	1	0	0	0	1	0

23.14.9.33 ISSTART

- Function:** Start program execution
- Description:** The ISSTART instruction starts the CSP program execution from first instruction written to instruction memory. Do not issue an ISSTART instruction if CSP is already running.
- Operation:** PC := 0, start execution

Opcode: 0xE1

7	6	5	4	3	2	1	0
1	1	1	0	0	0	0	1

23.14.9.34 ISRXON

- Function:** Enable and calibrate frequency synthesizer for RX
- Description:** The ISRXON instruction immediately enables and calibrates the frequency synthesizer for RX.
- Operation:** SRXON

Opcode: 0xE3

7	6	5	4	3	2	1	0
1	1	1	0	0	0	1	1

23.14.9.35 ISRXMASKBITSET

- Function:** Set bit in `RXENABLE`
- Description:** The ISRXMASKBITSET instruction immediately sets bit 5 in the `RXENABLE` register.
- Operation:** SRXMASKBITSET

Opcode: 0xE4

7	6	5	4	3	2	1	0
1	1	1	0	0	1	0	0

23.14.9.36 ISRXMASKBITCLR

- Function:** Clear bit in `RXENABLE`
- Description:** The ISRXMASKBITCLR instruction immediately clears bit 5 in the `RXENABLE` register.
- Operation:** SRXMASKBITCLR

Opcode: 0xE5

7	6	5	4	3	2	1	0
1	1	1	0	0	1	0	1

23.14.9.37 ISTXON

- Function:** Enable TX after calibration
- Description:** The ISTXON instruction immediately enables TX after calibration. The instruction waits for the radio to acknowledge the command before executing the next instruction.
- Operation:** STXON_STRB

Opcode: 0xE9

7	6	5	4	3	2	1	0
1	1	1	0	1	0	0	1

23.14.9.38 ISTXONCCA

Function: Enable calibration and TX if CCA indicates a clear channel

Description: The ISTXONCCA instruction immediately enables TX after calibration if CCA indicates a clear channel.

Operation: STXONCCA

Opcode: 0xEA

7	6	5	4	3	2	1	0
1	1	1	0	1	0	1	0

23.14.9.39 ISSAMPLECCA

Function: Sample the current CCA value to `SAMPLED_CCA`

Description: The current CCA value is immediately written to `SAMPLED_CCA` in XREG.

Operation: SSAMPLECCA

Opcode: 0xEB

7	6	5	4	3	2	1	0
1	1	1	0	1	0	1	1

23.14.9.40 ISRFOFF

Function: Disable RX/TX and frequency synthesizer.

Description: The ISRFOFF instruction immediately disables RX/TX and the frequency synthesizer.

Operation: `FFCTL_SRFOFF_STRB = 1`

Opcode: 0xEF

7	6	5	4	3	2	1	0
1	1	1	0	1	1	1	1

23.14.9.41 ISFLUSHRX

Function: Flush RXFIFO buffer and reset demodulator

Description: The ISFLUSHRX instruction immediately flushes the RXFIFO buffer and resets the demodulator.

Operation: SFLUSHRX

Opcode: 0xED

7	6	5	4	3	2	1	0
1	1	1	0	1	1	0	1

23.14.9.42 ISFLUSHTX

- Function:** Flush TXFIFO buffer
Description: The ISFLUSHTX instruction immediately flushes the TXFIFO buffer.
Operation: SFLUSHTX

Opcode: 0xEE

7	6	5	4	3	2	1	0
1	1	1	0	1	1	1	0

23.14.9.43 ISACK

- Function:** Send acknowledge frame with the pending field cleared
Description: The ISACK instruction immediately sends an acknowledge frame.
Operation: SACK

Opcode: 0xE6

7	6	5	4	3	2	1	0
1	1	1	0	0	1	1	0

23.14.9.44 ISACKPEND

- Function:** Send acknowledge frame with the pending field set
Description: The ISACKPEND instruction immediately sends an acknowledge frame with the pending field set. The instruction waits for the radio to receive and interpret the command before executing the next instruction.
Operation: SACKPEND

Opcode: 0xE7

7	6	5	4	3	2	1	0
1	1	1	0	0	1	1	1

23.14.9.45 ISNACK

- Function:** Abort sending of acknowledge frame
Description: The ISNACK instruction immediately prevents sending of an acknowledge frame to the currently received frame.
Operation: SNACK

Opcode: 0xE8

7	6	5	4	3	2	1	0
1	1	1	0	1	0	0	0

23.14.9.46 ISCLEAR

- Function:** Clear CSP program memory, reset program counter
- Description:** The ISCLEAR clears the program memory, resets the program counter, and aborts any running program. No stop interrupt is generated. The LABEL pointer is cleared. The ISCLEAR instruction must be issued twice to reset the program counter.
- Operation:** PC := 0, clear program memory

Opcode: 0xFF

7	6	5	4	3	2	1	0
1	1	1	1	1	1	1	1

23.15 Registers

Table 23-5. Register Overview

Address (Hex)	+ 0x000	+ 0x001	+ 0x002	+ 0x003
0x6180	FRMFILT0	FRMFILT1	SRCMATCH	SRCSHORTEN0
0x6184	SRCSHORTEN1	SRCSHORTEN2	SRCEXTEN0	SRCEXTEN1
0x6188	SRCEXTEN2	FRMCTRL0	FRMCTRL1	RXENABLE
0x618C	RXMASKSET	RXMASKCLR	FREQTUNE	FREQCTRL
0x6190	TXPOWER	TXCTRL	FSMSTAT0	FSMSTAT1
0x6194	FIFOPCTRL	FSMCTRL	CCACTRL0	CCACTRL1
0x6198	RSSI	RSSISTAT	RXFIRST	RXFIFOCNT
0x619C	TXFIFOCNT	RXFIRST_PTR	RXLAST_PTR	RXP1_PTR
0x61A0		TXFIRST_PTR	TXLAST_PTR	RFIRQM0
0x61A4	RFIRQM1	RFERRM	MONMUX	RFRRND
0x61A8	MDMCTRL0	MDMCTRL1	FREQEST	RXCTRL
0x61AC	FSCtrl		FSCAL1	FSCAL2
0x61B0	FSCAL3	AGCCTRL0	AGCCTRL1	AGCCTRL2
0x61B4	AGCCTRL3	ADCTEST0	ADCTEST1	ADCTEST2
0x61B8	MDMTEST0	MDMTEST1	DACTEST0	DACTEST1
0x61BC	DACTEST2	ATEST	PTEST0	PTEST1
0x61C0	CSPPROG0	CSPPROG1	CSPPROG2	CSPPROG3
0x61C4	CSPPROG4	CSPPROG5	CSPPROG6	CSPPROG7
0x61C8	CSPPROG8	CSPPROG9	CSPPROG10	CSPPROG11
0x61CC	CSPPROG12	CSPPROG13	CSPPROG14	CSPPROG15
0x61D0	CSPPROG16	CSPPROG17	CSPPROG18	CSPPROG19
0x61D4	CSPPROG20	CSPPROG21	CSPPROG22	CSPPROG23
0x61D8				
0x61DC				
0x61E0	CSPCTRL	CSPSTAT	CSPX	CSPY
0x61E4	CSPZ	CSPT		
0x61E8				RFC_OBS_CTRL0
0x61EC	RFC_OBS_CTRL1	RFC_OBS_CTRL2		
0x61F0				
0x61F4				
0x61F8			TXFILTCFG	

23.15.1 Register Settings Update

This section contains a summary of the register settings that must be updated from their default value to have optimal performance.

The following settings should be set for both RX and TX. Although not all settings are necessary for both RX and TX, it is recommended for simplicity (allowing one set of settings to be written at the initialization of the code).

Table 23-6. Registers That Require Update From Their Default Value

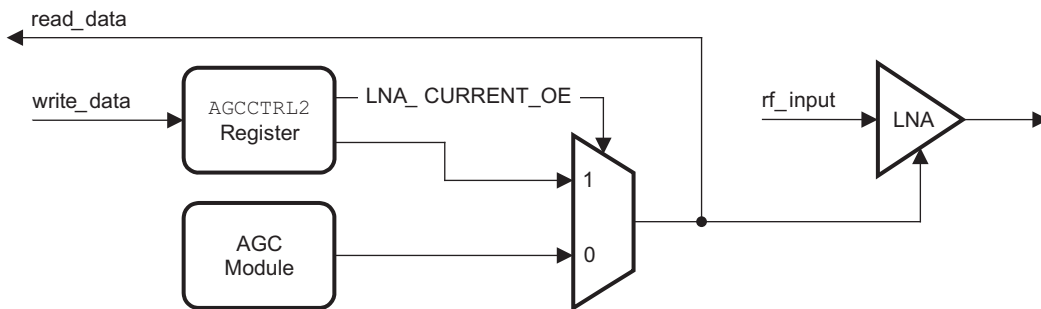
Register Name	New Value (Hex)	Description
AGCTRL1	0x15	Adjusts AGC target value.
TXFILTCFG	0x09	Sets TX anti-aliasing filter to appropriate bandwidth.
FSCAL1	0x00	Reduces the VCO leakage by about 3 dB compared to default setting. Default setting is recommended for optimal EVM.

23.15.2 Register Access Modes

The *Mode* column in [Table 23-7](#) shows what kind of accesses are allowed for each bit. The *Description* column gives the meaning of the different alternatives.

Table 23-7. Register-Bit Access Modes

Mode	Description
R	Read
W	Write
R0	Read constant zero
R1	Read constant one
W1	Only possible to write one
W0	Only possible to write zero
R*	The value read is not the actual register value, but rather the value seen by the module. This is typically used where a configuration value may be generated automatically (through calibration, dynamic control etc.) or manually overridden with a register value. An example structure is shown for the AGCTRL2 register in Figure 23-22 .



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Figure 23-22. Example Hardware Structure for the R* Register Access Mode

23.15.3 Register Descriptions

FRMFILT0 (0x6180) – Frame Filtering

Bit No.	Name	Reset	R/W	Description
7	–	0	R/W	Reserved. Always write 0
6:4	FCF_RESERVED_MASK[2:0]	000	R/W	Used for filtering on the reserved part of the frame control field (FCF). FCF_RESERVED_MASK[2:0] is ANDed with FCF[9:7]. If the result is nonzero and frame filtering is enabled, the frame is rejected.
3:2	MAX_FRAME_VERSION[1:0]	11	R/W	Used for filtering on the frame version field of the frame control field (FCF). If FCF[13:12] (the frame version subfield) is higher than MAX_FRAME_VERSION[1:0] and frame filtering is enabled, the frame is rejected.
1	PAN_COORDINATOR	0	R/W	Should be set high when the device is a PAN coordinator, to accept frames with no destination address (as specified in section 7.5.6.2 of IEEE 802.15.4(b)) 0: Device is not PAN coordinator. 1: Device is PAN coordinator.
0	FRAME_FILTER_EN	1	R/W	Enables frame filtering When this bit is set, the radio performs frame filtering as specified in section 7.5.6.2 of IEEE 802.15.4(b), third filtering level. FRMFILT0[6:1] and FRMFILT1[7:1], together with the local address information, define the behavior of the filtering algorithm. 0: Frame filtering off. (FRMFILT0[6:1], FRMFILT1[7:1] and SRCMATCH[2:0] are don't care.) 1: Frame filtering on.

FRMFILT1 (0x6181) – Frame Filtering

Bit No.	Name	Reset	R/W	Description
7	ACCEPT_FT_4TO7_RESERVED	0	R/W	Defines whether reserved frames are accepted or not. Reserved frames have frame type = 100, 101, 110, or 111. 0: Reject 1: Accept
6	ACCEPT_FT_3_MAC_CMD	1	R/W	Defines whether MAC command frames are accepted or not. MAC command frames have frame type = 011. 0: Reject 1: Accept
5	ACCEPT_FT_2_ACK	1	R/W	Defines whether acknowledgment frames are accepted or not. Acknowledgement frames have frame type = 010. 0: Reject 1: Accept
4	ACCEPT_FT_1_DATA	1	R/W	Defines whether data frames are accepted or not. Data frames have frame type = 001. 0: Reject 1: Accept
3	ACCEPT_FT_0_BEACON	1	R/W	Defines whether beacon frames are accepted or not. Beacon frames have frame type = 000. 0: Reject 1: Accept
2:1	MODIFY_FT_FILTER[1:0]	00	R/W	These bits are used to modify the frame-type field of a received frame before frame-type filtering is performed. The modification does not influence the frame that is written to the RXFIFO. 00: Leave as it is 01: Invert MSB 10: Set MSB to 0 11: Set MSB to 1
0	–	0	R/W	Reserved. Always write 0

SRCMATCH (0x6182) – Source Address Matching and Pending Bits

Bit No.	Name	Reset	R/W	Description
7:3	–	0000 0	R/W	Reserved. Always write 0
2	PEND_DATAREQ_ONLY	1	R/W	When this bit is set, the AUTOPEND function also requires that the received frame is a <i>DATA REQUEST</i> MAC command frame.
1	AUTOPEND	1	R/W	Automatic acknowledgment pending flag enable. On reception of a frame, the pending bit in the (possibly) returned acknowledgment is set automatically, given that: <ul style="list-style-type: none"> – FRMFILT0.FRAME_FILTER_EN is set. – SRCMATCH.SRC_MATCH_EN is set. – SRCMATCH.AUTOPEND is set. – The received frame matches the current SRCMATCH.PEND_DATAREQ_ONLY setting. – The received source address matches at least one source-match table entry, which is enabled in both SHORT_ADDR_EN and SHORT_PEND_EN or EXT_ADDR_EN and EXT_PEND_EN. Note: Details for SHORT_PEND_EN and EXT_PEND_EN is found in the memory map description (Section 23.4).
0	SRC_MATCH_EN	1	R/W	Source address matching enable (This bit is don't care if FRMFILT0.FRAME_FILTER_EN = 0.)

SRCSHORTEN0 (0x6183) – Short Address Matching

Bit No.	Name	Reset	R/W	Description
7:0	SHORT_ADDR_EN[7:0]	0x00	R/W	The 7:0 part of the 24-bit word SHORT_ADDR_EN that enables/disables source address matching for each of the 24 short address table entries. Optional safety feature: To ensure that an entry in the source-matching table is not used while it is being updated, set the corresponding SHORT_ADDR_EN bit to 0 while updating.

SRCSHORTEN1 (0x6184) – Short Address Matching

Bit No.	Name	Reset	R/W	Description
7:0	SHORT_ADDR_EN[15:8]	0x00	R/W	The 15:8 part of the 24-bit word SHORT_ADDR_EN. See previous description of SRCSHORTEN0.

SRCSHORTEN2 (0x6185) – Short Address Matching

Bit No.	Name	Reset	R/W	Description
7:0	SHORT_ADDR_EN[23:16]	0x00	R/W	The 23:16 part of the 24-bit word SHORT_ADDR_EN. See previous description of SRCSHORTEN0.

SRCEXTEN0 (0x6186) – Extended Address Matching

Bit No.	Name	Reset	R/W	Description
7:0	EXT_ADDR_EN[7:0]	0x00	R/W	The 7:0 part of the 24-bit word EXT_ADDR_EN that enables/disables source address matching for each of the 12 extended address table entries. Write access: Extended address enable for table entry n (0 to 7) is mapped to EXT_ADDR_EN[2n]. All EXT_ADDR_EN[2n + 1] bits are read-only and don't care when written to. Read access: Extended address enable for table entry n (0 to 7) is mapped to both EXT_ADDR_EN[2n] and EXT_ADDR_EN[2n + 1]. To ensure that an entry in the source matching table is not used while it is being updated, set the corresponding EXT_ADDR_EN bit to 0 while updating.

SRCEXTEN1 (0x6187) – Extended Address Matching

Bit No.	Name	Reset	R/W	Description
7:0	EXT_ADDR_EN[15:8]	0x00	R/W	The 15:8 part of the 24-bit word EXT_ADDR_EN. See previous description of SRCEXTEN0.

SRCEXTEN2 (0x6188) – Extended Address Matching

Bit No.	Name	Reset	R/W	Description
7:0	EXT_ADDR_EN[23:16]	0x00	R/W	The 23:16 part of the 24-bit word EXT_ADDR_EN. See previous description of SRCEXTEN0.

FRMCTRL0 (0x6189) – Frame Handling

Bit No.	Name	Reset	R/W	Description
7	APPEND_DATA_MODE	0	R/W	When AUTOCRC = 0: Don't care When AUTOCRC = 1: 0: RSSI + The CRC_OK bit and the 7-bit correlation value are appended at the end of each received frame 1: RSSI + The CRC_OK bit and the 7-bit SRCRESINDEX are appended at the end of each received frame. See Table 23-1 for details.
6	AUTOCRC	1	R/W	In TX 1: A CRC-16 (ITU-T) is generated in hardware and appended to the transmitted frame. There is no need to write the last 2 bytes to TXBUF. 0: No CRC-16 is appended to the frame. The last 2 bytes of the frame must be generated manually and written to TXBUF (if not, TX_UNDERFLOW occurs). In RX 1: The CRC-16 is checked in hardware, and replaced in the RXFIFO by a 16-bit status word which contains a CRC OK bit. The status word is controllable through APPEND_DATA_MODE. 0: The last two bytes of the frame (CRC-16 field) are stored in the RXFIFO. The CRC check (if any) must be done manually. Note that this setting does not influence acknowledgment transmission (including AUTOACK).
5	AUTOACK	0	R/W	Defines whether the radio automatically transmits acknowledge frames or not. When autoack is enabled, all frames that are accepted by address filtering, have the acknowledge request flag set, and have a valid CRC are automatically acknowledged 12 symbol periods after being received. 0: Autoack disabled 1: Autoack enabled
4	ENERGY_SCAN	0	R/W	Defines whether the RSSI register contains the most-recent signal strength or the peak signal strength since the energy scan was enabled. 0: Most-recent signal strength 1: Peak signal strength
3:2	RX_MODE[1:0]	00	R/W	Set RX modes 00: Normal operation, use RXFIFO. 01: Reserved 10: RXFIFO looping ignores overflow in RXFIFO; infinite reception. 11: Same as normal operation except that symbol search is disabled. Can be used for RSSI or CCA measurements when it is not desired to find symbol.
1:0	TX_MODE[1:0]	00	R/W	Set test modes for TX 00: Normal operation, transmit TXFIFO 01: Reserved. Should not be used 10: TXFIFO looping ignores underflow in TXFIFO and reads cyclically; infinite transmission. 11: Send pseudorandom data from CRC, infinite transmission.

FRMCTRL1 (0x618A) – Frame Handling

Bit No.	Name	Reset	R/W	Description
7:3	–	0000 0	R0	Read as zero
2	PENDING_OR	0	R/W	Defines whether the pending data bit in outgoing acknowledgment frames is always set to 1 or controlled by the main FSM and the address filtering. 0: Pending data bit is controlled by main FSM and address filtering. 1: Pending data bit is always 1.
1	IGNORE_TX_UNDERF	0	R/W	Defines whether TX underflow should be ignored or not. 0: Normal TX operation. TX underflow is detected and TX is aborted if underflow occurs. 1: Ignore TX underflow. Transmit the number of bytes given by the frame-length field.
0	SET_RXENMASK_ON_TX	1	R/W	Defines whether STXON sets bit 6 in the RXENABLE register or leaves it unchanged. 0: Does not affect RXENABLE. 1: Sets bit 6 in RXENABLE. Used for backwards compatibility with the CC2420.

RXENABLE (0x618B) – RX Enabling

Bit No.	Name	Reset	R/W	Description
7:0	RXENMASK[7:0]	0x00	R	RXENABLE enables the receiver. A nonzero value in this register causes the main FSM to enable the receiver when in idle, after transmission, and after acknowledgement transmission. The following strobes can modify RXENMASK: SRXON: Sets bit 7 in RXENMASK STXON: Sets bit 6 in RXENMASK if SET_RXENMASK_ON_TX = 1 SRFOFF: Clears all bits in RXENMASK SRXMASKBITSET: Sets bit 5 in RXENMASK SRXMASKBITCLR: Clears bit 5 in RXENMASK RXENABLE can be modified directly by the CPU by accessing registers RXMASKSET and RXMASKCLR. There might be conflicts between the CSP and CPU operations if both try to modify RXENMASK simultaneously. To handle the case of simultaneous access to RXENMASK, the following rules apply: – If two sources are not in conflict (they modify different parts of the register), both their requests to modify RXENMASK are processed. – If both try to modify the mask simultaneously, bus-write operations to RXMASKSET and RXMASKCLR have priority over the CSP. It is strongly recommended to avoid this situation.

RXMASKSET (0x618C) – RX Enabling

Bit No.	Name	Reset	R/W	Description
7:0	RXENMASKSET[7:0]	0x00	R0/W	When written, the written data is ORed with RXENMASK and stored in RXENMASK.

RXMASKCLR (0x618D) – RX Disabling

Bit No.	Name	Reset	R/W	Description
7:0	RXENMASKCLR[7:0]	0x00	R0/W	When written, the written data is inverted and ANDed with RXENMASK and stored in RXENMASK. For example, if a 1 is written to one or more bit positions in this register, the corresponding bits are cleared in RXENMASK.

RFIRQM0 (0x61A3) – RF Interrupt Masks

Bit No.	Name	Reset	R/W	Description
7:0	RFIRQM[7:0]	0x00	R/W	Bit mask masking out interrupt sources Bit position 7: RXMASKZERO 6: RXPKTDONE 5: FRAME_ACCEPTED 4: SRC_MATCH_FOUND 3: SRC_MATCH_DONE 2: FIFOP 1: SFD 0: ACT_UNUSED

RFIRQM1 (0x61A4) – RF Interrupt Masks

Bit No.	Name	Reset	R/W	Description
7:0	RFIRQM[14:8]	0x00	R/W	Bit mask masking out interrupt sources Bit position 7: Reserved 6: Reserved 5: CSP_WAIT 4: CSP_STOP 3: CSP_MANINT 2: RF_IDLE 1: TXDONE 0: TXACKDONE

RFERRM (0x61A5) – RF Error Interrupt Mask

Bit No.	Name	Reset	R/W	Description
7:0	RFERRM[7:0]	0x00	R/W	Bit mask masking out interrupt sources Bit position 7: Reserved 6: STROBE_ERR 5: TXUNDERF 4: TXOVERF 3: RXUNDERF 2: RXOVERF 1: RXABO 0: NLOCK

FREQCTRL (0x618F) – Controls the RF Frequency

Bit No.	Name	Reset	R/W	Description
7	–	0	R0	Read as zero
6:0	FREQ[6:0]	0x0B (2405 MHz)	R/W	Frequency control word $f_{RF} = f_{LO} = (2394 + \text{FREQ}[6:0]) \text{ MHz}$ The frequency word in FREQ[6:0] is an offset value from 2394. The device supports the frequency range from 2394 MHz to 2507 MHz. The usable settings for FREQ[6:0] are consequently 0 to 113. Settings outside this range (114–127) give a frequency of 2507 MHz. IEEE 802.15.4-2006 specifies a frequency range from 2405 MHz to 2480 MHz with 16 channels 5 MHz apart. The channels are numbered 11 through 26. For an IEEE 802.15.4-2006 compliant system, the only valid settings are thus $\text{FREQ}[6:0] = 11 + 5 (\text{channel number} - 11)$.

FREQTUNE (0x618E) – Crystal Oscillator Frequency Tuning

Bit No.	Name	Reset	R/W	Description
7:4	–	0x0	R0	Read as zero
3:0	XOSC32M_TUNE[3:0]	0xF	R/W	Tune crystal oscillator The default setting, 1111, leaves the XOSC not tuned. Changing the setting from default switches in extra capacitance to the oscillator, effectively lowering the XOSC frequency. Hence, a higher setting gives a higher frequency.

TXPOWER (0x6190) – Controls the Output Power

Bit No.	Name	Reset	R/W	Description
7:0	PA_POWER [7:0]	0xF5	R/W	PA power control. NOTE: Before going to TX, this value should be updated. Please consult the device's data sheet (Appendix C) for recommended values; see also Section 23.8.13 .

TXCTRL (0x6191) – Controls the TX Settings

Bit No.	Name	Reset	R/W	Description
7	–	0	R0	Reserved
6:4	DAC_CURR[2:0]	110	R/W	Change the current in the DAC.
3:2	DAC_DC[1:0]	10	R/W	Adjusts the dc level to the TX mixer.
1:0	TXMIX_CURRENT[1:0]	01	R/W	Transmit mixers core current: current increases with increasing setting.

FSMSTAT0 (0x6192) – Radio Status Register

Bit No.	Name	Reset	R/W	Description
7	–	0	R	Reserved
6	CAL_RUNNING	0	R	Frequency synthesizer calibration status 0: Calibration done or not started 1: Calibration in progress
5:0	FSM_FFCTRL_STATE[5:0]	–	R	Gives the current state of the FIFO and frame-control (FFCTRL) finite-state machine.

FSMSTAT1 (0x6193) – Radio Status Register

Bit No.	Name	Reset	R/W	Description
7	FIFO	0	R	FIFO is high whenever there is data in the RXFIFO. Low during RXFIFO overflow
6	FIFOP	0	R	FIFOP is set high when there are more than FIFOP_THR bytes of data in the RXFIFO that have passed frame filtering. FIFOP is set high when there is at least one complete frame in the RXFIFO. FIFOP is set low again when a byte is read from the RXFIFO and this leaves FIFOP_THR bytes in the FIFO. FIFOP is high during RXFIFO overflow.
5	SFD	0	R	In TX 0: When a complete frame with SFD has been sent or no SFD has been sent 1: SFD has been sent. In RX 0: When a complete frame has been received or no SFD has been received 1: SFD has been received.
4	CCA	0	R	Clear-channel assessment. Dependent on CCA_MODE settings. See the following description of CCACTRL1.
3	SAMPLED_CCA	0	R	Contains a sampled value of the CCA. The value is updated whenever a SSAMPLECCA or STXONCCA strobe is issued.
2	LOCK_STATUS	0	R	1 when PLL is in lock, otherwise 0.
1	TX_ACTIVE	0	R	Status signal, active when FFCTRL is in one of the transmit states
0	RX_ACTIVE	0	R	Status signal, active when FFCTRL is in one of the receive states

FIFOPCTRL (0x6194) – FIFOP Threshold

Bit No.	Name	Reset	R/W	Description
7	–	0	R0	Read as zero
6:0	FIFOP_THR[6:0]	100 0000	R/W	Threshold used when generating FIFOP signal

FSMCTRL (0x6195) – FSM Options

Bit No.	Name	Reset	R/W	Description
7:2	–	0000 00	R0	Read as zero
1	SLOTTED_ACK	0	R/W	Controls timing of transmission of acknowledge frames 0: The acknowledge frame is sent 12 symbol periods after the end of the received frame which requests the acknowledge. 1: The acknowledge frame is sent at the first backoff-slot boundary more than 12 symbol periods after the end of the received frame which requests the acknowledge.
0	RX2RX_TIME_OFF	1	R/W	Defines whether or not a 12-symbol time-out should be used after frame reception has ended. 0: No time-out 1: 12-symbol-period time-out

CCACTRL0 (0x6196) – CCA Threshold

Bit No.	Name	Reset	R/W	Description
7:0	CCA_THR[7:0]	0xE0	R/W	<p>Clear-channel-assessment threshold value, signed 2s-complement number for comparison with the RSSI.</p> <p>The unit is 1 dB, offset is about 76 dBm. The CCA signal goes high when the received signal is below this value. The CCA signal is available on the CCA pin and in the FSMSTAT1 register.</p> <p>Note that the value should never be set lower than CCA_HYST – 128 in order to avoid erroneous behavior of the CCA signal.</p> <p>NOTE: The reset value translates to an input level of approximately $-32 - 76 = -108$ dBm, which is well below the sensitivity limit. That means the CCA signal never indicates a clear channel.</p> <p>This register should be updated to 0xF8, which translates to an input level of about $-8 - 76 = -84$ dBm.</p>

CCACTRL1 (0x6197) – Other CCA Options

Bit No.	Name	Reset	R/W	Description
7:5	–	000	R0	Read as zero
4:3	CCA_MODE[1:0]	11	R/W	<p>00: CCA always set to 1</p> <p>01: CCA = 1 when $RSSI < CCA_THR - CCA_HYST$; CCA = 0 when $RSSI \geq CCA_THR$</p> <p>10: CCA = 1 when not receiving a frame, else CCA = 0</p> <p>11: CCA = 1 when $RSSI < CCA_THR - CCA_HYST$ and not receiving a frame; CCA = 0 when $RSSI \geq CCA_THR$ or when receiving a frame</p>
2:0	CCA_HYST[2:0]	010	R/W	Sets the level of CCA hysteresis. Unsigned values given in dB

RSSI (0x6198) – RSSI Status Register

Bit No.	Name	Reset	R/W	Description
7:0	RSSI_VAL[7:0]	0x80	R	<p>RSSI estimate on a logarithmic scale, signed number in 2s complement</p> <p>Unit is 1 dB. The offset to use in order to convert the register value into the real RSSI value can be found in the device's data sheet (Appendix C). The RSSI value is averaged over 8 symbol periods. The RSSI_VALID status bit should be checked before reading RSSI_VAL the first time.</p> <p>The reset value of –128 also indicates that the RSSI value is invalid.</p>

RSSISTAT (0x6199) – RSSI Valid Status Register

Bit No.	Name	Reset	R/W	Description
7:1	–	0000 000	R0	Read as zero
0	RSSI_VALID	0	R	RSSI value is valid. Occurs eight symbol periods after entering RX

RXFIRST (0x619A) – First Byte in RXFIFO

Bit No.	Name	Reset	R/W	Description
7:0	DATA[7:0]	0x00	R	<p>First byte of the RXFIFO.</p> <p>Note: Reading this register does not modify the contents of the FIFO.</p>

RXFIFOCNT (0x619B) – Number of Bytes in RXFIFO

Bit No.	Name	Reset	R/W	Description
7:0	RXFIFOCNT[7:0]	0x00	R	Number of bytes in the RXFIFO. Unsigned integer.

TXFIFOCNT (0x619C) – Number of Bytes in TXFIFO

Bit No.	Name	Reset	R/W	Description
7:0	TXFIFOCNT[7:0]	0x00	R	Number of bytes in the TXFIFO. Unsigned integer

RXFIRST_PTR (0x619D) – RXFIFO Pointer

Bit No.	Name	Reset	R/W	Description
7	–	0	R	Reserved
6:0	RXFIRST_PTR[6:0]	000 0000	R	RAM address offset of the first byte in the RXFIFO

RXLAST_PTR (0x619E) – RXFIFO Pointer

Bit No.	Name	Reset	R/W	Description
7	–	0	R	Reserved
6:0	RXLAST_PTR[6:0]	000 0000	R	RAM address offset of the last byte +1 byte in the RXFIFO

RXP1_PTR (0x619F) – RXFIFO Pointer

Bit No.	Name	Reset	R/W	Description
7:0	RXP1_PTR[7:0]	0x00	R	RAM address offset of the first byte of the first frame in the RXFIFO

TXFIRST_PTR (0x61A1) – TXFIFO Pointer

Bit No.	Name	Reset	R/W	Description
7:0	TXFIRST_PTR[7:0]	0x00	R	RAM address offset of the next byte to be transmitted from the TXFIFO

TXLAST_PTR (0x61A2) – TXFIFO Pointer

Bit No.	Name	Reset	R/W	Description
7:0	TXLAST_PTR[7:0]	0x00	R	RAM address offset of the last byte +1 byte of the TXFIFO

MDMCTRL0 (0x61A8) – Controls Modem

Bit No.	Name	Reset	R/W	Description
7:6	DEM_NUM_ZEROS[1:0]	10	R/W	Sets how many zero symbols must be detected before the sync word when searching for sync. Note that only one is required to have a correlation value above the correlation threshold set in the MDMCTRL1 register. 00: Reserved 01: 1 zero symbol 10: 2 zero symbols 11: 3 zero symbols
5	DEMOD_AVG_MODE	0	R/W	Defines the behavior of the frequency offset averaging filter. 0: Lock average level after preamble match. Restart frequency offset calibration when searching for the next frame. 1: Continuously update average level.
4:1	PREAMBLE_LENGTH [3:0]	0010	R/W	The number of preamble bytes (two zero-symbols) to be sent in TX mode prior to the SFD, encoded in steps of 2 symbols (1 byte). The reset value of 2 is compliant with IEEE 802.15.4. 0000: 2 leading-zero bytes 0001: 3 leading-zero bytes 0010: 4 leading-zero bytes 1111: 17 leading-zero bytes
0	TX_FILTER	1	R/W	Defines the kind of TX filter that is used. The normal TX filter is as defined by the IEEE802.15.4 standard. Extra filtering may be applied in order to lower the out-of-band emissions. 0: Normal TX filtering 1: Enable extra filtering

MDMCTRL1 (0x61A9) – Controls Modem

Bit No.	Name	Reset	R/W	Description
7:6	–	00	R0	Read as zero
5	CORR_THR_SFD	0	R/W	Defines requirements for SFD detection: 0: The correlation value of one of the zero symbols of the preamble must be above the correlation threshold. 1: The correlation value of one zero symbol of the preamble and both symbols in the SFD must be above the correlation threshold.
4:0	CORR_THR[4:0]	0x14	R/W	Demodulator correlator threshold value, required before SFD search. Threshold value adjusts how the receiver synchronizes to data from the radio. If the threshold is set too low, sync can more easily be found on noise. If set too high, the sensitivity is reduced, but sync is not likely to be found on noise. In combination with DEM_NUM_ZEROS, the system can be tuned so sensitivity is high with less sync found on noise.

FREQEST (0x61AA) – Estimated RF Frequency Offset

Bit No.	Name	Reset	R/W	Description
7:0	FREQEST[7:0]	0x00	R	Signed 2s-complement value. Contains an estimate of the frequency offset between carrier and the receiver LO. The offset frequency is $FREQEST \times 7800$ Hz. DEM_AVG_MODE controls when this estimate is updated. If DEM_AVG_MODE = 0, it is updated until sync is found. Then the frequency offset estimate is frozen until the end of the received frame. If DEM_AVG_MODE = 1, it is updated as long as the demodulator is enabled. To calculate the correct value, one must use an offset (FREQEST_offset), which can be found in the device's data sheet (Appendix C). Real FREQEST value = FREQEST – FREQEST_offset.

RXCTRL (0x61AB) – Tune Receive Section

Bit No.	Name	Reset	R/W	Description
7:6	–	00	R0	Reserved. Read as 0
5:4	GBIAS_LNA2_REF[1:0]	11	R/W	Adjusts front-end LNA2/mixer PTAT current output (from M = 3 to M = 6), default: M = 5
3:2	GBIAS_LNA_REF[1:0]	11	R/W	Adjusts front-end LNA PTAT current output (from M = 3 to M = 6), default: M = 5
1:0	MIX_CURRENT[1:0]	11	R/W	Control of the receiver mixers output current. The current increases with increasing setting.

FSCTRL (0x61AC) – Tune Frequency Synthesizer

Bit No.	Name	Reset	R/W	Description
7:6	PRE_CURRENT [1:0]	01	R/W	Prescaler current setting
5:4	LODIV_BUF_CURRENT_TX [1:0]	01	R/W	Adjusts current in mixer and PA buffers. Used when TX_ACTIVE = 1
3:2	LODIV_BUF_CURRENT_RX [1:0]	10	R/W	Adjusts current in mixer and PA buffers. Used when TX_ACTIVE = 0
1:0	LODIV_CURRENT [1:0]	10	R/W	Adjusts divider currents, except mixer and PA buffers.

FSCAL1 (0x61AE) – Tune Frequency Calibration

Bit No.	Name	Reset	R/W	Description
7:2	–	0010 10	R/W0	Reserved
1:0	VCO_CURR[1:0]	01	R/W	Defines current in VCO core. Sets the multiplier between calibrated current and VCO current. For the best value to use, see Table 23-6 in Section 23.15.1 .

FSCAL2 (0x61AF) – Tune Frequency Calibration

Bit No.	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6	VCO_CAPARR_OE	0	R/W	Override the calibration result with the value from VCO_CAPARR[5:0].
5:0	VCO_CAPARR[5:0]	10 0000	R*/W	VCO capacitor array setting. Programmed during calibration. Override value when VCO_CAPARR_OE = 1.

FSCAL3 (0x61B0) – Tune Frequency Calibration

Bit No.	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6	VCO_DAC_EN_OV	0	R/W	Enables the VCO DAC when 1
5:2	VCO_VC_DAC [3:0]	1010	R/W	Bit vector for programming varactor control voltage from VC DAC.
1:0	VCO_CAPARR_CAL_CTRL[1:0]	10	R/W	Calibration accuracy setting for the capacitor array part of the calibration 00: 80 XOSC periods 01: 100 XOSC periods 10: 125 XOSC periods 11: 250 XOSC periods

AGCCTRL0 (0x61B1) – AGC Dynamic Range Control

Bit No.	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6	AGC_DR_XTND_EN	1	R/W	0: The AGC performs no adjustment of attenuation in the AAF. 1: The AGC adjusts the gain in the AAF to achieve extra dynamic range for the receiver.
5:0	AGC_DR_XTND_THR[5:0]	01 1111	R/W	If the measured error between the AGC reference magnitude and the actual magnitude in dB is larger than this threshold, the extra attenuation is enabled in the front end. This threshold should be set higher than 0x0C. This feature is enabled by AGC_DR_XTND_EN.

AGCCTRL1 (0x61B2) – AGC Reference Level

Bit No.	Name	Reset	R/W	Description
7:6	–	00	R0	Reserved. Read as 0
5:0	AGC_REF[5:0]	01 0001	R/W	Target value for the AGC control loop, given in 1-dB steps. For the best value to use see Table 23-6 in Section 23.15.1 .

AGCCTRL2 (0x61B3) – AGC Gain Override

Bit No.	Name	Reset	R/W	Description
7:6	LNA1_CURRENT[1:0]	00	R*/W	Override value for LNA 1. Only used when LNA_CURRENT_OE = 1. When read, this register returns the current applied gain setting. 00: 0-dB gain (reference level) 01: 3-dB gain 10: Reserved 11: 6-dB gain
5:3	LNA2_CURRENT[2:0]	000	R*/W	Override value for LNA 2. Only used when LNA_CURRENT_OE = 1. When read, this register returns the current applied gain setting. 000: 0-dB gain (reference level) 001: 3-dB gain 010: 6-dB gain 011: 9-dB gain 100: 12-dB gain 101: 15-dB gain 110: 18-dB gain 111: 21-dB gain
2:1	LNA3_CURRENT[1:0]	00	R*/W	Override value for LNA 3. Only used when LNA_CURRENT_OE = 1. When read, this register returns the current applied gain setting. 00: 0-dB gain (reference level) 01: 3-dB gain 10: 6-dB gain 11: 9-dB gain
0	LNA_CURRENT_OE	0	R/W	Write 1 to override the AGC LNA current setting with the values above (LNA1_CURRENT, LNA2_CURRENT, and LNA3_CURRENT).

AGCCTRL3 (0x61B4) – AGC Control

Bit No.	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6:5	AGC_SETTLE_WAIT[1:0]	01	R/W	Time for AGC to wait for analog gain to settle after a gain change. During this period, the energy measurement in the AGC is paused. 00: 15 periods 01: 20 periods 10: 25 periods 11: 30 periods
4:3	AGC_WIN_SIZE[1:0]	01	R/W	Window size for the accumulate and dump function in the AGC 00: 16 samples 01: 32 samples 10: 64 samples 11: 128 samples
2:1	AAF_RP[1:0]	11	R*/W	Overrides the AGC control signals to AAF when AAF_RP_OE = 1. When read, it returns the applied signal to the AAF. 00: 9-dB attenuation in AAF 01: 6-dB attenuation in AAF 10: 3-dB attenuation in AAF 11: 0-dB attenuation in AAF (reference level)
0	AAF_RP_OE	0	R/W	Write 1 to override the AGC AAF control signals with the values stored in AAF_RP.

ADCTEST0 (0x61B5) – ADC Tuning

Bit No.	Name	Reset	R/W	Description
7:6	ADC_VREF_ADJ[1:0]	00	R/W	Quantizer threshold control for test/debug
5:4	ADC_QUANT_ADJ[1:0]	01	R/W	Quantizer threshold control for test/debug
3:1	ADC_GM_ADJ[2:0]	000	R/W	Gm control for test/debug
0	ADC_DAC2_EN	0	R/W	Enables DAC2 for enhanced ADC stability

ADCTEST1 (0x61B6) – ADC Tuning

Bit No.	Name	Reset	R/W	Description
7:4	ADC_TEST_CTRL[3:0]	0000	R/W	ADC test mode selector
3:2	ADC_C2_ADJ[1:0]	11	R/W	Used to adjust capacitor values in ADC
1:0	ADC_C3_ADJ[1:0]	10	R/W	Used to adjust capacitor values in ADC

ADCTEST2 (0x61B7) – ADC Tuning

Bit No.	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6:5	ADC_TEST_MODE	00	R/W	Test mode to enable output of ADC data from demodulator. When enabled, raw ADC data is clocked out on the GPIO pins. 00: Test mode disabled 01: Data from both I and Q ADCs is output, data rate 76 MHz 10: Data from I ADC is output. Two and two ADC samples grouped, data rate 38 MHz 11: Data from Q ADC is output. Two and two ADC samples grouped, data rate 38 MHz
4:3	AAF_RS[1:0]	00	R/W	Controls series resistance of AAF
2:1	ADC_FF_ADJ[1:0]	01	R/W	Adjust feedforward
0	ADC_DAC_ROT	1	R/W	Control of DAC DWA scheme 0: DWA (scrambling) disabled 1: DWA enabled

MDMTEST0 (0x61B8) – Test Register for Modem

Bit No.	Name	Reset	R/W	Description
7:4	TX_TONE[3:0]	0111	R/W	<p>Enables the possibility to transmit a baseband tone by picking samples from the sine tables with a controllable phase step between the samples. The step size is controlled by TX_TONE. If MDMTEST1.MOD_IF is 0, the tone is superpositioned on the modulated data, effectively giving modulation with an IF. If MDMTEST1.MOD_IF is 1, only the tone is transmitted.</p> <p>0000: –6 MHz 0001: –4 MHz 0010: –3 MHz 0011: –2 MHz 0100: –1 MHz 0101: –500 kHz 0110: –4 kHz 0111: 0 1000: 4 kHz 1001: 500 kHz 1010: 1 MHz 1011: 2 MHz 1100: 3 MHz 1101: 4 MHz 1110: 6 MHz Others: Reserved</p>
3:2	DC_WIN_SIZE[1:0]	01	R/W	<p>Controls the number of samples to be accumulated between each dump of the accumulate-and-dump filter used in dc removal.</p> <p>00: 32 samples 01: 64 samples 10: 128 samples 11: 256 samples</p>
1:0	DC_BLOCK_MODE[1:0]	01	R/W	<p>Selects the mode of operation:</p> <p>00: The input signal to the dc blocker is passed on to the output without any attempt to remove dc. 01: Enable dc cancellation. Normal operation 10: Freeze estimates of dc when sync is found. Start estimating dc again when searching for the next frame 11: Reserved</p>

MDMTEST1 (0x61B9) – Test Register for Modem

Bit No.	Name	Reset	R/W	Description
7:5	–	000	R0	Reserved. Read as 0
4	MOD_IF	0	R/W	<p>0: Modulation is performed at an IF set by MDMTEST0.TX_TONE. 1: A tone is transmitted with frequency set by MDMTEST0.TX_TONE.</p>
3	RAMP_AMP	1	R/W	<p>1: Enable ramping of DAC output amplitude during startup and finish. 0: Disable ramping of DAC output amplitude</p>
2	RFC_SNIFF_EN	0	R/W	<p>0: Packet sniffer module disabled 1: Packet sniffer module enabled. The received and transmitted data can be observed on GPIO pins.</p>
1	MODULATION_MODE	0	R/W	<p>Set one of two RF modulation modes for RX/TX</p> <p>0: IEEE 802.15.4 compliant mode 1: Reversed phase, non-IEEE compliant</p>
0	RESERVED	0	R/W	Reserved. Do not write.

DACTEST0 (0x61BA) – DAC Override Value

Bit No.	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6:0	DAC_Q_O[6:0]	000 0000	R/W	Q-branch DAC override value when DAC_SRC = 001 If DAC_SRC is set to be ADC data, CORDIC magnitude, channel filtered data, then DAC_Q_O controls the part of the word in question that actually is muxed to the DAC as described in the following list. 00 0110 ≥ bits 6:0 00 0111 ≥ bits 7:1 00 1000 ≥ bits 8:2 and so on If an invalid setting is chosen, then the DAC outputs only zeros (minimum value).

DACTEST1 (0x61BB) – DAC Override Value

Bit No.	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6:0	DAC_I_O[6:0]	000 0000	R/W	I-branch DAC override value when DAC_SRC = 001 If DAC_SRC is set to be ADC data, CORDIC magnitude, channel filtered data, then DAC_I_O controls the part of the word in question that actually is muxed to the DAC as described in the following list. 00 0110 ≥ bits 6:0 00 0111 ≥ bits 7:1 00 1000 ≥ bits 8:2 And so on If an invalid setting is chosen, then the DAC outputs only zeros (minimum value),

DACTEST2 (0x61BC) – DAC Test Setting

Bit No.	Name	Reset	R/W	Description
7:3	–	0010 1	R0	Reserved
2:0	DAC_SRC[2:0]	000	R/W	The TX DAC's data source is selected by DAC_SRC according to: 000: Normal operation (from modulator). 001: The DAC_I_O and DAC_Q_O override values 010: ADC data after decimation, magnitude-controlled by DAC_I_O and DAC_Q_O 011: I/Q after decimation, channel and dc filtering, magnitude-controlled by DAC_I_O and DAC_Q_O 100: Cordic magnitude output and front-end gain is output, magnitude-controlled by DAC_I_O and DAC_Q_O 101: RSSI I output on the I DAC 111: Reserved

AATEST (0x61BD) – Analog Test Control

Bit No.	Name	Reset	R/W	Description
7:6	–	00	R0	Reserved. Read as 0
5:0	AATEST_CTRL[5:0]	00 0000	R/W	Controls the analog test mode: 00 0000: Disabled 00 0001: Enables the temperature sensor (see also the TR0 register description in Section 12.2.10). Other values reserved.

RFRND (0x61A7) – Random Data

Bit No.	Name	Reset	R/W	Description
7:2	–	0000 00	R0	Reserved. Read as 0
1	QRND	0	R/W	Random bit from the Q channel of the receiver
0	IRND	0	R/W	Random bit from the I channel of the receiver

PTEST0 (0x61BE) – Override Power-Down Register

Bit No.	Name	Reset	R/W	Description
7	PRE_PD	0	R/W	Prescaler power-down signal when PD_OVERRIDE = 1
6	CHP_PD	0	R/W	Charge-pump power-down signal when PD_OVERRIDE = 1
5	ADC_PD	0	R/W	Analog-to-digital converter power-down signal when PD_OVERRIDE = 1
4	DAC_PD	0	R/W	Digital-to-analog converter power-down signal when PD_OVERRIDE = 1
3:2	LNA_PD[1:0]	0	R/W	Low-noise amplifier power-down signal. Defines LNA/mixer PD modes. 00: Power up 01: LNA off, mixer/regulator on 10: LNA/mixer off, regulator on 11: PD When PD_OVERRIDE = 1
1	TXMIX_PD	0	R/W	Transmit mixer power-down signal when PD_OVERRIDE = 1
0	AAF_PD	0	R/W	Antialiasing filter power-down signal when PD_OVERRIDE = 1

PTEST1 (0x61BF) – Override Power-Down Register

Bit No.	Name	Reset	R/W	Description
7:4	–	0000	R0	Reserved. Read as 0
3	PD_OVERRIDE	0	R/W	Override enabling/disabling of various modules. For debug and testing only. It is impossible to override hard-coded BIAS_PD[1:0] dependency.
2	PA_PD	0	R/W	Power amplifier power-down signal when PD_OVERRIDE = 1
1	VCO_PD	0	R/W	Voltage-controlled oscillator power-down signal when PD_OVERRIDE = 1
0	LODIV_PD	0	R/W	LO power-down signal when PD_OVERRIDE = 1

RFC_OBS_CTRL0 (0x61EB) – RF Observation Mux Control

Bit No.	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6	RFC_OBS_POL0	0	R/W	The signal chosen by RFC_OBS_MUX0 is XORed with this bit.
5:0	RFC_OBS_MUX0	00 0000	R/W	<p>Controls which observable signal from RF Core is to be muxed out to rfc_obs_sigs[0].</p> <p>00 0000: 0 – Constant value</p> <p>00 0001: 1 – Constant value</p> <p>00 1000: rfc_sniff_data – Data from packet sniffer. Sample data on rising edges of sniff_clk.</p> <p>00 1001: rfc_sniff_clk – 250kHz clock for packet sniffer data.</p> <p>00 1100: rssi_valid – Pin is high when the RSSI value has been updated at least once since RX was started. Cleared when leaving RX.</p> <p>00 1101: demod_cca – Clear channel assessment. See FSMSTAT1 register for details on how to configure the behavior of this signal.</p> <p>00 1110: sampled_cca – A sampled version of the CCA bit from demodulator. The value is updated whenever a SSAMPLECCA or STXONCCA strobe is issued.</p> <p>00 1111: sfd_sync – Pin is high when a SFD has been received or transmitted. Cleared when leaving RX/TX respectively. Not to be confused with the SFD exception.</p> <p>01 0000: tx_active – Indicates that FFCTRL is in one of the TX states. Active-high. Note: This signal might have glitches, because it has no output flip-flop and is based on the current state register of the FFCTRL FSM.</p> <p>01 0001: rx_active – Indicates that FFCTRL is in one of the RX states. Active-high. Note: This signal might have glitches, because it has no output flip-flop and is based on the current state register of the FFCTRL FSM.</p> <p>01 0010: ffctrl_fifo – Pin is high when one or more bytes are in the RXFIFO. Low during RXFIFO overflow.</p> <p>01 0011: ffctrl_fifop – Pin is high when the number of bytes in the RXFIFO exceeds the programmable threshold or at least one complete frame is in the RXFIFO. Also high during RXFIFO overflow. Not to be confused with the FIFOP exception.</p> <p>01 0100: packet_done – A complete frame has been received. I.e., the number of bytes set by the frame-length field has been received.</p> <p>01 0110: rfc_xor_rand_i_q – XOR between I and Q random outputs. Updated at 8 MHz.</p> <p>01 0111: rfc_rand_q – Random data output from the Q channel of the receiver. Updated at 8 MHz.</p> <p>01 1000: rfc_rand_i – Random data output from the I channel of the receiver. Updated at 8 MHz</p> <p>01 1001: lock_status – 1 when PLL is in lock, otherwise 0</p> <p>10 1000: pa_pd – Power amplifier power-down signal</p> <p>10 1010: lna_pd – LNA power-down signal</p> <p>Others: Reserved</p>

RFC_OBS_CTRL1 (0x61EC) – RF Observation Mux Control

Bit No.	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6	RFC_OBS_POL1	0	R/W	The signal chosen by RFC_OBS_MUX1 is XORed with this bit.
5:0	RFC_OBS_MUX1	00 0000	R/W	<p>Controls which observable signal from RF Core is to be muxed out to rfc_obs_sigs[1]. See description of RFC_OBS_CTRL0 for details.</p>

RFC_OBS_CTRL2 (0x61ED) – RF Observation Mux Control

Bit No.	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6	RFC_OBS_POL2	0	R/W	The signal chosen by RFC_OBS_MUX2 is XORed with this bit.
5:0	RFC_OBS_MUX2	00 0000	R/W	<p>Controls which observable signal from RF Core is to be muxed out to rfc_obs_sigs[2]. See description of RFC_OBS_CTRL0 for details.</p>

TXFILTCFG (0x61FA) – TX Filter Configuration

Bit No.	Name	Reset	R/W	Description
7:4	–	0	R0	Reserved
3:0	FC	0xF	R/W	Sets TX anti-aliasing filter to appropriate bandwidth. Reduces spurious emissions close to signal. For the best value to use, see Table 23-6 in Section 23.15.1 .

IVCTRL (0x6265) – Analog control register (CC2533 only)

Bit No.	Name	Reset	R/W	Description
7:6	–	00	R0	Reserved. Always read as 0.
5:4	DAC_CURR_CTRL	01	R/W	Controls bias current to DAC 00: 100% IVREF, 0% IREF bias 01: 60% IVREF, 40% IREF bias 10: 40% IVREF, 60% IREF bias 11: 0% IVREF, 100% IREF bias
3	LODIV_BIAS_CTRL	0	R/W	Controls bias current to LODIV 1: PTAT bias 0: IVREF bias
2	TXMIX_DC_CTRL	0	R/W	Controls dc bias in TXMIX
1:0	PA_BIAS_CTRL	11	R/W	Controls bias current to PA 00: IREF bias 01: IREF and IVREF bias 10: PTAT bias 11: Increased PTAT slope bias

CC2540 Radio

The CC2540 provides a Bluetooth low-energy compliant radio transceiver. On the CC2540, radio operation is controlled by the *Bluetooth* low energy stack. The application is not allowed to access the radio directly. The application interacts with the radio by sending API commands to the stack. The TI BLE stack with documentation is available at www.ti.com/blestack.

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24.1 Registers

The following status registers are available to the user:

RFSTAT (0x618D) RF Core Status

Bit	Name	Reset	R/W	Description
7	MOD_UNDERFLOW	0	R/W0	Modulator has underflowed. Must be cleared by software
6:5	DEM_STATUS	00	R	Demodulator status 00: Idle 01: Active 10: Finishing 11: Error
4	SFD	0	R	High when the access address has been sent in TX or when sync has been obtained in RX
3	CAL_RUNNING	0	R	Frequency synth calibration status 0: Calibration done or not started 1: Calibration in progress
2	LOCK_STATUS	0	R	1 when PLL is in lock, otherwise 0
1	TX_ACTIVE	0	R	Status signal, active when radio is in transmit state
0	RX_ACTIVE	0	R	Status signal, active when radio is in receive state

RFC_OBS_CTRL0 (0x61AE) RF Observation Mux Control 0

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6	RFC_OBS_POL0	0	R/W	The signal chosen by RFC_OBS_MUX0 is XORed with this bit.
5:0	RFC_OBS_MUX0	00 0000	R/W	Controls which observable signal from rf_core is to be muxed out to rfc_obs_sigs(0). 00 0000: 0 – Constant value 00 0001: 1 – Constant value 00 1001: TX_active 00 1010: RX_active 11 0000: High from when receiver has found access address until packet is finished, low otherwise 11 0001: High from the access address has been transmitted until end of packet, low otherwise Other values reserved

RFC_OBS_CTRL1 (0x61AF) RF Observation Mux Control 1

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6	RFC_OBS_POL1	0	R/W	The signal chosen by RFC_OBS_MUX1 is XORed with this bit.
5:0	RFC_OBS_MUX1	00 0000	R/W	Controls which observable signal from rf_core is to be muxed out to rfc_obs_sigs(1). 00 0000: 0 – Constant value 00 0001: 1 – Constant value 00 1001: TX_active 00 1010: RX_active 11 0000: High from when receiver has found access address until packet is finished, low otherwise 11 0001: High from the access address has been transmitted until end of packet, low otherwise Other values reserved

RFC_OBS_CTRL2 (0x61B0) RF Observation Mux Control 2

Bit	Name	Reset	R/W	Description
7	–	0	R0	Reserved. Read as 0
6	RFC_OBS_POL2	0	R/W	The signal chosen by RFC_OBS_MUX2 is XORed with this bit.
5:0	RFC_OBS_MUX2	00 0000	R/W	Controls which observable signal from rf_core is to be muxed out to rfc_obs_sigs(2). 00 0000: 0 – Constant value 00 0001: 1 – Constant value 00 1001: TX active 00 1010: RX_active 11 0000: High from when receiver has found access address until packet is finished, low otherwise 11 0001: High from the access address has been transmitted until end of packet, low otherwise Other values reserved

ATEST (0x61A9) – Analog Test Control

Bit	Name	Reset	R/W	Description
7:6	–	00	R0	Reserved. Read as 0
5:0	ATEST_CTRL[5:0]	00 0000	R/W	Controls the analog test mode: 00 0000: Disabled 00 0001: Enables the temperature sensor (see also the TR0 register description in Section 12.2.10). Other values reserved.

Voltage Regulator

The digital voltage regulator is used to power the digital core. The output of this regulator is available on the DCOUPL pin and requires capacitive decoupling to function properly (see, e.g., the CC2530 reference design).

The voltage regulator is disabled in power modes PM2 and PM3 (see [Chapter 4](#)). When the voltage regulator is disabled, register and RAM contents are retained while the unregulated 2 V to 3.6 V power supply is present

NOTE: The voltage regulator should not be used to provide power to external circuits.

Available Software

This chapter presents the various available software solutions relevant to the CC253x/CC2540 family. They are all available free of charge on the TI Web site at www.ti.com/lprf when used with TI LPRF devices.

As shown in [Table 0-1](#) in the Preface, the members of the CC253x/CC2540 family have different flash/RAM sizes; hence, they are not equally well suited for the different software offerings in the sections below. For example, a user designing a ZigBee device should use the CC2530F256 as the Z-Stack™ requires in most cases more than 128 KB of flash and needs the 8-KB RAM.

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26.1 SmartRF™ Software for Evaluation (www.ti.com/smarrfstudio)

Texas Instruments' SmartRF Studio can be used for radio performance and functionality evaluation and is great for exploring and gaining knowledge about the RF-IC products. This software helps the designers of radio systems to evaluate the RF-ICs easily at an early stage in the design process. It is especially useful for generation of the configuration data and for finding optimized external component values.

SmartRF Studio software runs on Microsoft™ Windows™ 98, Windows 2000, Windows XP, Windows Vista (32 bit) and Windows 7 (32 bit). SmartRF Studio software can be downloaded from the Texas Instruments Web page: www.ti.com/smarrfstudio (<http://www.ti.com/litv/zip/swrc046m>).

Features

- Link tests. Send and receive packets between nodes
- Packet error-rate (PER) tests
- Communication with evaluation boards through the USB port or the parallel port
- Up to eight USB devices are supported on a single computer.
- Normal view with preferred register settings
- Register view with possibilities to read and write each individual register. Each register given with detailed information
- Save/Open configuration data from file
- Save/Load register settings from file
- Export/Import register values from text file
- Exports register settings into a C-compatible software structure

26.2 RemoTI™ Network Protocol (www.ti.com/remoti)

Most existing remote controls use infrared technology to communicate commands to consumer electronics devices. However, radio frequency (RF) remote controls enable non-line-of-sight operation and provide more advanced features based on bidirectional RF communication.

ZigBee Radio Frequency for Consumer Electronics (RF4CE) is the result of a recent agreement between the ZigBee Alliance and the RF4CE Consortium (<http://www.zigbee.org/rf4ce>) and has been designed to be deployed in a wide range of remotely-controlled audio/visual consumer electronics products, such as TVs and set-top boxes. ZigBee RF4CE promises you:

- Richer communication and increased reliability
- Enhanced features and flexibility
- Interoperability
- No line-of-sight barrier

The RemoTI network protocol is Texas Instruments' implementation of the ZigBee RF4CE standard. It is a complete solution offering hardware and software support for TI's low-power RF product portfolio. With the RemoTI network protocol we provide:

- The industry-leading RF4CE-compliant stack featuring the interoperable CERC profile support, a simple API, easy-to-understand sample application code, full development kits and reference designs, and much more.
- Operation on our best-in-class IEEE 802.15.4 compliant System-on-Chip, the CC2530, with excellent RF co-existence and RF performance. The four flexible power modes include the lowest-current-consumption power-down mode for long battery in life low-duty-cycle applications.
- Extensive worldwide support and tools to ensure that development of ZigBee RF4CE-based products is simple, fast, and can be completed at minimal cost.
- The RemoTI network protocol is a Golden Unit platform; i.e., it is used for testing other implementations of the ZigBee RF4CE standard for standard compliance.

For more information on TI's RemoTI network protocol, see the Texas Instruments RemoTI network protocol Web site www.ti.com/remoti.

26.3 SimpliciTI™ Network Protocol (www.ti.com/simpliciti)

The SimpliciTI network protocol is a low-power RF protocol (for sub-1 GHz, 2.4 GHz, and IEEE 802.15.4 RF ICs) targeting simple, small RF networks. This open-source software is an excellent start for building a network with battery-operated devices using a TI low-power RF System-on-Chip (SoC). The SimpliciTI network protocol was designed for easy implementation and deployment out-of-the-box on several TI RF platforms. It provides several sample applications.

Key Applications

- Alarm and security: occupancy sensors, light sensors, carbon monoxide sensors, glass-breakage detectors
- Smoke detectors
- Automatic meter reading: gas meters, water meters, e-meters
- Active RFID applications

Key Features

- Low power: A TI-proprietary low-power network protocol
- Flexible:
 - Direct device-to-device communication
 - Simple star with access point for store and forward to end device
 - Range extenders to increase range to four hops
- Simple: uses a five-command API
- Low data rate and low duty cycle
- Ease of use

For more information about the SimpliciTI network protocol, see the Texas Instruments SimpliciTI network protocol Web site www.ti.com/simpliciti.

26.4 TIMAC Software (www.ti.com/timac)

TIMAC software is an IEEE 802.15.4 medium-access-control software stack for TI's IEEE 802.15.4 transceivers and System-on-Chips.

You can use TIMAC when you:

- Need a wireless point-to-point or point-to-multipoint solution; e.g., multiple sensors reporting directly to a master
- Need a standardized wireless protocol
- Have battery-powered and/or mains-powered nodes
- Need support for acknowledgement and retransmission
- Have low data-rate requirements (around 100-kbps effective data rate)

Features

- Support for IEEE 802.15.4 standard
- Support for beacon-enabled and non-beaconing systems
- Multiple platforms
- Easy application development

The TIMAC software stack is certified to be compliant with the IEEE 802.15.4 standard. TIMAC software is distributed as object code free of charge. There are no royalties for using TIMAC software.

For more information about TIMAC software, see the Texas Instruments TIMAC Web site www.ti.com/timac.

26.5 Z-Stack™ Software (www.ti.com/z-stack)

The Z-Stack software is TI's ZigBee-compliant protocol stack for a growing portfolio of IEEE 802.15.4 products and platforms. The Z-Stack software stack is compliant with the ZigBee-2007 specification, supporting both the ZigBee and ZigBee PRO features sets. The Z-Stack software includes implementation of two ZigBee application profiles – SmartEnergy and HomeAutomation. Other application profiles can easily be implemented by the user.

Z-Stack software notables include:

- A fully compliant ZigBee and ZigBee PRO feature set
- A range of sample applications including support for the ZigBee Smart Energy and ZigBee Home Automation profiles
- Over-the-air download and serial boot loader support
- Can be used together with the RF front ends, [CC2590](#) and [CC2591](#), which support 10 dBm and 20 dBm output power, respectively, and improved receive sensitivity.

The Z-Stack software has been awarded the ZigBee Alliance's golden-unit status for both the ZigBee and ZigBee PRO stack profiles and is used by ZigBee developers worldwide.

Z-Stack software is well suited for:

- Smart energy (AMI)
- Home automation
- Commercial building automation
- Medical, assisted living, or personal health and hospital care
- Monitoring and control applications
- Wireless sensor networks
- Alarm and security
- Asset tracking
- Applications that require interoperability

For more information about Z-Stack software, see the Texas Instruments Z-Stack software Web site www.ti.com/z-stack.

26.6 BLE Stack Software

TI's single-mode *Bluetooth* low energy stack has been certified according to the *Bluetooth* 4.0 low energy specification. Key features:

- Supports all BLE roles
- Range of example applications
- Multi-role capabilities

For more information about TI's BLE stack software, visit Texas Instruments *Bluetooth* low energy stack software Web site at www.ti.com/blestack.

Abbreviations

Abbreviations used in this user's guide:

AAF	Anti-aliasing filter
ADC	Analog-to-digital converter
AES	Advanced Encryption Standard
AGC	Automatic gain control
ARIB	Association of Radio Industries and Businesses
BCD	Binary-coded decimal
BER	Bit error rate
BLE	Bluetooth low-energy
BOD	Brownout detector
BOM	Bill of materials
CBC	Cipher block chaining
CBC-MAC	Cipher block chaining message authentication code
CCA	Clear channel assessment
CCM	Counter mode + CBC-MAC
CFB	Cipher feedback
CFR	Code of Federal Regulations
CMRR	Common-mode rejection ratio
CPU	Central processing unit
CRC	Cyclic redundancy check
CSMA-CA	Carrier sense multiple access with collision avoidance
CSP	CSMA/CA strobe processor
CTR	Counter mode (encryption)
CW	Continuous wave
DAC	Digital-to-analog converter
DC	Direct current
DMA	Direct memory access
DSM	Delta-sigma modulator
DSSS	Direct-sequence spread spectrum
ECB	Electronic code book (encryption)
EM	Evaluation module
ENOB	Effective number of bits
ETSI	European Telecommunications Standards Institute
EVM	Error vector magnitude
FCC	Federal Communications Commission
FCF	Frame control field
FCS	Frame check sequence
FFCTRL	FIFO and frame control
FIFO	First in, first out
GPIO	General-purpose input/output

HF	High frequency
HSSD	High-speed serial data
I/O	Input/output
I/Q	In-phase/quadrature-phase
IEEE	Institute of Electrical and Electronics Engineers
IF	Intermediate frequency
IOC	I/O controller
IRQ	Interrupt request
IR	Infrared
ISM	Industrial, scientific and medical
ITU-T	International Telecommunication Union – Telecommunication
IV	Initialization vector
KB	1024 bytes
kbps	Kilobits per second
LFSR	Linear feedback shift register
LNA	Low-noise amplifier
LO	Local oscillator
LQI	Link quality indication
LSB	Least-significant bit/byte
MAC	Medium access control
MAC	Message authentication code
MCU	Microcontroller unit
MFR	MAC footer
MHR	MAC header
MIC	Message integrity code
MISO	Master in, slave out
MOSI	Master out, slave in
MPDU	MAC protocol data unit
MSB	Most-significant bit/byte
MSDU	MAC service data unit
MUX	Multiplexer
NA	Not applicable/available
NC	Not connected
OFB	Output feedback (encryption)
O-QPSK	Offset – quadrature phase-shift keying
PA	Power amplifier
PC	Program counter
PCB	Printed circuit board
PER	Packet error rate
PHR	PHY header
PHY	Physical layer
PLL	Phase-locked loop
PM1, PM2, PM3	Power mode 1, 2, and 3
PMC	Power management controller
POR	Power-on reset
PSDU	PHY service data unit
PWM	Pulse-width modulator
RAM	Random access memory
RBW	Resolution bandwidth

RC	Resistor-capacitor
RCOSC	RC oscillator
RF	Radio frequency
RSSI	Receive signal strength indicator
RTC	Real-time clock
RX	Receive
SCK	Serial clock
SFD	Start of frame delimiter
SFR	Special function register
SHR	Synchronization header
SINAD	Signal-to-noise and distortion ratio
SPI	Serial peripheral interface
SRAM	Static random-access memory
ST	Sleep timer
T/R	Tape and reel
T/R	Transmit/receive
THD	Total harmonic distortion
TI	Texas Instruments
TX	Transmit
UART	Universal asynchronous receiver/transmitter
USART	Universal synchronous/asynchronous receiver/transmitter
VCO	Voltage-controlled oscillator
VGA	Variable-gain amplifier
WDT	Watchdog timer
XOSC	Crystal oscillator

Additional Information

Texas Instruments offers a wide selection of cost-effective, low-power RF solutions for proprietary and standard-based wireless applications for use in industrial and consumer applications. Our selection includes RF transceivers, RF transmitters, RF front ends and System-on-Chips as well as various software solutions for the sub-1 and 2.4-GHz frequency bands.

In addition, Texas Instruments provides a large selection of support collateral such as development tools, technical documentation, reference designs, application expertise, customer support, third-party and university programs.

The Low-Power RF E2E Online Community provides you with technical support forums, videos and blogs, and the chance to interact with fellow engineers from all over the world.

With a broad selection of product solutions, end application possibilities, and the range of technical support, Texas Instruments offers the broadest low-power RF portfolio. **We make RF easy!**

The following subsections point to where to find more information.

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B.1 Texas Instruments Low-Power RF Web Site

Texas Instruments' Low-Power RF Web site has all our latest products, application and design notes, FAQ section, news and events updates, and much more. Just go to www.ti.com/lprf.

B.2 Low-Power RF Online Community

- Forums, videos, and blogs
- RF design help
- E2E interaction - Posting one's own and reading other users' questions

Join us today at www.ti.com/lprf-forum

B.3 Texas Instruments Low-Power RF Developer Network

Texas Instruments has launched an extensive network of low-power RF development partners to help customers speed up their application development. The network consists of recommended companies, RF consultants, and independent design houses that provide a series of hardware module products and design services, including:

- RF circuit, low-power RF and ZigBee design services
- Low-power RF and ZigBee module solutions and development tools
- RF certification services and RF circuit manufacturing

Need help with modules, engineering services or development tools?

Search the [Low-Power RF Developer Network](#) to find a suitable partner! www.ti.com/lprfnetwork

B.4 Low-Power RF eNewsletter

The Low-Power RF eNewsletter keeps you up to date on new products, news releases, developers' news, and other news and events associated with low-power RF products from TI. The Low-Power RF eNewsletter articles include links to get more online information.

Sign up today on www.ti.com/lprfnewsletter.

References

References and other useful material:

1. IEEE Std. 802.15.4-2006: Wireless Medium Access Control (MAC) and Physical Layer (PHY) specifications for Low Rate Wireless Personal Area Networks (LR-WPANs)
<http://standards.ieee.org/getieee802/download/802.15.4-2006.pdf>
2. CC2530 Data Sheet ([SWRS081](#))
3. CC2531 Data Sheet ([SWRS086](#))
4. CC2533 Data Sheet ([SWRS087](#))
5. CC2540 Data Sheet ([SWRS084](#))

Revision History – CC253x/CC2540 User's Guide

Changes from A Revision (June 2010) to B Revision	Page
• Included CC2540 device in document title	1
• Added new Operational Amplifier and Analog Comparator section	4
• Deleted <i>Calibration</i> and <i>Clock Source</i> sections	7
• Changed "CSP" to "Radio" in Section 22.3 title	8
• Added block diagram for CC2540 and inserted appropriate references in text	10
• Reversed direction of Time arrow in Figure 8-2	10
• In Figure 15-1 caption, changed "Block 0" to "Block B0"	10
• Added Operational Amplifier, Analog Comparator, and OBSSEL to map	12
• Added mention of and reference to CC2540 in <i>Related Documentation and Software</i> section	13
• Included mention of BLE stack software	13
• Included mention of Bluetooth fro CC2540	14
• Added CC2540 to <i>If You Need Assistance</i> section	14
• Add data to table for CC2540	14
• Added block diagram for CC2540 and inserted appropriate references in text	19
• Deleted text from first sentence of 8051 CPU core description	20
• Revised second sentence of 4/6.8-KB SRAM description	20
• Added 96-KB flash	20
• Added a reference to the family overview table	20
• Added CC2540 to USB devices description	21
• Added descriptions of operational amplifier and analog comparator	22
• Changed Radio section to include CC2540	22
• Added BLE stack software to third paragraph of Applications section	22
• Rewrote the Information Page subsection	27
• Added reference to new <i>CC2540 Radio</i> section	31
• Added rows to table for new registers	31
• Added mew paragraph at end of Interrupt Masking section	40
• Added I ² C to interrupt 6	40
• Changed PAGES-1:0 to PAGES-2:0	56
• Added CC2540 to CHIPID description.	57
• Deleted last two sentences of Power Management Introduction section	60
• Rewrote last paragraph of Oscillators and Clocks section	65
• Made mention of 1024-byte flash pages	72
• Deleted paragraph following Table 6-1	73
• Added a flash address for CC2533 and deleted part of a sentence in Flash Page Erase section	74
• Deleted a sentence from Section 6.3.2	75
• Added flash bits for CC2533	76
• Added Operational Amplifier, Analog Comparator, and OBSSEL to map	79
• Added Operational Amplifier, Analog Comparator, and OBSSEL to map	80
• Added new Operational Amplifier and Analog Comparator section	82
• Added note concerning register data retention in sleep states	89
• Reversed direction of Time arrow in Figure 8-2	95
• Rewrote first sentence of second paragraph in DMA Interrupts section	97
• Simplified the description of TRIG[4:0] in Table 8-2	99
• Changed bits 7:5 of DMAIRQ register from R/W0 to R0	101
• Added "occurs" to description of CMP[2:0] field in register T4CCTL0	127
• Deleted last sentence from first paragraph of General section	130
• Added three new paragraphs to the General section	130
• Major rewrite of Timer Compare section	130
• Added exception to use of Sleep Timer compare event for CC2540	130

• Added a sentence to the paragraph following the timer capture sequence	130
• Named devices in the CC25xx family that have an ADC	133
• In the second paragraph of Section 12.2.1 , changed "between the pairs" to "between the pins of each pair"	134
• In the fifth paragraph of Section 12.2.1 , noted that channel 13 is reserved	135
• Rewrote last sentence in first paragraph of Section 12.2.5	136
• Changed ADCCON1 bits 5:4 from R/W1 to R/W, and bit six from blank to R/W1/H0	137
• Added to description for the 3:2 bit field in the ADCCON1 register	137
• Noted that battery monitor is in CC2533 only	141
• Deleted "(CC2533 only)" from titles for BATTMON and MONMUX register description tables	144
• In the last sentence of Chapter 15 , replaced "block load" with "block is loaded"	150
• In nex-to-last paragraph of Chapter 15 , added "each" to parenthetical expression	150
• Deleted redundant text from CBC-MAC paragraph and referenced relevant section	150
• In Figure 15-1 caption, changed "Block 0" to "Block B0"	151
• Deleted 01 as a value that can stop and clear the timer	156
• Changed description for MODE[1:0] value 01 to Reserved	157
• Rewrote last paragraph of Section 19.2	162
• Added a chapter for the operational amplifier	169
• Additionally listed CC2530 and CC2531 as having an operational amplifier	169
• Deleted all but the first paragraph of the Calibration section	170
• Made calibration a mandatory, rather than a typical, operation	170
• Rewrote description of MODE bits. Changed Description and RW columns for reserved bits 7:2	170
• Added a chapter for the analog comparator	171
• Additionally listed CC2530 and CC2531 as devices that have an analog comparator	171
• Deleted third bullet in list	171
• Deleted <i>Calibration</i> and <i>Clock Source</i> sections	171
• Deleted <i>Calibration</i> and <i>Clock Source</i> sections	172
• Changed "operational amplifier" to "analog comparator"	172
• Noted that I ² C is in the CC2533 only	173
• Noted that the USB controller is in the CC2530/CC2531/CC2540 only	187
• Changed name of USBCTRL bit 2 from "PLL_LOCK" to "-"	198
• Revised description of USBCTRL.USB_EN bit	198
• Added new information to Timer 2 explanation	203
• Changed "CSP" to "Radio" in Section 22.3 title	203
• Changed "CSP" to "Radio" in Section 22.3 title	205
• Changed second sentence of first Section 22.3 paragraph	205
• Retitled T2EVTCFG register description table	210
• Changed 14 to 6 in description of FRMCTRL1, bit 0	263
• Changed STXON to set bit 6 instead of bit 8	263
• New chapter added for CC2540 radio	279

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

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